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## MSP430F676x1 Polyphase Metering SoCs

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### 1 Device Overview

#### 1.1 Features

- Accuracy <0.5% Over 2000:1 Dynamic Range for Phase Current
- Meets or Exceeds ANSI C12.20 and IEC 63053 Standards
- Support for Multiple Sensors Such as Current Transformers, Rogowski Coils, or Shunts
- Power Measurement for up to Three Phases
- Dedicated Pulse Output Pins for Active and Reactive Energy for Calibration
- Four-Quadrant Measurement per Phase or Cumulative
- Exact Phase Angle Measurements
- Digital Phase Correction for Current Transformers
- 40-Hz to 70-Hz Line Frequency Range Using Single Calibration
- Flexible Power Supply Options With Automatic Switching
- Display Operates at Very Low Power During AC Mains Failure: 3  $\mu$ A in LPM3
- Real-Time Clock (RTC) Module With Integrated Offset and Temperature Calibration
- Multiple Communication Interfaces for Smart Meter Implementations
- High-Performance 25-MHz CPU With 32-Bit Multiplier
- Up to 128KB of Flash With Single-Cycle Execution
- Up to 8KB of RAM With Single-Cycle Access
- Up to Three Independent 24-Bit Sigma-Delta ADCs With Differential Inputs and Variable Gain
- System Analog-to-Digital Converter (ADC): 10-Bit, 200-ksps, Six Channels Plus Temperature Sensor and Supply Measurement
- Wide Input Supply Voltage Range: 1.8 V to 3.6 V
- Ultra-Low-Power Consumption During Energy Measurement
  - 3.0 mW at 10-MHz Operation (3.0 V)
- Multiple Low-Power Modes
  - Standby Mode (LPM3): 2.5  $\mu$ A at 3 V, Wakeup in 3  $\mu$ s (Typical)
  - RTC Mode (LPM3.5): 1.24  $\mu$ A at 3 V (Typical)
  - Shutdown Mode (LPM4.5): 0.78  $\mu$ A at 3 V (Typical)
- LCD Driver With Contrast Control for up to 320 Segments
- Password-Protected RTC With Crystal Offset Calibration and Temperature Compensation
- Four Communications Ports
  - Configurable Among Four UART, Three SPI, and One I<sup>2</sup>C Interfaces
- Four 16-Bit Timers With Nine Capture/Compare Registers
- 100-Pin LQFP (PZ) Package with 72 I/O Pins
- 80-Pin LQFP (PN) Package with 52 I/O Pins
- Industrial Temperature Range of –40°C to 85°C

#### 1.2 Applications

- Three-Phase Electronic Watt-Hour Meters
- Utility Metering
- Energy Monitoring



### 1.3 Description

The Texas Instruments MSP430F676x1 polyphase metering SoCs are powerful highly integrated solutions for revenue meters that offer accuracy and low system cost with few external components. The F676x1 uses the low-power MSP430™ CPU with a 32-bit multiplier to perform all energy calculations, metering applications such as tariff rate management, and communications with AMR or AMI modules. The F676x1 features TI's 24-bit sigma-delta converter technology, which provides better than 0.5% accuracy. Family members include up to 128KB of flash and 8KB of RAM and an LCD controller with support for up to 320 segments. The ultra-low-power nature of the F676x1 means that the system power supply can be minimized to reduce overall cost. Lowest standby power means that backup energy storage can be minimized, and critical data retained longer in case of a mains power failure. The F676x1 family executes the TI energy measurement software library, which calculates all relevant energy and power results. The energy measurement software library is available with the F676x1 at no cost. Industry standard development tools and hardware platforms are available to speed development of meters that meet all of the ANSI and IEC standards globally.

**Device Information<sup>(1)</sup>**

| ORDER NUMBER   | PACKAGE (PIN) | BODY SIZE <sup>(2)</sup> |
|----------------|---------------|--------------------------|
| MSP430F67641PZ | LQFP (100)    | 14 mm x 14 mm            |
| MSP430F67641PN | LQFP (80)     | 12 mm x 12 mm            |
| MSP430F67621PZ | LQFP (100)    | 14 mm x 14 mm            |
| MSP430F67621PN | LQFP (80)     | 12 mm x 12 mm            |

- (1) For the most current device, package, and ordering information, see the Package Option Addendum in [Section 9](#), or see the TI web site at [www.ti.com](http://www.ti.com).
- (2) The sizes shown here are approximations. For the package dimensions with tolerances, see the Mechanical Data in [Section 9](#).

### 1.4 Application Diagram

Figure 1-1 shows a typical application diagram for the MSP430F676x1 devices.

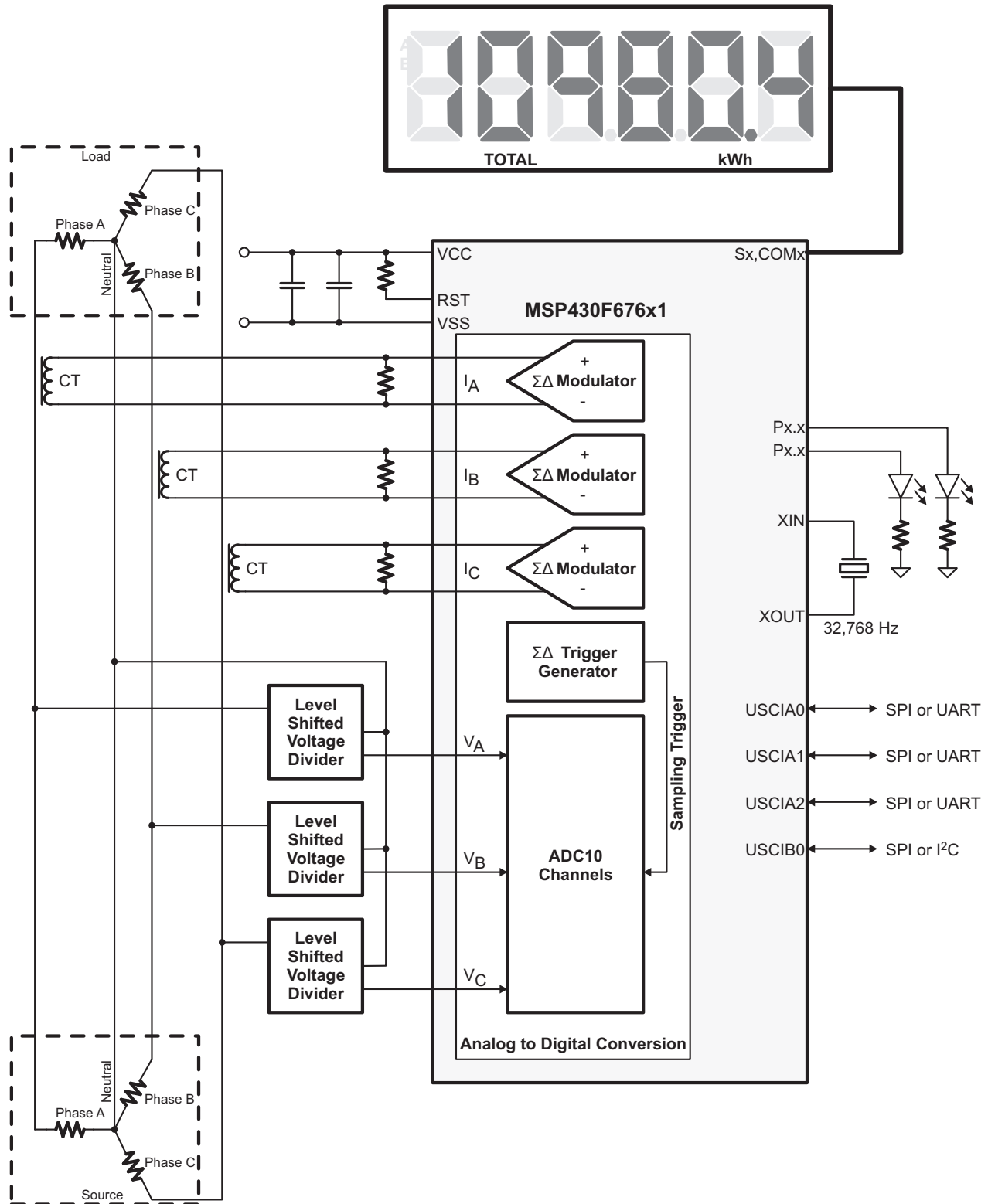


Figure 1-1. 3-Phase 4-Wire Star Connection Using MSP430F676x1

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## 2 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| DATE      | REVISION | NOTES           |
|-----------|----------|-----------------|
| June 2014 | *        | Initial Release |

### 3 Device Comparison

Table 3-1 summarizes the available family members.

**Table 3-1. Device Comparison<sup>(1)(2)</sup>**

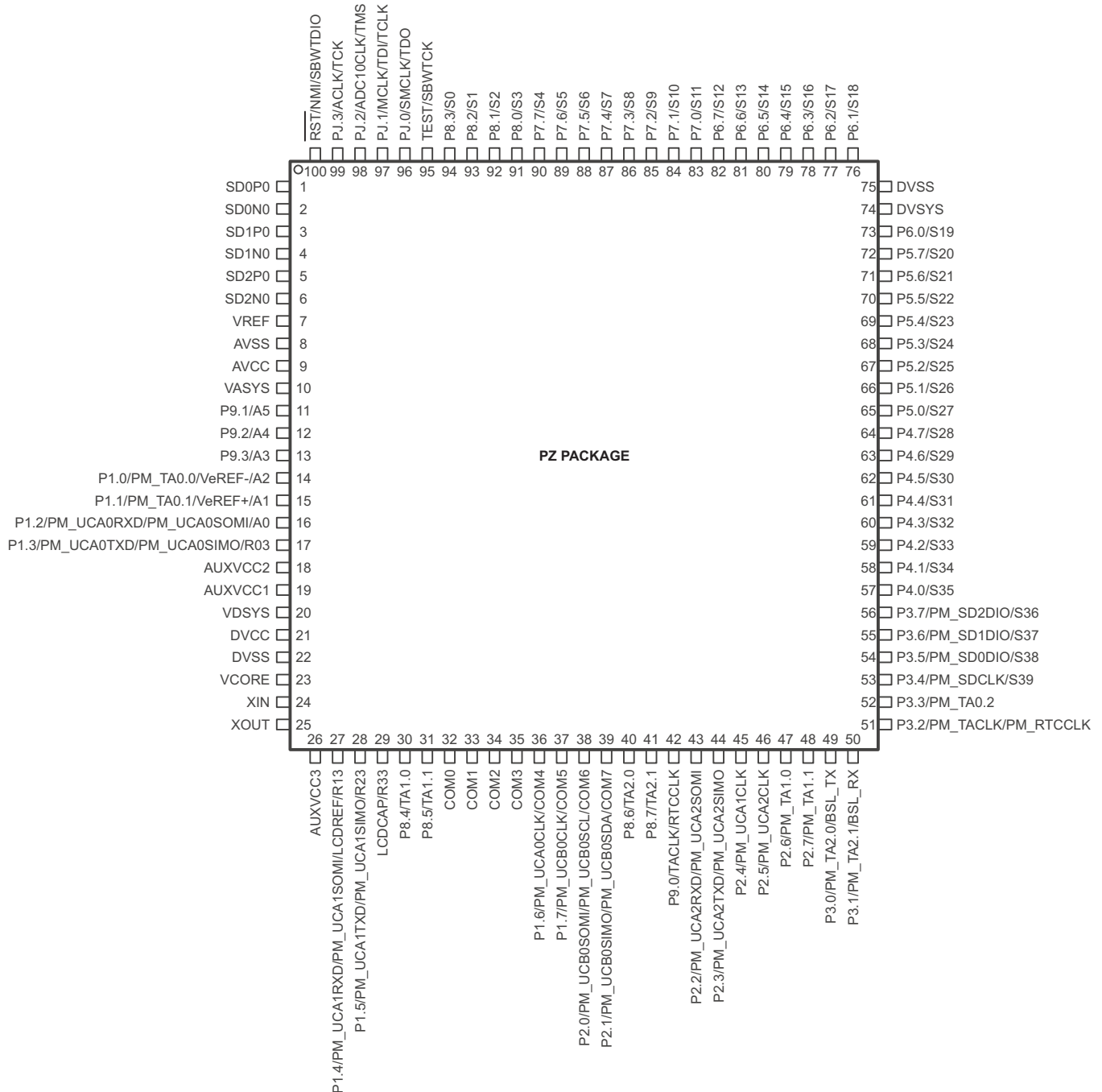
| Device       | Flash (KB) | SRAM (KB) | SD24_B Converters | ADC10_A Channels | Timer_A <sup>(3)</sup> | eUSCI                      |                                  | I/O | Package Type |
|--------------|------------|-----------|-------------------|------------------|------------------------|----------------------------|----------------------------------|-----|--------------|
|              |            |           |                   |                  |                        | Channel A: UART, IrDA, SPI | Channel B: SPI, I <sup>2</sup> C |     |              |
| MSP430F67641 | 128        | 8         | 3                 | 6 ext, 2 int     | 3, 2, 2, 2             | 3                          | 1                                | 72  | 100 PZ       |
|              |            |           |                   |                  |                        |                            |                                  | 52  | 80 PN        |
| MSP430F67621 | 64         | 4         | 3                 | 6 ext, 2 int     | 3, 2, 2, 2             | 3                          | 1                                | 72  | 100 PZ       |
|              |            |           |                   |                  |                        |                            |                                  | 52  | 80 PN        |

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](http://www.ti.com).
- (2) Package drawings, thermal data, and symbolization are available at [www.ti.com/packaging](http://www.ti.com/packaging).
- (3) Each number in the sequence represents an instantiation of Timer\_A with its associated number of capture compare registers and PWM output generators available. For example, a number sequence of 3, 5 would represent two instantiations of Timer\_A, the first instantiation having 3 and the second instantiation having 5 capture compare registers and PWM output generators, respectively.

## 4 Terminal Configuration and Functions

### 4.1 Pin Diagrams

Figure 4-1 shows the pin assignments for the 100-pin PZ package.



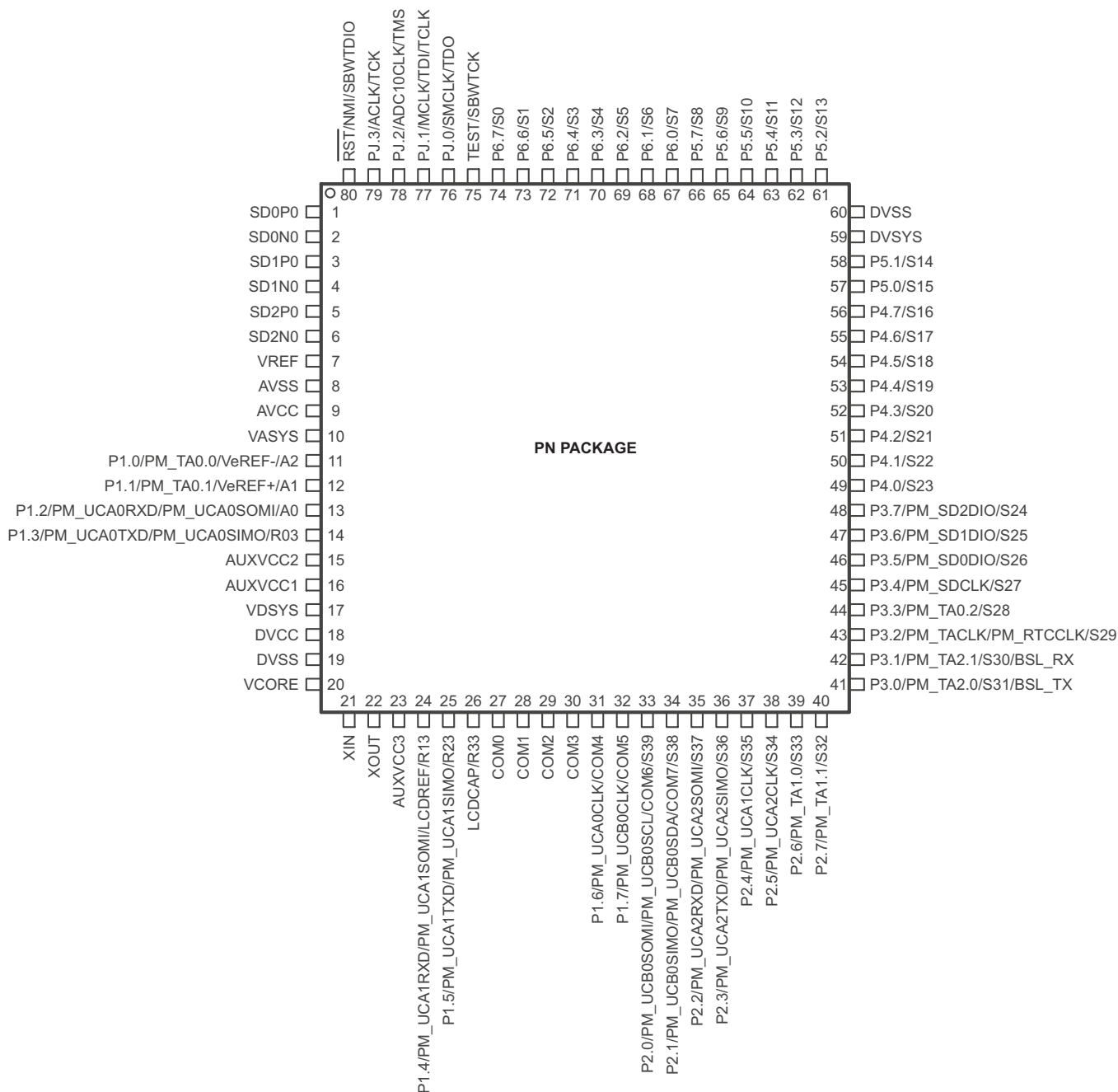
NOTE: The secondary digital functions on Ports P1, P2, and P3 are fully mappable. The pin designation shows the default mapping. See Table 6-8 for details.

NOTE: The pins VDSYS and DVSYS must be connected externally on board for proper device operation.

CAUTION: The LDCAP/R33 pin must be connected to DVSS if not used.

Figure 4-1. Pin Designation – PZ Package (Top View)

Figure 4-2 shows the pin assignments for the 80-pin PN package.



NOTE: The secondary digital functions on Ports P1, P2, and P3 are fully mappable. The pin designation shows the default mapping. See Table 6-8 for details.

NOTE: The pins VDSYS and DVSYS must be connected externally on board for proper device operation.

CAUTION: The LCDCAP/R33 pin must be connected to DVSS if not used.

Figure 4-2. Pin Designation – PN Package (Top View)

## 4.2 Signal Descriptions

[Table 4-1](#) describes the signals for the 100-pin PZ package.

[Table 4-2](#) describes the signals for the 80-pin PN package.

**Table 4-1. Signal Descriptions – PZ Package**

| TERMINAL                           |           | I/O <sup>(1)</sup> | DESCRIPTION  |
|------------------------------------|-----------|--------------------|--|
| NAME                               | NO.<br>PZ |                    |  |
| SD0P0                              | 1         | I                  | SD24_B positive analog input for converter 0 <sup>(2)</sup>  |
| SD0N0                              | 2         | I                  | SD24_B negative analog input for converter 0 <sup>(2)</sup>  |
| SD1P0                              | 3         | I                  | SD24_B positive analog input for converter 1 <sup>(2)</sup>  |
| SD1N0                              | 4         | I                  | SD24_B negative analog input for converter 1 <sup>(2)</sup>  |
| SD2P0                              | 5         | I                  | SD24_B positive analog input for converter 2 <sup>(2)</sup>  |
| SD2N0                              | 6         | I                  | SD24_B negative analog input for converter 2 <sup>(2)</sup>  |
| VREF                               | 7         | I                  | SD24_B external reference voltage  |
| AVSS                               | 8         |                    | Analog ground supply   |
| AVCC                               | 9         |                    | Analog power supply  |
| VASYS                              | 10        |                    | Analog power supply selected between AVCC, AUXVCC1, AUXVCC2. Connect recommended capacitor value of C <sub>VSYS</sub> (see <a href="#">Table 5-18</a> ).   |
| P9.1/A5                            | 11        | I/O                | General-purpose digital I/O<br>Analog input A5 - 10-bit ADC  |
| P9.2/A4                            | 12        | I/O                | General-purpose digital I/O<br>Analog input A4 - 10-bit ADC  |
| P9.3/A3                            | 13        | I/O                | General-purpose digital I/O<br>Analog input A3 - 10-bit ADC  |
| P1.0/PM_TA0.0/VeREF-/A2            | 14        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: Timer TA0 CCR0 capture: CCI0A input, compare: Out0 output<br>Negative terminal for the ADC's reference voltage for an external applied reference voltage<br>Analog input A2 - 10-bit ADC |
| P1.1/PM_TA0.1/VeREF+/A1            | 15        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: Timer TA0 CCR1 capture: CCI1A input, compare: Out1 output<br>Positive terminal for the ADC's reference voltage for an external applied reference voltage<br>Analog input A1 - 10-bit ADC |
| P1.2/PM_UCA0RXD/<br>PM_UCA0SOMI/A0 | 16        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_A0 UART receive data<br>Default mapping: eUSCI_A0 SPI slave out/master in<br>Analog input A0 - 10-bit ADC  |

(1) I = input, O = output

(2) It is recommended to short unused analog input pairs and connect them to analog ground.



**Table 4-1. Signal Descriptions – PZ Package (continued)**

| TERMINAL                                   |           | I/O <sup>(1)</sup> | DESCRIPTION   |
|--|-----------|--------------------|---|
| NAME                                       | NO.<br>PZ |                    |   |
| P1.3/PM_UCA0TXD/<br>PM_UCA0SIMO/R03        | 17        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_A0 UART transmit data<br>Default mapping: eUSCI_A0 SPI slave in/master out<br>Input/output port of lowest analog LCD voltage (V5)   |
| AUXVCC2                                    | 18        |                    | Auxiliary power supply AUXVCC2  |
| AUXVCC1                                    | 19        |                    | Auxiliary power supply AUXVCC1  |
| VDSYS <sup>(3)</sup>                       | 20        |                    | Digital power supply selected between DVCC, AUXVCC1, AUXVCC2. Connect recommended capacitor value of C <sub>VSYS</sub> (see <a href="#">Table 5-18</a> ).   |
| DVCC                                       | 21        |                    | Digital power supply  |
| DVSS                                       | 22        |                    | Digital ground supply   |
| VCORE <sup>(4)</sup>                       | 23        |                    | Regulated core power supply (internal use only, no external current loading)  |
| XIN  | 24        | I                  | Input terminal for crystal oscillator   |
| XOUT                                       | 25        | O                  | Output terminal for crystal oscillator  |
| AUXVCC3                                    | 26        |                    | Auxiliary power supply AUXVCC3 for back up subsystem  |
| P1.4/PM_UCA1RXD/<br>PM_UCA1SOMI/LCDREF/R13 | 27        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_A1 UART receive data<br>Default mapping: eUSCI_A1 SPI slave out/master in<br>External reference voltage input for regulated LCD voltage<br>Input/output port of third most positive analog LCD voltage (V3 or V4) |
| P1.5/PM_UCA1TXD/<br>PM_UCA1SIMO/R23        | 28        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_A1 UART transmit data<br>Default mapping: eUSCI_A1 SPI slave in/master out<br>Input/output port of second most positive analog LCD voltage (V2)   |
| LDCAP/R33                                  | 29        | I/O                | LCD capacitor connection<br>Input/output port of most positive analog LCD voltage (V1)<br><b>CAUTION:</b> This pin must be connected to DVSS if not used.   |
| P8.4/TA1.0                                 | 30        | I/O                | General-purpose digital I/O<br>Timer TA1 CCR0 capture: CCI0A input, compare: Out0 output  |
| P8.5/TA1.1                                 | 31        | I/O                | General-purpose digital I/O<br>Timer TA1 CCR1 capture: CCI1A input, compare: Out1 output  |
| COM0                                       | 32        | O                  | LCD common output COM0 for LCD backplane  |
| COM1                                       | 33        | O                  | LCD common output COM1 for LCD backplane  |
| COM2                                       | 34        | O                  | LCD common output COM2 for LCD backplane  |
| COM3                                       | 35        | O                  | LCD common output COM3 for LCD backplane  |
| P1.6/PM_UCA0CLK/COM4                       | 36        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_A0 clock input/output<br>LCD common output COM4 for LCD backplane   |

(3) The pins VDSYS and DVSYS must be connected externally on board for proper device operation.

(4) VCORE is for internal use only. No external current loading is possible. VCORE should only be connected to the recommended capacitor value, C<sub>VCORE</sub>.

**Table 4-1. Signal Descriptions – PZ Package (continued)**

| TERMINAL                             |           | I/O <sup>(1)</sup> | DESCRIPTION  |
|--------------------------------------|-----------|--------------------|--|
| NAME                                 | NO.<br>PZ |                    |  |
| P1.7/PM_UCB0CLK/COM5                 | 37        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_B0 clock input/output<br>LCD common output COM5 for LCD backplane  |
| P2.0/PM_UCB0SOMI/<br>PM_UCB0SCL/COM6 | 38        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_B0 SPI slave out/master in<br>Default mapping: eUSCI_B0 I <sup>2</sup> C clock<br>LCD common output COM6 for LCD backplane |
| P2.1/PM_UCB0SIMO/<br>PM_UCB0SDA/COM7 | 39        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_B0 SPI slave in/master out<br>Default mapping: eUSCI_B0 I <sup>2</sup> C data<br>LCD common output COM7 for LCD backplane  |
| P8.6/TA2.0                           | 40        | I/O                | General-purpose digital I/O<br>Timer TA2 CCR0 capture: CCI0A input, compare: Out0 output   |
| P8.7/TA2.1                           | 41        | I/O                | General-purpose digital I/O<br>Timer TA2 CCR1 capture: CCI1A input, compare: Out1 output   |
| P9.0/TACLK/RTCCLK                    | 42        | I/O                | General-purpose digital I/O<br>Timer clock input TACLK for TA0, TA1, TA2, TA3<br>RTCCLK clock output   |
| P2.2/PM_UCA2RXD/<br>PM_UCA2SOMI      | 43        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_A2 UART receive data<br>Default mapping: eUSCI_A2 SPI slave out/master in  |
| P2.3/PM_UCA2TXD/<br>PM_UCA2SIMO      | 44        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_A2 UART transmit data<br>Default mapping: eUSCI_A2 SPI slave in/master out   |
| P2.4/PM_UCA1CLK                      | 45        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_A1 clock input/output  |
| P2.5/PM_UCA2CLK                      | 46        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_A2 clock input/output  |
| P2.6/PM_TA1.0                        | 47        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: Timer TA1 capture CCR0: CCI0A input, compare: Out0 output  |
| P2.7/PM_TA1.1                        | 48        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: Timer TA1 capture CCR1: CCI1A input, compare: Out1 output  |
| P3.0/PM_TA2.0/BSL_TX                 | 49        | I/O                | General-purpose digital I/O with mappable secondary function<br>Default mapping: Timer TA2 capture CCR0: CCI0A input, compare: Out0 output<br>Bootstrap loader: Data transmit  |

**Table 4-1. Signal Descriptions – PZ Package (continued)**

| TERMINAL                |           | I/O <sup>(1)</sup> | DESCRIPTION  |
|-------------------------|-----------|--------------------|--|
| NAME                    | NO.<br>PZ |                    |  |
| P3.1/PM_TA2.1/BSL_RX    | 50        | I/O                | General-purpose digital I/O with mappable secondary function<br>Default mapping: Timer TA2 capture CCR1: CCI1A input, compare: Out1 output<br>Bootstrap loader: Data receive |
| P3.2/PM_TACLK/PM_RTCCLK | 51        | I/O                | General-purpose digital I/O with mappable secondary function<br>Default mapping: Timer clock input TACLK for TA0, TA1, TA2, TA3<br>Default mapping: RTCCLK clock output      |
| P3.3/PM_TA0.2           | 52        | I/O                | General-purpose digital I/O with mappable secondary function<br>Default mapping: Timer TA0 capture CCR2: CCI2A input, compare: Out2 output                                   |
| P3.4/PM_SDCLK/S39       | 53        | I/O                | General-purpose digital I/O with mappable secondary function<br>Default mapping: SD24_B bit stream clock input/output<br>LCD segment output S39                              |
| P3.5/PM_SD0DIO/S38      | 54        | I/O                | General-purpose digital I/O with mappable secondary function<br>Default mapping: SD24_B converter-0 bit stream data input/output<br>LCD segment output S38                   |
| P3.6/PM_SD1DIO/S37      | 55        | I/O                | General-purpose digital I/O with mappable secondary function<br>Default mapping: SD24_B converter-1 bit stream data input/output<br>LCD segment output S37                   |
| P3.7/PM_SD2DIO/S36      | 56        | I/O                | General-purpose digital I/O with mappable secondary function<br>Default mapping: SD24_B converter-2 bit stream data input/output<br>LCD segment output S36                   |
| P4.0/S35                | 57        | I/O                | General-purpose digital I/O<br>LCD segment output S35  |
| P4.1/S34                | 58        | I/O                | General-purpose digital I/O<br>LCD segment output S34  |
| P4.2/S33                | 59        | I/O                | General-purpose digital I/O<br>LCD segment output S33  |
| P4.3/S32                | 60        | I/O                | General-purpose digital I/O<br>LCD segment output S32  |
| P4.4/S31                | 61        | I/O                | General-purpose digital I/O<br>LCD segment output S31  |
| P4.5/S30                | 62        | I/O                | General-purpose digital I/O<br>LCD segment output S30  |
| P4.6/S29                | 63        | I/O                | General-purpose digital I/O<br>LCD segment output S29  |
| P4.7/S28                | 64        | I/O                | General-purpose digital I/O<br>LCD segment output S28  |

**Table 4-1. Signal Descriptions – PZ Package (continued)**

| TERMINAL              |           | I/O <sup>(1)</sup> | DESCRIPTION   |
|-----------------------|-----------|--------------------|---|
| NAME                  | NO.<br>PZ |                    |   |
| P5.0/S27              | 65        | I/O                | General-purpose digital I/O<br>LCD segment output S27 |
| P5.1/S26              | 66        | I/O                | General-purpose digital I/O<br>LCD segment output S26 |
| P5.2/S25              | 67        | I/O                | General-purpose digital I/O<br>LCD segment output S25 |
| P5.3/S24              | 68        | I/O                | General-purpose digital I/O<br>LCD segment output S24 |
| P5.4/S23              | 69        | I/O                | General-purpose digital I/O<br>LCD segment output S23 |
| P5.5/S22              | 70        | I/O                | General-purpose digital I/O<br>LCD segment output S22 |
| P5.6/S21              | 71        | I/O                | General-purpose digital I/O<br>LCD segment output S21 |
| P5.7/S20              | 72        | I/O                | General-purpose digital I/O<br>LCD segment output S20 |
| P6.0/S19              | 73        | I/O                | General-purpose digital I/O<br>LCD segment output S19 |
| DVSSYS <sup>(5)</sup> | 74        |                    | Digital power supply for I/Os                         |
| DVSS                  | 75        |                    | Digital ground supply                                 |
| P6.1/S18              | 76        | I/O                | General-purpose digital I/O<br>LCD segment output S18 |
| P6.2/S17              | 77        | I/O                | General-purpose digital I/O<br>LCD segment output S17 |
| P6.3/S16              | 78        | I/O                | General-purpose digital I/O<br>LCD segment output S16 |
| P6.4/S15              | 79        | I/O                | General-purpose digital I/O<br>LCD segment output S15 |
| P6.5/S14              | 80        | I/O                | General-purpose digital I/O<br>LCD segment output S14 |
| P6.6/S13              | 81        | I/O                | General-purpose digital I/O<br>LCD segment output S13 |
| P6.7/S12              | 82        | I/O                | General-purpose digital I/O<br>LCD segment output S12 |

(5) The pins VDSYS and DVSSYS must be connected externally on board for proper device operation.

**Table 4-1. Signal Descriptions – PZ Package (continued)**

| TERMINAL           |           | I/O <sup>(1)</sup> | DESCRIPTION   |
|--------------------|-----------|--------------------|---|
| NAME               | NO.<br>PZ |                    |   |
| P7.0/S11           | 83        | I/O                | General-purpose digital I/O<br>LCD segment output S11                                   |
| P7.1/S10           | 84        | I/O                | General-purpose digital I/O<br>LCD segment output S10                                   |
| P7.2/S9            | 85        | I/O                | General-purpose digital I/O<br>LCD segment output S9                                    |
| P7.3/S8            | 86        | I/O                | General-purpose digital I/O<br>LCD segment output S8                                    |
| P7.4/S7            | 87        | I/O                | General-purpose digital I/O<br>LCD segment output S7                                    |
| P7.5/S6            | 88        | I/O                | General-purpose digital I/O<br>LCD segment output S6                                    |
| P7.6/S5            | 89        | I/O                | General-purpose digital I/O<br>LCD segment output S5                                    |
| P7.7/S4            | 90        | I/O                | General-purpose digital I/O<br>LCD segment output S4                                    |
| P8.0/S3            | 91        | I/O                | General-purpose digital I/O<br>LCD segment output S3                                    |
| P8.1/S2            | 92        | I/O                | General-purpose digital I/O<br>LCD segment output S2                                    |
| P8.2/S1            | 93        | I/O                | General-purpose digital I/O<br>LCD segment output S1                                    |
| P8.3/S0            | 94        | I/O                | General-purpose digital I/O<br>LCD segment output S0                                    |
| TEST/SBWTCK        | 95        | I                  | Test mode pin – select digital I/O on JTAG pins<br>Spy-Bi-Wire input clock              |
| PJ.0/SMCLK/TDO     | 96        | I/O                | General-purpose digital I/O<br>SMCLK clock output<br>Test data output                   |
| PJ.1/MCLK/TDI/TCLK | 97        | I/O                | General-purpose digital I/O<br>MCLK clock output<br>Test data input or Test clock input |
| PJ.2/ADC10CLK/TMS  | 98        | I/O                | General-purpose digital I/O<br>ADC10_A clock output<br>Test mode select                 |

**Table 4-1. Signal Descriptions – PZ Package (continued)**

| TERMINAL                            |           | I/O <sup>(1)</sup> | DESCRIPTION  |
|-------------------------------------|-----------|--------------------|--|
| NAME                                | NO.<br>PZ |                    |  |
| PJ.3/ACLK/TCK                       | 99        | I/O                | General-purpose digital I/O<br>ACLK clock output<br>Test clock   |
| $\overline{\text{RST}}$ /NMI/SBWDIO | 100       | I/O                | Reset input active low <sup>(6)</sup><br>Non-maskable interrupt input<br>Spy-Bi-Wire data input/output |

(6) When this pin is configured as reset, the internal pullup resistor is enabled by default.

**Table 4-2. Signal Descriptions – PN Package**

| TERMINAL                            |           | I/O <sup>(1)</sup> | DESCRIPTION  |
|-------------------------------------|-----------|--------------------|--|
| NAME                                | NO.<br>PN |                    |  |
| SD0P0                               | 1         | I                  | SD24_B positive analog input for converter 0 <sup>(2)</sup>  |
| SD0N0                               | 2         | I                  | SD24_B negative analog input for converter 0 <sup>(2)</sup>  |
| SD1P0                               | 3         | I                  | SD24_B positive analog input for converter 1 <sup>(2)</sup>  |
| SD1N0                               | 4         | I                  | SD24_B negative analog input for converter 1 <sup>(2)</sup>  |
| SD2P0                               | 5         | I                  | SD24_B positive analog input for converter 2 <sup>(2)</sup>  |
| SD2N0                               | 6         | I                  | SD24_B negative analog input for converter 2 <sup>(2)</sup>  |
| VREF                                | 7         | I                  | SD24_B external reference voltage  |
| AVSS                                | 8         |                    | Analog ground supply   |
| AVCC                                | 9         |                    | Analog power supply  |
| VASYS                               | 10        |                    | Analog power supply selected between AVCC, AUXVCC1, AUXVCC2. Connect recommended capacitor value of C <sub>VSYS</sub> (see <a href="#">Table 5-18</a> ).   |
| P1.0/PM_TA0.0/VeREF-/A2             | 11        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: Timer TA0 CCR0 capture: CCI0A input, compare: Out0 output<br>Negative terminal for the ADC's reference voltage for an external applied reference voltage<br>Analog input A2 - 10-bit ADC |
| P1.1/PM_TA0.1/VeREF+/A1             | 12        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: Timer TA0 CCR1 capture: CCI1A input, compare: Out1 output<br>Positive terminal for the ADC reference voltage for an external applied reference voltage<br>Analog input A1 - 10-bit ADC   |
| P1.2/PM_UCA0RXD/<br>PM_UCA0SOMI/A0  | 13        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_A0 UART receive data<br>Default mapping: eUSCI_A0 SPI slave out/master in<br>Analog input A0 - 10-bit ADC  |
| P1.3/PM_UCA0TXD/<br>PM_UCA0SIMO/R03 | 14        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_A0 UART transmit data<br>Default mapping: eUSCI_A0 SPI slave in/master out<br>Input/output port of lowest analog LCD voltage (V5)  |
| AUXVCC2                             | 15        |                    | Auxiliary power supply AUXVCC2   |
| AUXVCC1                             | 16        |                    | Auxiliary power supply AUXVCC1   |
| VDSYS <sup>(3)</sup>                | 17        |                    | Digital power supply selected between DVCC, AUXVCC1, AUXVCC2. Connect recommended capacitor value of C <sub>VSYS</sub> (see <a href="#">Table 5-18</a> ).  |
| DVCC                                | 18        |                    | Digital power supply   |
| DVSS                                | 19        |                    | Digital ground supply  |
| VCORE <sup>(4)</sup>                | 20        |                    | Regulated core power supply (internal use only, no external current loading)   |
| XIN                                 | 21        | I                  | Input terminal for crystal oscillator  |
| XOUT                                | 22        | O                  | Output terminal for crystal oscillator   |
| AUXVCC3                             | 23        |                    | Auxiliary power supply AUXVCC3 for back up subsystem   |

(1) I = input, O = output

(2) It is recommended to short unused analog input pairs and connect them to analog ground.

(3) The pins VDSYS and DVSYS must be connected externally on board for proper device operation.

(4) VCORE is for internal use only. No external current loading is possible. VCORE should only be connected to the recommended capacitor value, C<sub>VCORE</sub>.

Table 4-2. Signal Descriptions – PN Package (continued)

| TERMINAL                                   |           | I/O <sup>(1)</sup> | DESCRIPTION   |
|--|-----------|--------------------|---|
| NAME                                       | NO.<br>PN |                    |   |
| P1.4/PM_UCA1RXD/<br>PM_UCA1SOMI/LCDREF/R13 | 24        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_A1 UART receive data<br>Default mapping: eUSCI_A1 SPI slave out/master in<br>External reference voltage input for regulated LCD voltage<br>Input/output port of third most positive analog LCD voltage (V3 or V4) |
| P1.5/PM_UCA1TXD/<br>PM_UCA1SIMO/R23        | 25        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_A1 UART transmit data<br>Default mapping: eUSCI_A1 SPI slave in/master out<br>Input/output port of second most positive analog LCD voltage (V2)   |
| LDCAP/R33                                  | 26        | I/O                | LCD capacitor connection<br>Input/output port of most positive analog LCD voltage (V1)<br><b>CAUTION:</b> This pin must be connected to DVSS if not used.   |
| COM0                                       | 27        | O                  | LCD common output COM0 for LCD backplane  |
| COM1                                       | 28        | O                  | LCD common output COM1 for LCD backplane  |
| COM2                                       | 29        | O                  | LCD common output COM2 for LCD backplane  |
| COM3                                       | 30        | O                  | LCD common output COM3 for LCD backplane  |
| P1.6/PM_UCA0CLK/COM4                       | 31        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_A0 clock input/output<br>LCD common output COM4 for LCD backplane   |
| P1.7/PM_UCB0CLK/COM5                       | 32        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_B0 clock input/output<br>LCD common output COM5 for LCD backplane   |
| P2.0/PM_UCB0SOMI/<br>PM_UCB0SCL/COM6/S39   | 33        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_B0 SPI slave out/master in<br>Default mapping: eUSCI_B0 I <sup>2</sup> C clock<br>LCD common output COM6 for LCD backplane<br>LCD segment output S39  |
| P2.1/PM_UCB0SIMO/<br>PM_UCB0SDA/COM7/S38   | 34        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_B0 SPI slave in/master out<br>Default mapping: eUSCI_B0 I <sup>2</sup> C data<br>LCD common output COM7 for LCD backplane<br>LCD segment output S38   |
| P2.2/PM_UCA2RXD/<br>PM_UCA2SOMI/S37        | 35        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_A2 UART receive data<br>Default mapping: eUSCI_A2 SPI slave out/master in<br>LCD segment output S37   |



**Table 4-2. Signal Descriptions – PN Package (continued)**

| TERMINAL                            |           | I/O <sup>(1)</sup> | DESCRIPTION  |
|-------------------------------------|-----------|--------------------|--|
| NAME                                | NO.<br>PN |                    |  |
| P2.3/PM_UCA2TXD/<br>PM_UCA2SIMO/S36 | 36        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_A2 UART transmit data<br>Default mapping: eUSCI_A2 SPI slave in/master out<br>LCD segment output S36 |
| P2.4/PM_UCA1CLK/S35                 | 37        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_A1 clock input/output<br>LCD segment output S35  |
| P2.5/PM_UCA2CLK/S34                 | 38        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: eUSCI_A2 clock input/output<br>LCD segment output S34  |
| P2.6/PM_TA1.0/S33                   | 39        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: Timer TA1 capture CCR0: CCI0A input, compare: Out0 output<br>LCD segment output S33                        |
| P2.7/PM_TA1.1/S32                   | 40        | I/O                | General-purpose digital I/O with port interrupt and mappable secondary function<br>Default mapping: Timer TA1 capture CCR1: CCI1A input, compare: Out1 output<br>LCD segment output S32                        |
| P3.0/PM_TA2.0/S31/BSL_TX            | 41        | I/O                | General-purpose digital I/O with mappable secondary function<br>Default mapping: Timer TA2 capture CCR0: CCI0A input, compare: Out0 output<br>LCD segment output S31<br>Bootstrap loader: Data transmit        |
| P3.1/PM_TA2.1/S30/BSL_RX            | 42        | I/O                | General-purpose digital I/O with mappable secondary function<br>Default mapping: Timer TA2 capture CCR1: CCI1A input, compare: Out1 output<br>LCD segment output S30<br>Bootstrap loader: Data receive         |
| P3.2/PM_TACLK/PM_RTCCLK/<br>S29     | 43        | I/O                | General-purpose digital I/O with mappable secondary function<br>Default mapping: Timer clock input TACLK for TA0, TA1, TA2, TA3<br>Default mapping: RTCCLK clock output<br>LCD segment output S29              |
| P3.3/PM_TA0.2/S28                   | 44        | I/O                | General-purpose digital I/O with mappable secondary function<br>Default mapping: Timer TA0 capture CCR2: CCI2A input, compare: Out2 output<br>LCD segment output S28   |
| P3.4/PM_SDCLK/S27                   | 45        | I/O                | General-purpose digital I/O with mappable secondary function<br>Default mapping: SD24_B bit stream clock input/output<br>LCD segment output S27  |
| P3.5/PM_SD0DIO/S26                  | 46        | I/O                | General-purpose digital I/O with mappable secondary function<br>Default mapping: SD24_B converter-0 bit stream data input/output<br>LCD segment output S26   |

**Table 4-2. Signal Descriptions – PN Package (continued)**

| TERMINAL              |           | I/O <sup>(1)</sup> | DESCRIPTION  |
|-----------------------|-----------|--------------------|--|
| NAME                  | NO.<br>PN |                    |  |
| P3.6/PM_SD1DIO/S25    | 47        | I/O                | General-purpose digital I/O with mappable secondary function<br>Default mapping: SD24_B converter-1 bit stream data input/output<br>LCD segment output S25 |
| P3.7/PM_SD2DIO/S24    | 48        | I/O                | General-purpose digital I/O with mappable secondary function<br>Default mapping: SD24_B converter-2 bit stream data input/output<br>LCD segment output S24 |
| P4.0/S23              | 49        | I/O                | General-purpose digital I/O<br>LCD segment output S23  |
| P4.1/S22              | 50        | I/O                | General-purpose digital I/O<br>LCD segment output S22  |
| P4.2/S21              | 51        | I/O                | General-purpose digital I/O<br>LCD segment output S21  |
| P4.3/S20              | 52        | I/O                | General-purpose digital I/O<br>LCD segment output S20  |
| P4.4/S19              | 53        | I/O                | General-purpose digital I/O<br>LCD segment output S19  |
| P4.5/S18              | 54        | I/O                | General-purpose digital I/O<br>LCD segment output S18  |
| P4.6/S17              | 55        | I/O                | General-purpose digital I/O<br>LCD segment output S17  |
| P4.7/S16              | 56        | I/O                | General-purpose digital I/O<br>LCD segment output S16  |
| P5.0/S15              | 57        | I/O                | General-purpose digital I/O<br>LCD segment output S15  |
| P5.1/S14              | 58        | I/O                | General-purpose digital I/O<br>LCD segment output S14  |
| DVSSYS <sup>(5)</sup> | 59        |                    | Digital power supply for I/Os  |
| DVSS                  | 60        |                    | Digital ground supply  |
| P5.2/S13              | 61        | I/O                | General-purpose digital I/O<br>LCD segment output S13  |
| P5.3/S12              | 62        | I/O                | General-purpose digital I/O<br>LCD segment output S12  |
| P5.4/S11              | 63        | I/O                | General-purpose digital I/O<br>LCD segment output S11  |

(5) The pins VDSYS and DVSSYS must be connected externally on board for proper device operation.

**Table 4-2. Signal Descriptions – PN Package (continued)**

| TERMINAL           |           | I/O <sup>(1)</sup> | DESCRIPTION   |
|--------------------|-----------|--------------------|---|
| NAME               | NO.<br>PN |                    |   |
| P5.5/S10           | 64        | I/O                | General-purpose digital I/O<br>LCD segment output S10                                   |
| P5.6/S9            | 65        | I/O                | General-purpose digital I/O<br>LCD segment output S9                                    |
| P5.7/S8            | 66        | I/O                | General-purpose digital I/O<br>LCD segment output S8                                    |
| P6.0/S7            | 67        | I/O                | General-purpose digital I/O<br>LCD segment output S7                                    |
| P6.1/S6            | 68        | I/O                | General-purpose digital I/O<br>LCD segment output S6                                    |
| P6.2/S5            | 69        | I/O                | General-purpose digital I/O<br>LCD segment output S5                                    |
| P6.3/S4            | 70        | I/O                | General-purpose digital I/O<br>LCD segment output S4                                    |
| P6.4/S3            | 71        | I/O                | General-purpose digital I/O<br>LCD segment output S3                                    |
| P6.5/S2            | 72        | I/O                | General-purpose digital I/O<br>LCD segment output S2                                    |
| P6.6/S1            | 73        | I/O                | General-purpose digital I/O<br>LCD segment output S1                                    |
| P6.7/S0            | 74        | I/O                | General-purpose digital I/O<br>LCD segment output S0                                    |
| TEST/SBWTCK        | 75        | I                  | Test mode pin – select digital I/O on JTAG pins<br>Spy-Bi-Wire input clock              |
| PJ.0/SMCLK/TDO     | 76        | I/O                | General-purpose digital I/O<br>SMCLK clock output<br>Test data output                   |
| PJ.1/MCLK/TDI/TCLK | 77        | I/O                | General-purpose digital I/O<br>MCLK clock output<br>Test data input or Test clock input |
| PJ.2/ADC10CLK/TMS  | 78        | I/O                | General-purpose digital I/O<br>ADC10_A clock output<br>Test mode select                 |

**Table 4-2. Signal Descriptions – PN Package (continued)**

| TERMINAL  |           | I/O <sup>(1)</sup> | DESCRIPTION  |
|---|-----------|--------------------|--|
| NAME  | NO.<br>PN |                    |  |
| PJ.3/ACLK/TCK                                     | 79        | I/O                | General-purpose digital I/O<br>ACLK clock output<br>Test clock   |
| $\overline{\text{RST}}/\text{NMI}/\text{SBWTDIO}$ | 80        | I/O                | Reset input active low <sup>(6)</sup><br>Non-maskable interrupt input<br>Spy-Bi-Wire data input/output |

(6) When this pin is configured as reset, the internal pullup resistor is enabled by default.

### 4.3 Pin Multiplexing

Pin multiplexing for these devices is controlled by both register settings and operating modes (for example, if the device is in test mode). For details of the settings for each pin and schematics of the multiplexed ports, see [Section 6.13](#).

### 4.4 Connection of Unused Pins

The correct termination of all unused pins is listed in [Table 4-3](#).

**Table 4-3. Connection of Unused Pins<sup>(1)</sup>**

| Pin  | Potential                           | Comment   |
|--|-------------------------------------|---|
| AVCC   | DV <sub>CC</sub>                    |   |
| AVSS   | DV <sub>SS</sub>                    |   |
| Px.y   | Open                                | Switched to port function, output direction (PxDIR.n = 1). Px.y represents port x and bit y of port x (for example, P1.0, P1.1, P2.2, PJ.0, PJ.1)   |
| XIN  | DV <sub>SS</sub>                    | For dedicated XIN pins only. XIN pins with shared GPIO functions should be programmed to GPIO and follow Px.y recommendations.  |
| XOUT   | Open                                | For dedicated XOUT pins only. XOUT pins with shared GPIO functions should be programmed to GPIO and follow Px.y recommendations.  |
| LDCAP  | DV <sub>SS</sub>                    |   |
| $\overline{\text{RST}}/\text{NMI}$           | DV <sub>CC</sub> or V <sub>CC</sub> | 47-k $\Omega$ pullup or internal pullup selected with 10-nF (2.2 nF) pulldown <sup>(2)</sup>  |
| PJ.0/TDO<br>PJ.1/TDI<br>PJ.2/TMS<br>PJ.3/TCK | Open                                | The JTAG pins are shared with general purpose I/O function (PJ.x). If not being used, these should be switched to port function, output direction (PJDIR.n = 1). When used as JTAG pins, these pins should remain open. |
| TEST   | Open                                | This pin always has an internal pulldown enabled.   |

(1) Any unused pin with a secondary function that is shared with general purpose I/O should follow the Px.y unused pin connection guidelines.

(2) The pulldown capacitor should not exceed 2.2 nF when using devices with Spy-Bi-Wire interface in Spy-Bi-Wire mode or in 4-wire JTAG mode with TI tools such as FET interfaces or GANG programmers.

## 5 Specifications

### 5.1 Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|  |                                   |
|--|-----------------------------------|
| Voltage applied at DVCC to DVSS  | -0.3 V to 4.1 V                   |
| Voltage applied to any pin (excluding V <sub>CORE</sub> ) <sup>(2)</sup> | -0.3 V to V <sub>CC</sub> + 0.3 V |
| Diode current at any device pin  | ±2 mA                             |
| Maximum junction temperature, T <sub>J</sub>                             | 95°C                              |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltages referenced to V<sub>SS</sub>. V<sub>CORE</sub> is for internal device usage only. No external DC loading or voltage should be applied.

### 5.2 Handling Ratings

|                  |  | MIN | MAX | UNIT |
|------------------|--|-----|-----|------|
| T <sub>stg</sub> | Storage temperature range <sup>(1)</sup> | -55 | 150 | °C   |

- (1) Higher temperature may be applied during board soldering according to the current JEDEC J-STD-020 specification with peak reflow temperatures not higher than classified on the device label on the shipping boxes or reels.

### 5.3 Recommended Operating Conditions

Typical values are specified at V<sub>CC</sub> = 3.3 V and T<sub>A</sub> = 25°C (unless otherwise noted)

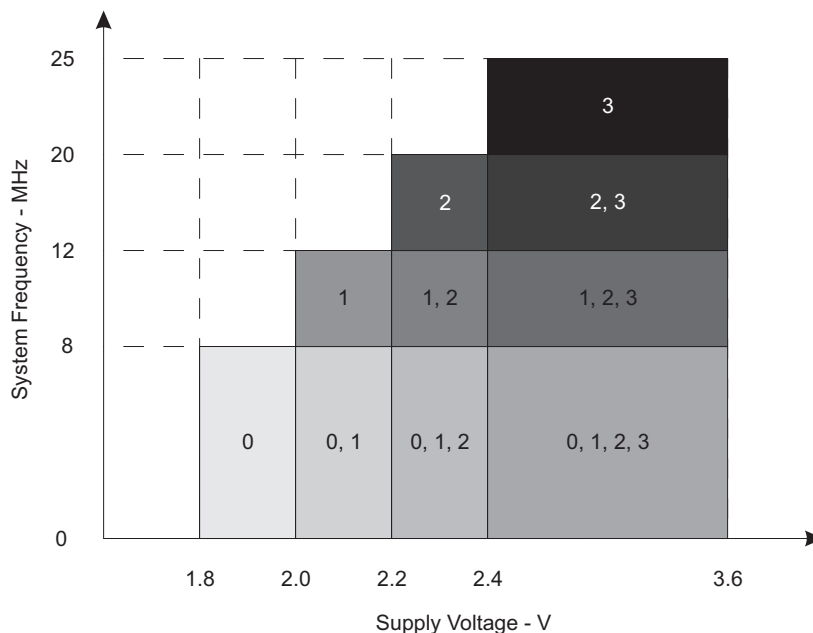
|  |  | MIN  | NOM | MAX  | UNIT |
|--|--|--|-----|------|------|
| V <sub>CC</sub>                                      | Supply voltage during program execution and flash programming. V(AVCC) = V(DVCC) = V <sub>CC</sub> <sup>(1)(2)</sup>           | PMMCOREV <sub>x</sub> = 0  | 1.8 | 3.6  | V    |
|  |  | PMMCOREV <sub>x</sub> = 0, 1   | 2.0 | 3.6  | V    |
|  |  | PMMCOREV <sub>x</sub> = 0, 1, 2  | 2.2 | 3.6  | V    |
|  |  | PMMCOREV <sub>x</sub> = 0, 1, 2, 3   | 2.4 | 3.6  | V    |
| V <sub>SS</sub>                                      | Supply voltage V(AVSS) = V(DVSS) = V <sub>SS</sub>   |  | 0   |      | V    |
| T <sub>A</sub>                                       | Operating free-air temperature   | I version  | -40 | 85   | °C   |
| T <sub>J</sub>                                       | Operating junction temperature   | I version  | -40 | 85   | °C   |
| C <sub>V<sub>CORE</sub></sub>                        | Recommended capacitor at V <sub>CORE</sub>   |  | 470 |      | nF   |
| C <sub>DVCC</sub> /<br>C <sub>V<sub>CORE</sub></sub> | Capacitor ratio of DVCC to V <sub>CORE</sub>   |  | 10  |      |      |
| f <sub>SYSTEM</sub>                                  | Processor frequency (maximum MCLK frequency) <sup>(3)(4)</sup> (see <a href="#">Figure 5-1</a> )                               | PMMCOREV <sub>x</sub> = 0, 1.8 V ≤ V <sub>CC</sub> ≤ 3.6 V (default condition) | 0   | 8.0  | MHz  |
|  |  | PMMCOREV <sub>x</sub> = 1, 2.0 V ≤ V <sub>CC</sub> ≤ 3.6 V                     | 0   | 12.0 |      |
|  |  | PMMCOREV <sub>x</sub> = 2, 2.2 V ≤ V <sub>CC</sub> ≤ 3.6 V                     | 0   | 20.0 |      |
|  |  | PMMCOREV <sub>x</sub> = 3, 2.4 V ≤ V <sub>CC</sub> ≤ 3.6 V                     | 0   | 25.0 |      |
| I <sub>LOAD, DVCCD</sub>                             | Maximum load current that can be drawn from DVCC for core and IO (I <sub>LOAD</sub> = I <sub>CORE</sub> + I <sub>IO</sub> )    |  |     | 20   | mA   |
| I <sub>LOAD, AUX1D</sub>                             | Maximum load current that can be drawn from AUXVCC1 for core and IO (I <sub>LOAD</sub> = I <sub>CORE</sub> + I <sub>IO</sub> ) |  |     | 20   | mA   |
| I <sub>LOAD, AUX2D</sub>                             | Maximum load current that can be drawn from AUXVCC2 for core and IO (I <sub>LOAD</sub> = I <sub>CORE</sub> + I <sub>IO</sub> ) |  |     | 20   | mA   |
| I <sub>LOAD, AVCCA</sub>                             | Maximum load current that can be drawn from AVCC for analog modules (I <sub>LOAD</sub> = I <sub>Modules</sub> )                |  |     | 10   | mA   |

- (1) It is recommended to power AVCC and DVCC from the same source. A maximum difference of 0.3 V between V(AVCC) and V(DVCC) can be tolerated during power up and operation.
- (2) The minimum supply voltage is defined by the supervisor SVS levels when it is enabled. See the [Table 5-13](#) threshold parameters for the exact values and further details.
- (3) The MSP430 CPU is clocked directly with MCLK. Both the high and low phase of MCLK must not exceed the pulse width of the specified maximum frequency.
- (4) Modules may have a different maximum input clock specification. Refer to the specification of the respective module in this data sheet.

## Recommended Operating Conditions (continued)

Typical values are specified at  $V_{CC} = 3.3\text{ V}$  and  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

|                   |   | MIN | NOM | MAX | UNIT |
|-------------------|---|-----|-----|-----|------|
| $I_{LOAD, AUX1A}$ | Maximum load current that can be drawn from AUXVCC1 for analog modules ( $I_{LOAD} = I_{Modules}$ ) |     |     | 5   | mA   |
| $I_{LOAD, AUX2A}$ | Maximum load current that can be drawn from AUXVCC2 for analog modules ( $I_{LOAD} = I_{Modules}$ ) |     |     | 5   | mA   |



The numbers within the fields denote the supported PMMCOREVx settings.

**Figure 5-1. Maximum System Frequency**

## 5.4 Active Mode Supply Current Into $V_{CC}$ Excluding External Current

over recommended operating free-air temperature (unless otherwise noted)<sup>(1)</sup> <sup>(2)</sup> <sup>(3)</sup>

| PARAMETER             | EXECUTION MEMORY | $V_{CC}$ | PMMCOREVx | FREQUENCY ( $f_{DCO} = f_{MCLK} = f_{SMCLK}$ ) |      |       |      |        |      |        |      |        |      | UNIT |
|-----------------------|------------------|----------|-----------|--|------|-------|------|--------|------|--------|------|--------|------|------|
|                       |                  |          |           | 1 MHz  |      | 8 MHz |      | 12 MHz |      | 20 MHz |      | 25 MHz |      |      |
|                       |                  |          |           | TYP  | MAX  | TYP   | MAX  | TYP    | MAX  | TYP    | MAX  | TYP    | MAX  |      |
| $I_{AM, Flash}^{(4)}$ | Flash            | 3.0 V    | 0         | 0.32   | 0.36 | 2.10  | 2.30 |        |      |        |      |        |      | mA   |
|                       |                  |          | 1         | 0.36   |      | 2.39  |      | 3.54   | 3.90 |        |      |        |      |      |
|                       |                  |          | 2         | 0.39   |      | 2.65  |      | 3.94   |      | 6.54   | 7.23 |        |      |      |
|                       |                  |          | 3         | 0.42   |      | 2.82  |      | 4.20   |      | 6.96   |      | 8.65   | 9.54 |      |
| $I_{AM, RAM}^{(5)}$   | RAM              | 3.0 V    | 0         | 0.20   | 0.22 | 1.10  | 1.22 |        |      |        |      |        |      | mA   |
|                       |                  |          | 1         | 0.22   |      | 1.30  |      | 1.90   | 2.10 |        |      |        |      |      |
|                       |                  |          | 2         | 0.24   |      | 1.45  |      | 2.15   |      | 3.55   | 4.0  |        |      |      |
|                       |                  |          | 3         | 0.26   |      | 1.55  |      | 2.30   |      | 3.80   |      | 4.70   | 5.30 |      |

(1) All inputs are tied to 0 or to  $V_{CC}$ . Outputs do not source or sink any current.

(2) The currents are characterized with a Micro Crystal MS1V-T1K crystal with a load capacitance of 12.5 pF. The internal and external load capacitance are chosen to closely match the required 12.5 pF.

(3) Characterized with program executing typical data processing.

$f_{ACLK} = 32786\text{ Hz}$ ,  $f_{DCO} = f_{MCLK} = f_{SMCLK}$  at specified frequency.

$XTS = CPUOFF = SCG0 = SCG1 = OSCOFF = SMCLKOFF = 0$ .

(4) Active mode supply current when program executes in flash at a nominal supply voltage of 3.0V.

(5) Active mode supply current when program executes in RAM at a nominal supply voltage of 3 V.

## 5.5 Low-Power Mode Supply Currents (Into $V_{CC}$ ) Excluding External Current

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)(2)</sup>

| PARAMETER   | $V_{CC}$ | PMMCOREVx | TEMPERATURE ( $T_A$ ) |     |      |      |      |     |      |      | UNIT    |
|---|----------|-----------|-----------------------|-----|------|------|------|-----|------|------|---------|
|   |          |           | -40°C                 |     | 25°C |      | 60°C |     | 85°C |      |         |
|   |          |           | TYP                   | MAX | TYP  | MAX  | TYP  | MAX | TYP  | MAX  |         |
| $I_{LPM0,1MHz}$ Low-power mode 0 <sup>(3)(4)</sup>                    | 2.2 V    | 0         | 75                    |     | 78   | 87   | 81   |     | 84   | 96   | $\mu A$ |
|   | 3.0 V    | 3         | 85                    |     | 89   | 99   | 93   |     | 98   | 110  |         |
| $I_{LPM2}$ Low-power mode 2 <sup>(5)(4)</sup>                         | 2.2 V    | 0         | 5.9                   |     | 6.2  | 9    | 6.9  |     | 9.4  | 17   | $\mu A$ |
|   | 3.0 V    | 3         | 6.9                   |     | 7.4  | 10   | 8.4  |     | 11   | 19   |         |
| $I_{LPM3,XT1LF}$ Low-power mode 3, crystal mode <sup>(6)(4)</sup>     | 2.2 V    | 0         | 1.4                   |     | 1.7  |      | 2.5  |     | 4.9  |      | $\mu A$ |
|   |          | 1         | 1.5                   |     | 1.9  |      | 2.7  |     | 5.2  |      |         |
|   |          | 2         | 1.7                   |     | 2.0  |      | 2.9  |     | 5.5  |      |         |
| $I_{LPM3,XT1LF}$ Low-power mode 3, crystal mode <sup>(6)(4)</sup>     | 3.0 V    | 0         | 2.2                   |     | 2.5  | 3.1  | 3.3  |     | 5.5  | 12.7 | $\mu A$ |
|   |          | 1         | 2.3                   |     | 2.7  |      | 3.5  |     | 6.1  |      |         |
|   |          | 2         | 2.5                   |     | 2.9  |      | 3.7  |     | 6.1  | 14.0 |         |
|   |          | 3         | 2.5                   |     | 2.9  | 3.5  | 3.7  |     | 6.1  | 14.0 |         |
| $I_{LPM3,VLO}$ Low-power mode 3, VLO mode <sup>(7)(4)</sup>           | 3.0 V    | 0         | 1.4                   |     | 1.7  | 2.2  | 2.4  |     | 4.5  | 11.5 | $\mu A$ |
|   |          | 1         | 1.5                   |     | 1.8  |      | 2.5  |     | 4.7  |      |         |
|   |          | 2         | 1.6                   |     | 1.9  |      | 2.7  |     | 4.9  |      |         |
|   |          | 3         | 1.6                   |     | 1.9  | 2.4  | 2.7  |     | 5.0  | 12.7 |         |
| $I_{LPM4}$ Low-power mode 4 <sup>(8)(4)</sup>                         | 3.0 V    | 0         | 1.3                   |     | 1.6  | 2.0  | 2.3  |     | 4.4  | 11.1 | $\mu A$ |
|   |          | 1         | 1.4                   |     | 1.6  |      | 2.4  |     | 4.5  |      |         |
|   |          | 2         | 1.4                   |     | 1.7  |      | 2.5  |     | 4.8  |      |         |
|   |          | 3         | 1.4                   |     | 1.7  | 2.2  | 2.5  |     | 4.8  | 12.2 |         |
| $I_{LPM3.5}$ Low-power mode 3.5, RTC active on AUXVCC3 <sup>(9)</sup> | 2.2V     |           | 0.65                  |     | 0.80 |      | 0.90 |     | 1.30 |      | $\mu A$ |
|   | 3.0V     |           | 1.16                  |     | 1.24 | 2.05 | 1.43 |     | 1.87 | 2.71 |         |
| $I_{LPM4.5}$ Low-power mode 4.5 <sup>(10)</sup>                       | 3.0V     |           | 0.70                  |     | 0.78 | 1.05 | 0.90 |     | 1.20 | 1.85 | $\mu A$ |

- (1) All inputs are tied to 0 V or to  $V_{CC}$ . Outputs do not source or sink any current.
- (2) The currents are characterized with a Micro Crystal MS1V-T1K crystal with a load capacitance of 12.5 pF. The internal and external load capacitance are chosen to closely match the required 12.5 pF.
- (3) Current for watchdog timer clocked by SMCLK included. ACLK = low frequency crystal operation (XTS = 0, XT1DRIVEx = 0). CPUOFF = 1, SCG0 = 0, SCG1 = 0, OSCOFF = 0 (LPM0);  $f_{ACLK}$  = 32768 Hz,  $f_{MCLK}$  = 0 MHz,  $f_{SMCLK}$  =  $f_{DCO}$  = 1 MHz
- (4) Current for brownout, high side supervisor (SVSH) normal mode included. Low side supervisor and monitors disabled (SVSL, SVM<sub>L</sub>). High side monitor disabled (SVM<sub>H</sub>). RAM retention enabled.
- (5) Current for watchdog timer clocked by ACLK and RTC clocked by XT1 included. ACLK = low frequency crystal operation (XTS = 0, XT1DRIVEx = 0). CPUOFF = 1, SCG0 = 0, SCG1 = 1, OSCOFF = 0 (LPM2);  $f_{ACLK}$  = 32768 Hz,  $f_{MCLK}$  = 0 MHz,  $f_{SMCLK}$  =  $f_{DCO}$  = 0 MHz; DCO setting = 1 MHz operation, DCO bias generator enabled.
- (6) Current for watchdog timer clocked by ACLK and RTC clocked by XT1 included. ACLK = low frequency crystal operation (XTS = 0, XT1DRIVEx = 0). CPUOFF = 1, SCG0 = 1, SCG1 = 1, OSCOFF = 0 (LPM3);  $f_{ACLK}$  = 32768 Hz,  $f_{MCLK}$  =  $f_{SMCLK}$  =  $f_{DCO}$  = 0 MHz
- (7) Current for watchdog timer clocked by ACLK included. RTC is disabled (RTCHOLD=1). ACLK = VLO. CPUOFF = 1, SCG0 = 1, SCG1 = 1, OSCOFF = 0 (LPM3);  $f_{ACLK}$  =  $f_{VLO}$ ,  $f_{MCLK}$  =  $f_{SMCLK}$  =  $f_{DCO}$  = 0 MHz
- (8) CPUOFF = 1, SCG0 = 1, SCG1 = 1, OSCOFF = 1 (LPM4);  $f_{DCO}$  =  $f_{ACLK}$  =  $f_{MCLK}$  =  $f_{SMCLK}$  = 0 MHz
- (9)  $f_{DCO}$  =  $f_{MCLK}$  =  $f_{SMCLK}$  = 0 MHz,  $f_{ACLK}$  = 32768 Hz, PMMREGOFF = 1, RTC active on AUXVCC3 supply
- (10)  $f_{DCO}$  =  $f_{MCLK}$  =  $f_{SMCLK}$  = 0 MHz,  $f_{ACLK}$  = 0 Hz, PMMREGOFF = 1

## 5.6 Low-Power Mode With LCD Supply Currents (Into $V_{CC}$ ) Excluding External Current

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)(2)</sup>

| PARAMETER                       | $V_{CC}$ | PMMCOREVx | Temperature ( $T_A$ ) |     |      |     |      |      |         |     | UNIT |
|---------------------------------|----------|-----------|-----------------------|-----|------|-----|------|------|---------|-----|------|
|                                 |          |           | -40°C                 |     | 25°C |     | 60°C |      | 85°C    |     |      |
|                                 |          |           | TYP                   | MAX | TYP  | MAX | TYP  | MAX  | TYP     | MAX |      |
| $I_{LPM3}$<br>LCD,<br>int. bias | 2.2 V    | 0         | 2.4                   | 2.9 | 3.6  | 3.8 | 5.8  | 12.2 | $\mu A$ |     |      |
|                                 |          | 1         | 2.5                   | 3.1 | 4.0  | 6.0 |      |      |         |     |      |
|                                 |          | 2         | 2.6                   | 3.3 | 3.9  | 4.2 | 6.3  | 13.4 |         |     |      |
| $I_{LPM3}$<br>LCD,<br>int. bias | 3.0 V    | 0         | 2.8                   | 3.2 | 3.9  | 4.1 | 6.4  | 13.3 | $\mu A$ |     |      |
|                                 |          | 1         | 2.9                   | 3.4 | 4.3  | 6.7 |      |      |         |     |      |
|                                 |          | 2         | 3.1                   | 3.6 | 4.5  | 7.0 |      |      |         |     |      |
|                                 |          | 3         | 3.1                   | 3.6 | 4.5  | 4.5 | 7.0  | 14.7 |         |     |      |
| $I_{LPM3}$<br>LCD,CP            | 2.2 V    | 0         |                       | 3.8 |      |     |      |      | $\mu A$ |     |      |
|                                 |          | 1         |                       | 3.9 |      |     |      |      |         |     |      |
|                                 |          | 2         |                       | 4.0 |      |     |      |      |         |     |      |
|                                 | 3.0 V    | 0         |                       | 4.0 |      |     |      |      | $\mu A$ |     |      |
|                                 |          | 1         |                       | 4.1 |      |     |      |      |         |     |      |
|                                 |          | 2         |                       | 4.2 |      |     |      |      |         |     |      |
|                                 |          | 3         |                       | 4.2 |      |     |      |      |         |     |      |

- All inputs are tied to 0 V or to  $V_{CC}$ . Outputs do not source or sink any current.
- The currents are characterized with a Micro Crystal MS1V-T1K crystal with a load capacitance of 12.5 pF. The internal and external load capacitance are chosen to closely match the required 12.5 pF.
- Current for watchdog timer clocked by ACLK and RTC clocked by XT1 included. ACLK = low-frequency crystal operation (XTS = 0, XT1DRIVEx = 0). CPUOFF = 1, SCG0 = 1, SCG1 = 1, OSCOFF = 0 (LPM3);  $f_{ACLK}$  = 32768 Hz,  $f_{MCLK}$  =  $f_{SMCLK}$  =  $f_{DCO}$  = 0 MHz. Current for brownout, high-side supervisor (SVSH) normal mode included. Low-side supervisor and monitors disabled (SVSL, SVM<sub>L</sub>). High-side monitor disabled (SVM<sub>H</sub>). RAM retention enabled.
- LCDMx = 11 (4-mux mode), LCDREXT = 0, LCDEXTBIAS = 0 (internal biasing), LCD2B = 0 (1/3 bias), LCDCPEN = 0 (charge pump disabled), LCDSSEL = 0, LCDPREx = 101, LCDDIVx = 00011 ( $f_{LCD}$  = 32768 Hz / 32 / 4 = 256 Hz). Even segments S0, S2, ... = 0 and odd segments S1, S3, ... = 1. No LCD panel load.
- LCDMx = 11 (4-mux mode), LCDREXT = 0, LCDEXTBIAS = 0 (internal biasing), LCD2B = 0 (1/3 bias), LCDCPEN = 1 (charge pump enabled), VLCDx = 1000 ( $V_{LCD}$  = 3V,typ.), LCDSSEL = 0, LCDPREx = 101, LCDDIVx = 00011 ( $f_{LCD}$  = 32768 Hz / 32 / 4 = 256 Hz). Even segments S0, S2, ... = 0 and odd segments S1, S3, ... = 1. No LCD panel load.



## 5.7 Timing and Switching Characteristics

### 5.7.1 Clock Specifications

**Table 5-1. Crystal Oscillator, XT1, Low-Frequency Mode<sup>(1)</sup>**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER  | TEST CONDITIONS  | V <sub>CC</sub> | MIN   | TYP    | MAX   | UNIT |
|--|--|-----------------|-------|--------|-------|------|
| $\Delta I_{DVCC,LF}$<br>Differential XT1 oscillator crystal current consumption from lowest drive setting, LF mode | $f_{OSC} = 32768$ Hz, XTS = 0, XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 1, T <sub>A</sub> = 25°C                             | 3.0 V           | 0.075 |        | μA    |      |
|  | $f_{OSC} = 32768$ Hz, XTS = 0, XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 2, T <sub>A</sub> = 25°C                             |                 | 0.170 |        |       |      |
|  | $f_{OSC} = 32768$ Hz, XTS = 0, XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 3, T <sub>A</sub> = 25°C                             |                 | 0.290 |        |       |      |
| $f_{XT1,LF0}$<br>XT1 oscillator crystal frequency, LF mode   | XTS = 0, XT1BYPASS = 0   |                 | 32768 |        | Hz    |      |
| $f_{XT1,LF,SW}$<br>XT1 oscillator logic-level square-wave input frequency, LF mode                                 | XTS = 0, XT1BYPASS = 1 <sup>(2) (3)</sup>  |                 | 10    | 32.768 | 50    | kHz  |
| $OA_{LF}$<br>Oscillation allowance for LF crystals <sup>(4)</sup>  | XTS = 0, XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 0, $f_{XT1,LF} = 32768$ Hz, C <sub>L,eff</sub> = 6 pF                      |                 | 210   |        | kΩ    |      |
|  | XTS = 0, XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 1, $f_{XT1,LF} = 32768$ Hz, C <sub>L,eff</sub> = 12 pF                     |                 | 300   |        |       |      |
| $C_{L,eff}$<br>Integrated effective load capacitance, LF mode <sup>(5)</sup>                                       | XTS = 0, XCAP <sub>x</sub> = 0 <sup>(6)</sup>  |                 | 2     |        | pF    |      |
|  | XTS = 0, XCAP <sub>x</sub> = 1   |                 | 5.5   |        |       |      |
|  | XTS = 0, XCAP <sub>x</sub> = 2   |                 | 8.5   |        |       |      |
|  | XTS = 0, XCAP <sub>x</sub> = 3   |                 | 12.0  |        |       |      |
| Duty cycle, LF mode  | XTS = 0, Measured at ACLK, $f_{XT1,LF} = 32768$ Hz   |                 | 30    |        | 70    | %    |
| $f_{Fault,LF}$<br>Oscillator fault frequency, LF mode <sup>(7)</sup>   | XTS = 0 <sup>(8)</sup>   |                 | 10    |        | 10000 | Hz   |
| $t_{START,LF}$<br>Startup time, LF mode  | $f_{OSC} = 32768$ Hz, XTS = 0, XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 0, T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 6 pF  | 3.0 V           | 1000  |        | ms    |      |
|  | $f_{OSC} = 32768$ Hz, XTS = 0, XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 3, T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 12 pF |                 | 500   |        |       |      |

- (1) To improve EMI on the XT1 oscillator, the following guidelines should be observed.
  - Keep the trace between the device and the crystal as short as possible.
  - Design a good ground plane around the oscillator pins.
  - Prevent crosstalk from other clock or data lines into oscillator pins XIN and XOUT.
  - Avoid running PCB traces underneath or adjacent to the XIN and XOUT pins.
  - Use assembly materials and processes that avoid any parasitic load on the oscillator XIN and XOUT pins.
  - If conformal coating is used, ensure that it does not induce capacitive or resistive leakage between the oscillator pins.
- (2) When XT1BYPASS is set, XT1 circuits are automatically powered down. Input signal is a digital square wave with parametrics defined in the Schmitt-Trigger Inputs section of this datasheet.
- (3) Maximum frequency of operation of the entire device cannot be exceeded.
- (4) Oscillation allowance is based on a safety factor of 5 for recommended crystals. The oscillation allowance is a function of the XT1DRIVE<sub>x</sub> settings and the effective load. In general, comparable oscillator allowance can be achieved based on the following guidelines, but should be evaluated based on the actual crystal selected for the application:
  - For XT1DRIVE<sub>x</sub> = 0, C<sub>L,eff</sub> ≤ 6 pF.
  - For XT1DRIVE<sub>x</sub> = 1, 6 pF ≤ C<sub>L,eff</sub> ≤ 9 pF.
  - For XT1DRIVE<sub>x</sub> = 2, 6 pF ≤ C<sub>L,eff</sub> ≤ 10 pF.
  - For XT1DRIVE<sub>x</sub> = 3, C<sub>L,eff</sub> ≥ 6 pF.
- (5) Includes parasitic bond and package capacitance (approximately 2 pF per pin). Because the PCB adds additional capacitance, it is recommended to verify the correct load by measuring the ACLK frequency. For a correct setup, the effective load capacitance should always match the specification of the used crystal.
- (6) Requires external capacitors at both terminals. Values are specified by crystal manufacturers.
- (7) Frequencies below the MIN specification set the fault flag. Frequencies above the MAX specification do not set the fault flag. Frequencies in between might set the flag.
- (8) Measured with logic-level input frequency but also applies to operation with crystals.

**Table 5-2. Internal Very-Low-Power Low-Frequency Oscillator (VLO)**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                           |                                    | TEST CONDITIONS                 | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|-------------------------------------|------------------------------------|---------------------------------|-----------------|-----|-----|-----|------|
| f <sub>VLO</sub>                    | VLO frequency                      | Measured at ACLK                | 1.8 V to 3.6 V  | 6   | 9.4 | 15  | kHz  |
| df <sub>VLO</sub> /dT               | VLO frequency temperature drift    | Measured at ACLK <sup>(1)</sup> | 1.8 V to 3.6 V  |     | 0.5 |     | %/°C |
| df <sub>VLO</sub> /dV <sub>CC</sub> | VLO frequency supply voltage drift | Measured at ACLK <sup>(2)</sup> | 1.8 V to 3.6 V  |     | 4   |     | %/V  |
|                                     | Duty cycle                         | Measured at ACLK                | 1.8 V to 3.6 V  | 30  |     | 70  | %    |

(1) Calculated using the box method: (MAX(-40 to 85°C) – MIN(-40 to 85°C)) / MIN(85°C – (-40°C))

(2) Calculated using the box method: (MAX(1.8 to 3.6 V) – MIN(1.8 to 3.6 V)) / MIN(1.8 to 3.6 V) / (3.6 V – 1.8 V)

**Table 5-3. Internal Reference, Low-Frequency Oscillator (REFO)**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                            |                                     | TEST CONDITIONS                 | V <sub>CC</sub> | MIN | TYP   | MAX  | UNIT |
|--------------------------------------|-------------------------------------|---------------------------------|-----------------|-----|-------|------|------|
| I <sub>REFO</sub>                    | REFO oscillator current consumption | T <sub>A</sub> = 25°C           | 1.8 V to 3.6 V  |     | 3     |      | μA   |
| f <sub>REFO</sub>                    | REFO frequency calibrated           | Measured at ACLK                | 1.8 V to 3.6 V  |     | 32768 |      | Hz   |
|                                      | REFO absolute tolerance calibrated  | Full temperature range          | 1.8 V to 3.6 V  |     |       | ±3.5 | %    |
|                                      |                                     | T <sub>A</sub> = 25°C           | 3 V             |     |       | ±1.5 | %    |
| df <sub>REFO</sub> /dT               | REFO frequency temperature drift    | Measured at ACLK <sup>(1)</sup> | 1.8 V to 3.6 V  |     | 0.01  |      | %/°C |
| df <sub>REFO</sub> /dV <sub>CC</sub> | REFO frequency supply voltage drift | Measured at ACLK <sup>(2)</sup> | 1.8 V to 3.6 V  |     | 1.0   |      | %/V  |
|                                      | Duty cycle                          | Measured at ACLK                | 1.8 V to 3.6 V  | 40  | 50    | 60   | %    |
| t <sub>START</sub>                   | REFO startup time                   | 40%/60% duty cycle              | 1.8 V to 3.6 V  |     | 25    |      | μs   |

(1) Calculated using the box method: (MAX(-40 to 85°C) – MIN(-40 to 85°C)) / MIN(85°C – (-40°C))

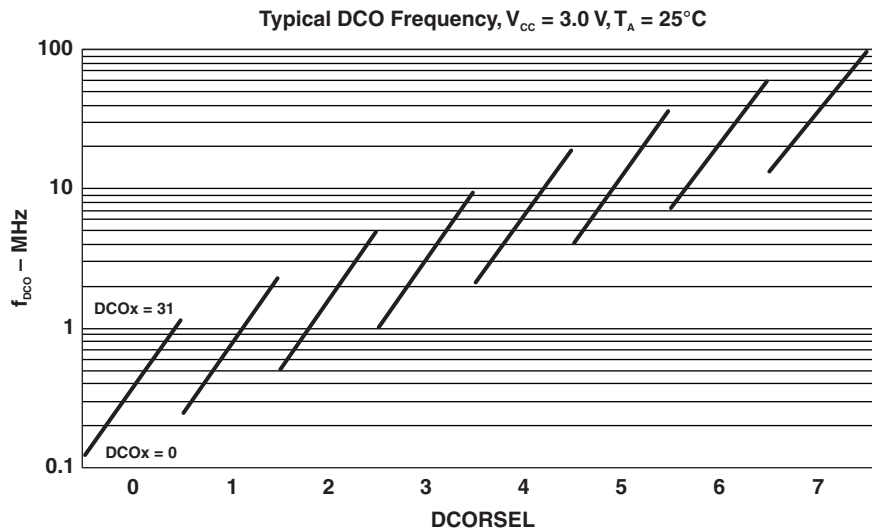
(2) Calculated using the box method: (MAX(1.8 to 3.6 V) – MIN(1.8 to 3.6 V)) / MIN(1.8 to 3.6 V) / (3.6 V – 1.8 V)

**Table 5-4. DCO Frequency**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER            | TEST CONDITIONS                                      | MIN  | TYP  | MAX  | UNIT  |      |
|----------------------|--|--|------|------|-------|------|
| $f_{DCO(0,0)}$       | DCO frequency (0, 0) <sup>(1)</sup>                  | DCORSELx = 0, DCOx = 0, MODx = 0                         | 0.07 | 0.20 | MHz   |      |
| $f_{DCO(0,31)}$      | DCO frequency (0, 31) <sup>(1)</sup>                 | DCORSELx = 0, DCOx = 31, MODx = 0                        | 0.70 | 1.70 | MHz   |      |
| $f_{DCO(1,0)}$       | DCO frequency (1, 0) <sup>(1)</sup>                  | DCORSELx = 1, DCOx = 0, MODx = 0                         | 0.15 | 0.36 | MHz   |      |
| $f_{DCO(1,31)}$      | DCO frequency (1, 31) <sup>(1)</sup>                 | DCORSELx = 1, DCOx = 31, MODx = 0                        | 1.47 | 3.45 | MHz   |      |
| $f_{DCO(2,0)}$       | DCO frequency (2, 0) <sup>(1)</sup>                  | DCORSELx = 2, DCOx = 0, MODx = 0                         | 0.32 | 0.75 | MHz   |      |
| $f_{DCO(2,31)}$      | DCO frequency (2, 31) <sup>(1)</sup>                 | DCORSELx = 2, DCOx = 31, MODx = 0                        | 3.17 | 7.38 | MHz   |      |
| $f_{DCO(3,0)}$       | DCO frequency (3, 0) <sup>(1)</sup>                  | DCORSELx = 3, DCOx = 0, MODx = 0                         | 0.64 | 1.51 | MHz   |      |
| $f_{DCO(3,31)}$      | DCO frequency (3, 31) <sup>(1)</sup>                 | DCORSELx = 3, DCOx = 31, MODx = 0                        | 6.07 | 14.0 | MHz   |      |
| $f_{DCO(4,0)}$       | DCO frequency (4, 0) <sup>(1)</sup>                  | DCORSELx = 4, DCOx = 0, MODx = 0                         | 1.3  | 3.2  | MHz   |      |
| $f_{DCO(4,31)}$      | DCO frequency (4, 31) <sup>(1)</sup>                 | DCORSELx = 4, DCOx = 31, MODx = 0                        | 12.3 | 28.2 | MHz   |      |
| $f_{DCO(5,0)}$       | DCO frequency (5, 0) <sup>(1)</sup>                  | DCORSELx = 5, DCOx = 0, MODx = 0                         | 2.5  | 6.0  | MHz   |      |
| $f_{DCO(5,31)}$      | DCO frequency (5, 31) <sup>(1)</sup>                 | DCORSELx = 5, DCOx = 31, MODx = 0                        | 23.7 | 54.1 | MHz   |      |
| $f_{DCO(6,0)}$       | DCO frequency (6, 0) <sup>(1)</sup>                  | DCORSELx = 6, DCOx = 0, MODx = 0                         | 4.6  | 10.7 | MHz   |      |
| $f_{DCO(6,31)}$      | DCO frequency (6, 31) <sup>(1)</sup>                 | DCORSELx = 6, DCOx = 31, MODx = 0                        | 39.0 | 88.0 | MHz   |      |
| $f_{DCO(7,0)}$       | DCO frequency (7, 0) <sup>(1)</sup>                  | DCORSELx = 7, DCOx = 0, MODx = 0                         | 8.5  | 19.6 | MHz   |      |
| $f_{DCO(7,31)}$      | DCO frequency (7, 31) <sup>(1)</sup>                 | DCORSELx = 7, DCOx = 31, MODx = 0                        | 60   | 135  | MHz   |      |
| $S_{DCORSEL}$        | Frequency step between range DCORSEL and DCORSEL + 1 | $S_{RSEL} = f_{DCO(DCORSEL+1,DCO)}/f_{DCO(DCORSEL,DCO)}$ | 1.2  | 2.3  | ratio |      |
| $S_{DCO}$            | Frequency step between tap DCO and DCO + 1           | $S_{DCO} = f_{DCO(DCORSEL,DCO+1)}/f_{DCO(DCORSEL,DCO)}$  | 1.02 | 1.12 | ratio |      |
|                      | Duty cycle   | Measured at SMCLK  | 40   | 50   | 60    | %    |
| $df_{DCO}/dT$        | DCO frequency temperature drift                      | $f_{DCO} = 1$ MHz  |      | 0.1  |       | %/°C |
| $df_{DCO}/dV_{CORE}$ | DCO frequency voltage drift                          | $f_{DCO} = 1$ MHz  |      | 1.9  |       | %/V  |

- (1) When selecting the proper DCO frequency range (DCORSELx), the target DCO frequency,  $f_{DCO}$ , should be set to reside within the range of  $f_{DCO(n,0),MAX} \leq f_{DCO} \leq f_{DCO(n,31),MIN}$ , where  $f_{DCO(n,0),MAX}$  represents the maximum frequency specified for the DCO frequency, range n, tap 0 (DCOx = 0) and  $f_{DCO(n,31),MIN}$  represents the minimum frequency specified for the DCO frequency, range n, tap 31 (DCOx = 31). This ensures that the target DCO frequency resides within the range selected. It should also be noted that if the actual  $f_{DCO}$  frequency for the selected range causes the FLL or the application to select tap 0 or 31, the DCO fault flag is set to report that the selected range is at its minimum or maximum tap setting.



**Figure 5-2. Typical DCO Frequency**

## 5.8 Peripherals

### 5.8.1 I/O Ports

**Table 5-5. Schmitt-Trigger Inputs – General Purpose I/O**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER  | TEST CONDITIONS  | V <sub>CC</sub> | MIN  | TYP | MAX  | UNIT |
|--|--|-----------------|------|-----|------|------|
| V <sub>IT+</sub> Positive-going input threshold voltage                          |  | 1.8 V           | 0.80 |     | 1.40 | V    |
|  |  | 3 V             | 1.50 |     | 2.10 |      |
| V <sub>IT-</sub> Negative-going input threshold voltage                          |  | 1.8 V           | 0.45 |     | 1.00 | V    |
|  |  | 3 V             | 0.75 |     | 1.65 |      |
| V <sub>hys</sub> Input voltage hysteresis (V <sub>IT+</sub> – V <sub>IT-</sub> ) |  | 1.8 V           | 0.3  |     | 0.85 | V    |
|  |  | 3 V             | 0.4  |     | 1.0  |      |
| R <sub>Pull</sub> Pullup or pulldown resistor <sup>(1)</sup>                     | For pullup: V <sub>IN</sub> = V <sub>SS</sub><br>For pulldown: V <sub>IN</sub> = V <sub>CC</sub> |                 | 20   | 35  | 50   | kΩ   |
| C <sub>I</sub> Input capacitance   | V <sub>IN</sub> = V <sub>SS</sub> or V <sub>CC</sub>   |                 |      | 5   |      | pF   |

(1) Also applies to  $\overline{\text{RST}}$  pin when pullup or pulldown resistor is enabled.

**Table 5-6. Inputs – Ports P1 and P2<sup>(1)</sup>**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER   | TEST CONDITIONS  | V <sub>CC</sub> | MIN | MAX | UNIT |
|---|--|-----------------|-----|-----|------|
| t <sub>(int)</sub> External interrupt timing <sup>(2)</sup> | Port P1, P2: P1.x to P2.x, External trigger pulse duration to set interrupt flag | 2.2 V, 3 V      | 20  |     | ns   |

(1) Some devices may contain additional ports with interrupts. See the block diagram and terminal function descriptions.

(2) An external signal sets the interrupt flag every time the minimum interrupt pulse duration t<sub>(int)</sub> is met. It might be set by trigger signals shorter than t<sub>(int)</sub>.

**Table 5-7. Leakage Current – General Purpose I/O**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER   | TEST CONDITIONS       | V <sub>CC</sub> | MIN | MAX | UNIT |
|---|-----------------------|-----------------|-----|-----|------|
| I <sub>lkg(Px.y)</sub> High-impedance leakage current | See <sup>(1)(2)</sup> | 1.8 V, 3 V      |     | ±50 | nA   |

(1) The leakage current is measured with V<sub>SS</sub> or V<sub>CC</sub> applied to the corresponding pins, unless otherwise noted.

(2) The leakage of the digital port pins is measured individually. The port pin is selected for input and the pullup or pulldown resistor is disabled.

**Table 5-8. Outputs – General Purpose I/O (Full Drive Strength)**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

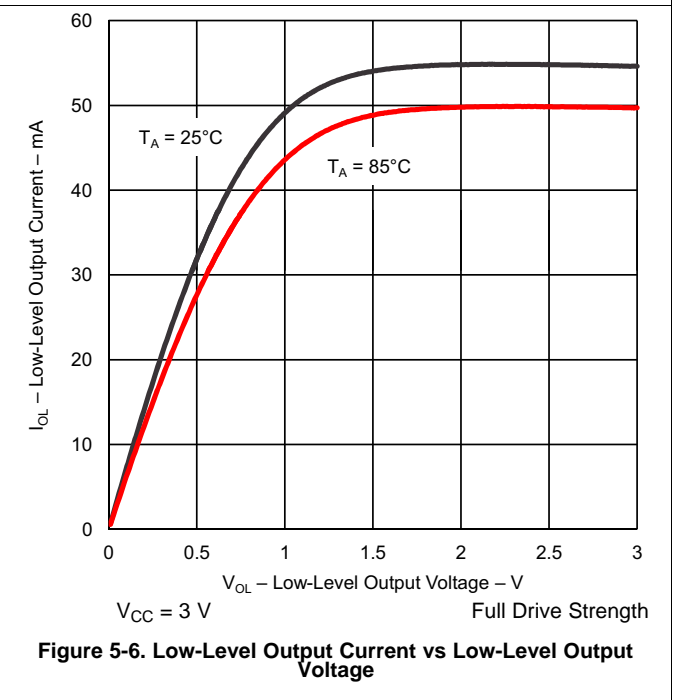
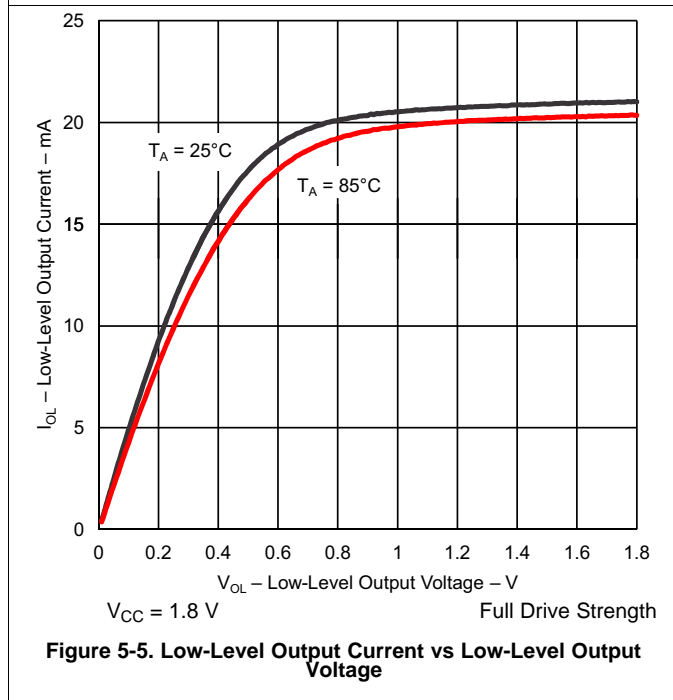
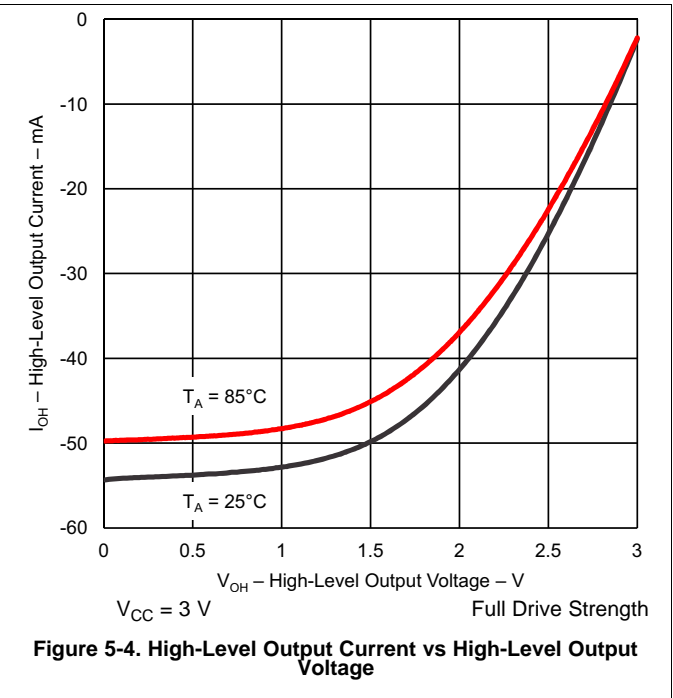
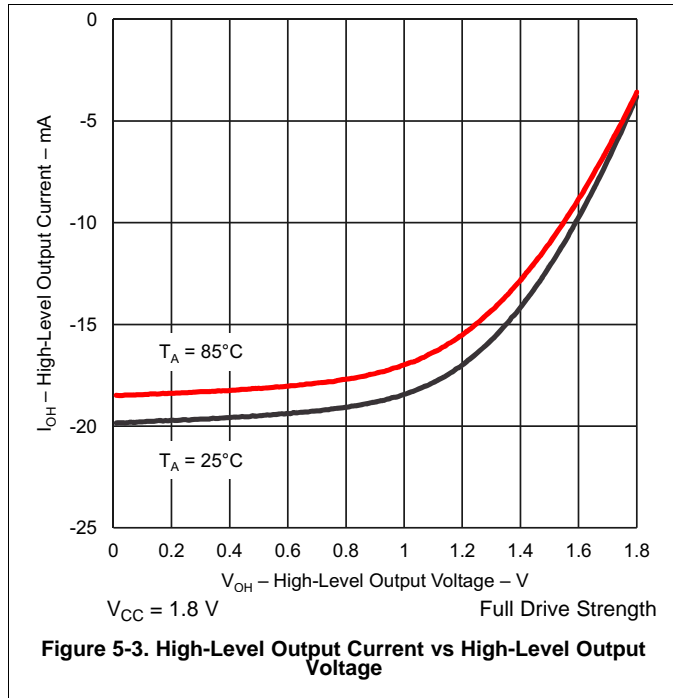
| PARAMETER                                 | TEST CONDITIONS                              | V <sub>CC</sub> | MIN                    | MAX                    | UNIT |
|---|--|-----------------|------------------------|------------------------|------|
| V <sub>OH</sub> High-level output voltage | I <sub>(OHmax)</sub> = –3 mA <sup>(1)</sup>  | 1.8 V           | V <sub>CC</sub> – 0.25 | V <sub>CC</sub>        | V    |
|   | I <sub>(OHmax)</sub> = –10 mA <sup>(1)</sup> |                 | V <sub>CC</sub> – 0.60 | V <sub>CC</sub>        |      |
|   | I <sub>(OHmax)</sub> = –5 mA <sup>(1)</sup>  | 3 V             | V <sub>CC</sub> – 0.25 | V <sub>CC</sub>        |      |
|   | I <sub>(OHmax)</sub> = –15 mA <sup>(1)</sup> |                 | V <sub>CC</sub> – 0.60 | V <sub>CC</sub>        |      |
| V <sub>OL</sub> Low-level output voltage  | I <sub>(OLmax)</sub> = 3 mA <sup>(2)</sup>   | 1.8 V           | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 | V    |
|   | I <sub>(OLmax)</sub> = 10 mA <sup>(3)</sup>  |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |
|   | I <sub>(OLmax)</sub> = 5 mA <sup>(2)</sup>   | 3 V             | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 |      |
|   | I <sub>(OLmax)</sub> = 15 mA <sup>(3)</sup>  |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |

(1) The maximum total current, I<sub>(OHmax)</sub>, for all outputs combined should not exceed ±20 mA to hold the maximum voltage drop specified. See [Section 5.3](#) for more details.

(2) The maximum total current, I<sub>(OLmax)</sub>, for all outputs combined should not exceed ±48 mA to hold the maximum voltage drop specified.

(3) The maximum total current, I<sub>(OLmax)</sub>, for all outputs combined should not exceed ±100 mA to hold the maximum voltage drop specified.

5.8.1.1 Typical Characteristics – General Purpose I/O (Full Drive Strength)



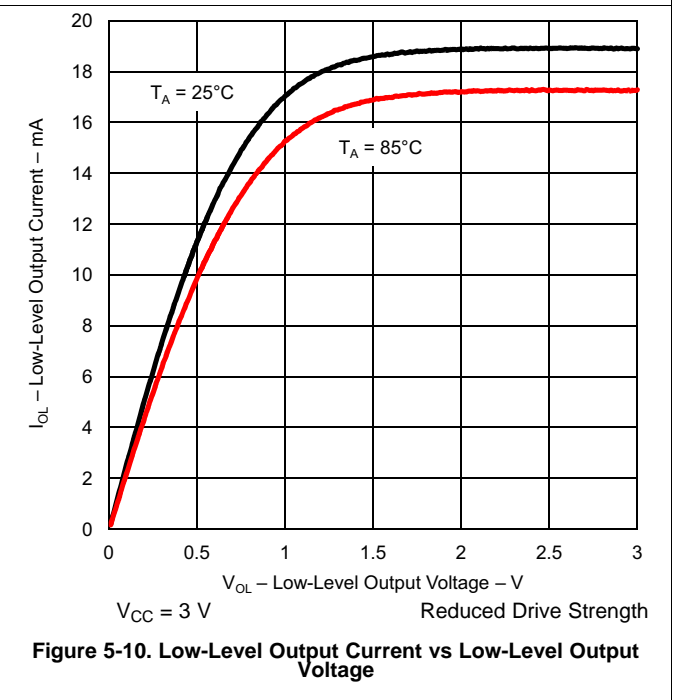
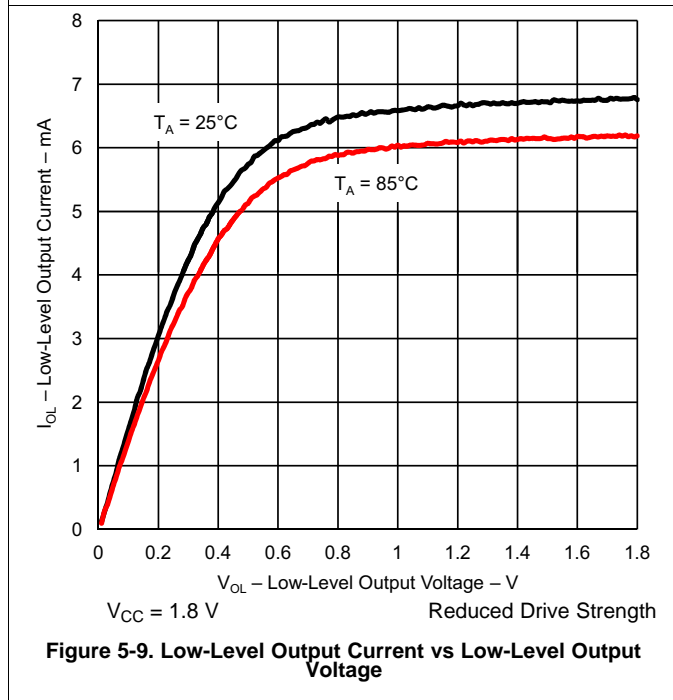
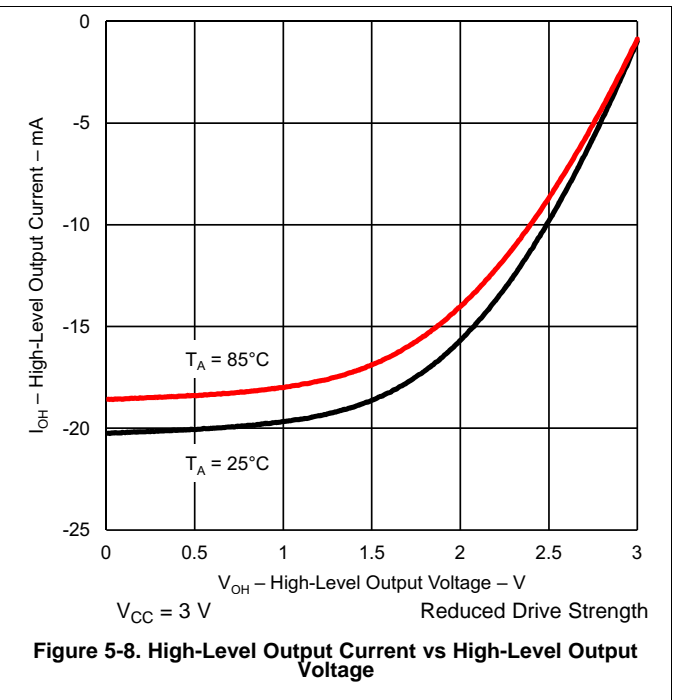
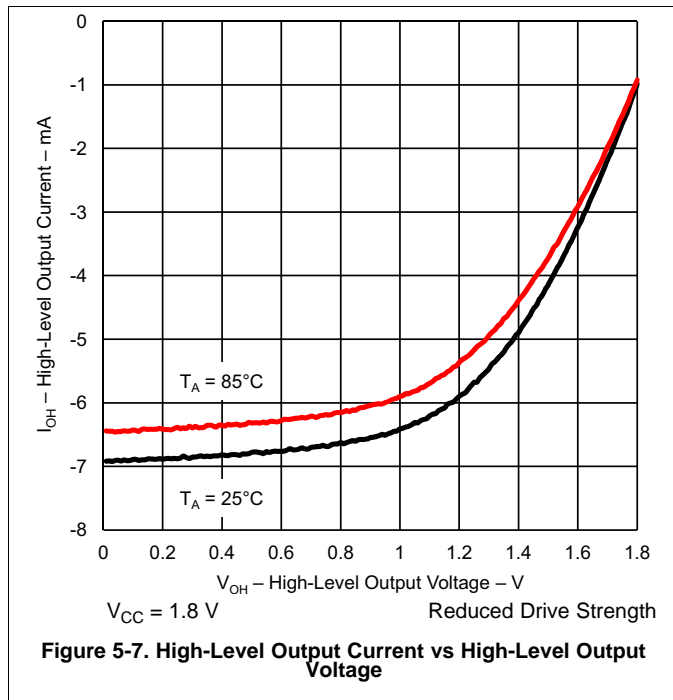
**Table 5-9. Outputs – General Purpose I/O (Reduced Drive Strength)**over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER       |                           | TEST CONDITIONS                             | V <sub>CC</sub> | MIN                    | MAX                    | UNIT |
|-----------------|---------------------------|---|-----------------|------------------------|------------------------|------|
| V <sub>OH</sub> | High-level output voltage | I <sub>(OHmax)</sub> = –1 mA <sup>(2)</sup> | 1.8 V           | V <sub>CC</sub> – 0.25 | V <sub>CC</sub>        | V    |
|                 |                           | I <sub>(OHmax)</sub> = –3 mA <sup>(2)</sup> |                 | V <sub>CC</sub> – 0.60 | V <sub>CC</sub>        |      |
|                 |                           | I <sub>(OHmax)</sub> = –2 mA <sup>(2)</sup> | 3.0 V           | V <sub>CC</sub> – 0.25 | V <sub>CC</sub>        |      |
|                 |                           | I <sub>(OHmax)</sub> = –6 mA <sup>(2)</sup> |                 | V <sub>CC</sub> – 0.60 | V <sub>CC</sub>        |      |
| V <sub>OL</sub> | Low-level output voltage  | I <sub>(OLmax)</sub> = 1 mA <sup>(3)</sup>  | 1.8 V           | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 | V    |
|                 |                           | I <sub>(OLmax)</sub> = 3 mA <sup>(4)</sup>  |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |
|                 |                           | I <sub>(OLmax)</sub> = 2 mA <sup>(3)</sup>  | 3.0 V           | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 |      |
|                 |                           | I <sub>(OLmax)</sub> = 6 mA <sup>(4)</sup>  |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |

(1) Selecting reduced drive strength may reduce EMI.

(2) The maximum total current, I<sub>(OHmax)</sub>, for all outputs combined should not exceed ±20 mA to hold the maximum voltage drop specified. See [Section 5.3](#) for more details.(3) The maximum total current, I<sub>(OLmax)</sub>, for all outputs combined, should not exceed ±48 mA to hold the maximum voltage drop specified.(4) The maximum total current, I<sub>(OLmax)</sub>, for all outputs combined, should not exceed ±100 mA to hold the maximum voltage drop specified.

5.8.1.2 Typical Characteristics – General Purpose I/O (Reduced Drive Strength)



**Table 5-10. Output Frequency – General Purpose I/O**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER             |                                   | TEST CONDITIONS   | MIN   | MAX | UNIT |
|-----------------------|-----------------------------------|---|---|-----|------|
| f <sub>Px,y</sub>     | Port output frequency (with load) | See <sup>(1)(2)</sup>                                       | V <sub>CC</sub> = 1.8 V,<br>PMMCOREV <sub>x</sub> = 0 | 16  | MHz  |
|                       |                                   |   | V <sub>CC</sub> = 3 V,<br>PMMCOREV <sub>x</sub> = 3   | 25  |      |
| f <sub>Port_CLK</sub> | Clock output frequency            | ACLK, SMCLK, MCLK,<br>C <sub>L</sub> = 20 pF <sup>(2)</sup> | V <sub>CC</sub> = 1.8 V,<br>PMMCOREV <sub>x</sub> = 0 | 16  | MHz  |
|                       |                                   |   | V <sub>CC</sub> = 3 V,<br>PMMCOREV <sub>x</sub> = 3   | 25  |      |

(1) A resistive divider with 2 × R1 between V<sub>CC</sub> and V<sub>SS</sub> is used as load. The output is connected to the center tap of the divider. For full drive strength, R1 = 550 Ω. For reduced drive strength, R1 = 1.6 kΩ. C<sub>L</sub> = 20 pF is connected to the output to V<sub>SS</sub>.

(2) The output voltage reaches at least 10% and 90% V<sub>CC</sub> at the specified toggle frequency.

## 5.8.2 Power Management Module

**Table 5-11. PMM, Brownout Reset (BOR)**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                         |   | TEST CONDITIONS                | MIN  | TYP  | MAX  | UNIT |
|-----------------------------------|---|--------------------------------|------|------|------|------|
| V <sub>(DVCC_BOR_IT-)</sub>       | BOR <sub>H</sub> on voltage, DV <sub>CC</sub> falling level | dDV <sub>CC</sub> /dt  < 3 V/s |      |      | 1.45 | V    |
| V <sub>(DVCC_BOR_IT+)</sub>       | BOR <sub>H</sub> off voltage, DV <sub>CC</sub> rising level | dDV <sub>CC</sub> /dt  < 3 V/s | 0.80 | 1.30 | 1.50 | V    |
| V <sub>(DVCC_BOR_hys)</sub>       | BOR <sub>H</sub> hysteresis                                 |                                | 60   |      | 250  | mV   |
| t <sub>RESET</sub> <sup>(1)</sup> | Pulse duration required at RST/NMI pin to accept a reset    |                                | 2    |      |      | μs   |

(1) Pulse much shorter than 2 μs might trigger reset.

**Table 5-12. PMM, Core Voltage**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER               |  | TEST CONDITIONS                  | MIN | TYP  | MAX | UNIT |
|-------------------------|--|----------------------------------|-----|------|-----|------|
| V <sub>CORE3(AM)</sub>  | Core voltage, active mode, PMMCOREV = 3      | 2.4 V ≤ DV <sub>CC</sub> ≤ 3.6 V |     | 1.93 |     | V    |
| V <sub>CORE2(AM)</sub>  | Core voltage, active mode, PMMCOREV = 2      | 2.2 V ≤ DV <sub>CC</sub> ≤ 3.6 V |     | 1.83 |     | V    |
| V <sub>CORE1(AM)</sub>  | Core voltage, active mode, PMMCOREV = 1      | 2.0 V ≤ DV <sub>CC</sub> ≤ 3.6 V |     | 1.62 |     | V    |
| V <sub>CORE0(AM)</sub>  | Core voltage, active mode, PMMCOREV = 0      | 1.8 V ≤ DV <sub>CC</sub> ≤ 3.6 V |     | 1.42 |     | V    |
| V <sub>CORE3(LPM)</sub> | Core voltage, low-current mode, PMMCOREV = 3 | 2.4 V ≤ DV <sub>CC</sub> ≤ 3.6 V |     | 1.96 |     | V    |
| V <sub>CORE2(LPM)</sub> | Core voltage, low-current mode, PMMCOREV = 2 | 2.2 V ≤ DV <sub>CC</sub> ≤ 3.6 V |     | 1.94 |     | V    |
| V <sub>CORE1(LPM)</sub> | Core voltage, low-current mode, PMMCOREV = 1 | 2.0 V ≤ DV <sub>CC</sub> ≤ 3.6 V |     | 1.74 |     | V    |
| V <sub>CORE0(LPM)</sub> | Core voltage, low-current mode, PMMCOREV = 0 | 1.8 V ≤ DV <sub>CC</sub> ≤ 3.6 V |     | 1.54 |     | V    |



**Table 5-13. PMM, SVS High Side**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER         |   | TEST CONDITIONS   | MIN  | TYP  | MAX  | UNIT          |
|-------------------|---|---|------|------|------|---------------|
| $I_{(SVSH)}$      | SVS current consumption                           | SVSHE = 0, $DV_{CC} = 3.6\text{ V}$                               |      | 0    |      | nA            |
|                   |   | SVSHE = 1, $DV_{CC} = 3.6\text{ V}$ , SVSHFP = 0                  |      | 200  |      | nA            |
|                   |   | SVSHE = 1, $DV_{CC} = 3.6\text{ V}$ , SVSHFP = 1                  |      | 1.5  |      | $\mu\text{A}$ |
| $V_{(SVSH\_IT-)}$ | SVS <sub>H</sub> on voltage level <sup>(1)</sup>  | SVSHE = 1, SVSHRVL = 0  | 1.60 | 1.65 | 1.70 | V             |
|                   |   | SVSHE = 1, SVSHRVL = 1  | 1.77 | 1.84 | 1.90 |               |
|                   |   | SVSHE = 1, SVSHRVL = 2  | 1.97 | 2.04 | 2.10 |               |
|                   |   | SVSHE = 1, SVSHRVL = 3  | 2.09 | 2.16 | 2.23 |               |
| $V_{(SVSH\_IT+)}$ | SVS <sub>H</sub> off voltage level <sup>(1)</sup> | SVSHE = 1, SVSMHRRRL = 0  | 1.68 | 1.74 | 1.80 | V             |
|                   |   | SVSHE = 1, SVSMHRRRL = 1  | 1.89 | 1.95 | 2.01 |               |
|                   |   | SVSHE = 1, SVSMHRRRL = 2  | 2.08 | 2.14 | 2.21 |               |
|                   |   | SVSHE = 1, SVSMHRRRL = 3  | 2.21 | 2.27 | 2.34 |               |
|                   |   | SVSHE = 1, SVSMHRRRL = 4  | 2.35 | 2.41 | 2.49 |               |
|                   |   | SVSHE = 1, SVSMHRRRL = 5  | 2.65 | 2.72 | 2.80 |               |
|                   |   | SVSHE = 1, SVSMHRRRL = 6  | 2.96 | 3.04 | 3.13 |               |
|                   |   | SVSHE = 1, SVSMHRRRL = 7  | 2.96 | 3.04 | 3.13 |               |
| $t_{pd(SVSH)}$    | SVS <sub>H</sub> propagation delay                | SVSHE = 1, $dV_{DVCC}/dt = 10\text{ mV}/\mu\text{s}$ , SVSHFP = 1 |      | 2.5  |      | $\mu\text{s}$ |
|                   |   | SVSHE = 1, $dV_{DVCC}/dt = 1\text{ mV}/\mu\text{s}$ , SVSHFP = 0  |      | 20   |      |               |
| $t_{(SVSH)}$      | SVS <sub>H</sub> on or off delay time             | SVSHE = 0 → 1, SVSHFP = 1   |      | 12.5 |      | $\mu\text{s}$ |
|                   |   | SVSHE = 0 → 1, SVSHFP = 0   |      | 100  |      |               |
| $dV_{DVCC}/dt$    | $DV_{CC}$ rise time                               |   | 0    |      | 1000 | V/s           |

(1) The SVS<sub>H</sub> settings available depend on the VCore (PMMCOREVx) setting. Please refer to the *Power Management Module and Supply Voltage Supervisor* chapter in the *MSP430x5xx Family User's Guide* ([SLAU208](#)) on recommended settings and usage.

**Table 5-14. PMM, SVM High Side**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER      |   | TEST CONDITIONS  | MIN  | TYP  | MAX  | UNIT |
|----------------|---|--|------|------|------|------|
| $I_{(SVMH)}$   | SVM <sub>H</sub> current consumption                    | SVMHE = 0, DV <sub>CC</sub> = 3.6 V                      |      | 0    |      | nA   |
|                |   | SVMHE = 1, DV <sub>CC</sub> = 3.6 V, SVMHFP = 0          |      | 200  |      | nA   |
|                |   | SVMHE = 1, DV <sub>CC</sub> = 3.6 V, SVMHFP = 1          |      | 1.5  |      | μA   |
| $V_{(SVMH)}$   | SVM <sub>H</sub> on or off voltage level <sup>(1)</sup> | SVMHE = 1, SVSMHRRRL = 0                                 | 1.68 | 1.74 | 1.80 | V    |
|                |   | SVMHE = 1, SVSMHRRRL = 1                                 | 1.89 | 1.95 | 2.01 |      |
|                |   | SVMHE = 1, SVSMHRRRL = 2                                 | 2.08 | 2.14 | 2.21 |      |
|                |   | SVMHE = 1, SVSMHRRRL = 3                                 | 2.21 | 2.27 | 2.34 |      |
|                |   | SVMHE = 1, SVSMHRRRL = 4                                 | 2.35 | 2.41 | 2.49 |      |
|                |   | SVMHE = 1, SVSMHRRRL = 5                                 | 2.65 | 2.72 | 2.80 |      |
|                |   | SVMHE = 1, SVSMHRRRL = 6                                 | 2.96 | 3.04 | 3.13 |      |
|                |   | SVMHE = 1, SVSMHRRRL = 7                                 | 2.96 | 3.04 | 3.13 |      |
| $t_{pd(SVMH)}$ | SVM <sub>H</sub> propagation delay                      | SVMHE = 1, dV <sub>DVCC</sub> /dt = 10 mV/μs, SVMHFP = 1 |      | 2.5  |      | μs   |
|                |   | SVMHE = 1, dV <sub>DVCC</sub> /dt = 1 mV/μs, SVMHFP = 0  |      | 20   |      |      |
| $t_{(SVMH)}$   | SVM <sub>H</sub> on or off delay time                   | SVMHE = 0 → 1, SVMHFP = 1                                |      | 12.5 |      | μs   |
|                |   | SVMHE = 0 → 1, SVMHFP = 0                                |      | 100  |      |      |

(1) The SVM<sub>H</sub> settings available depend on the V<sub>CORE</sub> (PMMCOREVx) setting. Refer to the *Power Management Module and Supply Voltage Supervisor* chapter in the *MSP430x5xx Family User's Guide* ([SLAU208](#)) on recommended settings and usage.

**Table 5-15. PMM, SVS Low Side**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER      |                                       | TEST CONDITIONS  | MIN | TYP  | MAX | UNIT |
|----------------|---------------------------------------|--|-----|------|-----|------|
| $I_{(SVSL)}$   | SVS <sub>L</sub> current consumption  | SVSLE = 0, PMMCOREV = 2  |     | 0    |     | nA   |
|                |                                       | SVSLE = 1, PMMCOREV = 2, SVSLFP = 0                                |     | 200  |     | nA   |
|                |                                       | SVSLE = 1, PMMCOREV = 2, SVSLFP = 1                                |     | 1.5  |     | μA   |
| $t_{pd(SVSL)}$ | SVS <sub>L</sub> propagation delay    | SVSLE = 1, $dV_{CORE}/dt = 10 \text{ mV}/\mu\text{s}$ , SVSLFP = 1 |     | 2.5  |     | μs   |
|                |                                       | SVSLE = 1, $dV_{CORE}/dt = 1 \text{ mV}/\mu\text{s}$ , SVSLFP = 0  |     | 20   |     |      |
| $t_{(SVSL)}$   | SVS <sub>L</sub> on or off delay time | SVSLE = 0 → 1, SVSLFP = 1  |     | 12.5 |     | μs   |
|                |                                       | SVSLE = 0 → 1, SVSLFP = 0  |     | 100  |     |      |

**Table 5-16. PMM, SVM Low Side**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER     |                                       | TEST CONDITIONS  | MIN | TYP  | MAX | UNIT |
|---------------|---------------------------------------|--|-----|------|-----|------|
| $I_{(SVM)}$   | SVM <sub>L</sub> current consumption  | SVMLE = 0, PMMCOREV = 2  |     | 0    |     | nA   |
|               |                                       | SVMLE = 1, PMMCOREV = 2, SVMLFP = 0                                |     | 200  |     | nA   |
|               |                                       | SVMLE = 1, PMMCOREV = 2, SVMLFP = 1                                |     | 1.5  |     | μA   |
| $t_{pd(SVM)}$ | SVM <sub>L</sub> propagation delay    | SVMLE = 1, $dV_{CORE}/dt = 10 \text{ mV}/\mu\text{s}$ , SVMLFP = 1 |     | 2.5  |     | μs   |
|               |                                       | SVMLE = 1, $dV_{CORE}/dt = 1 \text{ mV}/\mu\text{s}$ , SVMLFP = 0  |     | 20   |     |      |
| $t_{(SVM)}$   | SVM <sub>L</sub> on or off delay time | SVMLE = 0 → 1, SVMLFP = 1  |     | 12.5 |     | μs   |
|               |                                       | SVMLE = 0 → 1, SVMLFP = 0  |     | 100  |     |      |

**Table 5-17. Wakeup From Low-Power Modes and Reset**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                   |  | TEST CONDITIONS   | MIN | TYP                                  | MAX | UNIT |    |
|-----------------------------|--|---|-----|--------------------------------------|-----|------|----|
| $t_{\text{WAKE-UP-FAST}}$   | Wake-up time from LPM2, LPM3, or LPM4 to active mode <sup>(1)</sup>                  | PMMCOREV = SVSMLRRL = n (where n = 0, 1, 2, or 3), SVSLFP = 1 |     | $f_{\text{MCLK}} \geq 4 \text{ MHz}$ | 3   | 5    | μs |
|                             |  | $1 \text{ MHz} < f_{\text{MCLK}} < 4 \text{ MHz}$             |     | 4                                    | 6   |      |    |
| $t_{\text{WAKE-UP-SLOW}}$   | Wake-up time from LPM2, LPM3, or LPM4 to active mode <sup>(2)</sup>                  | PMMCOREV = SVSMLRRL = n (where n = 0, 1, 2, or 3), SVSLFP = 0 |     | 150                                  | 160 | μs   |    |
| $t_{\text{WAKE-UP-LPM4.5}}$ | Wake-up time from LPM4.5 to active mode <sup>(3)</sup>                               |   |     | 2                                    | 3   | ms   |    |
| $t_{\text{WAKE-UP-RESET}}$  | Wake-up time from $\overline{\text{RST}}$ or BOR event to active mode <sup>(3)</sup> |   |     | 2                                    | 3   | ms   |    |

- (1) This value represents the time from the wakeup event to the first active edge of MCLK. The wakeup time depends on the performance mode of the low-side supervisor (SVS<sub>L</sub>) and low-side monitor (SVM<sub>L</sub>). Fastest wakeup times are possible with SVS<sub>L</sub> and SVM<sub>L</sub> in full-performance mode or disabled when operating in AM, LPM0, and LPM1. Various options are available for SVS<sub>L</sub> and SVM<sub>L</sub> while operating in LPM2, LPM3, and LPM4. See the *Power Management Module and Supply Voltage Supervisor* chapter in the *MSP430x5xx and MSP430x6xx Family User's Guide* (SLAU208).
- (2) This value represents the time from the wakeup event to the first active edge of MCLK. The wakeup time depends on the performance mode of the low side supervisor (SVS<sub>L</sub>) and low side monitor (SVM<sub>L</sub>). In this case, the SVS<sub>L</sub> and SVM<sub>L</sub> are in normal mode (low current) mode when operating in AM, LPM0, and LPM1. Various options are available for SVS<sub>L</sub> and SVM<sub>L</sub> while operating in LPM2, LPM3, and LPM4. See the *Power Management Module and Supply Voltage Supervisor* chapter in the *MSP430x5xx and MSP430x6xx Family User's Guide* (SLAU208).
- (3) This value represents the time from the wakeup event to the reset vector execution.

### 5.8.3 Auxiliary Supplies

**Table 5-18. Auxiliary Supplies - Recommended Operating Conditions**

over operating free-air temperature range (unless otherwise noted)

|                       |  | MIN              | NOM | MAX | UNIT    |
|-----------------------|--|------------------|-----|-----|---------|
| $V_{CC}$              | Supply voltage range for all supplies at pins DVCC, AVCC, AUX1, AUX2, AUX3           | 1.8              |     | 3.6 | V       |
| $V_{DSYS}$            | Digital system supply voltage range,<br>$V_{DSYS} = V_{CC} - R_{ON} \times I_{LOAD}$ | PMMCOREVx = 0    |     | 3.6 | V       |
|                       |  | PMMCOREVx = 1    | 2.0 | 3.6 |         |
|                       |  | PMMCOREVx = 2    | 2.2 | 3.6 |         |
|                       |  | PMMCOREVx = 3    | 2.4 | 3.6 |         |
| $V_{ASYS}$            | Analog system supply voltage range, $V_{ASYS} = V_{CC} - R_{ON} \times I_{LOAD}$     | Refer to modules |     |     | V       |
| $C_{VCC}, C_{AUX1/2}$ | Recommended capacitor at pins DVCC, AVCC, AUX1, AUX2                                 | 4.7              |     |     | $\mu F$ |
| $C_{VSYs}$            | Recommended capacitor at pins VDSYS and VASYS  | 4.7              |     |     | $\mu F$ |
| $C_{V CORE}$          | Recommended capacitance at pin V CORE  | 0.47             |     |     | $\mu F$ |
| $C_{AUX3}$            | Recommended capacitor at pin AUX3  | 0.47             |     |     | $\mu F$ |

**Table 5-19. Auxiliary Supplies - AUX3 (Backup Subsystem) Currents**

over operating free-air temperature range (unless otherwise noted)

| PARAMETER          | TEST CONDITIONS  | $V_{CC}$ | $T_A$ | MIN | TYP | MAX  | UNIT    |
|--------------------|--|----------|-------|-----|-----|------|---------|
| $I_{AUX3, RTCOn}$  | AUX3 current with RTC enabled<br>RTC and 32-kHz oscillator in backup subsystem enabled   | 3 V      | 25°C  |     |     | 0.83 | $\mu A$ |
|                    |  |          | 85°C  |     |     | 0.95 |         |
| $I_{AUX3, RTCoff}$ | AUX3 current with RTC disabled<br>RTC and 32-kHz oscillator in backup subsystem disabled | 3 V      | 25°C  |     |     | 110  | nA      |
|                    |  |          | 85°C  |     |     | 165  |         |

**Table 5-20. Auxiliary Supplies - Auxiliary Supply Monitor**

over operating free-air temperature range (unless otherwise noted)

| PARAMETER           | TEST CONDITIONS   | $V_{CC}$    | MIN  | TYP  | MAX  | UNIT    |
|---------------------|---|-------------|------|------|------|---------|
| $I_{CC, Monitor}$   | Average supply current for monitoring circuitry drawn from VDSYS<br>LOCKAUX = 0, AUXMRx = 0,<br>AUX0MD = 0, AUX1MD = 0, AUX2MD = 1,<br>VDSYS = DVCC, VASYS = AVCC,<br>Current measured at VDSYS pin                         | 3 V         |      |      | 0.70 | $\mu A$ |
| $I_{Meas, Monitor}$ | Average current drawn from monitored supply during measurement cycle<br>LOCKAUX = 0, AUXMRx = 0,<br>AUX0MD = 0, AUX1MD = 0, AUX2MD = 1,<br>VDSYS = DVCC, VASYS = AVCC,<br>AUXVCC1 = 3 V,<br>Current measured at AUXVCC1 pin |             |      |      | 0.11 | $\mu A$ |
| $V_{Monitor}$       | Auxiliary supply threshold level<br>AUXLVLx = 0   |             | 1.67 | 1.74 | 1.80 | V       |
|                     |   | AUXLVLx = 1 | 1.87 | 1.95 | 2.01 |         |
|                     |   | AUXLVLx = 2 | 2.06 | 2.14 | 2.21 |         |
|                     |   | AUXLVLx = 3 | 2.19 | 2.27 | 2.33 |         |
|                     |   | AUXLVLx = 4 | 2.33 | 2.41 | 2.48 |         |
|                     |   | AUXLVLx = 5 | 2.63 | 2.72 | 2.79 |         |
|                     |   | AUXLVLx = 6 | 2.91 | 3.02 | 3.10 |         |
| AUXLVLx = 7         | 2.91  | 3.02        | 3.10 |      |      |         |

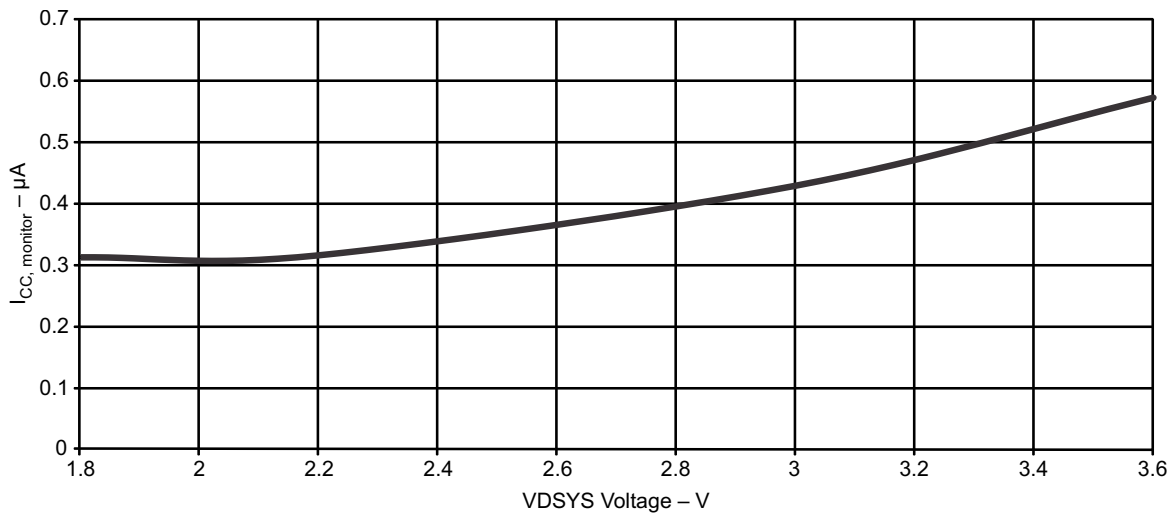


Figure 5-11. VDSYS Voltage vs  $I_{CC,Monitor}$

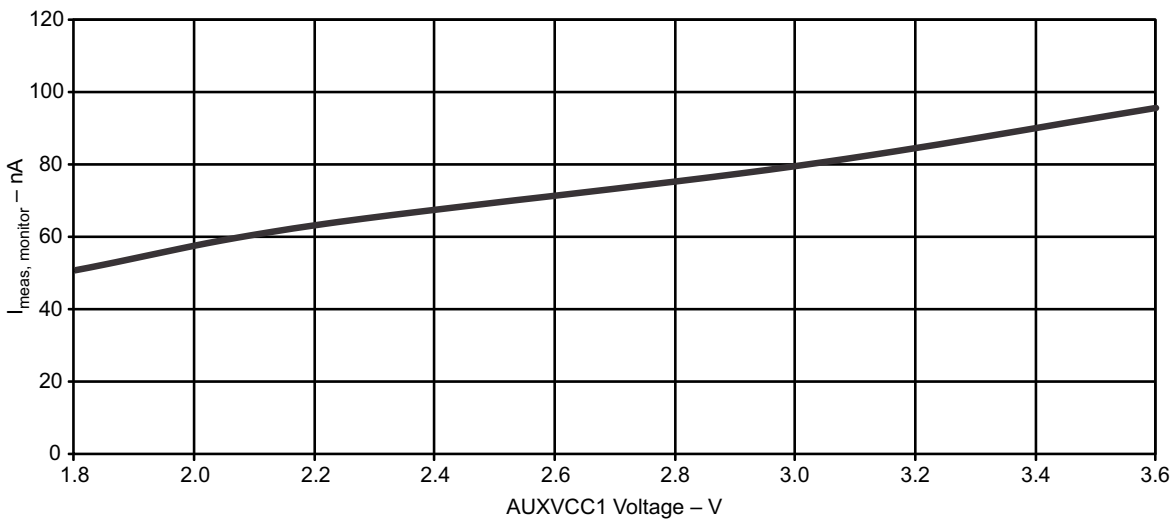


Figure 5-12. AUXVCC1 Voltage vs  $I_{Meas,Monitor}$

Table 5-21. Auxiliary Supplies - Switch On-Resistance

over operating free-air temperature range (unless otherwise noted)

| PARAMETER      |   | TEST CONDITIONS   | MIN | TYP | MAX | UNIT     |
|----------------|---|---|-----|-----|-----|----------|
| $R_{ON,DVCC}$  | On-resistance of switch between DVCC and VDSYS      | $I_{LOAD} = I_{CORE} + I_{IO} = 10\text{ mA} + 10\text{ mA} = 20\text{ mA}$ |     |     | 5   | $\Omega$ |
| $R_{ON,DAUX1}$ | On-resistance of switch between AUX1 and VDSYS      | $I_{LOAD} = I_{CORE} + I_{IO} = 10\text{ mA} + 10\text{ mA} = 20\text{ mA}$ |     |     | 5   | $\Omega$ |
| $R_{ON,DAUX2}$ | On-resistance of switch between AUX2 and VDSYS      | $I_{LOAD} = I_{CORE} + I_{IO} = 10\text{ mA} + 10\text{ mA} = 20\text{ mA}$ |     |     | 5   | $\Omega$ |
| $R_{ON,AVCC}$  | On-resistance of switch between AVCC and $V_{ASYS}$ | $I_{LOAD} = I_{Modules} = 10\text{ mA}$                                     |     |     | 5   | $\Omega$ |
| $R_{ON,AAUX1}$ | On-resistance of switch between AUX1 and $V_{ASYS}$ | $I_{LOAD} = I_{Modules} = 5\text{ mA}$                                      |     |     | 20  | $\Omega$ |
| $R_{ON,AAUX2}$ | On-resistance of switch between AUX2 and $V_{ASYS}$ | $I_{LOAD} = I_{Modules} = 5\text{ mA}$                                      |     |     | 20  | $\Omega$ |

**Table 5-22. Auxiliary Supplies - Switching Time**

over operating free-air temperature range (unless otherwise noted)

| PARAMETER            |   | MIN | TYP | MAX | UNIT          |
|----------------------|---|-----|-----|-----|---------------|
| $t_{\text{Switch}}$  | Time from occurrence of trigger (SVM or software) to "new" supply connected to system supplies      |     |     | 100 | ns            |
| $t_{\text{Recover}}$ | "Recovery time" after a switch over took place. During this time, no further switching takes place. | 200 |     | 450 | $\mu\text{s}$ |

**Table 5-23. Auxiliary Supplies - Switch Leakage**

over operating free-air temperature range (unless otherwise noted)

| PARAMETER           |   | TEST CONDITIONS                         |  | MIN | TYP | MAX | UNIT |
|---------------------|---|---|--|-----|-----|-----|------|
| $I_{\text{SW,Lkg}}$ | Current into DVCC, AVCC, AUX1 or AUX2 if not selected | Per supply (but not the highest supply) |  |     | 50  | 100 | nA   |
| $I_{\text{Vmax}}$   | Current drawn from highest supply                     |   |  |     | 450 | 730 | nA   |

**Table 5-24. Auxiliary Supplies - Auxiliary Supplies to ADC10\_A**

over operating free-air temperature range (unless otherwise noted)

| PARAMETER              |   | TEST CONDITIONS  |              | $V_{\text{CC}}$ | MIN  | TYP  | MAX  | UNIT       |
|------------------------|---|--|--------------|-----------------|------|------|------|------------|
| $V_3$                  | Supply voltage divider<br>$V_3 = V_{\text{Supply}}/3$ |  |              | 1.8 V           | 0.58 | 0.60 | 0.62 | V          |
|                        |   |  |              | 3.0 V           | 0.98 | 1.00 | 1.02 |            |
|                        |   |  |              | 3.6 V           | 1.18 | 1.20 | 1.22 |            |
| $R_{V3}$               | Load resistance                                       | AUXADCRx = 0   |              |                 |      |      | 18   | k $\Omega$ |
|                        |   | AUXADCRx = 1   |              |                 |      |      | 1.5  | k $\Omega$ |
|                        |   | AUXADCRx = 2   |              |                 |      |      | 0.6  | k $\Omega$ |
| $t_{\text{Sample,V3}}$ | Sampling time required if $V_3$ selected.             | AUXADC = 1,<br>ADC10ON = 1,<br>INCH = 0Ch,<br>Error of conversion<br>result $\leq 1$ LSB | AUXADCRx = 0 |                 | 1000 |      |      | ns         |
|                        |   |  | AUXADCRx = 1 |                 | 1000 |      |      | ns         |
|                        |   |  | AUXADCRx = 2 |                 | 1000 |      |      | ns         |

**Table 5-25. Auxiliary Supplies - Charge Limiting Resistor**

over operating free-air temperature range (unless otherwise noted)

| PARAMETER           |                          | TEST CONDITIONS |  | $V_{\text{CC}}$ | MIN | TYP | MAX | UNIT       |
|---------------------|--------------------------|-----------------|--|-----------------|-----|-----|-----|------------|
| $R_{\text{CHARGE}}$ | Charge limiting resistor | CHCx = 1        |  | 3 V             |     |     | 5   | k $\Omega$ |
|                     |                          | CHCx = 2        |  | 3 V             |     |     | 10  |            |
|                     |                          | CHCx = 3        |  | 3 V             |     |     | 20  |            |

### 5.8.4 Timer\_A

**Table 5-26. Timer\_A**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER           |                               | TEST CONDITIONS  | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|---------------------|-------------------------------|--|-----------------|-----|-----|-----|------|
| f <sub>TA</sub>     | Timer_A input clock frequency | Internal: SMCLK, ACLK<br>External: TACLK<br>Duty cycle = 50% ± 10% | 1.8 V, 3 V      |     |     | 25  | MHz  |
| t <sub>TA,cap</sub> | Timer_A capture timing        | All capture inputs.<br>Minimum pulse width required for capture.   | 1.8 V, 3 V      | 20  |     |     | ns   |

### 5.8.5 eUSCI

**Table 5-27. eUSCI (UART Mode) Recommended Operating Conditions**

| PARAMETER           |   | CONDITIONS  | V <sub>CC</sub> | MIN | TYP                 | MAX | UNIT |
|---------------------|---|---|-----------------|-----|---------------------|-----|------|
| f <sub>eUSCI</sub>  | eUSCI input clock frequency                           | Internal: SMCLK, ACLK<br>External: UCLK<br>Duty cycle = 50% ± 10% |                 |     | f <sub>SYSTEM</sub> |     | MHz  |
| f <sub>BITCLK</sub> | BITCLK clock frequency<br>(equals baud rate in MBaud) |   |                 |     |                     | 5   | MHz  |

**Table 5-28. eUSCI (UART Mode) Switching Characteristics**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER      |   | TEST CONDITIONS | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|----------------|---|-----------------|-----------------|-----|-----|-----|------|
| t <sub>t</sub> | UART receive deglitch time <sup>(1)</sup> | UCGLITx = 0     | 2 V, 3 V        | 10  | 15  | 25  | ns   |
|                |   | UCGLITx = 1     |                 | 30  | 50  | 85  |      |
|                |   | UCGLITx = 2     |                 | 50  | 80  | 150 |      |
|                |   | UCGLITx = 3     |                 | 70  | 120 | 200 |      |

(1) Pulses on the UART receive input (UCxRX) shorter than the UART receive deglitch time are suppressed. To ensure that pulses are correctly recognized their width should exceed the maximum specification of the deglitch time.

**Table 5-29. eUSCI (SPI Master Mode) Recommended Operating Conditions**

| PARAMETER          |                             | CONDITIONS                                      | V <sub>CC</sub> | MIN | TYP | MAX                 | UNIT |
|--------------------|-----------------------------|---|-----------------|-----|-----|---------------------|------|
| f <sub>eUSCI</sub> | eUSCI input clock frequency | Internal: SMCLK, ACLK<br>Duty cycle = 50% ± 10% |                 |     |     | f <sub>SYSTEM</sub> | MHz  |

**Table 5-30. eUSCI (SPI Master Mode) Switching Characteristics**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER             |   | TEST CONDITIONS                                 | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|-----------------------|---|---|-----------------|-----|-----|-----|------|
| t <sub>STE,LEAD</sub> | STE lead time, STE active to clock                    | UCSTEM = 0, UCMODEx = 01 or 10                  | 2 V, 3 V        | 150 |     |     | ns   |
|                       |   | UCSTEM = 1, UCMODEx = 01 or 10                  | 2 V, 3 V        | 150 |     |     |      |
| t <sub>STE,LAG</sub>  | STE lag time, Last clock to STE inactive              | UCSTEM = 0, UCMODEx = 01 or 10                  | 2 V, 3 V        | 200 |     |     | ns   |
|                       |   | UCSTEM = 1, UCMODEx = 01 or 10                  | 2 V, 3 V        | 200 |     |     |      |
| t <sub>STE,ACC</sub>  | STE access time, STE active to SIMO data out          | UCSTEM = 0, UCMODEx = 01 or 10                  | 2 V             |     |     | 50  | ns   |
|                       |   |   | 3 V             |     |     | 30  |      |
|                       |   | UCSTEM = 1, UCMODEx = 01 or 10                  | 2 V             |     |     | 50  |      |
|                       |   |   | 3 V             |     |     | 30  |      |
| t <sub>STE,DIS</sub>  | STE disable time, STE inactive to SIMO high impedance | UCSTEM = 0, UCMODEx = 01 or 10                  | 2 V             |     |     | 40  | ns   |
|                       |   |   | 3 V             |     |     | 25  |      |
|                       |   | UCSTEM = 1, UCMODEx = 01 or 10                  | 2 V             |     |     | 40  |      |
|                       |   |   | 3 V             |     |     | 25  |      |
| t <sub>SU,MI</sub>    | SOMI input data setup time                            |   | 2 V             | 50  |     |     | ns   |
|                       |   |   | 3 V             | 30  |     |     |      |
| t <sub>HD,MI</sub>    | SOMI input data hold time                             |   | 2 V             | 0   |     |     | ns   |
|                       |   |   | 3 V             | 0   |     |     |      |
| t <sub>VALID,MO</sub> | SIMO output data valid time <sup>(2)</sup>            | UCLK edge to SIMO valid, C <sub>L</sub> = 20 pF | 2 V             |     |     | 9   | ns   |
|                       |   |   | 3 V             |     |     | 5   |      |
| t <sub>HD,MO</sub>    | SIMO output data hold time <sup>(3)</sup>             | C <sub>L</sub> = 20 pF                          | 2 V             | 0   |     |     | ns   |
|                       |   |   | 3 V             | 0   |     |     |      |

- (1)  $f_{UCxCLK} = 1/2t_{LO/HI}$  with  $t_{LO/HI} = \max(t_{VALID,MO(eUSCI)} + t_{SU,SI(Slave)}, t_{SU,MI(eUSCI)} + t_{VALID,SO(Slave)})$ .  
For the slave's parameters  $t_{SU,SI(Slave)}$  and  $t_{VALID,SO(Slave)}$  refer to the SPI parameters of the attached slave.
- (2) Specifies the time to drive the next valid data to the SIMO output after the output changing UCLK clock edge. See the timing diagrams in [Figure 5-15](#) and [Figure 5-16](#).
- (3) Specifies how long data on the SIMO output is valid after the output changing UCLK clock edge. Negative values indicate that the data on the SIMO output can become invalid before the output changing clock edge observed on UCLK. See the timing diagrams in [Figure 5-15](#) and [Figure 5-16](#).



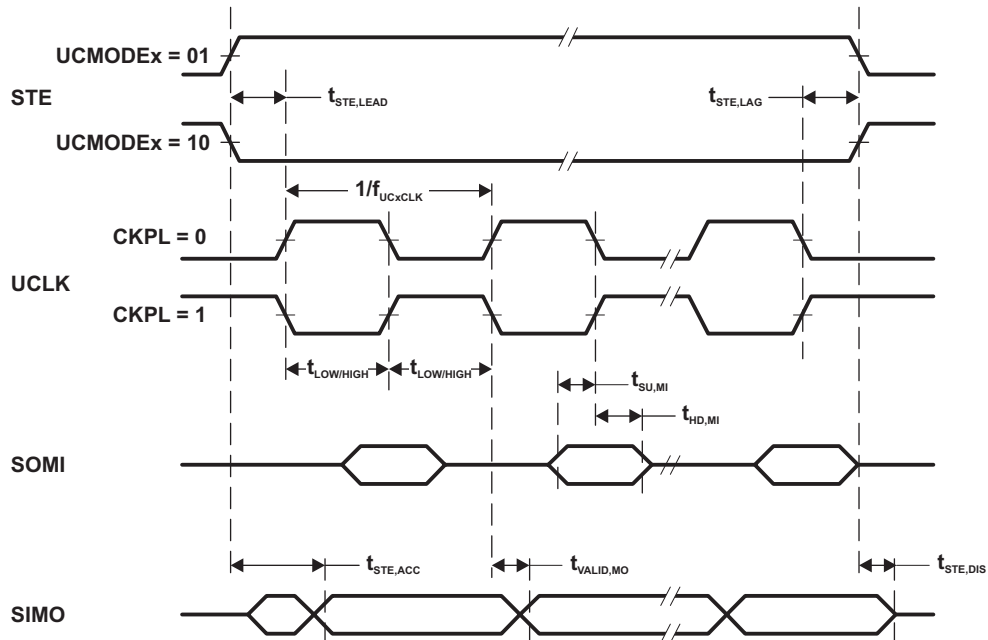


Figure 5-13. SPI Master Mode, CKPH = 0

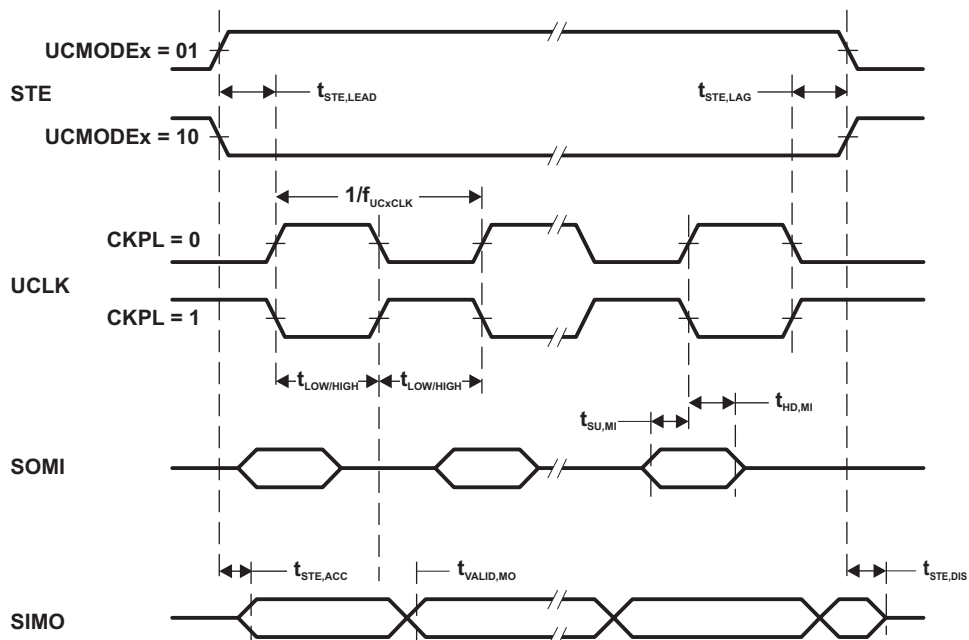


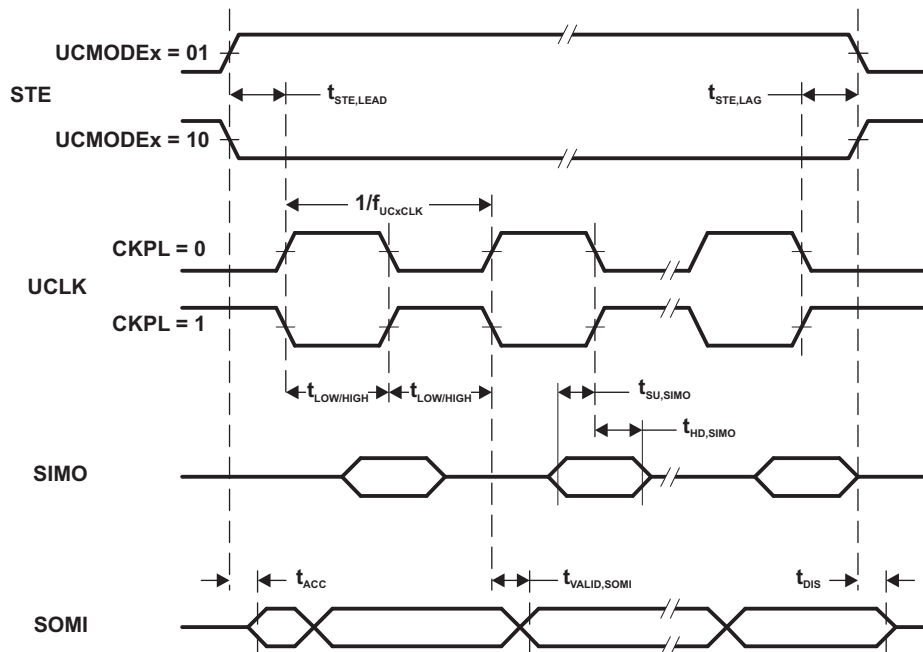
Figure 5-14. SPI Master Mode, CKPH = 1

**Table 5-31. eUSCI (SPI Slave Mode)**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER             |   | TEST CONDITIONS                                 | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|-----------------------|---|---|-----------------|-----|-----|-----|------|
| t <sub>STE,LEAD</sub> | STE lead time, STE active to clock                    |   | 2.0 V           | 4   |     |     | ns   |
|                       |   |   | 3.0 V           | 3   |     |     |      |
| t <sub>STE,LAG</sub>  | STE lag time, Last clock to STE inactive              |   | 2.0 V           | 0   |     |     | ns   |
|                       |   |   | 3.0 V           | 0   |     |     |      |
| t <sub>STE,ACC</sub>  | STE access time, STE active to SOMI data out          |   | 2.0 V           |     |     | 46  | ns   |
|                       |   |   | 3.0 V           |     |     | 24  |      |
| t <sub>STE,DIS</sub>  | STE disable time, STE inactive to SOMI high impedance |   | 2.0 V           |     |     | 38  | ns   |
|                       |   |   | 3.0 V           |     |     | 25  |      |
| t <sub>SU,SI</sub>    | SIMO input data setup time                            |   | 2.0 V           | 2   |     |     | ns   |
|                       |   |   | 3.0 V           | 1   |     |     |      |
| t <sub>HD,SI</sub>    | SIMO input data hold time                             |   | 2.0 V           | 2   |     |     | ns   |
|                       |   |   | 3.0 V           | 2   |     |     |      |
| t <sub>VALID,SO</sub> | SOMI output data valid time <sup>(2)</sup>            | UCLK edge to SOMI valid, C <sub>L</sub> = 20 pF | 2.0 V           |     |     | 55  | ns   |
|                       |   |   | 3.0 V           |     |     | 32  |      |
| t <sub>HD,SO</sub>    | SOMI output data hold time <sup>(3)</sup>             | C <sub>L</sub> = 20 pF                          | 2.0 V           | 24  |     |     | ns   |
|                       |   |   | 3.0 V           | 16  |     |     |      |

- (1)  $f_{UCxCLK} = 1/2t_{LO/HI}$  with  $t_{LO/HI} = \max(t_{VALID,MO(Master)} + t_{SU,SI(eUSCI)}, t_{SU,MI(Master)} + t_{VALID,SO(eUSCI)})$ . For the master's parameters  $t_{SU,MI(Master)}$  and  $t_{VALID,MO(Master)}$  refer to the SPI parameters of the attached slave.
- (2) Specifies the time to drive the next valid data to the SOMI output after the output changing UCLK clock edge. Refer to the timing diagrams in Figure 5-15 and Figure 5-16.
- (3) Specifies how long data on the SOMI output is valid after the output changing UCLK clock edge. Refer to the timing diagrams in Figure 5-15 and Figure 5-16.



**Figure 5-15. SPI Slave Mode, CKPH = 0**

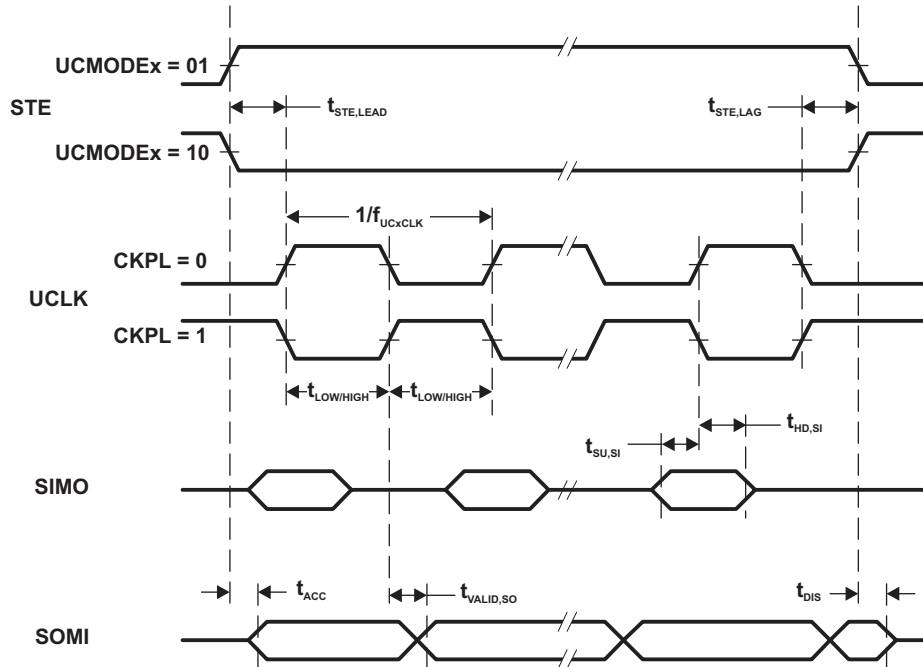
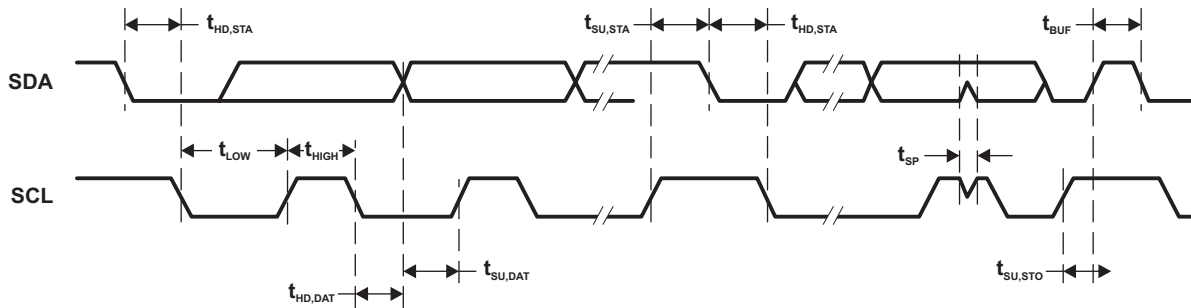


Figure 5-16. SPI Slave Mode, CKPH = 1

**Table 5-32. eUSCI (I2C Mode)**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see [Figure 5-17](#))

| PARAMETER            | TEST CONDITIONS                                     | V <sub>CC</sub>            | MIN         | TYP | MAX                 | UNIT |
|----------------------|---|----------------------------|-------------|-----|---------------------|------|
| f <sub>eUSCI</sub>   | eUSCI input clock frequency                         |                            |             |     | f <sub>SYSTEM</sub> | MHZ  |
| f <sub>SCL</sub>     | SCL clock frequency                                 | 2 V/3 V                    | 0           |     | 400                 | KHZ  |
| t <sub>HD,STA</sub>  | Hold time (repeated) START                          | f <sub>SCL</sub> = 100 kHz | 5.1         |     |                     | μs   |
|                      |   | f <sub>SCL</sub> > 100 kHz | 1.5         |     |                     |      |
| t <sub>SU,STA</sub>  | Setup time for a repeated START                     | f <sub>SCL</sub> = 100 kHz | 5.1         |     |                     | μs   |
|                      |   | f <sub>SCL</sub> > 100 kHz | 1.4         |     |                     |      |
| t <sub>HD,DAT</sub>  | Data hold time                                      | 2 V/3 V                    | 0.4         |     |                     | μs   |
| t <sub>SU,DAT</sub>  | Data setup time                                     | f <sub>SCL</sub> = 100 kHz | 5.0         |     |                     | μs   |
|                      |   | f <sub>SCL</sub> > 100 kHz | 1.3         |     |                     |      |
| t <sub>SU,STO</sub>  | Setup time for STOP                                 | f <sub>SCL</sub> = 100 kHz | 5.2         |     |                     | μs   |
|                      |   | f <sub>SCL</sub> > 100 kHz | 1.7         |     |                     |      |
| t <sub>SP</sub>      | Pulse duration of spikes suppressed by input filter | 2 V/3 V                    | UCGLITx = 0 | 75  | 220                 | ns   |
|                      |   |                            | UCGLITx = 1 | 35  | 120                 | ns   |
|                      |   |                            | UCGLITx = 2 | 30  | 60                  | ns   |
|                      |   |                            | UCGLITx = 3 | 20  | 35                  | ns   |
| t <sub>TIMEOUT</sub> | Clock low timeout                                   | 2 V/3 V                    | UCCLTOx = 1 | 30  |                     | ms   |
|                      |   |                            | UCCLTOx = 2 | 33  |                     | ms   |
|                      |   |                            | UCCLTOx = 3 | 37  |                     | ms   |



**Figure 5-17. I2C Mode Timing**

### 5.8.6 LCD Controller

**Table 5-33. LCD\_C Recommended Operating Conditions**

| PARAMETER                  | CONDITIONS   | MIN  | NOM | MAX       | UNIT   |               |   |
|----------------------------|--|--|-----|-----------|--|---------------|---|
| $V_{CC,LCD\_C,CP\ en,3.6}$ | Supply voltage range, charge pump enabled, $V_{LCD} \leq 3.6\text{ V}$                         | LCDCPEN = 1, $0000 < VLCDx \leq 1111$<br>(charge pump enabled, $V_{LCD} \leq 3.6\text{ V}$ ) |     | 2.2       | 3.6  | V             |   |
| $V_{CC,LCD\_C,CP\ en,3.3}$ | Supply voltage range, charge pump enabled, $V_{LCD} \leq 3.3\text{ V}$                         | LCDCPEN = 1, $0000 < VLCDx \leq 1100$<br>(charge pump enabled, $V_{LCD} \leq 3.3\text{ V}$ ) |     | 2.0       | 3.6  | V             |   |
| $V_{CC,LCD\_C,int.\ bias}$ | Supply voltage range, internal biasing, charge pump disabled                                   | LCDCPEN = 0, VLCDEXT = 0   |     | 2.4       | 3.6  | V             |   |
| $V_{CC,LCD\_C,ext.\ bias}$ | Supply voltage range, external biasing, charge pump disabled                                   | LCDCPEN = 0, VLCDEXT = 0   |     | 2.4       | 3.6  | V             |   |
| $V_{CC,LCD\_C,VLCDEXT}$    | Supply voltage range, external LCD voltage, internal or external biasing, charge pump disabled | LCDCPEN = 0, VLCDEXT = 1   |     | 2.0       | 3.6  | V             |   |
| $V_{LDCAP/R33}$            | External LCD voltage at LDCAP/R33, internal or external biasing, charge pump disabled          | LCDCPEN = 0, VLCDEXT = 1   |     | 2.4       | 3.6  | V             |   |
| $C_{LDCAP}$                | Capacitor on LDCAP when charge pump enabled  | LCDCPEN = 1, $VLCDx > 0000$<br>(charge pump enabled)   |     | 4.7       | 10   | $\mu\text{F}$ |   |
| $f_{Frame}$                | LCD frame frequency range  | $f_{LCD} = 2 \times \text{mux} \times f_{FRAME}$<br>with mux = 1 (static), 2, 3, 4 up to 8   |     | 0         | 100  | Hz            |   |
| $f_{ACLK,in}$              | ACLK input frequency range   | 30   | 32  | 40        |  | kHz           |   |
| $C_{Panel}$                | Panel capacitance  | 100-Hz frame frequency   |     |           | 10000  | pF            |   |
| $V_{R33}$                  | Analog input voltage at R33  | LCDCPEN = 0, VLCDEXT = 1   |     | 2.4       | $V_{CC}+0.2$   | V             |   |
| $V_{R23,1/3bias}$          | Analog input voltage at R23  | LCDREXT = 1, LCDEXTBIAS = 1,<br>LCD2B = 0  |     | $V_{R13}$ | $\frac{V_{R03} + 2/3 \times (V_{R33} - V_{R03})}{V_{R03}}$ | $V_{R33}$     | V |
| $V_{R13,1/3bias}$          | Analog input voltage at R13 with 1/3 biasing   | LCDREXT = 1, LCDEXTBIAS = 1,<br>LCD2B = 0  |     | $V_{R03}$ | $\frac{V_{R03} + 1/3 \times (V_{R33} - V_{R03})}{V_{R03}}$ | $V_{R23}$     | V |
| $V_{R13,1/2bias}$          | Analog input voltage at R13 with 1/2 biasing   | LCDREXT = 1, LCDEXTBIAS = 1,<br>LCD2B = 1  |     | $V_{R03}$ | $\frac{V_{R03} + 1/2 \times (V_{R33} - V_{R03})}{V_{R03}}$ | $V_{R33}$     | V |
| $V_{R03}$                  | Analog input voltage at R03  | R0EXT = 1  |     | $V_{SS}$  |  |               | V |
| $V_{LCD}-V_{R03}$          | Voltage difference between $V_{LCD}$ and R03   | LCDCPEN = 0, R0EXT = 1   |     | 2.4       | $V_{CC}+0.2$   |               | V |
| $V_{LDCREF/R13}$           | External LCD reference voltage applied at LCDREF/R13   | VLCDREFx = 01  |     | 0.8       | 1.2  | 1.5           | V |

**Table 5-34. LCD\_C Electrical Characteristics**

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                 |  | TEST CONDITIONS                                       | V <sub>CC</sub> | MIN | TYP             | MAX | UNIT |
|---------------------------|--|---|-----------------|-----|-----------------|-----|------|
| V <sub>LCD</sub>          | LCD voltage  | VLCDx = 0000, VLCDEXT = 0                             | 2.4 V to 3.6 V  |     | V <sub>CC</sub> |     | V    |
|                           |  | LCDCPEN = 1, VLCDx = 0001                             | 2 V to 3.6 V    |     | 2.58            |     |      |
|                           |  | LCDCPEN = 1, VLCDx = 0010                             | 2 V to 3.6 V    |     | 2.64            |     |      |
|                           |  | LCDCPEN = 1, VLCDx = 0011                             | 2 V to 3.6 V    |     | 2.71            |     |      |
|                           |  | LCDCPEN = 1, VLCDx = 0100                             | 2 V to 3.6 V    |     | 2.78            |     |      |
|                           |  | LCDCPEN = 1, VLCDx = 0101                             | 2 V to 3.6 V    |     | 2.83            |     |      |
|                           |  | LCDCPEN = 1, VLCDx = 0110                             | 2 V to 3.6 V    |     | 2.90            |     |      |
|                           |  | LCDCPEN = 1, VLCDx = 0111                             | 2 V to 3.6 V    |     | 2.96            |     |      |
|                           |  | LCDCPEN = 1, VLCDx = 1000                             | 2 V to 3.6 V    |     | 3.02            |     |      |
|                           |  | LCDCPEN = 1, VLCDx = 1001                             | 2 V to 3.6 V    |     | 3.07            |     |      |
|                           |  | LCDCPEN = 1, VLCDx = 1010                             | 2 V to 3.6 V    |     | 3.14            |     |      |
|                           |  | LCDCPEN = 1, VLCDx = 1011                             | 2 V to 3.6 V    |     | 3.21            |     |      |
|                           |  | LCDCPEN = 1, VLCDx = 1100                             | 2 V to 3.6 V    |     | 3.27            |     |      |
|                           |  | LCDCPEN = 1, VLCDx = 1101                             | 2.2 V to 3.6 V  |     | 3.32            |     |      |
|                           |  | LCDCPEN = 1, VLCDx = 1110                             | 2.2 V to 3.6 V  |     | 3.38            |     |      |
| LCDCPEN = 1, VLCDx = 1111 | 2.2 V to 3.6 V                                     |   | 3.44            | 3.6 |                 |     |      |
| I <sub>CC,Peak,CP</sub>   | Peak supply currents due to charge pump activities | LCDCPEN = 1, VLCDx = 1111                             | 2.2 V           |     | 400             |     | μA   |
| t <sub>LCD,CP,on</sub>    | Time to charge C <sub>LCD</sub> when discharged    | C <sub>LCD</sub> = 4.7μF, LCDCPEN = 0→1, VLCDx = 1111 | 2.2 V           |     | 150             | 500 | ms   |
| I <sub>CP,Load</sub>      | Maximum charge pump load current                   | LCDCPEN = 1, VLCDx = 1111                             | 2.2 V           | 50  |                 |     | μA   |
| R <sub>LCD,Seg</sub>      | LCD driver output impedance, segment lines         | LCDCPEN = 1, VLCDx = 1000, I <sub>LOAD</sub> = ±10μA  | 2.2 V           |     |                 | 10  | kΩ   |
| R <sub>LCD,COM</sub>      | LCD driver output impedance, common lines          | LCDCPEN = 1, VLCDx = 1000, I <sub>LOAD</sub> = ±10μA  | 2.2 V           |     |                 | 10  | kΩ   |

**5.8.7 SD24**
**Table 5-35. SD24\_B Power Supply and Recommended Operating Conditions**

|             |   |  | MIN                  | TYP       | MAX             | UNIT |
|-------------|---|--|----------------------|-----------|-----------------|------|
| $V_{CC}$    | Analog supply voltage   | $V_{CC} = DV_{CC}$ , $V_{SS} = DV_{SS} = 0\text{ V}$ | 2.4                  |           | 3.6             | V    |
| $f_{SD}$    | Modulator clock frequency <sup>(1)</sup>                            |  | 0.03                 |           | 2.3             | MHz  |
| $V_I$       | Absolute input voltage range  |  | $V_{SS} - 1\text{V}$ |           | $V_{CC}$        | V    |
| $V_{IC}$    | Common-mode input voltage range                                     |  | $V_{SS} - 1\text{V}$ |           | $V_{CC}$        | V    |
| $V_{ID,FS}$ | Differential full scale input voltage                               | $V_{ID} = V_{I,A+} - V_{I,A-}$                       | $-V_{REF}/GAIN$      |           | $+V_{REF}/GAIN$ |      |
| $V_{ID}$    | Differential input voltage for specified performance <sup>(2)</sup> | $SD24REFS = 1$                                       | $SD24GAINx = 1$      | $\pm 910$ | $\pm 920$       | mV   |
|             |   |  | $SD24GAINx = 2$      | $\pm 455$ | $\pm 460$       |      |
|             |   |  | $SD24GAINx = 4$      | $\pm 227$ | $\pm 230$       |      |
|             |   |  | $SD24GAINx = 8$      | $\pm 113$ | $\pm 115$       |      |
|             |   |  | $SD24GAINx = 16$     | $\pm 57$  | $\pm 58$        |      |
|             |   |  | $SD24GAINx = 32$     | $\pm 28$  | $\pm 29$        |      |
|             |   |  | $SD24GAINx = 64$     | $\pm 14$  | $\pm 14.5$      |      |
|             |   | $SD24GAINx = 128$                                    | $\pm 7$              | $\pm 7.2$ |                 |      |
| $C_{REF}$   | VREF load capacitance <sup>(3)</sup>                                | $SD24REFS = 1$                                       |                      | 100       |                 | nF   |

(1) Modulator clock frequency: MIN = 32.768 kHz - 10%  $\approx$  30 kHz. MAX = 32.768 kHz  $\times$  64 + 10%  $\approx$  2.3 MHz

(2) The full-scale range (FSR) is defined by  $V_{FS+} = +V_{REF}/GAIN$  and  $V_{FS-} = -V_{REF}/GAIN$ :  $FSR = V_{FS+} - V_{FS-} = 2 \times V_{REF}/GAIN$ . If  $V_{REF}$  is sourced externally, the analog input range should not exceed 80% of  $V_{FS+}$  or  $V_{FS-}$ ; that is,  $V_{ID} = 0.8 V_{FS-}$  to  $0.8 V_{FS+}$ . If  $V_{REF}$  is sourced internally, the given  $V_{ID}$  ranges apply.

(3) There is no capacitance required on VREF. However, a capacitance of 100 nF is recommended to reduce any reference voltage noise.

**Table 5-36. SD24\_B Analog Input <sup>(1)</sup>**

| PARAMETER | TEST CONDITIONS                                    | $V_{CC}$                 | MIN | TYP | MAX | UNIT       |                  |     |     |
|-----------|--|--------------------------|-----|-----|-----|------------|------------------|-----|-----|
| $C_I$     | Input capacitance                                  |                          |     |     |     | pF         |                  |     |     |
|           |  |                          |     |     |     |            | $SD24GAINx = 1$  | 5   |     |
|           |  |                          |     |     |     |            | $SD24GAINx = 2$  | 5   |     |
|           |  |                          |     |     |     |            | $SD24GAINx = 4$  | 5   |     |
|           |  |                          |     |     |     |            | $SD24GAINx = 8$  | 5   |     |
|           |  |                          |     |     |     |            | $SD24GAINx = 16$ | 5   |     |
|           | $SD24GAINx = 32, 64, 128$                          | 5                        |     |     |     |            |                  |     |     |
| $Z_I$     | Input impedance<br>(Pin A+ or A- to $V_{SS}$ )     | $f_{SD24} = 1\text{MHz}$ | 3 V |     |     | k $\Omega$ |                  |     |     |
|           |  |                          |     |     |     |            | $SD24GAINx = 1$  | 200 |     |
|           |  |                          |     |     |     |            | $SD24GAINx = 8$  | 200 |     |
|           | $SD24GAINx = 32$                                   | 200                      |     |     |     |            |                  |     |     |
| $Z_{ID}$  | Differential input impedance<br>(Pin A+ to pin A-) | $f_{SD24} = 1\text{MHz}$ | 3 V |     |     | k $\Omega$ |                  |     |     |
|           |  |                          |     |     |     |            | $SD24GAINx = 1$  | 300 | 400 |
|           |  |                          |     |     |     |            | $SD24GAINx = 8$  | 400 |     |
|           | $SD24GAINx = 32$                                   | 300                      | 400 |     |     |            |                  |     |     |

(1) All parameters pertain to each SD24\_B converter.

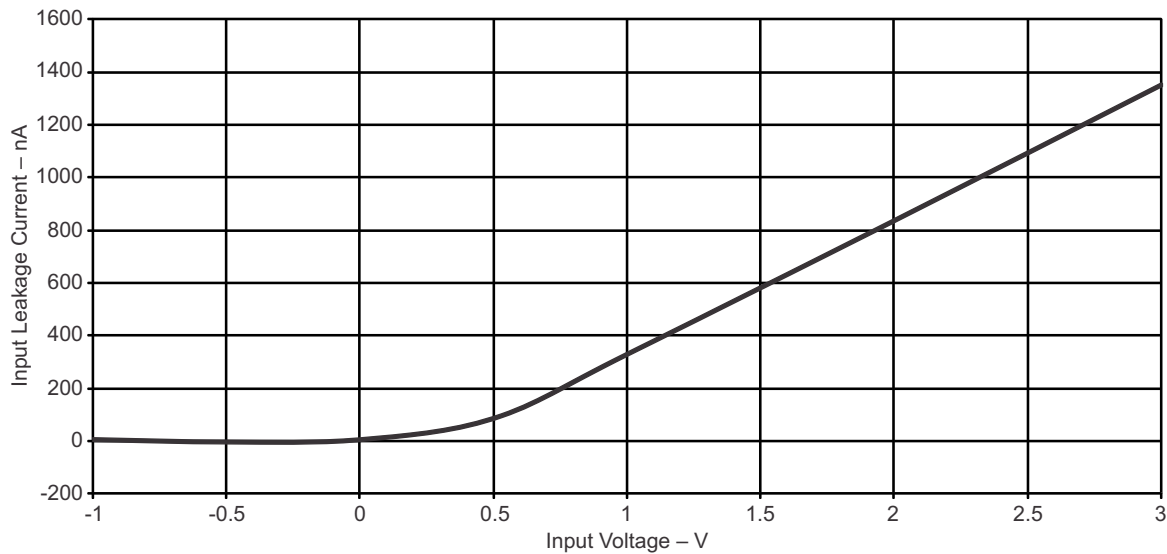


Figure 5-18. Input Leakage Current vs Input Voltage (Modulator OFF)

Table 5-37. SD24\_B Supply Currents

| PARAMETER   | TEST CONDITIONS                          | V <sub>CC</sub> | MIN | TYP | MAX  | UNIT |
|---|--|-----------------|-----|-----|------|------|
| I <sub>SD,256</sub> Analog plus digital supply current per converter (reference not included) | f <sub>SD24</sub> = 1 MHz, SD24OSR = 256 | SD24GAIN: 1     | 3 V | 600 | 675  | μA   |
|   |  | SD24GAIN: 2     | 3 V | 600 | 675  |      |
|   |  | SD24GAIN: 4     | 3 V | 600 | 675  |      |
|   |  | SD24GAIN: 8     | 3 V | 700 | 750  |      |
|   |  | SD24GAIN: 16    | 3 V | 700 | 750  |      |
|   |  | SD24GAIN: 32    | 3 V | 775 | 850  |      |
|   |  | SD24GAIN: 64    | 3 V | 775 | 850  |      |
| I <sub>SD,512</sub> Analog plus digital supply current per converter (reference not included) | f <sub>SD24</sub> = 2 MHz, SD24OSR = 512 | SD24GAIN: 1     | 3 V | 750 | 800  | μA   |
|   |  | SD24GAIN: 8     | 3 V | 825 | 900  |      |
|   |  | SD24GAIN: 32    | 3 V | 900 | 1000 |      |

Table 5-38. SD24\_B Performance

f<sub>SD24</sub> = 1 MHz, SD24OSRx = 256, SD24REFS = 1

| PARAMETER                                | TEST CONDITIONS | V <sub>CC</sub> | MIN   | TYP  | MAX  | UNIT     |
|--|-----------------|-----------------|-------|------|------|----------|
| INL Integral nonlinearity, end-point fit | SD24GAIN: 1     | 3 V             | -0.01 |      | 0.01 | % of FSR |
|  | SD24GAIN: 8     | 3 V             | -0.01 |      | 0.01 |          |
|  | SD24GAIN: 32    | 3 V             | -0.01 |      | 0.01 |          |
| G <sub>nom</sub> Nominal gain            | SD24GAIN: 1     | 3 V             |       | 1    |      |          |
|  | SD24GAIN: 2     | 3 V             |       | 2    |      |          |
|  | SD24GAIN: 4     | 3 V             |       | 4    |      |          |
|  | SD24GAIN: 8     | 3 V             |       | 8    |      |          |
|  | SD24GAIN: 16    | 3 V             |       | 16   |      |          |
|  | SD24GAIN: 32    | 3 V             |       | 31.7 |      |          |
|  | SD24GAIN: 64    | 3 V             |       | 63.4 |      |          |
| SD24GAIN: 128                            | 3 V             |                 | 126.8 |      |      |          |



**SD24\_B Performance (continued)**
 $f_{SD24} = 1 \text{ MHz}$ ,  $SD24OSRx = 256$ ,  $SD24REFS = 1$ 

| PARAMETER                          |  | TEST CONDITIONS                               | V <sub>CC</sub> | MIN  | TYP  | MAX  | UNIT   |
|------------------------------------|--|---|-----------------|------|------|------|--------|
| E <sub>G</sub>                     | Gain error <sup>(1)</sup>  | SD24GAIN: 1, with external reference (1.2 V)  | 3 V             | -1   |      | +1   | %      |
|                                    |  | SD24GAIN: 8, with external reference (1.2 V)  | 3 V             | -2   |      | +2   |        |
|                                    |  | SD24GAIN: 32, with external reference (1.2 V) | 3 V             | -2   |      | +2   |        |
| ΔE <sub>G</sub> /ΔT                | Gain error temperature coefficient <sup>(2)</sup> , internal reference | SD24GAIN: 1/8/32 (with internal reference)    | 3 V             |      |      | 50   | ppm/°C |
| ΔE <sub>G</sub> /ΔV <sub>CC</sub>  | Gain error vs V <sub>CC</sub> <sup>(3)</sup>                           | SD24GAIN: 1                                   |                 |      | 0.15 |      | %/V    |
|                                    |  | SD24GAIN: 8                                   |                 |      | 0.15 |      |        |
|                                    |  | SD24GAIN: 32                                  |                 |      | 0.4  |      |        |
| E <sub>OS</sub> [V]                | Offset error <sup>(4)</sup>  | SD24GAIN: 1 (with V <sub>diff</sub> = 0 V)    | 3 V             |      |      | 2.3  | mV     |
|                                    |  | SD24GAIN: 8                                   | 3 V             |      |      | 0.73 |        |
|                                    |  | SD24GAIN: 32                                  | 3 V             |      |      | 0.18 |        |
| E <sub>OS</sub> [FS]               | Offset error <sup>(4)</sup>  | SD24GAIN: 1 (with V <sub>diff</sub> = 0 V)    | 3 V             | -0.2 |      | 0.2  | % FS   |
|                                    |  | SD24GAIN: 8                                   | 3 V             | -0.5 |      | 0.5  |        |
|                                    |  | SD24GAIN: 32                                  | 3 V             | -0.5 |      | 0.5  |        |
| ΔE <sub>OS</sub> /ΔT               | Offset error temperature coefficient <sup>(5)</sup>                    | SD24GAIN: 1                                   | 3 V             |      | 1    |      | μV/°C  |
|                                    |  | SD24GAIN: 8                                   | 3 V             |      | 0.15 |      |        |
|                                    |  | SD24GAIN: 32                                  | 3 V             |      | 0.1  |      |        |
| ΔE <sub>OS</sub> /ΔV <sub>CC</sub> | Offset error vs V <sub>CC</sub> <sup>(6)</sup>                         | SD24GAIN: 1                                   |                 |      | 600  |      | μV/V   |
|                                    |  | SD24GAIN: 8                                   |                 |      | 100  |      |        |
|                                    |  | SD24GAIN: 32                                  |                 |      | 50   |      |        |
| CMRR,DC                            | Common mode rejection at DC <sup>(7)</sup>                             | SD24GAIN: 1                                   | 3 V             |      |      | -110 | dB     |
|                                    |  | SD24GAIN: 8                                   | 3 V             |      |      | -110 |        |
|                                    |  | SD24GAIN: 32                                  | 3 V             |      |      | -110 |        |

- The gain error E<sub>G</sub> specifies the deviation of the actual gain G<sub>act</sub> from the nominal gain G<sub>nom</sub>:  $E_G = (G_{act} - G_{nom})/G_{nom}$ . It covers process, temperature and supply voltage variations.
- The gain error temperature coefficient ΔE<sub>G</sub>/ΔT specifies the variation of the gain error E<sub>G</sub> over temperature ( $E_G(T) = (G_{act}(T) - G_{nom})/G_{nom}$ ) using the box method (that is, MIN and MAX values):  
 $\Delta E_G / \Delta T = (\text{MAX}(E_G(T)) - \text{MIN}(E_G(T))) / (\text{MAX}(T) - \text{MIN}(T)) = (\text{MAX}(G_{act}(T)) - \text{MIN}(G_{act}(T))) / G_{nom} / (\text{MAX}(T) - \text{MIN}(T))$   
with T ranging from -40°C to +85°C.
- The gain error vs V<sub>CC</sub> coefficient ΔE<sub>G</sub>/ΔV<sub>CC</sub> specifies the variation of the gain error E<sub>G</sub> over supply voltage ( $E_G(V_{CC}) = (G_{act}(V_{CC}) - G_{nom})/G_{nom}$ ) using the box method (that is, MIN and MAX values):  
 $\Delta E_G / \Delta V_{CC} = (\text{MAX}(E_G(V_{CC})) - \text{MIN}(E_G(V_{CC}))) / (\text{MAX}(V_{CC}) - \text{MIN}(V_{CC})) = (\text{MAX}(G_{act}(V_{CC})) - \text{MIN}(G_{act}(V_{CC}))) / G_{nom} / (\text{MAX}(V_{CC}) - \text{MIN}(V_{CC}))$   
with V<sub>CC</sub> ranging from 2.4V to 3.6V.
- The offset error E<sub>OS</sub> is measured with shorted inputs in 2s complement mode with +100% FS = V<sub>REF</sub>/G and -100% FS = -V<sub>REF</sub>/G. Conversion between E<sub>OS</sub> [FS] and E<sub>OS</sub> [V] is as follows: E<sub>OS</sub> [FS] = E<sub>OS</sub> [V] × G/V<sub>REF</sub>; E<sub>OS</sub> [V] = E<sub>OS</sub> [FS] × V<sub>REF</sub>/G.
- The offset error temperature coefficient ΔE<sub>OS</sub>/ΔT specifies the variation of the offset error E<sub>OS</sub> over temperature using the box method (that is, MIN and MAX values):  
 $\Delta E_{OS} / \Delta T = (\text{MAX}(E_{OS}(T)) - \text{MIN}(E_{OS}(T))) / (\text{MAX}(T) - \text{MIN}(T))$   
with T ranging from -40°C to +85°C.
- The offset error vs V<sub>CC</sub> ΔE<sub>OS</sub>/ΔV<sub>CC</sub> specifies the variation of the offset error E<sub>OS</sub> over supply voltage using the box method (that is, MIN and MAX values):  
 $\Delta E_{OS} / \Delta V_{CC} = (\text{MAX}(E_{OS}(V_{CC})) - \text{MIN}(E_{OS}(V_{CC}))) / (\text{MAX}(V_{CC}) - \text{MIN}(V_{CC}))$   
with V<sub>CC</sub> ranging from 2.4 V to 3.6 V.
- The DC CMRR specifies the change in the measured differential input voltage value when the common mode voltage varies:  
DC CMRR = -20log(Δ<sub>MAX</sub>/FSR) with Δ<sub>MAX</sub> being the difference between the minimum value and the maximum value measured when sweeping the common mode voltage (for example, calculating with 16-bits FSR = 65536 a maximum change by 1 LSB results in -20log(1/65536) ≈ -96 dB).  
The DC CMRR is measured with both inputs connected to the common mode voltage (that is, no differential input signal is applied), and the common mode voltage is swept from -1 V to V<sub>CC</sub>.

## SD24\_B Performance (continued)

 $f_{SD24} = 1 \text{ MHz}$ ,  $SD24OSRx = 256$ ,  $SD24REFS = 1$ 

| PARAMETER   |  | TEST CONDITIONS  | V <sub>CC</sub> | MIN | TYP  | MAX | UNIT |
|-------------|--|--|-----------------|-----|------|-----|------|
| CMRR,50Hz   | Common mode rejection at 50 Hz <sup>(8)</sup>                      | SD24GAIN: 1, $f_{CM} = 50 \text{ Hz}$ , $V_{CM} = 930 \text{ mV}$  | 3 V             |     | -110 |     | dB   |
|             |  | SD24GAIN: 8, $f_{CM} = 50 \text{ Hz}$ , $V_{CM} = 120 \text{ mV}$  | 3 V             |     | -110 |     |      |
|             |  | SD24GAIN: 32, $f_{CM} = 50 \text{ Hz}$ , $V_{CM} = 30 \text{ mV}$  | 3 V             |     | -110 |     |      |
| AC PSRR,ext | AC power supply rejection ratio, external reference <sup>(9)</sup> | SD24GAIN: 1, $V_{CC} = 3 \text{ V} + 50 \text{ mV} \times \sin(2\pi \times f_{VCC} \times t)$ , $f_{VCC} = 50 \text{ Hz}$                              |                 |     | -61  |     | dB   |
|             |  | SD24GAIN: 8, $V_{CC} = 3 \text{ V} + 50 \text{ mV} \times \sin(2\pi \times f_{VCC} \times t)$ , $f_{VCC} = 50 \text{ Hz}$                              |                 |     | -77  |     |      |
|             |  | SD24GAIN: 32, $V_{CC} = 3 \text{ V} + 50 \text{ mV} \times \sin(2\pi \times f_{VCC} \times t)$ , $f_{VCC} = 50 \text{ Hz}$                             |                 |     | -79  |     |      |
| AC PSRR,int | AC power supply rejection ratio, internal reference <sup>(9)</sup> | SD24GAIN: 1, $V_{CC} = 3 \text{ V} + 50 \text{ mV} \times \sin(2\pi \times f_{VCC} \times t)$ , $f_{VCC} = 50 \text{ Hz}$                              |                 |     | -61  |     | dB   |
|             |  | SD24GAIN: 8, $V_{CC} = 3 \text{ V} + 50 \text{ mV} \times \sin(2\pi \times f_{VCC} \times t)$ , $f_{VCC} = 50 \text{ Hz}$                              |                 |     | -77  |     |      |
|             |  | SD24GAIN: 32, $V_{CC} = 3 \text{ V} + 50 \text{ mV} \times \sin(2\pi \times f_{VCC} \times t)$ , $f_{VCC} = 50 \text{ Hz}$                             |                 |     | -79  |     |      |
| XT          | Crosstalk between converters <sup>(10)</sup>                       | Crosstalk source: SD24GAIN: 1, Sine wave with maximum possible V <sub>pp</sub> , $f_{IN} = 50 \text{ Hz}$ , 100 Hz, Converter under test: SD24GAIN: 1  | 3 V             |     | -120 |     | dB   |
|             |  | Crosstalk source: SD24GAIN: 1, Sine wave with maximum possible V <sub>pp</sub> , $f_{IN} = 50 \text{ Hz}$ , 100 Hz, Converter under test: SD24GAIN: 8  | 3 V             |     | -115 |     |      |
|             |  | Crosstalk source: SD24GAIN: 1, Sine wave with maximum possible V <sub>pp</sub> , $f_{IN} = 50 \text{ Hz}$ , 100 Hz, Converter under test: SD24GAIN: 32 | 3 V             |     | -100 |     |      |

(8) The AC CMRR is the difference between a hypothetical signal with the amplitude and frequency of the applied common mode ripple applied to the inputs of the ADC and the actual common mode signal spur visible in the FFT spectrum:  
 $AC \text{ CMRR} = \text{Error Spur [dBFS]} - 20\log(V_{CM}/1.2V/G) \text{ [dBFS]}$  with a common mode signal of  $V_{CM} \times \sin(2\pi \times f_{CM} \times t)$  applied to the analog inputs.

The AC CMRR is measured with the both inputs connected to the common mode signal (that is, no differential input signal is applied). With the specified typical values the error spur is within the noise floor (as specified by the SINAD values).

(9) The AC PSRR is the difference between a hypothetical signal with the amplitude and frequency of the applied supply voltage ripple applied to the inputs of the ADC and the actual supply ripple spur visible in the FFT spectrum:

$AC \text{ PSRR} = \text{Error Spur [dBFS]} - 20\log(50 \text{ mV} / 1.2 \text{ V} / G) \text{ [dBFS]}$  with a signal of  $50 \text{ mV} \times \sin(2\pi \times f_{VCC} \times t)$  added to  $V_{CC}$ .

The AC PSRR is measured with the inputs grounded (that is, no analog input signal is applied).

With the specified typical values the error spur is within the noise floor (as specified by the SINAD values).

SD24GAIN: 1 → Hypothetical signal:  $20\log(50 \text{ mV} / 1.2 \text{ V} / 1) = -27.6 \text{ dBFS}$

SD24GAIN: 8 → Hypothetical signal:  $20\log(50 \text{ mV} / 1.2 \text{ V} / 8) = -9.5 \text{ dBFS}$

SD24GAIN: 32 → Hypothetical signal:  $20\log(50 \text{ mV} / 1.2 \text{ V} / 32) = 2.5 \text{ dBFS}$

(10) The crosstalk (XT) is specified as the tone level of the signal applied to the crosstalk source seen in the spectrum of the converter under test. It is measured with the inputs of the converter under test being grounded.

**Table 5-39. SD24\_B AC Performance**
 $f_{SD24} = 1\text{MHz}$ ,  $SD24OSRx = 256$ ,  $SD24REFS = 1$ 

| PARAMETER |                                    | TEST CONDITIONS | V <sub>CC</sub>               | MIN | TYP | MAX | UNIT |
|-----------|------------------------------------|-----------------|-------------------------------|-----|-----|-----|------|
| SINAD     | Signal-to-noise + distortion ratio | SD24GAIN: 1     | $f_{IN} = 50\text{ Hz}^{(1)}$ | 3 V | 85  | 87  | dB   |
|           |                                    | SD24GAIN: 2     |                               |     | 86  |     |      |
|           |                                    | SD24GAIN: 4     |                               |     | 85  |     |      |
|           |                                    | SD24GAIN: 8     |                               |     | 82  | 84  |      |
|           |                                    | SD24GAIN: 16    |                               |     | 80  |     |      |
|           |                                    | SD24GAIN: 32    |                               |     | 73  | 74  |      |
|           |                                    | SD24GAIN: 64    |                               |     | 68  |     |      |
|           |                                    | SD24GAIN: 128   |                               |     | 62  |     |      |
| THD       | Total harmonic distortion          | SD24GAIN: 1     | $f_{IN} = 50\text{ Hz}^{(1)}$ | 3 V | 100 |     | dB   |
|           |                                    | SD24GAIN: 8     |                               |     | 90  |     |      |
|           |                                    | SD24GAIN: 32    |                               |     | 80  |     |      |

(1) The following voltages were applied to the SD24\_B inputs:

$$V_{I,A+}(t) = 0\text{ V} + V_{PP}/2 \times \sin(2\pi \times f_{IN} \times t)$$

$$V_{I,A-}(t) = 0\text{ V} - V_{PP}/2 \times \sin(2\pi \times f_{IN} \times t)$$

resulting in a differential voltage of  $V_{ID} = V_{I,A+}(t) - V_{I,A-}(t) = V_{PP} \times \sin(2\pi \times f_{IN} \times t)$  with  $V_{PP}$  being selected as the maximum value allowed for a given range (according to SD24\_B recommended operating conditions).

**Table 5-40. SD24\_B AC Performance**
 $f_{SD24} = 2\text{MHz}$ ,  $SD24OSRx = 512$ ,  $SD24REFS = 1$ 

| PARAMETER |                                    | TEST CONDITIONS | V <sub>CC</sub>               | MIN | TYP | MAX | UNIT |
|-----------|------------------------------------|-----------------|-------------------------------|-----|-----|-----|------|
| SINAD     | Signal-to-noise + distortion ratio | SD24GAIN: 1     | $f_{IN} = 50\text{ Hz}^{(1)}$ | 3 V | 87  |     | dB   |
|           |                                    | SD24GAIN: 2     |                               |     | 86  |     |      |
|           |                                    | SD24GAIN: 4     |                               |     | 85  |     |      |
|           |                                    | SD24GAIN: 8     |                               |     | 84  |     |      |
|           |                                    | SD24GAIN: 16    |                               |     | 81  |     |      |
|           |                                    | SD24GAIN: 32    |                               |     | 76  |     |      |
|           |                                    | SD24GAIN: 64    |                               |     | 71  |     |      |
|           |                                    | SD24GAIN: 128   |                               |     | 65  |     |      |

(1) The following voltages were applied to the SD24\_B inputs:

$$V_{I,A+}(t) = 0\text{ V} + V_{PP}/2 \times \sin(2\pi \times f_{IN} \times t)$$

$$V_{I,A-}(t) = 0\text{ V} - V_{PP}/2 \times \sin(2\pi \times f_{IN} \times t)$$

resulting in a differential voltage of  $V_{ID} = V_{I,A+}(t) - V_{I,A-}(t) = V_{PP} \times \sin(2\pi \times f_{IN} \times t)$  with  $V_{PP}$  being selected as the maximum value allowed for a given range (according to SD24\_B recommended operating conditions).

**Table 5-41. SD24\_B AC Performance**
 $f_{SD24} = 32\text{ kHz}$ ,  $SD24OSRx = 512$ ,  $SD24REFS = 1$ 

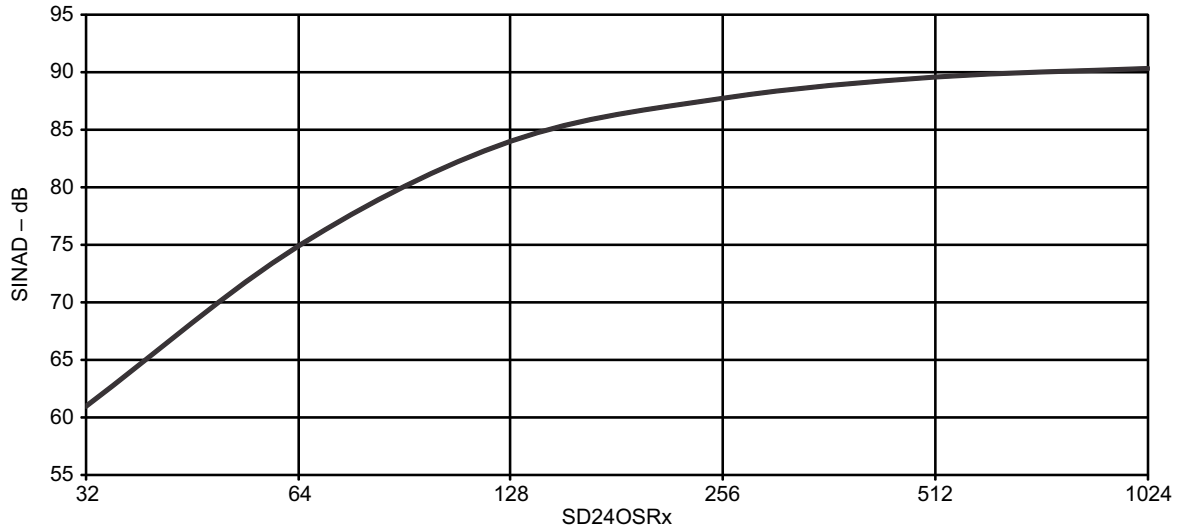
| PARAMETER |                                    | TEST CONDITIONS | V <sub>CC</sub>               | MIN | TYP | MAX | UNIT |
|-----------|------------------------------------|-----------------|-------------------------------|-----|-----|-----|------|
| SINAD     | Signal-to-noise + distortion ratio | SD24GAIN: 1     | $f_{IN} = 12\text{ Hz}^{(1)}$ | 3 V | 89  |     | dB   |
|           |                                    | SD24GAIN: 2     |                               |     | 85  |     |      |
|           |                                    | SD24GAIN: 4     |                               |     | 84  |     |      |
|           |                                    | SD24GAIN: 8     |                               |     | 86  |     |      |
|           |                                    | SD24GAIN: 16    |                               |     | 80  |     |      |
|           |                                    | SD24GAIN: 32    |                               |     | 76  |     |      |
|           |                                    | SD24GAIN: 64    |                               |     | 67  |     |      |
|           |                                    | SD24GAIN: 128   |                               |     | 61  |     |      |

(1) The following voltages were applied to the SD24\_B inputs:

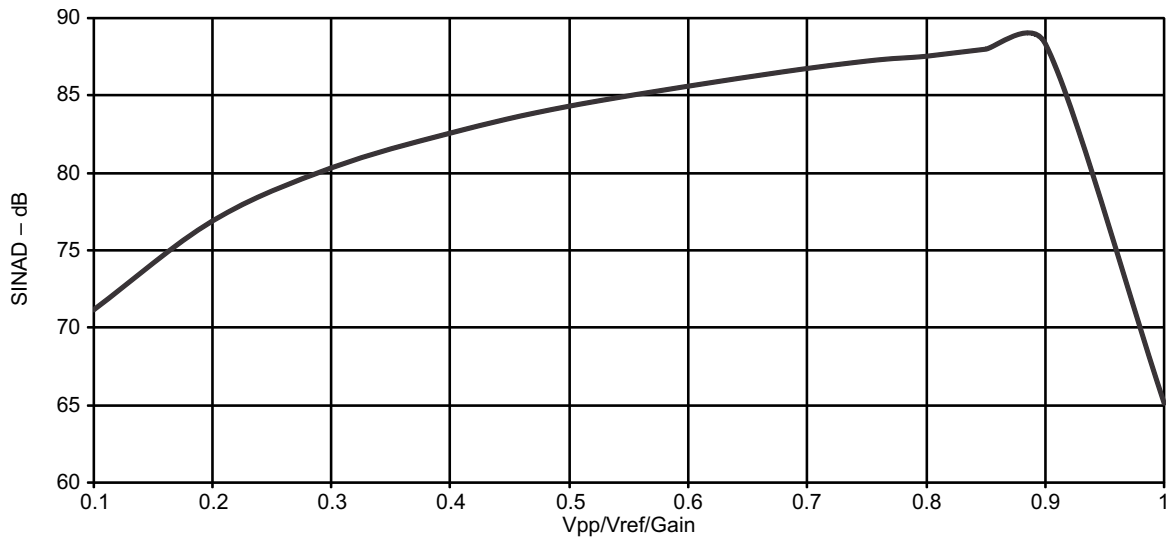
$$V_{I,A+}(t) = 0\text{ V} + V_{PP}/2 \times \sin(2\pi \times f_{IN} \times t)$$

$$V_{I,A-}(t) = 0\text{ V} - V_{PP}/2 \times \sin(2\pi \times f_{IN} \times t)$$

resulting in a differential voltage of  $V_{ID} = V_{I,A+}(t) - V_{I,A-}(t) = V_{PP} \times \sin(2\pi \times f_{IN} \times t)$  with  $V_{PP}$  being selected as the maximum value allowed for a given range (according to SD24\_B recommended operating conditions).



**Figure 5-19. SINAD vs OSR**  
 ( $f_{SD24} = 1 \text{ MHz}$ ,  $SD24REFS = 1$ ,  $SD24GAIN = 1$ )



**Figure 5-20. SINAD vs V<sub>pp</sub>**

**Table 5-42. SD24\_B External Reference Input**

ensure correct input voltage range according to  $V_{REF}$

| PARAMETER                  | TEST CONDITIONS | V <sub>CC</sub> | MIN | TYP  | MAX | UNIT |
|----------------------------|-----------------|-----------------|-----|------|-----|------|
| $V_{REF(I)}$ Input voltage | SD24REFS = 0    | 3 V             | 1.0 | 1.20 | 1.5 | V    |
| $I_{REF(I)}$ Input current | SD24REFS = 0    | 3 V             |     |      | 50  | nA   |

## 5.8.8 ADC10\_A

**Table 5-43. 10-Bit ADC, Power Supply and Input Range Conditions**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER   |   | TEST CONDITIONS   | V <sub>CC</sub> | MIN | TYP | MAX              | UNIT |
|---|---|---|-----------------|-----|-----|------------------|------|
| AV <sub>CC</sub>  | Analog supply voltage   | AV <sub>CC</sub> and DV <sub>CC</sub> are connected together, AV <sub>SS</sub> and DV <sub>SS</sub> are connected together, V <sub>(AVSS)</sub> = V <sub>(DVSS)</sub> = 0 V |                 | 1.8 |     | 3.6              | V    |
| V <sub>(Ax)</sub>   | Analog input voltage range <sup>(1)</sup>   | All ADC10_A pins  |                 | 0   |     | AV <sub>CC</sub> | V    |
| I <sub>ADC10_A</sub>  | Operating supply current into AV <sub>CC</sub> terminal, REF module and reference buffer off                                      | f <sub>ADC10CLK</sub> = 5 MHz, ADC10ON = 1, REFON = 0, SHT0 = 0, SHT1 = 0, ADC10DIV = 0, ADC10SREF = 00   | 2.2 V           |     | 70  | 105              | μA   |
|   |   |   | 3 V             |     | 80  | 115              |      |
|   | Operating supply current into AV <sub>CC</sub> terminal, REF module on, reference buffer on                                       | f <sub>ADC10CLK</sub> = 5 MHz, ADC10ON = 1, REFON = 1, SHT0 = 0, SHT1 = 0, ADC10DIV = 0, ADC10SREF = 01   | 3 V             |     | 130 | 185              | μA   |
|   |   | f <sub>ADC10CLK</sub> = 5 MHz, ADC10ON = 1, REFON = 0, SHT0 = 0, SHT1 = 0, ADC10DIV = 0, ADC10SREF = 10, V <sub>REF</sub> = 2.5 V   | 3 V             |     | 108 | 160              | μA   |
| Operating supply current into AV <sub>CC</sub> terminal, REF module off, reference buffer off | f <sub>ADC10CLK</sub> = 5 MHz, ADC10ON = 1, REFON = 0, SHT0 = 0, SHT1 = 0, ADC10DIV = 0, ADC10SREF = 11, V <sub>REF</sub> = 2.5 V | 3 V   |                 | 74  | 105 | μA               |      |
| C <sub>I</sub>  | Input capacitance   | Only one terminal Ax can be selected at one time from the pad to the ADC10_A capacitor array including wiring and pad.  | 2.2 V           |     | 3.5 |                  | pF   |
| R <sub>I</sub>  | Input MUX ON resistance   | AV <sub>CC</sub> > 2 V, 0 V ≤ V <sub>Ax</sub> ≤ AV <sub>CC</sub>  |                 |     |     | 36               | kΩ   |
|   |   | 1.8 V < AV <sub>CC</sub> < 2 V, 0 V ≤ V <sub>Ax</sub> ≤ AV <sub>CC</sub>  |                 |     |     | 96               |      |

- (1) The analog input voltage range must be within the selected reference voltage range V<sub>R+</sub> to V<sub>R-</sub> for valid conversion results. The external reference voltage requires decoupling capacitors. Two decoupling capacitors, 10 μF and 100 nF, should be connected to V<sub>REF</sub> to decouple the dynamic current required for an external reference source if it is used for the ADC10\_A. Also see the *MSP430x5xx and MSP430x6xx Family User's Guide* ([SLAU208](#)).

**Table 5-44. 10-Bit ADC, Timing Parameters**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER             |  | TEST CONDITIONS   | V <sub>CC</sub> | MIN  | TYP | MAX | UNIT |
|-----------------------|--|---|-----------------|------|-----|-----|------|
| f <sub>ADC10CLK</sub> |  | For specified performance of ADC10_A linearity parameters   | 2.2 V, 3 V      | 0.45 | 5   | 5.5 | MHz  |
| f <sub>ADC10OSC</sub> | Internal ADC10_A oscillator <sup>(1)</sup> | ADC10DIV = 0, f <sub>ADC10CLK</sub> = f <sub>ADC10OSC</sub>   | 2.2 V, 3 V      | 4.4  | 5.0 | 5.6 | MHz  |
| t <sub>CONVERT</sub>  | Conversion time                            | REFON = 0, Internal oscillator, 12 ADC10CLK cycles, 10-bit mode<br>f <sub>ADC10OSC</sub> = 4 MHz to 5 MHz | 2.2 V, 3 V      | 2.4  |     | 3.0 | μs   |
|                       |  | External f <sub>ADC10CLK</sub> from ACLK, MCLK or SMCLK, ADC10SSEL ≠ 0                                    |                 |      | (2) |     |      |
| t <sub>ADC10ON</sub>  | Turn on settling time of the ADC           | See <sup>(3)</sup>  |                 |      |     | 100 | ns   |
| t <sub>Sample</sub>   | Sampling time                              | R <sub>S</sub> = 1000 Ω, R <sub>I</sub> = 96 kΩ, C <sub>I</sub> = 3.5 pF <sup>(4)</sup>                   | 1.8 V           | 3    |     |     | μs   |
|                       |  | R <sub>S</sub> = 1000 Ω, R <sub>I</sub> = 36 kΩ, C <sub>I</sub> = 3.5 pF <sup>(4)</sup>                   | 3 V             | 1    |     |     | μs   |

- (1) The ADC10OSC is sourced directly from MODOSC inside the UCS.

- (2) 12 × ADC10DIV × 1/f<sub>ADC10CLK</sub>

- (3) The condition is that the error in a conversion started after t<sub>ADC10ON</sub> is less than ±0.5 LSB. The reference and input signal are already settled.

- (4) Approximately eight Tau (t) are needed to get an error of less than ±0.5 LSB

**Table 5-45. 10-Bit ADC, Linearity Parameters**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER      |                              | TEST CONDITIONS   | V <sub>CC</sub> | MIN | TYP  | MAX  | UNIT |
|----------------|------------------------------|---|-----------------|-----|------|------|------|
| E <sub>I</sub> | Integral linearity error     | 1.4 V ≤ (V <sub>eREF+</sub> - V <sub>eREF-</sub> ) <sub>min</sub> ≤ 1.6 V   | 2.2 V, 3 V      |     |      | ±1.0 | LSB  |
|                |                              | 1.6 V < (V <sub>eREF+</sub> - V <sub>eREF-</sub> ) <sub>min</sub> ≤ V <sub>AVCC</sub>   |                 |     |      | ±1.0 |      |
| E <sub>D</sub> | Differential linearity error | (V <sub>eREF+</sub> - V <sub>eREF-</sub> ) <sub>min</sub> ≤ (V <sub>eREF+</sub> - V <sub>eREF-</sub> ),<br>C <sub>VeREF+</sub> = 20 pF  | 2.2 V, 3 V      |     |      | ±1.0 | LSB  |
| E <sub>O</sub> | Offset error                 | (V <sub>eREF+</sub> - V <sub>eREF-</sub> ) <sub>min</sub> ≤ (V <sub>eREF+</sub> - V <sub>eREF-</sub> ),<br>Internal impedance of source R <sub>S</sub> < 100 Ω, C <sub>VeREF+</sub> = 20 pF | 2.2 V, 3 V      |     |      | ±1.0 | LSB  |
| E <sub>G</sub> | Gain error                   | (V <sub>eREF+</sub> - V <sub>eREF-</sub> ) <sub>min</sub> ≤ (V <sub>eREF+</sub> - V <sub>eREF-</sub> ),<br>C <sub>VeREF+</sub> = 20 pF  | 2.2 V, 3 V      |     |      | ±1.0 | LSB  |
| E <sub>T</sub> | Total unadjusted error       | (V <sub>eREF+</sub> - V <sub>eREF-</sub> ) <sub>min</sub> ≤ (V <sub>eREF+</sub> - V <sub>eREF-</sub> ),<br>C <sub>VeREF+</sub> = 20 pF  | 2.2 V, 3 V      |     | ±1.0 | ±2.0 | LSB  |

**Table 5-46. 10-Bit ADC, External Reference**over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER                                  |   | TEST CONDITIONS  | V <sub>CC</sub> | MIN | TYP  | MAX              | UNIT |
|--|---|--|-----------------|-----|------|------------------|------|
| V <sub>eREF+</sub>                         | Positive external reference voltage input     | V <sub>eREF+</sub> > V <sub>eREF-</sub> <sup>(2)</sup>   |                 | 1.4 |      | AV <sub>CC</sub> | V    |
| V <sub>eREF-</sub>                         | Negative external reference voltage input     | V <sub>eREF+</sub> > V <sub>eREF-</sub> <sup>(3)</sup>   |                 | 0   |      | 1.2              | V    |
| (V <sub>eREF+</sub> - V <sub>eREF-</sub> ) | Differential external reference voltage input | V <sub>eREF+</sub> > V <sub>eREF-</sub> <sup>(4)</sup>   |                 | 1.4 |      | AV <sub>CC</sub> | V    |
| I <sub>VeREF+</sub><br>I <sub>VeREF-</sub> | Static input current                          | 1.4 V ≤ V <sub>eREF+</sub> ≤ V <sub>AVCC</sub> , V <sub>eREF-</sub> = 0 V,<br>f <sub>ADC10CLK</sub> = 5 MHz, ADC10SHTX = 0x0001,<br>Conversion rate 200 ksps | 2.2 V, 3 V      |     | ±8.5 | ±26              | μA   |
|  |   | 1.4 V ≤ V <sub>eREF+</sub> ≤ V <sub>AVCC</sub> , V <sub>eREF-</sub> = 0 V,<br>f <sub>ADC10CLK</sub> = 5 MHz, ADC10SHTX = 0x1000,<br>Conversion rate 20 ksps  | 2.2 V, 3 V      |     |      | ±1               | μA   |
| C <sub>VeREF+/-</sub>                      | Capacitance at VeREF+ or VeREF- terminal      | See <sup>(5)</sup>   |                 | 10  |      |                  | μF   |

- (1) The external reference is used during ADC conversion to charge and discharge the capacitance array. The input capacitance, C<sub>I</sub>, is also the dynamic load for an external reference during conversion. The dynamic impedance of the reference supply should follow the recommendations on analog-source impedance to allow the charge to settle for 10-bit accuracy.
- (2) The accuracy limits the minimum positive external reference voltage. Lower reference voltage levels may be applied with reduced accuracy requirements.
- (3) The accuracy limits the maximum negative external reference voltage. Higher reference voltage levels may be applied with reduced accuracy requirements.
- (4) The accuracy limits minimum external differential reference voltage. Lower differential reference voltage levels may be applied with reduced accuracy requirements.
- (5) Two decoupling capacitors, 10 μF and 100 nF, should be connected to VeREF to decouple the dynamic current required for an external reference source if it is used for the ADC10\_A. Also see the *MSP430x5xx and MSP430x6xx Family User's Guide (SLAU208)*.

## 5.8.9 REF

**Table 5-47. REF, Built-In Reference**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                   |  | TEST CONDITIONS   | V <sub>CC</sub> | MIN   | TYP   | MAX   | UNIT   |
|-----------------------------|--|---|-----------------|-------|-------|-------|--------|
| V <sub>REF+</sub>           | Positive built-in reference voltage                                    | REFVSEL = {2} for 2.5 V, REFON = 1  | 3 V             | 2.47  | 2.51  | 2.55  | V      |
|                             |  | REFVSEL = {1} for 2.0 V, REFON = 1  | 3 V             | 1.95  | 1.99  | 2.03  |        |
|                             |  | REFVSEL = {0} for 1.5 V, REFON = 1  | 2.2 V, 3 V      | 1.46  | 1.50  | 1.54  |        |
| AV <sub>CC(min)</sub>       | AV <sub>CC</sub> minimum voltage, Positive built-in reference active   | REFVSEL = {0} for 1.5 V   |                 | 1.8   |       |       | V      |
|                             |  | REFVSEL = {1} for 2.0 V   |                 | 2.2   |       |       |        |
|                             |  | REFVSEL = {2} for 2.5 V   |                 | 2.7   |       |       |        |
| I <sub>REF+</sub>           | Operating supply current into AV <sub>CC</sub> terminal <sup>(1)</sup> | f <sub>ADC10CLK</sub> = 5 MHz, REFON = 1, REFBURST = 0, REFVSEL = {2} for 2.5 V   | 3 V             |       | 23    | 30    | μA     |
|                             |  | f <sub>ADC10CLK</sub> = 5 MHz, REFON = 1, REFBURST = 0, REFVSEL = {1} for 2.0 V   | 3 V             |       | 21    | 27    | μA     |
|                             |  | f <sub>ADC10CLK</sub> = 5 MHz, REFON = 1, REFBURST = 0, REFVSEL = {0} for 1.5 V   | 3 V             |       | 19    | 25    | μA     |
| TC <sub>REF+</sub>          | Temperature coefficient of built-in reference <sup>(2)</sup>           | REFVSEL = {0, 1, 2}, REFON = 1  |                 |       | 10    | 50    | ppm/°C |
| I <sub>SENSOR</sub>         | Operating supply current into AV <sub>CC</sub> terminal                | REFON = 1, ADC10ON = 1, INCH = 0Ah, T <sub>A</sub> = 30°C   | 2.2 V           |       | 145   | 220   | μA     |
|                             |  |   | 3 V             |       | 170   | 245   |        |
| V <sub>SENSOR</sub>         | See <sup>(3)</sup>   | REFON = 1, ADC10ON = 1, INCH = 0Ah, T <sub>A</sub> = 30°C   | 2.2 V           |       | 780   |       | mV     |
|                             |  |   | 3 V             |       | 780   |       |        |
| V <sub>MID</sub>            | AV <sub>CC</sub> divider at channel 11                                 | ADC10ON = 1, INCH = 0Bh, V <sub>MID</sub> is ~0.5 × V <sub>AVCC</sub>   | 2.2 V           | 1.08  | 1.1   | 1.12  | V      |
|                             |  |   | 3 V             | 1.48  | 1.5   | 1.52  |        |
| t <sub>SENSOR(sample)</sub> | Sample time required if channel 10 is selected <sup>(4)</sup>          | REFON = 1, ADC10ON = 1, INCH = 0Ah, Error of conversion result ≤ 1 LSB  |                 | 30    |       |       | μs     |
| t <sub>VMID(sample)</sub>   | Sample time required if channel 11 is selected <sup>(5)</sup>          | ADC10ON = 1, INCH = 0Bh, Error of conversion result ≤ 1 LSB   |                 | 1     |       |       | μs     |
| PSRR <sub>DC</sub>          | Power supply rejection ratio (dc)                                      | AV <sub>CC</sub> = AV <sub>CC (min)</sub> - AV <sub>CC(max)</sub><br>T <sub>A</sub> = 25 °C<br>REFVSEL = {0, 1, 2}, REFON = 1   |                 |       | 120   | 300   | μV/V   |
| PSRR <sub>AC</sub>          | Power supply rejection ratio (ac)                                      | AV <sub>CC</sub> = AV <sub>CC (min)</sub> - AV <sub>CC(max)</sub><br>T <sub>A</sub> = 25 °C<br>f = 1 kHz, ΔV <sub>pp</sub> = 100 mV<br>REFVSEL = {0, 1, 2}, REFON = 1 |                 |       | 1     |       | mV/V   |
| t <sub>SETTLE</sub>         | Settling time of reference voltage <sup>(6)</sup>                      | AV <sub>CC</sub> = AV <sub>CC (min)</sub> - AV <sub>CC(max)</sub><br>REFVSEL = {0, 1, 2}, REFON = 0 → 1   |                 |       | 75    |       | μs     |
| V <sub>SD24REF</sub>        | SD24_B internal reference voltage                                      | SD24REFS = 1  | 3 V             | 1.137 | 1.151 | 1.165 | V      |
| t <sub>ON</sub>             | SD24_B internal reference turn-on time <sup>(7)</sup>                  | SD24REFS = 0->1, C <sub>REF</sub> = 100 nF  | 3 V             |       | 200   |       | μs     |

- (1) The internal reference current is supplied via terminal AV<sub>CC</sub>. Consumption is independent of the ADC10ON control bit, unless a conversion is active. The REFON bit enables to settle the built-in reference before starting an A/D conversion.
- (2) Calculated using the box method: (MAX(-40 to 85°C) – MIN(-40 to 85°C)) / MIN(-40 to 85°C)/(85°C – (-40°C)).
- (3) The temperature sensor offset can be as much as ±20°C. A single-point calibration is recommended to minimize the offset error of the built-in temperature sensor.
- (4) The typical equivalent impedance of the sensor is 51 kΩ. The sample time required includes the sensor-on time t<sub>SENSOR(on)</sub>.
- (5) The on-time t<sub>VMID(on)</sub> is included in the sampling time t<sub>VMID(sample)</sub>; no additional on time is needed.
- (6) The condition is that the error in a conversion started after t<sub>REFON</sub> is ≤ 1 LSB.
- (7) The condition is that SD24\_B conversion started after t<sub>ON</sub> should guarantee specified SINAD values for the selected Gain, OSR and f<sub>SD24</sub>.

## 5.8.10 Flash Memory

**Table 5-48. Flash Memory**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                               |   | TEST CONDITIONS       | MIN             | TYP             | MAX | UNIT   |
|---|---|-----------------------|-----------------|-----------------|-----|--------|
| DV <sub>CC(PGM/ERASE)</sub>             | Program and erase supply voltage  |                       | 1.8             |                 | 3.6 | V      |
| I <sub>PGM</sub>                        | Average supply current from DV <sub>CC</sub> during program                       |                       |                 | 3               | 5   | mA     |
| I <sub>ERASE</sub>                      | Average supply current from DV <sub>CC</sub> during erase                         |                       |                 | 6               | 11  | mA     |
| I <sub>MERASE</sub> , I <sub>BANK</sub> | Average supply current from DV <sub>CC</sub> during mass erase or bank erase      |                       |                 | 6               | 11  | mA     |
| t <sub>CPT</sub>                        | Cumulative program time   | See <sup>(1)</sup>    |                 |                 | 16  | ms     |
|   | Program and erase endurance   |                       | 10 <sup>4</sup> | 10 <sup>5</sup> |     | cycles |
| t <sub>Retention</sub>                  | Data retention duration   | T <sub>J</sub> = 25°C | 100             |                 |     | years  |
| t <sub>Word</sub>                       | Word or byte program time   | See <sup>(2)</sup>    | 64              |                 | 85  | μs     |
| t <sub>Block, 0</sub>                   | Block program time for first byte or word   | See <sup>(2)</sup>    | 49              |                 | 65  | μs     |
| t <sub>Block, 1–(N–1)</sub>             | Block program time for each additional byte or word, except for last byte or word | See <sup>(2)</sup>    | 37              |                 | 49  | μs     |
| t <sub>Block, N</sub>                   | Block program time for last byte or word  | See <sup>(2)</sup>    | 55              |                 | 73  | μs     |
| t <sub>Erase</sub>                      | Erase time for segment erase, mass erase, and bank erase when available           | See <sup>(2)</sup>    | 23              |                 | 32  | ms     |
| f <sub>MCLK,MGR</sub>                   | MCLK frequency in marginal read mode (FCTL4.MGR0 = 1 or FCTL4.MGR1 = 1)           |                       | 0               |                 | 1   | MHz    |

(1) The cumulative program time must not be exceeded when writing to a 128-byte flash block. This parameter applies to all programming methods: individual word- or byte-write and block-write modes.

(2) These values are hardwired into the flash controller's state machine.

## 5.9 Emulation and Debug

**Table 5-49. JTAG and Spy-Bi-Wire Interface**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER             |  | TEST CONDITIONS | MIN   | TYP | MAX | UNIT |
|-----------------------|--|-----------------|-------|-----|-----|------|
| f <sub>SBW</sub>      | Spy-Bi-Wire input frequency  | 2.2 V, 3 V      | 0     |     | 20  | MHz  |
| t <sub>SBW,Low</sub>  | Spy-Bi-Wire low clock pulse duration   | 2.2 V, 3 V      | 0.025 |     | 15  | μs   |
| t <sub>SBW,En</sub>   | Spy-Bi-Wire enable time (TEST high to acceptance of first clock edge) <sup>(1)</sup> | 2.2 V, 3 V      |       |     | 1   | μs   |
| t <sub>SBW,Rst</sub>  | Spy-Bi-Wire return to normal operation time  |                 | 15    |     | 100 | μs   |
| f <sub>TCK</sub>      | TCK input frequency for 4-wire JTAG <sup>(2)</sup>                                   | 2.2 V           | 0     |     | 5   | MHz  |
|                       |  | 3 V             | 0     |     | 10  |      |
| R <sub>Internal</sub> | Internal pulldown resistance on TEST   | 2.2 V, 3 V      | 45    | 60  | 80  | kΩ   |

(1) Tools accessing the Spy-Bi-Wire interface need to wait for the minimum t<sub>SBW,En</sub> time after pulling the TEST/SBWTCK pin high before applying the first SBWTCK clock edge.

(2) f<sub>TCK</sub> may be restricted to meet the timing requirements of the module selected.



## 6 Detailed Description

### 6.1 Functional Block Diagrams

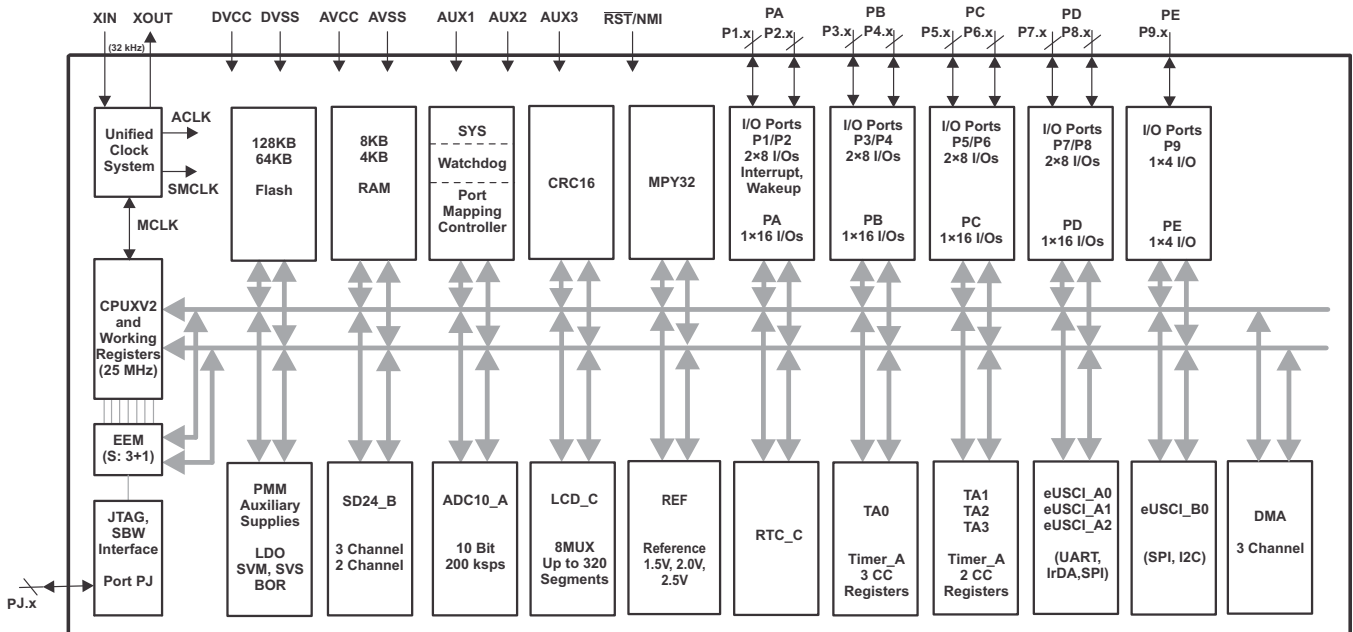


Figure 6-1. Functional Block Diagram – PZ Package

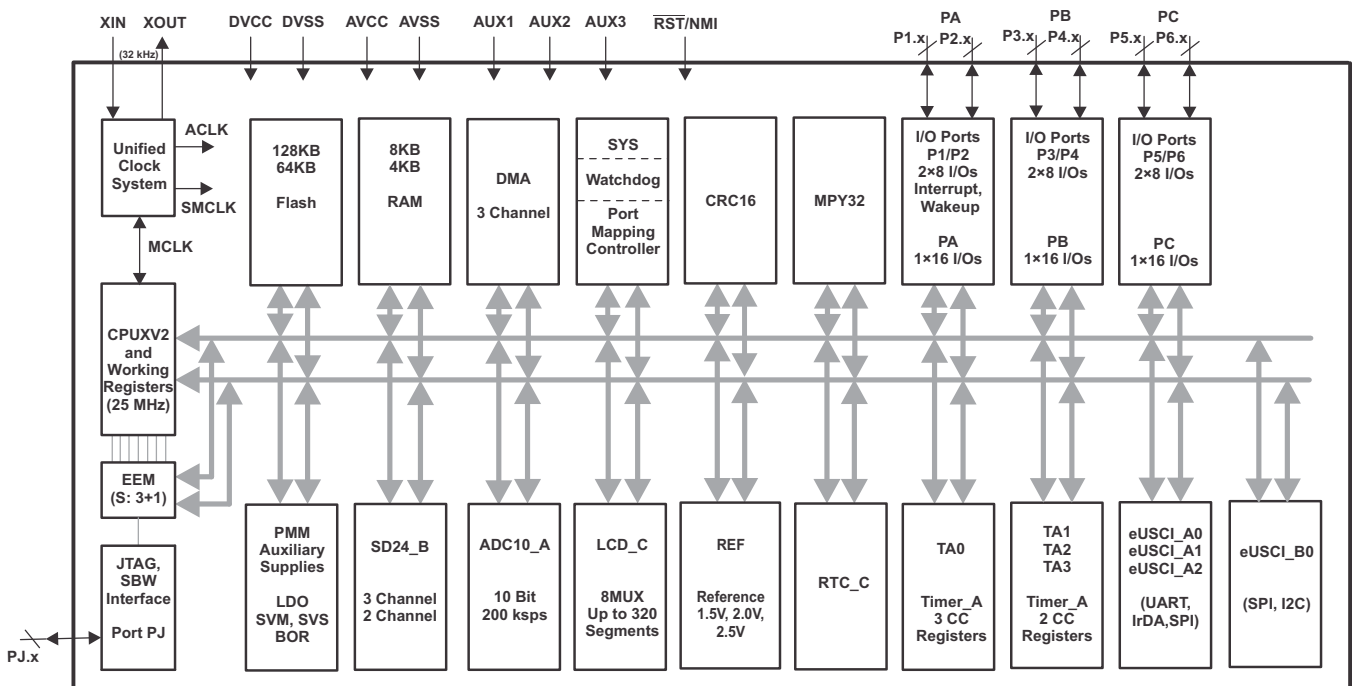


Figure 6-2. Functional Block Diagram – PN Package

## 6.2 CPU

The MSP430 CPU has a 16-bit RISC architecture that is highly transparent to the application. All operations, other than program-flow instructions, are performed as register operations in conjunction with seven addressing modes for source operand and four addressing modes for destination operand.

The CPU is integrated with 16 registers that provide reduced instruction execution time. The register-to-register operation execution time is one cycle of the CPU clock.

Four of the registers, R0 to R3, are dedicated as program counter, stack pointer, status register, and constant generator, respectively. The remaining registers are general-purpose registers.

Peripherals are connected to the CPU using data, address, and control buses, and can be handled with all instructions.

## 6.3 Instruction Set

The instruction set consists of the original 51 instructions with three formats and seven address modes and additional instructions for the expanded address range. Each instruction can operate on word and byte data. [Table 6-1](#) shows examples of the three types of instruction formats; [Table 6-2](#) shows the address modes.

|                          |           |
|--------------------------|-----------|
| Program Counter          | PC/R0     |
| Stack Pointer            | SP/R1     |
| Status Register          | SR/CG1/R2 |
| Constant Generator       | CG2/R3    |
| General-Purpose Register | R4        |
| General-Purpose Register | R5        |
| General-Purpose Register | R6        |
| General-Purpose Register | R7        |
| General-Purpose Register | R8        |
| General-Purpose Register | R9        |
| General-Purpose Register | R10       |
| General-Purpose Register | R11       |
| General-Purpose Register | R12       |
| General-Purpose Register | R13       |
| General-Purpose Register | R14       |
| General-Purpose Register | R15       |

**Table 6-1. Instruction Word Formats**

| INSTRUCTION WORD FORMAT               | EXAMPLE   | OPERATION             |
|---------------------------------------|-----------|-----------------------|
| Dual operands, source and destination | ADD R4,R5 | R4 + R5 → R5          |
| Single operands, destination only     | CALL R8   | PC → (TOS), R8 → PC   |
| Relative jump, un/conditional         | JNE       | Jump-on-equal bit = 0 |

**Table 6-2. Address Mode Descriptions**

| ADDRESS MODE           | S <sup>(1)</sup> | D <sup>(1)</sup> | SYNTAX             | EXAMPLE          | OPERATION                     |
|------------------------|------------------|------------------|--------------------|------------------|-------------------------------|
| Register               | +                | +                | MOV Rs,Rd          | MOV R10,R11      | R10 → R11                     |
| Indexed                | +                | +                | MOV X(Rn),Y(Rm)    | MOV 2(R5),6(R6)  | M(2+R5) → M(6+R6)             |
| Symbolic (PC relative) | +                | +                | MOV EDE,TONI       |                  | M(EDE) → M(TONI)              |
| Absolute               | +                | +                | MOV & MEM, & TCDAT |                  | M(MEM) → M(TCDAT)             |
| Indirect               | +                |                  | MOV @Rn,Y(Rm)      | MOV @R10,Tab(R6) | M(R10) → M(Tab+R6)            |
| Indirect autoincrement | +                |                  | MOV @Rn+,Rm        | MOV @R10+,R11    | M(R10) → R11<br>R10 + 2 → R10 |
| Immediate              | +                |                  | MOV #X,TONI        | MOV #45,TONI     | #45 → M(TONI)                 |

(1) S = source, D = destination

## 6.4 Operating Modes

The MSP430 has one active mode and seven software selectable low-power modes of operation. An interrupt event can wake up the device from any of the low-power modes, service the request, and restore back to the low-power mode on return from the interrupt program.

The following seven operating modes can be configured by software:

- Active mode (AM)
  - All clocks are active
- Low-power mode 0 (LPM0)
  - CPU is disabled
  - ACLK and SMCLK remain active, MCLK is disabled
  - FLL loop control remains active
- Low-power mode 1 (LPM1)
  - CPU is disabled
  - FLL loop control is disabled
  - ACLK and SMCLK remain active, MCLK is disabled
- Low-power mode 2 (LPM2)
  - CPU is disabled
  - MCLK and FLL loop control and DCOCLK are disabled
  - DCO's dc-generator remains enabled
  - ACLK remains active
- Low-power mode 3 (LPM3)
  - CPU is disabled
  - MCLK, FLL loop control, and DCOCLK are disabled
  - DCO's dc-generator is disabled
  - ACLK remains active
- Low-power mode 4 (LPM4)
  - CPU is disabled
  - ACLK is disabled
  - MCLK, FLL loop control, and DCOCLK are disabled
  - DCO's dc-generator is disabled
  - Crystal oscillator is stopped
  - Complete data retention
- Low-power mode 3.5 (LPM3.5)
  - Internal regulator disabled
  - No RAM retention, Backup RAM retained
  - I/O pad state retention
  - RTC clocked by low-frequency oscillator
  - Wakeup from  $\overline{\text{RST}}$ /NMI, RTC\_C events, Ports P1 and P2
- Low-power mode 4.5 (LPM4.5)
  - Internal regulator disabled
  - No RAM retention, Backup RAM retained
  - RTC is disabled
  - I/O pad state retention
  - Wakeup from  $\overline{\text{RST}}$ /NMI, Ports P1 and P2

## 6.5 Interrupt Vector Addresses

The interrupt vectors and the power-up start address are located in the address range 0FFFFh to 0FF80h. The vector contains the 16-bit address of the appropriate interrupt-handler instruction sequence.

**Table 6-3. Interrupt Sources, Flags, and Vectors**

| INTERRUPT SOURCE   | INTERRUPT FLAG  | SYSTEM INTERRUPT | WORD ADDRESS | PRIORITY    |
|--|---|------------------|--------------|-------------|
| <b>System Reset</b><br>Power-Up<br>External Reset<br>Watchdog Timeout, Key Violation<br>Flash Memory Key Violation | WDTIFG, KEYV (SYSRSTIV) <sup>(1)(2)</sup>   | Reset            | 0FFFEh       | 63, highest |
| <b>System NMI</b><br>PMM<br>Vacant Memory Access<br>JTAG Mailbox   | SVMLIFG, SVMHIFG, DLYLIFG, DLYHIFG, VLRIFG, VLRHIFG, VMAIFG, JMBNIFG, JMBOUTIFG (SYSSNIV) <sup>(1)(3)</sup> | (Non)maskable    | 0FFFCh       | 62          |
| <b>User NMI</b><br>NMI<br>Oscillator Fault<br>Flash Memory Access Violation<br>Supply Switch                       | NMIIFG, OFIFG, ACCVIFG, AUXSWNMIFG (SYSUNIV) <sup>(1)(3)</sup>  | (Non)maskable    | 0FFFAh       | 61          |
| Watchdog Timer_A Interval Timer Mode   | WDTIFG  | Maskable         | 0FFF8h       | 60          |
| eUSCI_A0 Receive or Transmit   | UCA0RXIFG, UCA0TXIFG (UCA0IV) <sup>(1)(4)</sup>   | Maskable         | 0FFF6h       | 59          |
| eUSCI_B0 Receive or Transmit   | UCB0RXIFG, UCB0TXIFG (UCB0IV) <sup>(1)(4)</sup>   | Maskable         | 0FFF4h       | 58          |
| ADC10_A  | ADC10IFG0, ADC10INIFG, ADC10LOIFG, ADC10HIIFG, ADC10TOVIFG, ADC10OVIFG (ADC10IV) <sup>(1)(4)</sup>          | Maskable         | 0FFF2h       | 57          |
| SD24_B   | SD24_B Interrupt Flags (SD24IV) <sup>(1)(4)</sup>   | Maskable         | 0FFF0h       | 56          |
| Timer TA0  | TA0CCR0 CCIFG0 <sup>(4)</sup>   | Maskable         | 0FFEEh       | 55          |
| Timer TA0  | TA0CCR1 CCIFG1, TA0CCR2 CCIFG2, TA0IFG (TA0IV) <sup>(1)(4)</sup>  | Maskable         | 0FFECCh      | 54          |
| eUSCI_A1 Receive or Transmit   | UCA1RXIFG, UCA1TXIFG (UCA1IV) <sup>(1)(4)</sup>   | Maskable         | 0FFEAh       | 53          |
| eUSCI_A2 Receive or Transmit   | UCA2RXIFG, UCA2TXIFG (UCA2IV) <sup>(1)(4)</sup>   | Maskable         | 0FFE8h       | 52          |
| Auxiliary Supplies   | Auxiliary Supplies Interrupt Flags (AUXIV) <sup>(1)(4)</sup>  | Maskable         | 0FFE6h       | 51          |
| DMA  | DMA0IFG, DMA1IFG, DMA2IFG (DMAIV) <sup>(1)(4)</sup>   | Maskable         | 0FFE4h       | 50          |
| Timer TA1  | TA1CCR0 CCIFG0 <sup>(4)</sup>   | Maskable         | 0FFE2h       | 49          |
| Timer TA1  | TA1CCR1 CCIFG1, TA1IFG (TA1IV) <sup>(1)(4)</sup>  | Maskable         | 0FFE0h       | 48          |
| I/O Port P1  | P1IFG.0 to P1IFG.7 (P1IV) <sup>(1)(4)</sup>   | Maskable         | 0FFDEh       | 47          |
| Timer TA2  | TA2CCR0 CCIFG0 <sup>(4)</sup>   | Maskable         | 0FFDCCh      | 46          |
| Timer TA2  | TA2CCR1 CCIFG1, TA2IFG (TA2IV) <sup>(1)(4)</sup>  | Maskable         | 0FFDAh       | 45          |
| I/O Port P2  | P2IFG.0 to P2IFG.7 (P2IV) <sup>(1)(4)</sup>   | Maskable         | 0FFD8h       | 44          |
| Timer TA3  | TA3CCR0 CCIFG0 <sup>(4)</sup>   | Maskable         | 0FFD6h       | 43          |
| Timer TA3  | TA3CCR1 CCIFG1, TA3IFG (TA3IV) <sup>(1)(4)</sup>  | Maskable         | 0FFD4h       | 42          |
| LCD_C  | LCD_C Interrupt Flags (LCDIV) <sup>(1)(4)</sup>   | Maskable         | 0FFD2h       | 41          |
| RTC_C  | RTCOFIG, RTCRDYIFG, RTCTEVIIFG, RTCAIFG, RT0PSIFG, RT1PSIFG (RTCIV) <sup>(1)(4)</sup>                       | Maskable         | 0FFD0h       | 40          |

(1) Multiple source flags

(2) A reset is generated if the CPU tries to fetch instructions from within peripheral space or vacant memory space.

(3) (Non)maskable: the individual interrupt-enable bit can disable an interrupt event, but the general-interrupt enable cannot disable it.

(4) Interrupt flags are located in the module.

**Table 6-3. Interrupt Sources, Flags, and Vectors (continued)**

| INTERRUPT SOURCE | INTERRUPT FLAG          | SYSTEM INTERRUPT | WORD ADDRESS | PRIORITY  |
|------------------|-------------------------|------------------|--------------|-----------|
| Reserved         | Reserved <sup>(5)</sup> |                  | 0FFCEh       | 39        |
|                  |                         |                  | ⋮            | ⋮         |
|                  |                         |                  | 0FF80h       | 0, lowest |

(5) Reserved interrupt vectors at addresses are not used in this device and can be used for regular program code if necessary. To maintain compatibility with other devices, it is recommended to reserve these locations.

## 6.6 Memory Organization

**Table 6-4. Memory Organization**

|                                       |            | MSP430F67641                | MSP430F67621                |
|---------------------------------------|------------|-----------------------------|-----------------------------|
| Main Memory (flash)                   | Total Size | 128KB                       | 64KB                        |
| Main: Interrupt vector                |            | 00FFFFh to 00FF80h          | 00FFFFh to 00FF80h          |
| Main: code memory                     | Bank 3     | 32KB<br>023FFFh to 01C000h  | not available               |
|                                       | Bank 2     | 32KB<br>01BFFFh to 014000h  | not available               |
|                                       | Bank 1     | 32KB<br>013FFFh to 00C000h  | 32KB<br>013FFFh to 00C000h  |
|                                       | Bank 0     | 32KB<br>00BFFFh to 004000h  | 32KB<br>00BFFFh to 004000h  |
| RAM                                   | Total Size | 8KB                         | 4KB                         |
|                                       | Sector 3   | 2KB<br>003BFFh to 003400h   | not available               |
|                                       | Sector 2   | 2KB<br>0033FFh to 002C00h   | not available               |
|                                       | Sector 1   | 2KB<br>002BFFh to 002400h   | 2KB<br>002BFFh to 002400h   |
|                                       | Sector 0   | 2KB<br>0023FFh to 001C00h   | 2KB<br>0023FFh to 001C00h   |
| Information memory (flash)            | Info A     | 128 B<br>0019FFh to 001980h | 128 B<br>0019FFh to 001980h |
|                                       | Info B     | 128 B<br>00197Fh to 001900h | 128 B<br>00197Fh to 001900h |
|                                       | Info C     | 128 B<br>0018FFh to 001880h | 128 B<br>0018FFh to 001880h |
|                                       | Info D     | 128 B<br>00187Fh to 001800h | 128 B<br>00187Fh to 001800h |
| Bootstrap loader (BSL) memory (flash) | BSL 3      | 512 B<br>0017FFh to 001600h | 512 B<br>0017FFh to 001600h |
|                                       | BSL 2      | 512 B<br>0015FFh to 001400h | 512 B<br>0015FFh to 001400h |
|                                       | BSL 1      | 512 B<br>0013FFh to 001200h | 512 B<br>0013FFh to 001200h |
|                                       | BSL 0      | 512 B<br>0011FFh to 001000h | 512 B<br>0011FFh to 001000h |
| Peripherals                           |            | 4KB<br>000FFFh to 0h        | 4KB<br>000FFFh to 0h        |

## 6.7 Bootstrap Loader (BSL)

The BSL enables users to program the flash memory or RAM using various serial interfaces. Access to the device memory by the BSL is protected by an user-defined password. BSL entry requires a specific entry sequence on the  $\overline{\text{RST}}$ /NMI/SBWDIO and TEST/SBWTCK pins. For complete description of the features of the BSL and its implementation, see *MSP430 Programming via the Bootstrap Loader (BSL)* ([SLAU319](#)).

**Table 6-5. UART BSL Pin Requirements and Functions**

| DEVICE SIGNAL                       | BSL FUNCTION          |
|-------------------------------------|-----------------------|
| $\overline{\text{RST}}$ /NMI/SBWDIO | Entry sequence signal |
| TEST/SBWTCK                         | Entry sequence signal |
| P3.0                                | Data transmit         |
| P3.1                                | Data receive          |
| VCC                                 | Power supply          |
| VSS                                 | Ground supply         |

## 6.8 JTAG Operation

### 6.8.1 JTAG Standard Interface

The MSP430 family supports the standard JTAG interface which requires four signals for sending and receiving data. The JTAG signals are shared with general-purpose I/O. The TEST/SBWTCK pin is used to enable the JTAG signals. In addition to these signals, the  $\overline{\text{RST}}$ /NMI/SBWDIO is required to interface with MSP430 development tools and device programmers. The JTAG pin requirements are shown in [Table 6-6](#). For further details on interfacing to development tools and device programmers, see the *MSP430 Hardware Tools User's Guide* ([SLAU278](#)) and *MSP430 Programming Via the JTAG Interface* ([SLAU320](#)).

**Table 6-6. JTAG Pin Requirements and Functions**

| DEVICE SIGNAL                       | DIRECTION | FUNCTION                    |
|-------------------------------------|-----------|-----------------------------|
| PJ.3/ACLK/TCK                       | IN        | JTAG clock input            |
| PJ.2/ADC10CLK/TMS                   | IN        | JTAG state control          |
| PJ.1/MCLK/TDI/TCLK                  | IN        | JTAG data input, TCLK input |
| PJ.0/SMCLK/TDO                      | OUT       | JTAG data output            |
| TEST/SBWTCK                         | IN        | Enable JTAG pins            |
| $\overline{\text{RST}}$ /NMI/SBWDIO | IN        | External reset              |
| VCC                                 |           | Power supply                |
| VSS                                 |           | Ground supply               |

### 6.8.2 Spy-Bi-Wire Interface

In addition to the standard JTAG interface, the MSP430 family supports the two-wire Spy-Bi-Wire interface. Spy-Bi-Wire can be used to interface with MSP430 development tools and device programmers. The Spy-Bi-Wire interface pin requirements are shown in [Table 6-7](#). For further details on interfacing to development tools and device programmers, see the *MSP430 Hardware Tools User's Guide* ([SLAU278](#)) and *MSP430 Programming Via the JTAG Interface* ([SLAU320](#)).

**Table 6-7. Spy-Bi-Wire Pin Requirements and Functions**

| DEVICE SIGNAL | DIRECTION | FUNCTION                |
|---------------|-----------|-------------------------|
| TEST/SBWTCK   | IN        | Spy-Bi-Wire clock input |

**Table 6-7. Spy-Bi-Wire Pin Requirements and Functions (continued)**

| DEVICE SIGNAL                        | DIRECTION | FUNCTION                      |
|--------------------------------------|-----------|-------------------------------|
| $\overline{\text{RST}}$ /NMI/SBWTDIO | IN, OUT   | Spy-Bi-Wire data input/output |
| VCC                                  |           | Power supply                  |
| VSS                                  |           | Ground supply                 |

## 6.9 Flash Memory

The flash memory can be programmed through the JTAG port, Spy-Bi-Wire (SBW), the BSL, or in-system by the CPU. The CPU can perform single-byte, single-word, and long-word writes to the flash memory. Features of the flash memory include:

- Flash memory has n segments of main memory and four segments of information memory (A to D) of 128 bytes each. Each segment in main memory is 512 bytes in size.
- Segments 0 to n may be erased in one step, or each segment may be individually erased.
- Segments A to D can be erased individually or as a group with segments 0 to n. Segments A to D are also called *information memory*.
- Segment A can be locked separately.

## 6.10 RAM Memory

The RAM memory is made up of n sectors. Each sector can be completely powered down to save leakage; however, all data is lost. Features of the RAM memory include:

- RAM memory has n sectors of 2K bytes each.
- Each sector 0 to n can be complete disabled; however, data retention is lost.
- Each sector 0 to n automatically enters low-power retention mode when possible.

## 6.11 Backup RAM Memory

The Backup RAM provides a limited number of bytes of RAM that are retained during LPMx.5. This Backup RAM is part of the Backup subsystem, which operates on dedicated power supply AUXVCC3. There are 8 bytes of Backup RAM available in this device. It can be word-wise accessed through the registers BAKMEM0, BAKMEM1, BAKMEM2, and BAKMEM3. The Backup RAM registers cannot be accessed by the CPU when the high-side SVS is disabled by software.

## 6.12 Peripherals

Peripherals are connected to the CPU through data, address, and control buses and can be handled using all instructions. For complete module descriptions, see the *MSP430x5xx and MSP430x6xx Family User's Guide* ([SLAU208](#)).

### 6.12.1 Oscillator and System Clock

The Unified Clock System (UCS) module includes support for a 32768-Hz watch crystal oscillator, an internal very-low-power low-frequency oscillator (VLO), an internal trimmed low-frequency oscillator (REFO), and an integrated internal digitally controlled oscillator (DCO). The UCS module is designed to meet the requirements of both low system cost and low power consumption. The UCS module features digital frequency locked loop (FLL) hardware that, in conjunction with a digital modulator, stabilizes the DCO frequency to a programmable multiple of the selected FLL reference frequency. The internal DCO provides a fast turn-on clock source and stabilizes in 3  $\mu$ s (typical). The UCS module provides the following clock signals:

- Auxiliary clock (ACLK), sourced from a 32768-Hz watch crystal, the internal low-frequency oscillator (VLO), or the trimmed low-frequency oscillator (REFO).
- Main clock (MCLK), the system clock used by the CPU. MCLK can be sourced by same sources made available to ACLK.
- Sub-Main clock (SMCLK), the subsystem clock used by the peripheral modules. SMCLK can be sourced by same sources made available to ACLK.
- ACLK/n, the buffered output of ACLK, ACLK/2, ACLK/4, ACLK/8, ACLK/16, ACLK/32.

### 6.12.2 Power Management Module (PMM)

The PMM includes an integrated voltage regulator that supplies the core voltage to the device and contains programmable output levels to provide for power optimization. The PMM also includes supply voltage supervisor (SVS) and supply voltage monitoring (SVM) circuitry, and brownout protection. The brownout circuit provides the proper internal reset signal to the device during power-on and power-off. The SVS and SVM circuitry detects if the supply voltage drops below a user-selectable level and supports both supply voltage supervision (the device is automatically reset) and supply voltage monitoring (the device is not automatically reset). SVS and SVM circuitry is available on the primary supply and core supply.

### 6.12.3 Auxiliary Supply System

The auxiliary supply system can operate the device from auxiliary supplies when the primary supply fails. There are two auxiliary supplies supported: AUXVCC1 and AUXVCC2. This module supports automatic and manual switching from primary supply to auxiliary supplies while maintaining full functionality. It allows threshold based monitoring of primary and auxiliary supplies. The device can be started from primary supply or AUXVCC1, whichever is higher. Auxiliary supply system enables internal monitoring of voltage levels on primary and auxiliary supplies using ADC10\_A. Also this module implements simple charger for backup supplies.

### 6.12.4 Backup Subsystem

The Backup subsystem operates on a dedicated power supply AUXVCC3. This subsystem includes low-frequency oscillator (XT1), RTC module, and Backup RAM. The functionality of the Backup subsystem is retained during LPM3.5. The Backup subsystem module registers cannot be accessed by the CPU when the high-side SVS is disabled by user. It is necessary to keep the high-side SVS enabled with SVSHMD = 1 and SVSMHACE = 0 to turn off the low-frequency oscillator (XT1) in LPM4.



### 6.12.5 Digital I/O

There are up to nine I/O ports implemented. For 100-pin options, Ports P1 to P8 are complete. P9 is reduced to 4-bit I/O. For 80-pin options, Ports P1 to P6 are complete, and P7, P8, and P9 are completely removed. Port PJ contains four individual I/O pins, common to all devices. All I/O bits are individually programmable.

- Any combination of input, output, and interrupt conditions is possible.
- Pullup or pulldown on all ports is programmable.
- Programmable drive strength on all ports.
- Edge-selectable interrupt and LPM3.5 or LPM4.5 wakeup input capability available for all bits of ports P1 and P2.
- Read and write access to port-control registers is supported by all instructions.
- Ports can be accessed byte-wise (P1 through P9) or word-wise in pairs (PA through PE).

### 6.12.6 Port Mapping Controller

The port mapping controller allows flexible and reconfigurable mapping of digital functions to P1, P2, and P3.

**Table 6-8. Port Mapping Mnemonics and Functions**

| VALUE | PxMAPy MNEMONIC | INPUT PIN FUNCTION   | OUTPUT PIN FUNCTION          |
|-------|-----------------|--|------------------------------|
| 0     | PM_NONE         | None   | DVSS                         |
| 1     | PM_UCA0RXD      | eUSCI_A0 UART RXD (direction controlled by eUSCI – Input)                      |                              |
|       | PM_UCA0SOMI     | eUSCI_A0 SPI slave out master in (direction controlled by eUSCI)               |                              |
| 2     | PM_UCA0TXD      | eUSCI_A0 UART TXD (direction controlled by eUSCI – Output)                     |                              |
|       | PM_UCA0SIMO     | eUSCI_A0 SPI slave in master out (direction controlled by eUSCI)               |                              |
| 3     | PM_UCA0CLK      | eUSCI_A0 clock input/output (direction controlled by eUSCI)                    |                              |
| 4     | PM_UCA0STE      | eUSCI_A0 SPI slave transmit enable (direction controlled by eUSCI)             |                              |
| 5     | PM_UCA1RXD      | eUSCI_A1 UART RXD (direction controlled by eUSCI – Input)                      |                              |
|       | PM_UCA1SOMI     | eUSCI_A1 SPI slave out master in (direction controlled by eUSCI)               |                              |
| 6     | PM_UCA1TXD      | eUSCI_A1 UART TXD (direction controlled by eUSCI – Output)                     |                              |
|       | PM_UCA1SIMO     | eUSCI_A1 SPI slave in master out (direction controlled by eUSCI)               |                              |
| 7     | PM_UCA1CLK      | eUSCI_A1 clock input/output (direction controlled by eUSCI)                    |                              |
| 8     | PM_UCA1STE      | eUSCI_A1 SPI slave transmit enable (direction controlled by eUSCI)             |                              |
| 9     | PM_UCA2RXD      | eUSCI_A2 UART RXD (direction controlled by eUSCI – Input)                      |                              |
|       | PM_UCA2SOMI     | eUSCI_A2 SPI slave out master in (direction controlled by eUSCI)               |                              |
| 10    | PM_UCA2TXD      | eUSCI_A2 UART TXD (direction controlled by eUSCI – Output)                     |                              |
|       | PM_UCA2SIMO     | eUSCI_A2 SPI slave in master out (direction controlled by eUSCI)               |                              |
| 11    | PM_UCA2CLK      | eUSCI_A2 clock input/output (direction controlled by eUSCI)                    |                              |
| 12    | PM_UCA2STE      | eUSCI_A2 SPI slave transmit enable (direction controlled by eUSCI)             |                              |
| 13    | PM_UCB0SIMO     | eUSCI_B0 SPI slave in master out (direction controlled by eUSCI)               |                              |
|       | PM_UCB0SDA      | eUSCI_B0 I <sup>2</sup> C data (open drain and direction controlled by eUSCI)  |                              |
| 14    | PM_UCB0SOMI     | eUSCI_B0 SPI slave out master in (direction controlled by eUSCI)               |                              |
|       | PM_UCB0SCL      | eUSCI_B0 I <sup>2</sup> C clock (open drain and direction controlled by eUSCI) |                              |
| 15    | PM_UCB0CLK      | eUSCI_B0 clock input/output (direction controlled by eUSCI)                    |                              |
| 16    | PM_UCB0STE      | eUSCI_B0 SPI slave transmit enable (direction controlled by eUSCI)             |                              |
| 17    | PM_TA0.0        | TA0 CCR0 capture input CCI0A   | TA0 CCR0 compare output Out0 |
| 18    | PM_TA0.1        | TA0 CCR1 capture input CCI1A   | TA0 CCR1 compare output Out1 |
| 19    | PM_TA0.2        | TA0 CCR2 capture input CCI2A   | TA0 CCR2 compare output Out2 |
| 20    | PM_TA1.0        | TA1 CCR0 capture input CCI0A   | TA1 CCR0 compare output Out0 |
| 21    | PM_TA1.1        | TA1 CCR1 capture input CCI1A   | TA1 CCR1 compare output Out1 |

**Table 6-8. Port Mapping Mnemonics and Functions (continued)**

| VALUE                   | PxMAPy MNEMONIC | INPUT PIN FUNCTION   | OUTPUT PIN FUNCTION          |
|-------------------------|-----------------|--|------------------------------|
| 22                      | PM_TA2.0        | TA2 CCR0 capture input CCI0A   | TA2 CCR0 compare output Out0 |
| 23                      | PM_TA2.1        | TA2 CCR1 capture input CCI1A   | TA2 CCR1 compare output Out1 |
| 24                      | PM_TA3.0        | TA3 CCR0 capture input CCI0A   | TA3 CCR0 compare output Out0 |
| 25                      | PM_TA3.1        | TA3 CCR1 capture input CCI1A   | TA3 CCR1 compare output Out1 |
| 26                      | PM_TACLK        | Timer_A clock input to<br>TA0, TA1, TA2, TA3   | None                         |
|                         | PM_RTCCLK       | None   | RTC_C clock output           |
| 27                      | PM_SDCLK        | SD24_B bit stream clock input/output (direction controlled by SD24_B)  |                              |
| 28                      | PM_SD0DIO       | SD24_B converter-0 bit stream data input/output (direction controlled by SD24_B)   |                              |
| 29                      | PM_SD1DIO       | SD24_B converter-1 bit stream data input/output (direction controlled by SD24_B)   |                              |
| 30                      | PM_SD2DIO       | SD24_B converter-2 bit stream data input/output (direction controlled by SD24_B)   |                              |
| 31(0FFh) <sup>(1)</sup> | PM_ANALOG       | Disables the output driver and the input Schmitt-trigger to prevent parasitic cross currents when applying analog signals. |                              |

(1) The value of the PM\_ANALOG mnemonic is set to 0FFh. The port mapping registers are only 5 bits wide, and the upper bits are ignored, which results in a read out value of 31.

**Table 6-9. Default Mapping**

| PIN NAME                                       |  | PxMAPy MNEMONIC            | INPUT PIN FUNCTION  | OUTPUT PIN FUNCTION          |
|--|--|----------------------------|---|------------------------------|
| PZ   | PN   |                            |   |                              |
| P1.0/PM_TA0.0/<br>VeREF-/A2                    | P1.0/PM_TA0.0/<br>VeREF-/A2                    | PM_TA0.0                   | TA0 CCR0 capture input CCI0A  | TA0 CCR0 compare output Out0 |
| P1.1/PM_TA0.1/<br>VeREF+/A1                    | P1.1/PM_TA0.1/<br>VeREF+/A1                    | PM_TA0.1                   | TA0 CCR1 capture input CCI1A  | TA0 CCR1 compare output Out1 |
| P1.2/PM_UCA0RXD/<br>PM_UCA0SOMI/A0             | P1.2/PM_UCA0RXD/<br>PM_UCA0SOMI/A0             | PM_UCA0RXD,<br>PM_UCA0SOMI | eUSCI_A0 UART RXD<br>(direction controlled by eUSCI – input),<br>eUSCI_A0 SPI slave out master in<br>(direction controlled by eUSCI)                      |                              |
| P1.3/PM_UCA0TXD/<br>PM_UCA0SIMO/R03            | P1.3/PM_UCA0TXD/<br>PM_UCA0SIMO/R03            | PM_UCA0TXD,<br>PM_UCA0SIMO | eUSCI_A0 UART TXD<br>(direction controlled by eUSCI – output),<br>eUSCI_A0 SPI slave in master out<br>(direction controlled by eUSCI)                     |                              |
| P1.4/PM_UCA1RXD/<br>PM_UCA1SOMI/<br>LCDREF/R13 | P1.4/PM_UCA1RXD/<br>PM_UCA1SOMI/<br>LCDREF/R13 | PM_UCA1RXD,<br>PM_UCA1SOMI | eUSCI_A1 UART RXD<br>(direction controlled by eUSCI – input),<br>eUSCI_A1 SPI slave out master in<br>(direction controlled by eUSCI)                      |                              |
| P1.5/PM_UCA1TXD/<br>PM_UCA1SIMO/R23            | P1.5/PM_UCA1TXD/<br>PM_UCA1SIMO/R23            | PM_UCA1TXD,<br>PM_UCA1SIMO | eUSCI_A1 UART TXD<br>(direction controlled by eUSCI – output),<br>eUSCI_A1 SPI slave in master out<br>(direction controlled by eUSCI)                     |                              |
| P1.6/PM_UCA0CLK/<br>COM4                       | P1.6/PM_UCA0CLK/<br>COM4                       | PM_UCA0CLK                 | eUSCI_A0 clock input/output (direction controlled by eUSCI)   |                              |
| P1.7/PM_UCB0CLK/<br>COM5                       | P1.7/PM_UCB0CLK/<br>COM5                       | PM_UCB0CLK                 | eUSCI_B0 clock input/output (direction controlled by eUSCI)   |                              |
| P2.0/PM_UCB0SOMI/<br>PM_UCB0SCL/COM6           | P2.0/PM_UCB0SOMI/<br>PM_UCB0SCL/COM6/S39       | PM_UCB0SOMI,<br>PM_UCB0SCL | eUSCI_B0 SPI slave out master in<br>(direction controlled by eUSCI),<br>eUSCI_B0 I <sup>2</sup> C clock<br>(open drain and direction controlled by eUSCI) |                              |
| P2.1/PM_UCB0SIMO/<br>PM_UCB0SDA/COM7           | P2.1/PM_UCB0SIMO/<br>PM_UCB0SDA/COM7/S38       | PM_UCB0SIMO,<br>PM_UCB0SDA | eUSCI_B0 SPI slave in master out<br>(direction controlled by eUSCI),<br>eUSCI_B0 I <sup>2</sup> C data<br>(open drain and direction controlled by eUSCI)  |                              |
| P2.2/PM_UCA2RXD/<br>PM_UCA2SOMI                | P2.2/PM_UCA2RXD/<br>PM_UCA2SOMI/S37            | PM_UCA2RXD,<br>PM_UCA2SOMI | eUSCI_A2 UART RXD<br>(direction controlled by eUSCI – input),<br>eUSCI_A2 SPI slave out master in<br>(direction controlled by eUSCI)                      |                              |
| P2.3/PM_UCA2TXD/<br>PM_UCA2SIMO                | P2.3/PM_UCA2TXD/<br>PM_UCA2SIMO/S36            | PM_UCA2TXD,<br>PM_UCA2SIMO | eUSCI_A2 UART TXD<br>(direction controlled by eUSCI – output),<br>eUSCI_A2 SPI slave in master out<br>(direction controlled by eUSCI)                     |                              |
| P2.4/PM_UCA1CLK                                | P2.4/PM_UCA1CLK/S35                            | PM_UCA1CLK                 | eUSCI_A1 clock input/output (direction controlled by eUSCI)   |                              |

**Table 6-9. Default Mapping (continued)**

| PIN NAME                    |                                 | PxMAPy MNEMONIC        | INPUT PIN FUNCTION  | OUTPUT PIN FUNCTION          |
|-----------------------------|---------------------------------|------------------------|---|------------------------------|
| PZ                          | PN                              |                        |   |                              |
| P2.5/PM_UCA2CLK             | P2.5/PM_UCA2CLK/S34             | PM_UCA2CLK             | eUSCI_A2 clock input/output (direction controlled by eUSCI)                         |                              |
| P2.6/PM_TA1.0               | P2.6/PM_TA1.0/S33               | PM_TA1.0               | TA1 CCR0 capture input CCI0A  | TA1 CCR0 compare output Out0 |
| P2.7/PM_TA1.1               | P2.7/PM_TA1.1/S32               | PM_TA1.1               | TA1 CCR1 capture input CCI1A  | TA1 CCR1 compare output Out1 |
| P3.0/PM_TA2.0               | P3.0/PM_TA2.0/S31               | PM_TA2.0               | TA2 CCR0 capture input CCI0A  | TA2 CCR0 compare output Out0 |
| P3.1/PM_TA2.1               | P3.1/PM_TA2.1/S30               | PM_TA2.1               | TA2 CCR1 capture input CCI1A  | TA2 CCR1 compare output Out1 |
| P3.2/PM_TACLK/<br>PM_RTCCLK | P3.2/PM_TACLK/<br>PM_RTCCLK/S29 | PM_TACLK,<br>PM_RTCCLK | Timer_A clock input to<br>TA0, TA1, TA2, TA3  | RTC_C clock output           |
| P3.3/PM_TA0.2               | P3.3/PM_TA0.2/S28               | PM_TA0.2               | TA0 CCR2 capture input CCI2A  | TA0 CCR2 compare output Out2 |
| P3.4/PM_SDCLK/S39           | P3.4/PM_SDCLK/S27               | PM_SDCLK               | SD24_B bit stream clock input/output<br>(direction controlled by SD24_B)            |                              |
| P3.5/PM_SD0DIO/S38          | P3.5/PM_SD0DIO/S26              | PM_SD0DIO              | SD24_B converter-0 bit stream data input/output<br>(direction controlled by SD24_B) |                              |
| P3.6/PM_SD1DIO/S37          | P3.6/PM_SD1DIO/S25              | PM_SD1DIO              | SD24_B converter-1 bit stream data input/output<br>(direction controlled by SD24_B) |                              |
| P3.7/PM_SD2DIO/S36          | P3.7/PM_SD2DIO/S24              | PM_SD2DIO              | SD24_B converter-2 bit stream data input/output<br>(direction controlled by SD24_B) |                              |

### 6.12.7 System Module (SYS)

The SYS module handles many of the system functions within the device. These include power on reset (POR) and power up clear (PUC) handling, NMI source selection and management, reset interrupt vector generators, boot strap loader entry mechanisms, as well as, configuration management (device descriptors). It also includes a data exchange mechanism through JTAG called a JTAG mailbox that can be used in the application.

**Table 6-10. System Module Interrupt Vector Registers**

| INTERRUPT VECTOR REGISTER     | INTERRUPT EVENT                | WORD ADDRESS | OFFSET | PRIORITY |
|-------------------------------|--------------------------------|--------------|--------|----------|
| <b>SYSRSTIV, System Reset</b> | No interrupt pending           | 019Eh        | 00h    |          |
|                               | Brownout (BOR)                 |              | 02h    | Highest  |
|                               | RST/NMI (POR)                  |              | 04h    |          |
|                               | DoBOR (BOR)                    |              | 06h    |          |
|                               | Wake up from LPMx.5 (BOR)      |              | 08h    |          |
|                               | Security violation (BOR)       |              | 0Ah    |          |
|                               | SVSL (POR)                     |              | 0Ch    |          |
|                               | SVSH (POR)                     |              | 0Eh    |          |
|                               | SVML_OVP (POR)                 |              | 10h    |          |
|                               | SVMH_OVP (POR)                 |              | 12h    |          |
|                               | DoPOR (POR)                    |              | 14h    |          |
|                               | WDT timeout (PUC)              |              | 16h    |          |
|                               | WDT key violation (PUC)        |              | 18h    |          |
|                               | KEYV flash key violation (PUC) |              | 1Ah    |          |
|                               | Reserved                       |              | 1Ch    |          |
|                               | Peripheral area fetch (PUC)    |              | 1Eh    |          |
|                               | PMM key violation (PUC)        |              | 20h    |          |
| Reserved                      | 22h to 3Eh                     | Lowest       |        |          |

**Table 6-10. System Module Interrupt Vector Registers (continued)**

| INTERRUPT VECTOR REGISTER | INTERRUPT EVENT      | WORD ADDRESS | OFFSET     | PRIORITY |
|---------------------------|----------------------|--------------|------------|----------|
| SYSSNIV, System NMI       | No interrupt pending | 019Ch        | 00h        |          |
|                           | SVMLIFG              |              | 02h        | Highest  |
|                           | SVMHIFG              |              | 04h        |          |
|                           | DLYLIFG              |              | 06h        |          |
|                           | DLYHIFG              |              | 08h        |          |
|                           | VMAIFG               |              | 0Ah        |          |
|                           | JMBINIFG             |              | 0Ch        |          |
|                           | JMBOUTIFG            |              | 0Eh        |          |
|                           | VLRIFG               |              | 10h        |          |
|                           | VLRHIFG              |              | 12h        |          |
|                           | Reserved             |              | 14h to 1Eh | Lowest   |
| SYSUNIV, User NMI         | No interrupt pending | 019Ah        | 00h        |          |
|                           | NMIFG                |              | 02h        | Highest  |
|                           | OFIFG                |              | 04h        |          |
|                           | ACCVIFG              |              | 06h        |          |
|                           | AUXSWNMIFG           |              | 08h        |          |
|                           | Reserved             |              | 0Ah to 1Eh | Lowest   |

### 6.12.8 Watchdog Timer (WDT\_A)

The primary function of the WDT\_A module is to perform a controlled system restart after a software problem occurs. If the selected time interval expires, a system reset is generated. If the watchdog function is not needed in an application, the timer can be configured as an interval timer and can generate interrupts at selected time intervals.

### 6.12.9 DMA Controller

The DMA controller allows movement of data from one memory address to another without CPU intervention. For example, the DMA controller can be used to move data from the ADC10\_A conversion memory to RAM. Using the DMA controller can increase the throughput of peripheral modules. The DMA controller reduces system power consumption by allowing the CPU to remain in sleep mode, without having to awaken to move data to or from a peripheral.

**Table 6-11. DMA Trigger Assignments<sup>(1)</sup>**

| TRIGGER | CHANNEL       |   |   |
|---------|---------------|---|---|
|         | 0             | 1 | 2 |
| 0       | DMAREQ        |   |   |
| 1       | TA0CCR0 CCIFG |   |   |
| 2       | TA0CCR2 CCIFG |   |   |
| 3       | TA1CCR0 CCIFG |   |   |
| 4       | Reserved      |   |   |
| 5       | TA2CCR0 CCIFG |   |   |
| 6       | Reserved      |   |   |
| 7       | TA3CCR0 CCIFG |   |   |
| 8       | Reserved      |   |   |
| 9       | Reserved      |   |   |

(1) Reserved DMA triggers may be used by other devices in the family. Reserved DMA triggers do not cause any DMA trigger event when selected.

**Table 6-11. DMA Trigger Assignments<sup>(1)</sup> (continued)**

| TRIGGER | CHANNEL    |         |         |
|---------|------------|---------|---------|
|         | 0          | 1       | 2       |
| 10      | Reserved   |         |         |
| 11      | Reserved   |         |         |
| 12      | Reserved   |         |         |
| 13      | SD24IFG    |         |         |
| 14      | Reserved   |         |         |
| 15      | Reserved   |         |         |
| 16      | UCA0RXIFG  |         |         |
| 17      | UCA0TXIFG  |         |         |
| 18      | UCA1RXIFG  |         |         |
| 19      | UCA1TXIFG  |         |         |
| 20      | UCA2RXIFG  |         |         |
| 21      | UCA2TXIFG  |         |         |
| 22      | UCB0RXIFG0 |         |         |
| 23      | UCB0TXIFG0 |         |         |
| 24      | ADC10IFG0  |         |         |
| 25      | Reserved   |         |         |
| 26      | Reserved   |         |         |
| 27      | Reserved   |         |         |
| 28      | Reserved   |         |         |
| 29      | MPY ready  |         |         |
| 30      | DMA2IFG    | DMA0IFG | DMA1IFG |
| 31      | Reserved   |         |         |

### 6.12.10 CRC16

The CRC16 module produces a signature based on a sequence of entered data values and can be used for data checking purposes. The CRC16 module signature is based on the CRC-CCITT standard.

### 6.12.11 Hardware Multiplier

The multiplication operation is supported by a dedicated peripheral module. The module performs operations with 32-bit, 24-bit, 16-bit, and 8-bit operands. The module is capable of supporting signed and unsigned multiplication as well as signed and unsigned multiply and accumulate operations.

### 6.12.12 Enhanced Universal Serial Communication Interface (eUSCI)

The eUSCI module is used for serial data communication. The eUSCI module supports synchronous communication protocols such as SPI (3 or 4 pin) and I<sup>2</sup>C, and asynchronous communication protocols such as UART, enhanced UART with automatic baudrate detection, and IrDA.

The eUSCI\_An module supports for SPI (3 or 4 pin), UART, enhanced UART, or IrDA.

The eUSCI\_Bn module supports for SPI (3 or 4 pin) or I<sup>2</sup>C.

Three eUSCI\_A and one eUSCI\_B module are implemented.

### 6.12.13 ADC10\_A

The ADC10\_A module supports fast 10-bit analog-to-digital conversions. The module implements a 10-bit SAR core, sample select control, reference generator, and a conversion results buffer. A window comparator with a lower and upper limit allows CPU independent result monitoring with three window comparator interrupt flags.

### 6.12.14 SD24\_B

The SD24\_B module integrates up to three independent 24-bit sigma-delta A/D converters. Each converter is designed with a fully differential analog input pair and programmable gain amplifier input stage. The converters are based on second-order over-sampling sigma-delta modulators and digital decimation filters. The decimation filters are comb type filters with selectable oversampling ratios of up to 1024.

### 6.12.15 TA0

TA0 is a 16-bit timer/counter (Timer\_A type) with three capture/compare registers. TA0 can support multiple capture/compares, PWM outputs, and interval timing. TA0 also has extensive interrupt capabilities. Interrupts may be generated from the counter on overflow conditions and from each of the capture/compare registers.

**Table 6-12. TA0 Signal Connections**

| DEVICE INPUT SIGNAL | MODULE INPUT NAME | MODULE BLOCK | MODULE OUTPUT SIGNAL | DEVICE OUTPUT SIGNAL                  |
|---------------------|-------------------|--------------|----------------------|---------------------------------------|
| PM_TACLK            | TACLK             | Timer        | NA                   | NA                                    |
| ACLK (internal)     | ACLK              |              |                      |                                       |
| SMCLK (internal)    | SMCLK             |              |                      |                                       |
| PM_TACLK            | INCLK             |              |                      |                                       |
| PM_TA0.0            | CCI0A             | CCR0         | TA0                  | PM_TA0.0                              |
| DVSS                | CCI0B             |              |                      |                                       |
| DVSS                | GND               |              |                      |                                       |
| DVCC                | VCC               |              |                      |                                       |
| PM_TA0.1            | CCI1A             | CCR1         | TA1                  | PM_TA0.1                              |
| ACLK (internal)     | CCI1B             |              |                      | ADC10_A (internal)<br>ADC10SHSx = {1} |
| DVSS                | GND               |              |                      | SD24_B (internal)<br>SD24SCSx = {1}   |
| DVCC                | VCC               |              |                      |                                       |
| PM_TA0.2            | CCI2A             | CCR2         | TA2                  | PM_TA0.2                              |
| DVSS                | CCI2B             |              |                      |                                       |
| DVSS                | GND               |              |                      |                                       |
| DVCC                | VCC               |              |                      |                                       |

### 6.12.16 TA1

TA1 is a 16-bit timer/counter (Timer\_A type) with two capture/compare registers. TA1 can support multiple capture/compares, PWM outputs, and interval timing. TA1 also has extensive interrupt capabilities. Interrupts may be generated from the counter on overflow conditions and from each of the capture/compare registers.

**Table 6-13. TA1 Signal Connections**

| DEVICE INPUT SIGNAL | MODULE INPUT NAME | MODULE BLOCK | MODULE OUTPUT SIGNAL | DEVICE OUTPUT SIGNAL |
|---------------------|-------------------|--------------|----------------------|----------------------|
| PM_TACLK            | TACLK             | Timer        | NA                   | NA                   |
| ACLK (internal)     | ACLK              |              |                      |                      |
| SMCLK (internal)    | SMCLK             |              |                      |                      |
| PM_TACLK            | INCLK             |              |                      |                      |
| PM_TA1.0            | CCI0A             | CCR0         | TA0                  | PM_TA1.0             |
| DVSS                | CCI0B             |              |                      |                      |
| DVSS                | GND               |              |                      |                      |
| DVCC                | VCC               |              |                      |                      |
| PM_TA1.1            | CCI1A             | CCR1         | TA1                  | PM_TA1.1             |
| ACLK (internal)     | CCI1B             |              |                      |                      |
| DVSS                | GND               |              |                      |                      |
| DVCC                | VCC               |              |                      |                      |

### 6.12.17 TA2

TA2 is a 16-bit timer/counter (Timer\_A type) with two capture/compare registers. TA2 can support multiple capture/compares, PWM outputs, and interval timing. TA2 also has extensive interrupt capabilities. Interrupts may be generated from the counter on overflow conditions and from each of the capture/compare registers.

**Table 6-14. TA2 Signal Connections**

| DEVICE INPUT SIGNAL | MODULE INPUT NAME | MODULE BLOCK | MODULE OUTPUT SIGNAL | DEVICE OUTPUT SIGNAL |
|---------------------|-------------------|--------------|----------------------|----------------------|
| PM_TACLK            | TACLK             | Timer        | NA                   | NA                   |
| ACLK (internal)     | ACLK              |              |                      |                      |
| SMCLK (internal)    | SMCLK             |              |                      |                      |
| PM_TACLK            | INCLK             |              |                      |                      |
| PM_TA2.0            | CCI0A             | CCR0         | TA0                  | PM_TA2.0             |
| DVSS                | CCI0B             |              |                      |                      |
| DVSS                | GND               |              |                      |                      |
| DVCC                | VCC               |              |                      |                      |
| PM_TA2.1            | CCI1A             | CCR1         | TA1                  | PM_TA2.1             |
| ACLK (internal)     | CCI1B             |              |                      |                      |
| DVSS                | GND               |              |                      |                      |
| DVCC                | VCC               |              |                      |                      |

### 6.12.18 TA3

TA3 is a 16-bit timer/counter (Timer\_A type) with two capture/compare registers. TA3 can support multiple capture/compares, PWM outputs, and interval timing. TA3 also has extensive interrupt capabilities. Interrupts may be generated from the counter on overflow conditions and from each of the capture/compare registers.

**Table 6-15. TA3 Signal Connections**

| DEVICE INPUT SIGNAL | MODULE INPUT NAME | MODULE BLOCK | MODULE OUTPUT SIGNAL | DEVICE OUTPUT SIGNAL |
|---------------------|-------------------|--------------|----------------------|----------------------|
| PM_TACLK            | TACLK             | Timer        | NA                   |                      |
| ACLK (internal)     | ACLK              |              |                      |                      |
| SMCLK (internal)    | SMCLK             |              |                      |                      |
| PM_TACLK            | INCLK             |              |                      |                      |
| PM_TA3.0            | CCI0A             | CCR0         | TA0                  | PM_TA3.0             |
| DVSS                | CCI0B             |              |                      |                      |
| DVSS                | GND               |              |                      |                      |
| DVCC                | VCC               |              |                      |                      |
| PM_TA3.1            | CCI1A             | CCR1         | TA1                  | PM_TA3.1             |
| ACLK (internal)     | CCI1B             |              |                      |                      |
| DVSS                | GND               |              |                      |                      |
| DVCC                | VCC               |              |                      |                      |



### 6.12.19 SD24\_B Triggers

Table 6-16 shows the input trigger connections to SD24\_B converters from Timer\_A modules and output trigger pulse connection from SD24\_B to ADC10\_A.

**Table 6-16. SD24\_B Input/Output Trigger Connections**

| DEVICE INPUT SIGNAL | MODULE INPUT SIGNAL      | MODULE BLOCK | MODULE OUTPUT SIGNAL | DEVICE OUTPUT SIGNAL                  |
|---------------------|--------------------------|--------------|----------------------|---------------------------------------|
| TA0.1 (internal)    | SD24_B<br>SD24SCSx = {1} | SD24_B       | Trigger Pulse        | ADC10_A (internal)<br>ADC10SHSx = {3} |
| TA2.1 (internal)    | SD24_B<br>SD24SCSx = {2} |              |                      |                                       |
| TA3.1 (internal)    | SD24_B<br>SD24SCSx = {3} |              |                      |                                       |

### 6.12.20 ADC10\_A Triggers

Table 6-17 shows input trigger connections to ADC10\_A from Timer\_A modules and SD24\_B.

**Table 6-17. ADC10\_A Input Trigger Connections**

| DEVICE INPUT SIGNAL                | MODULE INPUT SIGNAL        | MODULE BLOCK |
|------------------------------------|----------------------------|--------------|
| TA0.1 (internal)                   | ADC10_A<br>ADC10SHSx = {1} | ADC10_A      |
| TA3.0 (internal)                   | ADC10_A<br>ADC10SHSx = {2} |              |
| SD24_B<br>trigger pulse (internal) | ADC10_A<br>ADC10SHSx = {3} |              |

### 6.12.21 Real-Time Clock (RTC\_C)

The RTC\_C module can be configured for real-time clock (RTC) or calendar mode providing seconds, hours, day of week, day of month, month, and year. The RTC\_C control and configuration registers are password protected to ensure clock integrity against runaway code. Calendar mode integrates an internal calendar that compensates for months with less than 31 days and includes leap year correction. The RTC\_C also supports flexible alarm functions, offset calibration, and temperature compensation. The RTC\_C on this device operates on dedicated AUXVCC3 supply and supports operation in LPM3.5.

### 6.12.22 REF Voltage Reference

The reference module (REF) is responsible for generation of all critical reference voltages that can be used by the various analog peripherals in the device. These include the ADC10\_A, LCD\_C, and SD24\_B modules.

### 6.12.23 LCD\_C

The LCD\_C driver generates the segment and common signals required to drive a liquid crystal display (LCD). The LCD\_C controller has dedicated data memories to hold segment drive information. Common and segment signals are generated as defined by the mode. Static, 2-mux, 3-mux, 4-mux, up to 8-mux LCDs are supported. The module can provide a LCD voltage independent of the supply voltage with its integrated charge pump. It is possible to control the level of the LCD voltage and thus contrast by software. The module also provides an automatic blinking capability for individual segments in static, 2-mux, 3-mux, and 4-mux modes.

#### **6.12.24 Embedded Emulation Module (EEM) (S Version)**

The EEM supports real-time in-system debugging. The S version of the EEM has the following features:

- Three hardware triggers or breakpoints on memory access
- One hardware trigger or breakpoint on CPU register write access
- Up to four hardware triggers can be combined to form complex triggers or breakpoints
- One cycle counter
- Clock control on module level

## 6.12.25 Peripheral File Map

**Table 6-18. Peripherals**

| MODULE NAME  | BASE ADDRESS | OFFSET ADDRESS RANGE |
|--|--------------|----------------------|
| Special Functions (see <a href="#">Table 6-19</a> )                            | 0100h        | 000h-01Fh            |
| PMM (see <a href="#">Table 6-20</a> )  | 0120h        | 000h-01Fh            |
| Flash Control (see <a href="#">Table 6-21</a> )                                | 0140h        | 000h-00Fh            |
| CRC16 (see <a href="#">Table 6-22</a> )  | 0150h        | 000h-007h            |
| RAM Control (see <a href="#">Table 6-23</a> )                                  | 0158h        | 000h-001h            |
| Watchdog (see <a href="#">Table 6-24</a> )                                     | 015Ch        | 000h-001h            |
| UCS (see <a href="#">Table 6-25</a> )  | 0160h        | 000h-01Fh            |
| SYS (see <a href="#">Table 6-26</a> )  | 0180h        | 000h-01Fh            |
| Shared Reference (see <a href="#">Table 6-27</a> )                             | 01B0h        | 000h-001h            |
| Port Mapping Control (see <a href="#">Table 6-28</a> )                         | 01C0h        | 000h-007h            |
| Port Mapping Port P1 (see <a href="#">Table 6-29</a> )                         | 01C8h        | 000h-007h            |
| Port Mapping Port P2 (see <a href="#">Table 6-30</a> )                         | 01D0h        | 000h-007h            |
| Port Mapping Port P3 (see <a href="#">Table 6-31</a> )                         | 01D8h        | 000h-007h            |
| Port P1, P2 (see <a href="#">Table 6-32</a> )                                  | 0200h        | 000h-01Fh            |
| Port P3, P4 (see <a href="#">Table 6-33</a> )                                  | 0220h        | 000h-00Bh            |
| Port P5, P6 (see <a href="#">Table 6-34</a> )                                  | 0240h        | 000h-00Bh            |
| Port P7, P8 (see <a href="#">Table 6-35</a> )<br>(not available in PN package) | 0260h        | 000h-00Bh            |
| Port P9 (see <a href="#">Table 6-36</a> )<br>(not available in PN package)     | 0280h        | 000h-00Bh            |
| Port PJ (see <a href="#">Table 6-37</a> )                                      | 0320h        | 000h-01Fh            |
| Timer TA0 (see <a href="#">Table 6-38</a> )                                    | 0340h        | 000h-03Fh            |
| Timer TA1 (see <a href="#">Table 6-39</a> )                                    | 0380h        | 000h-03Fh            |
| Timer TA2 (see <a href="#">Table 6-40</a> )                                    | 0400h        | 000h-03Fh            |
| Timer TA3 (see <a href="#">Table 6-41</a> )                                    | 0440h        | 000h-03Fh            |
| Backup Memory (see <a href="#">Table 6-42</a> )                                | 0480h        | 000h-00Fh            |
| RTC_C (see <a href="#">Table 6-43</a> )  | 04A0h        | 000h-01Fh            |
| 32-bit Hardware Multiplier (see <a href="#">Table 6-44</a> )                   | 04C0h        | 000h-02Fh            |
| DMA General Control (see <a href="#">Table 6-45</a> )                          | 0500h        | 000h-00Fh            |
| DMA Channel 0 (see <a href="#">Table 6-46</a> )                                | 0500h        | 010h-01Fh            |
| DMA Channel 1 (see <a href="#">Table 6-47</a> )                                | 0500h        | 020h-02Fh            |
| DMA Channel 2 (see <a href="#">Table 6-48</a> )                                | 0500h        | 030h-03Fh            |
| eUSCI_A0 (see <a href="#">Table 6-49</a> )                                     | 05C0h        | 000h-01Fh            |
| eUSCI_A1 (see <a href="#">Table 6-50</a> )                                     | 05E0h        | 000h-01Fh            |
| eUSCI_A2 (see <a href="#">Table 6-51</a> )                                     | 0600h        | 000h-01Fh            |
| eUSCI_B0 (see <a href="#">Table 6-52</a> )                                     | 0640h        | 000h-02Fh            |
| ADC10_A (see <a href="#">Table 6-53</a> )                                      | 0740h        | 000h-01Fh            |
| SD24_B (see <a href="#">Table 6-54</a> )                                       | 0800h        | 000h-06Fh            |
| Auxiliary Supply (see <a href="#">Table 6-48</a> )                             | 09E0h        | 000h-01Fh            |
| LCD_C (see <a href="#">Table 6-56</a> )  | 0A00h        | 000h-05Fh            |

**Table 6-19. Special Function Registers (Base Address: 0100h)**

| REGISTER DESCRIPTION  | REGISTER | OFFSET |
|-----------------------|----------|--------|
| SFR interrupt enable  | SFRIE1   | 00h    |
| SFR interrupt flag    | SFRIFG1  | 02h    |
| SFR reset pin control | SFRRPCR  | 04h    |

**Table 6-20. PMM Registers (Base Address: 0120h)**

| REGISTER DESCRIPTION                | REGISTER | OFFSET |
|-------------------------------------|----------|--------|
| PMM Control 0                       | PMMCTL0  | 00h    |
| PMM control 1                       | PMMCTL1  | 02h    |
| SVS high side control               | SVSMHCTL | 04h    |
| SVS low side control                | SVSMLCTL | 06h    |
| PMM interrupt flags                 | PMMIFG   | 0Ch    |
| PMM interrupt enable                | PMMIE    | 0Eh    |
| PMM Power Mode 5 control register 0 | PM5CTL0  | 10h    |

**Table 6-21. Flash Control Registers (Base Address: 0140h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| Flash control 1      | FCTL1    | 00h    |
| Flash control 3      | FCTL3    | 04h    |
| Flash control 4      | FCTL4    | 06h    |

**Table 6-22. CRC16 Registers (Base Address: 0150h)**

| REGISTER DESCRIPTION        | REGISTER  | OFFSET |
|-----------------------------|-----------|--------|
| CRC data input              | CRC16DI   | 00h    |
| CRC data input reverse byte | CRC16DIRB | 02h    |
| CRC result                  | CRCINIRES | 04h    |
| CRC result reverse byte     | CRCRESR   | 06h    |

**Table 6-23. RAM Control Registers (Base Address: 0158h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| RAM control 0        | RCCTL0   | 00h    |

**Table 6-24. Watchdog Registers (Base Address: 015Ch)**

| REGISTER DESCRIPTION   | REGISTER | OFFSET |
|------------------------|----------|--------|
| Watchdog timer control | WDTCTL   | 00h    |

**Table 6-25. UCS Registers (Base Address: 0160h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| UCS control 0        | UCSCTL0  | 00h    |
| UCS control 1        | UCSCTL1  | 02h    |
| UCS control 2        | UCSCTL2  | 04h    |
| UCS control 3        | UCSCTL3  | 06h    |
| UCS control 4        | UCSCTL4  | 08h    |
| UCS control 5        | UCSCTL5  | 0Ah    |
| UCS control 6        | UCSCTL6  | 0Ch    |
| UCS control 7        | UCSCTL7  | 0Eh    |
| UCS control 8        | UCSCTL8  | 10h    |

**Table 6-26. SYS Registers (Base Address: 0180h)**

| REGISTER DESCRIPTION                | REGISTER  | OFFSET |
|-------------------------------------|-----------|--------|
| System control                      | SYSCTL    | 00h    |
| Bootstrap loader configuration area | SYSBSLC   | 02h    |
| JTAG mailbox control                | SYSJMBC   | 06h    |
| JTAG mailbox input 0                | SYSJMBI0  | 08h    |
| JTAG mailbox input 1                | SYSJMBI1  | 0Ah    |
| JTAG mailbox output 0               | SYSJMBO0  | 0Ch    |
| JTAG mailbox output 1               | SYSJMBO1  | 0Eh    |
| Bus Error vector generator          | SYSBERRIV | 18h    |
| User NMI vector generator           | SYSUNIV   | 1Ah    |
| System NMI vector generator         | SYSSNIV   | 1Ch    |
| Reset vector generator              | SYSRSTIV  | 1Eh    |

**Table 6-27. Shared Reference Registers (Base Address: 01B0h)**

| REGISTER DESCRIPTION     | REGISTER | OFFSET |
|--------------------------|----------|--------|
| Shared reference control | REFCTL   | 00h    |

**Table 6-28. Port Mapping Controller (Base Address: 01C0h)**

| REGISTER DESCRIPTION           | REGISTER | OFFSET |
|--------------------------------|----------|--------|
| Port mapping password register | PMAPPWD  | 00h    |
| Port mapping control register  | PMAPCTL  | 02h    |

**Table 6-29. Port Mapping for Port P1 (Base Address: 01C8h)**

| REGISTER DESCRIPTION       | REGISTER | OFFSET |
|----------------------------|----------|--------|
| Port P1.0 mapping register | P1MAP0   | 00h    |
| Port P1.1 mapping register | P1MAP1   | 01h    |
| Port P1.2 mapping register | P1MAP2   | 02h    |
| Port P1.3 mapping register | P1MAP3   | 03h    |
| Port P1.4 mapping register | P1MAP4   | 04h    |
| Port P1.5 mapping register | P1MAP5   | 05h    |
| Port P1.6 mapping register | P1MAP6   | 06h    |
| Port P1.7 mapping register | P1MAP7   | 07h    |

**Table 6-30. Port Mapping for Port P2 (Base Address: 01D0h)**

| REGISTER DESCRIPTION       | REGISTER | OFFSET |
|----------------------------|----------|--------|
| Port P2.0 mapping register | P2MAP0   | 00h    |
| Port P2.1 mapping register | P2MAP2   | 01h    |
| Port P2.2 mapping register | P2MAP2   | 02h    |
| Port P2.3 mapping register | P2MAP3   | 03h    |
| Port P2.4 mapping register | P2MAP4   | 04h    |
| Port P2.5 mapping register | P2MAP5   | 05h    |
| Port P2.6 mapping register | P2MAP6   | 06h    |
| Port P2.7 mapping register | P2MAP7   | 07h    |

**Table 6-31. Port Mapping for Port P3 (Base Address: 01D8h)**

| REGISTER DESCRIPTION       | REGISTER | OFFSET |
|----------------------------|----------|--------|
| Port P3.0 mapping register | P3MAP0   | 00h    |
| Port P3.1 mapping register | P3MAP3   | 01h    |
| Port P3.2 mapping register | P3MAP2   | 02h    |
| Port P3.3 mapping register | P3MAP3   | 03h    |
| Port P3.4 mapping register | P3MAP4   | 04h    |
| Port P3.5 mapping register | P3MAP5   | 05h    |
| Port P3.6 mapping register | P3MAP6   | 06h    |
| Port P3.7 mapping register | P3MAP7   | 07h    |

**Table 6-32. Port P1, P2 Registers (Base Address: 0200h)**

| REGISTER DESCRIPTION           | REGISTER | OFFSET |
|--------------------------------|----------|--------|
| Port P1 input                  | P1IN     | 00h    |
| Port P1 output                 | P1OUT    | 02h    |
| Port P1 direction              | P1DIR    | 04h    |
| Port P1 pullup/pulldown enable | P1REN    | 06h    |
| Port P1 drive strength         | P1DS     | 08h    |
| Port P1 selection              | P1SEL    | 0Ah    |
| Port P1 interrupt vector word  | P1IV     | 0Eh    |
| Port P1 interrupt edge select  | P1IES    | 18h    |
| Port P1 interrupt enable       | P1IE     | 1Ah    |
| Port P1 interrupt flag         | P1IFG    | 1Ch    |
| Port P2 input                  | P2IN     | 01h    |
| Port P2 output                 | P2OUT    | 03h    |
| Port P2 direction              | P2DIR    | 05h    |
| Port P2 pullup/pulldown enable | P2REN    | 07h    |
| Port P2 drive strength         | P2DS     | 09h    |
| Port P2 selection              | P2SEL    | 0Bh    |
| Port P2 interrupt vector word  | P2IV     | 1Eh    |
| Port P2 interrupt edge select  | P2IES    | 19h    |
| Port P2 interrupt enable       | P2IE     | 1Bh    |
| Port P2 interrupt flag         | P2IFG    | 1Dh    |

**Table 6-33. Port P3, P4 Registers (Base Address: 0220h)**

| REGISTER DESCRIPTION           | REGISTER | OFFSET |
|--------------------------------|----------|--------|
| Port P3 input                  | P3IN     | 00h    |
| Port P3 output                 | P3OUT    | 02h    |
| Port P3 direction              | P3DIR    | 04h    |
| Port P3 pullup/pulldown enable | P3REN    | 06h    |
| Port P3 drive strength         | P3DS     | 08h    |
| Port P3 selection              | P3SEL    | 0Ah    |
| Port P4 input                  | P4IN     | 01h    |
| Port P4 output                 | P4OUT    | 03h    |
| Port P4 direction              | P4DIR    | 05h    |
| Port P4 pullup/pulldown enable | P4REN    | 07h    |
| Port P4 drive strength         | P4DS     | 09h    |
| Port P4 selection              | P4SEL    | 0Bh    |

**Table 6-34. Port P5, P6 Registers (Base Address: 0240h)**

| REGISTER DESCRIPTION           | REGISTER | OFFSET |
|--------------------------------|----------|--------|
| Port P5 input                  | P5IN     | 00h    |
| Port P5 output                 | P5OUT    | 02h    |
| Port P5 direction              | P5DIR    | 04h    |
| Port P5 pullup/pulldown enable | P5REN    | 06h    |
| Port P5 drive strength         | P5DS     | 08h    |
| Port P5 selection              | P5SEL    | 0Ah    |
| Port P6 input                  | P6IN     | 01h    |
| Port P6 output                 | P6OUT    | 03h    |
| Port P6 direction              | P6DIR    | 05h    |
| Port P6 pullup/pulldown enable | P6REN    | 07h    |
| Port P6 drive strength         | P6DS     | 09h    |
| Port P6 selection              | P6SEL    | 0Bh    |

**Table 6-35. Port P7, P8 Registers (Base Address: 0260h)**

| REGISTER DESCRIPTION           | REGISTER | OFFSET |
|--------------------------------|----------|--------|
| Port P7 input                  | P7IN     | 00h    |
| Port P7 output                 | P7OUT    | 02h    |
| Port P7 direction              | P7DIR    | 04h    |
| Port P7 pullup/pulldown enable | P7REN    | 06h    |
| Port P7 drive strength         | P7DS     | 08h    |
| Port P7 selection              | P7SEL    | 0Ah    |
| Port P8 input                  | P8IN     | 01h    |
| Port P8 output                 | P8OUT    | 03h    |
| Port P8 direction              | P8DIR    | 05h    |
| Port P8 pullup/pulldown enable | P8REN    | 07h    |
| Port P8 drive strength         | P8DS     | 09h    |
| Port P8 selection              | P8SEL    | 0Bh    |



**Table 6-36. Port P9 Registers (Base Address: 0280h)**

| REGISTER DESCRIPTION           | REGISTER | OFFSET |
|--------------------------------|----------|--------|
| Port P9 input                  | P9IN     | 00h    |
| Port P9 output                 | P9OUT    | 02h    |
| Port P9 direction              | P9DIR    | 04h    |
| Port P9 pullup/pulldown enable | P9REN    | 06h    |
| Port P9 drive strength         | P9DS     | 08h    |
| Port P9 selection              | P9SEL    | 0Ah    |

**Table 6-37. Port J Registers (Base Address: 0320h)**

| REGISTER DESCRIPTION           | REGISTER | OFFSET |
|--------------------------------|----------|--------|
| Port PJ input                  | PJIN     | 00h    |
| Port PJ output                 | PJOUT    | 02h    |
| Port PJ direction              | PJDIR    | 04h    |
| Port PJ pullup/pulldown enable | PJREN    | 06h    |
| Port PJ drive strength         | PJDS     | 08h    |
| Port PJ selection              | PJSEL    | 0Ah    |

**Table 6-38. TA0 Registers (Base Address: 0340h)**

| REGISTER DESCRIPTION       | REGISTER | OFFSET |
|----------------------------|----------|--------|
| TA0 control                | TA0CTL   | 00h    |
| Capture/compare control 0  | TA0CCTL0 | 02h    |
| Capture/compare control 1  | TA0CCTL1 | 04h    |
| Capture/compare control 2  | TA0CCTL2 | 06h    |
| TA0 counter register       | TA0R     | 10h    |
| Capture/compare register 0 | TA0CCR0  | 12h    |
| Capture/compare register 1 | TA0CCR1  | 14h    |
| Capture/compare register 2 | TA0CCR2  | 16h    |
| TA0 expansion register 0   | TA0EX0   | 20h    |
| TA0 interrupt vector       | TA0IV    | 2Eh    |

**Table 6-39. TA1 Registers (Base Address: 0380h)**

| REGISTER DESCRIPTION       | REGISTER | OFFSET |
|----------------------------|----------|--------|
| TA1 control                | TA1CTL   | 00h    |
| Capture/compare control 0  | TA1CCTL0 | 02h    |
| Capture/compare control 1  | TA1CCTL1 | 04h    |
| TA1 counter register       | TA1R     | 10h    |
| Capture/compare register 0 | TA1CCR0  | 12h    |
| Capture/compare register 1 | TA1CCR1  | 14h    |
| TA1 expansion register 0   | TA1EX0   | 20h    |
| TA1 interrupt vector       | TA1IV    | 2Eh    |

**Table 6-40. TA2 Registers (Base Address: 0400h)**

| REGISTER DESCRIPTION       | REGISTER | OFFSET |
|----------------------------|----------|--------|
| TA2 control                | TA2CTL   | 00h    |
| Capture/compare control 0  | TA2CCTL0 | 02h    |
| Capture/compare control 1  | TA2CCTL1 | 04h    |
| TA2 counter register       | TA2R     | 10h    |
| Capture/compare register 0 | TA2CCR0  | 12h    |
| Capture/compare register 1 | TA2CCR1  | 14h    |
| TA2 expansion register 0   | TA2EX0   | 20h    |
| TA2 interrupt vector       | TA2IV    | 2Eh    |

**Table 6-41. TA3 Registers (Base Address: 0440h)**

| REGISTER DESCRIPTION       | REGISTER | OFFSET |
|----------------------------|----------|--------|
| TA3 control                | TA3CTL   | 00h    |
| Capture/compare control 0  | TA3CCTL0 | 02h    |
| Capture/compare control 1  | TA3CCTL1 | 04h    |
| TA3 counter register       | TA3R     | 10h    |
| Capture/compare register 0 | TA3CCR0  | 12h    |
| Capture/compare register 1 | TA3CCR1  | 14h    |
| TA3 expansion register 0   | TA3EX0   | 20h    |
| TA3 interrupt vector       | TA3IV    | 2Eh    |

**Table 6-42. Backup Memory Registers (Base Address: 0480h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| Backup Memory 0      | BAKMEM0  | 00h    |
| Backup Memory 1      | BAKMEM1  | 02h    |
| Backup Memory 2      | BAKMEM2  | 04h    |
| Backup Memory 3      | BAKMEM3  | 06h    |

**Table 6-43. RTC\_C Registers (Base Address: 04A0h)**

| REGISTER DESCRIPTION              | REGISTER  | OFFSET |
|-----------------------------------|-----------|--------|
| RTC control 0                     | RTCCTL0   | 00h    |
| RTC password                      | RTCPWD    | 01h    |
| RTC control 1                     | RTCCTL1   | 02h    |
| RTC control 3                     | RTCCTL3   | 03h    |
| RTC offset calibration            | RTCOCAL   | 04h    |
| RTC temperature compensation      | RTCTCMP   | 06h    |
| RTC prescaler 0 control           | RTCPS0CTL | 08h    |
| RTC prescaler 1 control           | RTCPS1CTL | 0Ah    |
| RTC prescaler 0                   | RTCPS0    | 0Ch    |
| RTC prescaler 1                   | RTCPS1    | 0Dh    |
| RTC interrupt vector word         | RTCIV     | 0Eh    |
| RTC seconds                       | RTCSEC    | 10h    |
| RTC minutes                       | RTCMIN    | 11h    |
| RTC hours                         | RTCHOUR   | 12h    |
| RTC day of week                   | RTCDOW    | 13h    |
| RTC days                          | RTCDAY    | 14h    |
| RTC month                         | RTCMON    | 15h    |
| RTC year                          | RTCYEAR   | 16h    |
| RTC alarm minutes                 | RTCAMIN   | 18h    |
| RTC alarm hours                   | RTCAHOUR  | 19h    |
| RTC alarm day of week             | RTCADOW   | 1Ah    |
| RTC alarm days                    | RTCADAY   | 1Bh    |
| Binary-to-BCD conversion register | BIN2BCD   | 1Ch    |
| BCD-to-Binary conversion register | BCD2BIN   | 1Eh    |

**Table 6-44. 32-Bit Hardware Multiplier Registers (Base Address: 04C0h)**

| REGISTER DESCRIPTION                                    | REGISTER  | OFFSET |
|---|-----------|--------|
| 16-bit operand 1 – multiply                             | MPY       | 00h    |
| 16-bit operand 1 – signed multiply                      | MPYS      | 02h    |
| 16-bit operand 1 – multiply accumulate                  | MAC       | 04h    |
| 16-bit operand 1 – signed multiply accumulate           | MACS      | 06h    |
| 16-bit operand 2  | OP2       | 08h    |
| 16 × 16 result low word                                 | RESLO     | 0Ah    |
| 16 × 16 result high word                                | RESHI     | 0Ch    |
| 16 × 16 sum extension register                          | SUMEXT    | 0Eh    |
| 32-bit operand 1 – multiply low word                    | MPY32L    | 10h    |
| 32-bit operand 1 – multiply high word                   | MPY32H    | 12h    |
| 32-bit operand 1 – signed multiply low word             | MPYS32L   | 14h    |
| 32-bit operand 1 – signed multiply high word            | MPYS32H   | 16h    |
| 32-bit operand 1 – multiply accumulate low word         | MAC32L    | 18h    |
| 32-bit operand 1 – multiply accumulate high word        | MAC32H    | 1Ah    |
| 32-bit operand 1 – signed multiply accumulate low word  | MACS32L   | 1Ch    |
| 32-bit operand 1 – signed multiply accumulate high word | MACS32H   | 1Eh    |
| 32-bit operand 2 – low word                             | OP2L      | 20h    |
| 32-bit operand 2 – high word                            | OP2H      | 22h    |
| 32 × 32 result 0 – least significant word               | RES0      | 24h    |
| 32 × 32 result 1  | RES1      | 26h    |
| 32 × 32 result 2  | RES2      | 28h    |
| 32 × 32 result 3 – most significant word                | RES3      | 2Ah    |
| MPY32 control register 0                                | MPY32CTL0 | 2Ch    |

**Table 6-45. DMA General Control Registers (Base Address: 0500h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| DMA module control 0 | DMACTL0  | 00h    |
| DMA module control 1 | DMACTL1  | 02h    |
| DMA module control 2 | DMACTL2  | 04h    |
| DMA module control 3 | DMACTL3  | 06h    |
| DMA module control 4 | DMACTL4  | 08h    |
| DMA interrupt vector | DMAIV    | 0Eh    |

**Table 6-46. DMA Channel 0 Registers (Base Address: 0500h)**

| REGISTER DESCRIPTION                   | REGISTER | OFFSET |
|--|----------|--------|
| DMA channel 0 control                  | DMA0CTL  | 10h    |
| DMA channel 0 source address low       | DMA0SAL  | 12h    |
| DMA channel 0 source address high      | DMA0SAH  | 14h    |
| DMA channel 0 destination address low  | DMA0DAL  | 16h    |
| DMA channel 0 destination address high | DMA0DAH  | 18h    |
| DMA channel 0 transfer size            | DMA0SZ   | 1Ah    |

**Table 6-47. DMA Channel 1 Registers (Base Address: 0500h)**

| REGISTER DESCRIPTION                   | REGISTER | OFFSET |
|--|----------|--------|
| DMA channel 1 control                  | DMA1CTL  | 20h    |
| DMA channel 1 source address low       | DMA1SAL  | 22h    |
| DMA channel 1 source address high      | DMA1SAH  | 24h    |
| DMA channel 1 destination address low  | DMA1DAL  | 26h    |
| DMA channel 1 destination address high | DMA1DAH  | 28h    |
| DMA channel 1 transfer size            | DMA1SZ   | 2Ah    |

**Table 6-48. DMA Channel 2 Registers (Base Address: 0500h)**

| REGISTER DESCRIPTION                   | REGISTER | OFFSET |
|--|----------|--------|
| DMA channel 2 control                  | DMA2CTL  | 30h    |
| DMA channel 2 source address low       | DMA2SAL  | 32h    |
| DMA channel 2 source address high      | DMA2SAH  | 34h    |
| DMA channel 2 destination address low  | DMA2DAL  | 36h    |
| DMA channel 2 destination address high | DMA2DAH  | 38h    |
| DMA channel 2 transfer size            | DMA2SZ   | 3Ah    |

**Table 6-49. eUSCI\_A0 Registers (Base Address: 05C0h)**

| REGISTER DESCRIPTION          | REGISTER   | OFFSET |
|-------------------------------|------------|--------|
| eUSCI_A control word 0        | UCA0CTLW0  | 00h    |
| eUSCI_A control word 1        | UCA0CTLW1  | 02h    |
| eUSCI_A baud rate 0           | UCA0BR0    | 06h    |
| eUSCI_A baud rate 1           | UCA0BR1    | 07h    |
| eUSCI_A modulation control    | UCA0MCTLW  | 08h    |
| eUSCI_A status                | UCA0STAT   | 0Ah    |
| eUSCI_A receive buffer        | UCA0RXBUF  | 0Ch    |
| eUSCI_A transmit buffer       | UCA0TXBUF  | 0Eh    |
| eUSCI_A LIN control           | UCA0ABCTL  | 10h    |
| eUSCI_A IrDA transmit control | UCA0IRTCTL | 12h    |
| eUSCI_A IrDA receive control  | UCA0IRRCTL | 13h    |
| eUSCI_A interrupt enable      | UCA0IE     | 1Ah    |
| eUSCI_A interrupt flags       | UCA0IFG    | 1Ch    |
| eUSCI_A interrupt vector word | UCA0IV     | 1Eh    |

**Table 6-50. eUSCI\_A1 Registers (Base Address:05E0h)**

| REGISTER DESCRIPTION          | REGISTER   | OFFSET |
|-------------------------------|------------|--------|
| eUSCI_A control word 0        | UCA1CTLW0  | 00h    |
| eUSCI_A control word 1        | UCA1CTLW1  | 02h    |
| eUSCI_A baud rate 0           | UCA1BR0    | 06h    |
| eUSCI_A baud rate 1           | UCA1BR1    | 07h    |
| eUSCI_A modulation control    | UCA1MCTLW  | 08h    |
| eUSCI_A status                | UCA1STAT   | 0Ah    |
| eUSCI_A receive buffer        | UCA1RXBUF  | 0Ch    |
| eUSCI_A transmit buffer       | UCA1TXBUF  | 0Eh    |
| eUSCI_A LIN control           | UCA1ABCTL  | 10h    |
| eUSCI_A IrDA transmit control | UCA1IRTCTL | 12h    |
| eUSCI_A IrDA receive control  | UCA1IRRCTL | 13h    |
| eUSCI_A interrupt enable      | UCA1IE     | 1Ah    |
| eUSCI_A interrupt flags       | UCA1IFG    | 1Ch    |
| eUSCI_A interrupt vector word | UCA1IV     | 1Eh    |

**Table 6-51. eUSCI\_A2 Registers (Base Address:0600h)**

| REGISTER DESCRIPTION          | REGISTER   | OFFSET |
|-------------------------------|------------|--------|
| eUSCI_A control word 0        | UCA2CTLW0  | 00h    |
| eUSCI_A control word 1        | UCA2CTLW1  | 02h    |
| eUSCI_A baud rate 0           | UCA2BR0    | 06h    |
| eUSCI_A baud rate 1           | UCA2BR1    | 07h    |
| eUSCI_A modulation control    | UCA2MCTLW  | 08h    |
| eUSCI_A status                | UCA2STAT   | 0Ah    |
| eUSCI_A receive buffer        | UCA2RXBUF  | 0Ch    |
| eUSCI_A transmit buffer       | UCA2TXBUF  | 0Eh    |
| eUSCI_A LIN control           | UCA2ABCTL  | 10h    |
| eUSCI_A IrDA transmit control | UCA2IRTCTL | 12h    |
| eUSCI_A IrDA receive control  | UCA2IRRCTL | 13h    |
| eUSCI_A interrupt enable      | UCA2IE     | 1Ah    |
| eUSCI_A interrupt flags       | UCA2IFG    | 1Ch    |
| eUSCI_A interrupt vector word | UCA2IV     | 1Eh    |

**Table 6-52. eUSCI\_B Registers (Base Address: 0640h)**

| REGISTER DESCRIPTION                   | REGISTER    | OFFSET |
|--|-------------|--------|
| eUSCI_B control word 0                 | UCB0CTLW0   | 00h    |
| eUSCI_B control word 1                 | UCB0CTLW1   | 02h    |
| eUSCI_B bit rate 0                     | UCB0BR0     | 06h    |
| eUSCI_B bit rate 1                     | UCB0BR1     | 07h    |
| eUSCI_B status word                    | UCB0STATW   | 08h    |
| eUSCI_B byte counter threshold         | UCB0TBCNT   | 0Ah    |
| eUSCI_B receive buffer                 | UCB0RXBUF   | 0Ch    |
| eUSCI_B transmit buffer                | UCB0TXBUF   | 0Eh    |
| eUSCI_B I <sup>2</sup> C own address 0 | UCB0I2COA0  | 14h    |
| eUSCI_B I <sup>2</sup> C own address 1 | UCB0I2COA1  | 16h    |
| eUSCI_B I <sup>2</sup> C own address 2 | UCB0I2COA2  | 18h    |
| eUSCI_B I <sup>2</sup> C own address 3 | UCB0I2COA3  | 1Ah    |
| eUSCI_B received address               | UCB0ADDRX   | 1Ch    |
| eUSCI_B address mask                   | UCB0ADDMASK | 1Eh    |
| eUSCI I <sup>2</sup> C slave address   | UCB0I2CSA   | 20h    |
| eUSCI interrupt enable                 | UCB0IE      | 2Ah    |
| eUSCI interrupt flags                  | UCB0IFG     | 2Ch    |
| eUSCI interrupt vector word            | UCB0IV      | 2Eh    |

**Table 6-53. ADC10\_A Registers (Base Address: 0740h)**

| REGISTER DESCRIPTION                     | REGISTER   | OFFSET |
|--|------------|--------|
| ADC10_A Control register 0               | ADC10CTL0  | 00h    |
| ADC10_A Control register 1               | ADC10CTL1  | 02h    |
| ADC10_A Control register 2               | ADC10CTL2  | 04h    |
| ADC10_A Window Comparator Low Threshold  | ADC10LO    | 06h    |
| ADC10_A Window Comparator High Threshold | ADC10HI    | 08h    |
| ADC10_A Memory Control Register 0        | ADC10MCTL0 | 0Ah    |
| ADC10_A Conversion Memory Register       | ADC10MCTL0 | 12h    |
| ADC10_A Interrupt Enable                 | ADC10IE    | 1Ah    |
| ADC10_A Interrupt Flags                  | ADC10IGH   | 1Ch    |
| ADC10_A Interrupt Vector Word            | ADC10IV    | 1Eh    |

**Table 6-54. SD24\_B Registers (Base Address: 0800h)**

| REGISTER DESCRIPTION                                    | REGISTER    | OFFSET |
|---|-------------|--------|
| SD24_B Control 0 register                               | SD24BCTL0   | 00h    |
| SD24_B Control 1 register                               | SD24BCTL1   | 02h    |
| SD24_B Trigger Control register                         | SD24BTRGCTL | 04h    |
| SD24_B Trigger OSR Control register                     | SD24BTRGOSR | 06h    |
| SD24_B Trigger Preload register                         | SD24BTRGPRE | 08h    |
| SD24_B interrupt flag register                          | SD24BIFG    | 0Ah    |
| SD24_B interrupt enable register                        | SD24BIE     | 0Ch    |
| SD24_B Interrupt Vector register                        | SD24BIV     | 0Eh    |
| SD24_B converter 0 Control register                     | SD24BCCTL0  | 10h    |
| SD24_B converter 0 Input Control register               | SD24BINCTL0 | 12h    |
| SD24_B converter 0 OSR Control register                 | SD24BOSR0   | 14h    |
| SD24_B converter 0 Preload register                     | SD24BPRE0   | 16h    |
| SD24_B converter 1 Control register                     | SD24BCCTL1  | 18h    |
| SD24_B Converter 1 Input Control register               | SD24BINCTL1 | 1Ah    |
| SD24_B Converter 1 OSR Control register                 | SD24BOSR1   | 1Ch    |
| SD24_B Converter 1 Preload register                     | SD24BPRE1   | 1Eh    |
| SD24_B Converter 2 Control register                     | SD24BCCTL2  | 20h    |
| SD24_B Converter 2 Input Control register               | SD24BINCTL2 | 22h    |
| SD24_B Converter 2 OSR Control register                 | SD24BOSR2   | 24h    |
| SD24_B Converter 2 Preload register                     | SD24BPRE2   | 26h    |
| SD24_B Converter 0 Conversion Memory Low Word register  | SD24BMEML0  | 50h    |
| SD24_B Converter 0 Conversion Memory High Word register | SD24BMEMH0  | 52h    |
| SD24_B Converter 1 Conversion Memory Low Word register  | SD24BMEML1  | 54h    |
| SD24_B Converter 1 Conversion Memory High Word register | SD24BMEMH1  | 56h    |
| SD24_B Converter 2 Conversion Memory Low Word register  | SD24BMEML2  | 58h    |
| SD24_B Converter 2 Conversion Memory High Word register | SD24BMEMH2  | 5Ah    |

**Table 6-55. Auxiliary Supplies Registers (Base Address: 09E0h)**

| REGISTER DESCRIPTION                | REGISTER  | OFFSET |
|-------------------------------------|-----------|--------|
| Auxiliary Supply Control 0 register | AUXCTL0   | 00h    |
| Auxiliary Supply Control 1 register | AUXCTL1   | 02h    |
| Auxiliary Supply Control 2 register | AUXCTL2   | 04h    |
| AUX2 Charger Control                | AUX2CHCTL | 12h    |
| AUX3 Charger Control                | AUX3CHCTL | 14h    |
| AUX ADC Control                     | AUXADCCTL | 16h    |
| AUX Interrupt Flag                  | AUXIFG    | 1Ah    |
| AUX Interrupt Enable                | AUXIE     | 1Ch    |
| AUX Interrupt Vector Word           | AUXIV     | 1Eh    |

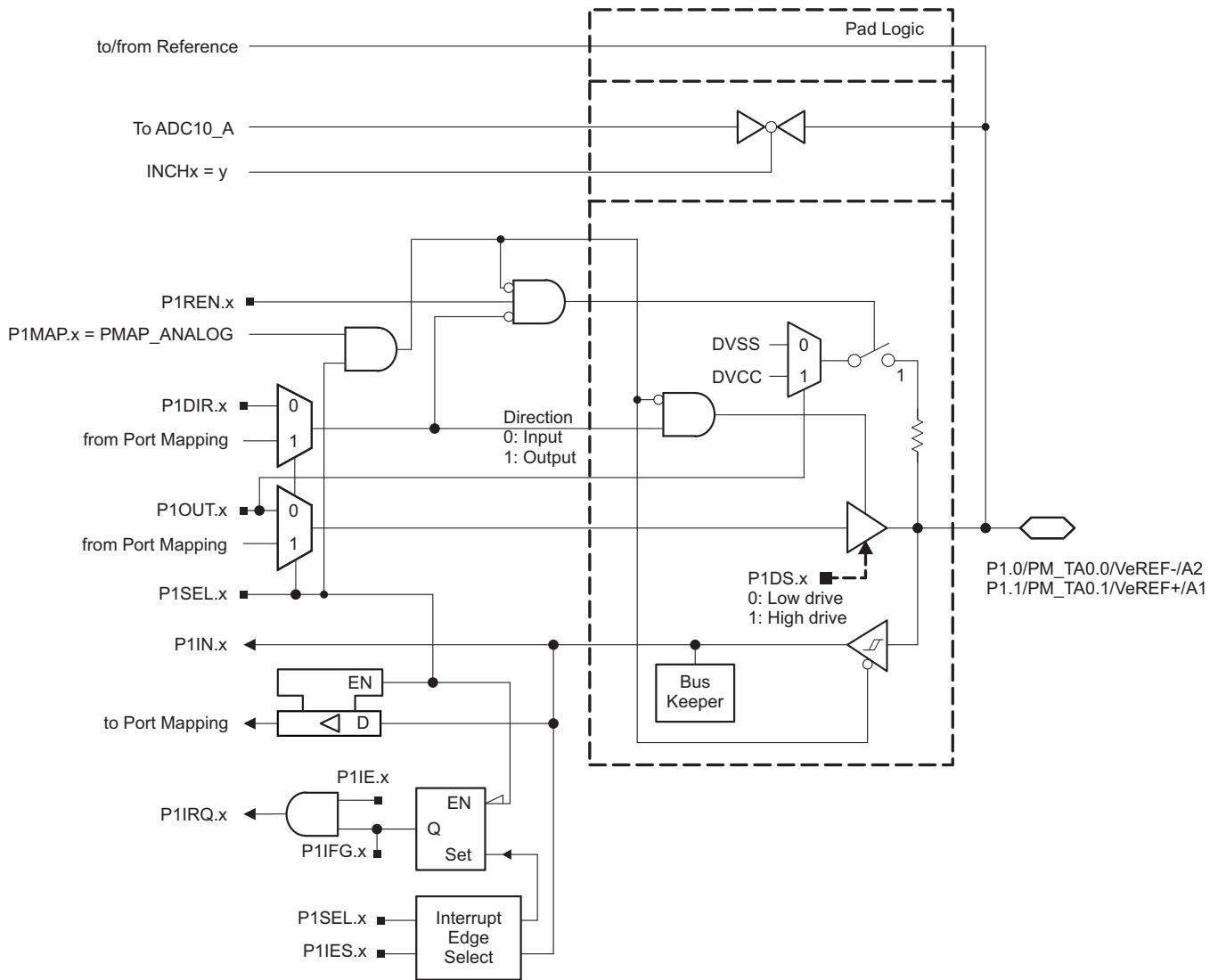


**Table 6-56. LCD\_C Registers (Base Address: 0A00h)**

| REGISTER DESCRIPTION               | REGISTER   | OFFSET |
|------------------------------------|------------|--------|
| LCD_C control register 0           | LCDCCTL0   | 000h   |
| LCD_C control register 1           | LCDCCTL1   | 002h   |
| LCD_C blinking control register    | LCDCBLKCTL | 004h   |
| LCD_C memory control register      | LCDCMEMCTL | 006h   |
| LCD_C voltage control register     | LCDCVCTL   | 008h   |
| LCD_C port control 0               | LCDCPCTL0  | 00Ah   |
| LCD_C port control 1               | LCDCPCTL1  | 00Ch   |
| LCD_C port control 2               | LCDCPCTL2  | 00Eh   |
| LCD_C charge pump control register | LCDCCPCTL  | 012h   |
| LCD_C interrupt vector             | LCDCIV     | 01Eh   |
| <b>Static and 2 to 4 mux modes</b> |            |        |
| LCD_C memory 1                     | LCDM1      | 020h   |
| LCD_C memory 2                     | LCDM2      | 021h   |
| ⋮                                  | ⋮          | ⋮      |
| LCD_C memory 20                    | LCDM20     | 033h   |
| LCD_C blinking memory 1            | LCDBM1     | 040h   |
| LCD_C blinking memory 2            | LCDBM2     | 041h   |
| ⋮                                  | ⋮          | ⋮      |
| LCD_C blinking memory 20           | LCDBM20    | 053h   |
| <b>5 to 8 mux modes</b>            |            |        |
| LCD_C memory 1                     | LCDM1      | 020h   |
| LCD_C memory 2                     | LCDM2      | 021h   |
| ⋮                                  | ⋮          | ⋮      |
| LCD_C memory 40                    | LCDM40     | 047h   |

### 6.13 Input/Output Schematics

#### 6.13.1 Port P1, P1.0 and P1.1, Input/Output With Schmitt Trigger



**Table 6-57. Port P1 (P1.0 and P1.1) Pin Functions**

| PIN NAME (P1.x)             | x | FUNCTION                 | CONTROL BITS AND SIGNALS <sup>(1)</sup> |         |         |
|-----------------------------|---|--------------------------|---|---------|---------|
|                             |   |                          | P1DIR.x                                 | P1SEL.x | P1MAPx  |
| P1.0/PM_TA0.0/<br>VeREF-/A2 | 0 | P1.0 (I/O)               | I: 0; O: 1                              | 0       | X       |
|                             |   | TA0.CCI0A                | 0                                       | 1       | default |
|                             |   | TA0.TA0                  | 1                                       | 1       | default |
|                             |   | VeREF-/A2 <sup>(2)</sup> | X                                       | 1       | = 31    |
| P1.1/PM_TA0.1/<br>VeREF+/A1 | 1 | P1.1 (I/O)               | I: 0; O: 1                              | 0       | X       |
|                             |   | TA0.CCI1A                | 0                                       | 1       | default |
|                             |   | TA0.TA1                  | 1                                       | 1       | default |
|                             |   | VeREF+/A1 <sup>(2)</sup> | X                                       | 1       | = 31    |

(1) X = Don't care

(2) Setting P1SEL.x bit together with P1MAPx = PM\_ANALOG disables the output driver and the input Schmitt trigger.

### 6.13.2 Port P1, P1.2, Input/Output With Schmitt Trigger

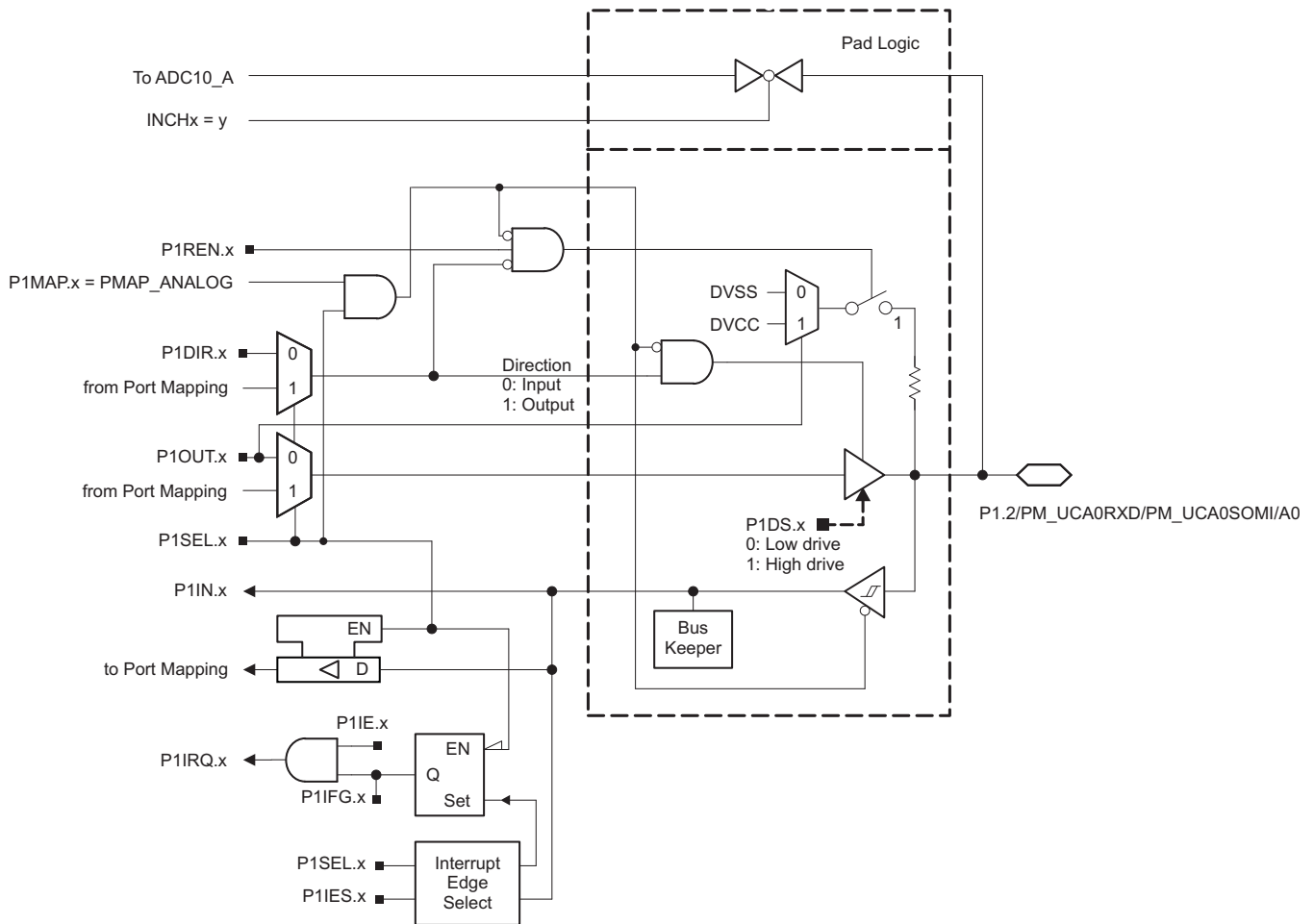


Table 6-58. Port P1 (P1.2) Pin Functions

| PIN NAME (P1.x)                    | x | FUNCTION          | CONTROL BITS AND SIGNALS <sup>(1)</sup> |         |         |
|------------------------------------|---|-------------------|---|---------|---------|
|                                    |   |                   | P1DIR.x                                 | P1SEL.x | P1MAPx  |
| P1.2/PM_UCA0RXD/<br>PM_UCA0SOMI/A0 | 2 | P1.2 (I/O)        | I: 0; O: 1                              | 0       | X       |
|                                    |   | UCA0RXD/UCA0SOMI  | X                                       | 1       | default |
|                                    |   | A0 <sup>(2)</sup> | X                                       | 1       | = 31    |

(1) X = Don't care

(2) Setting P1SEL.x bit together with P1MAPx = PM\_ANALOG disables the output driver and the input Schmitt trigger.

### 6.13.3 Port P1, P1.3 to P1.5, Input/Output With Schmitt Trigger

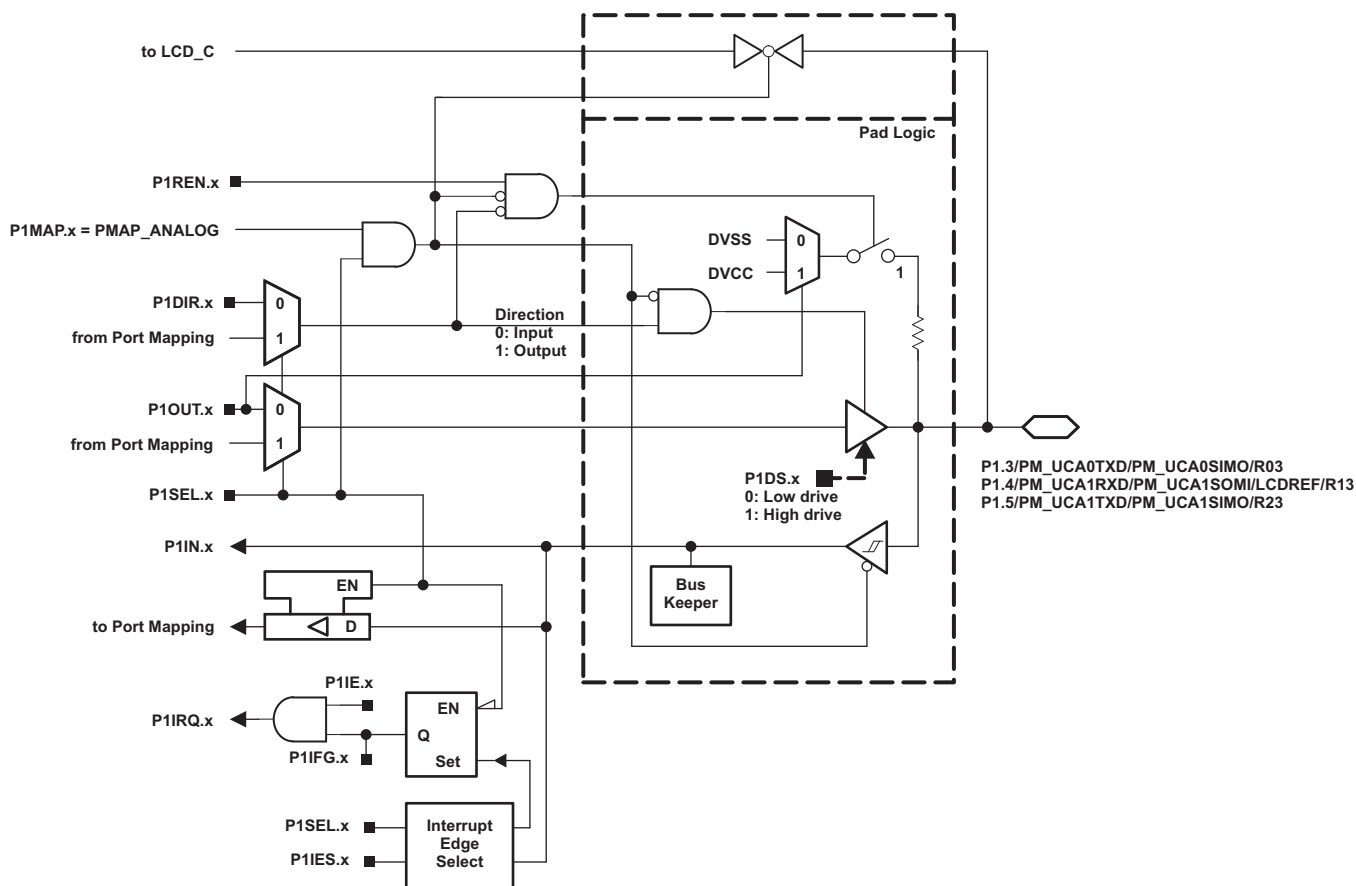


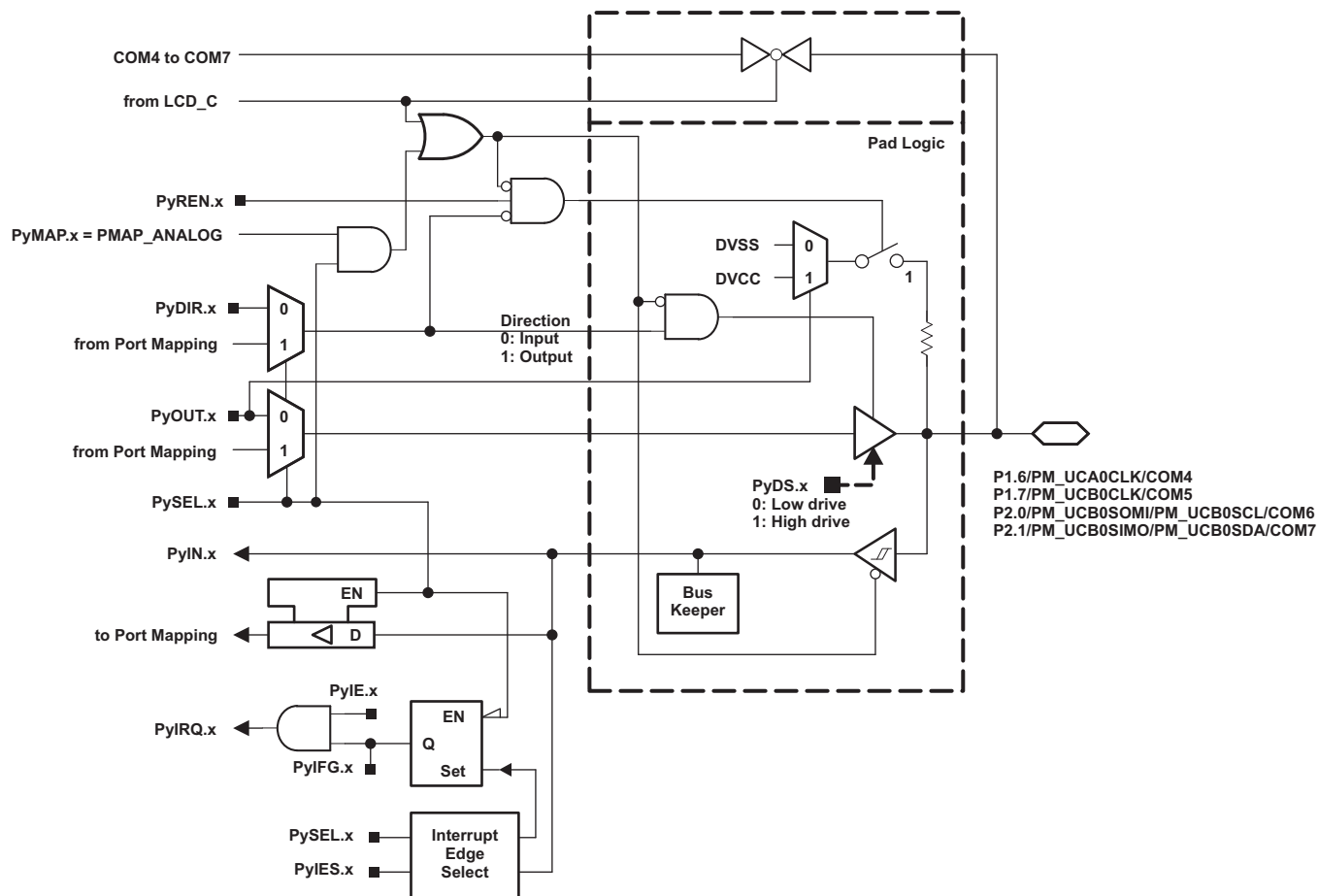
Table 6-59. Port P1 (P1.3 to P1.5) Pin Functions

| PIN NAME (P1.x)                                | x | FUNCTION                  | CONTROL BITS AND SIGNALS <sup>(1)</sup> |         |         |
|--|---|---------------------------|---|---------|---------|
|  |   |                           | P1DIR.x                                 | P1SEL.x | P1MAPx  |
| P1.3/PM_UCA0TXD/<br>PM_UCA0SIMO/R03            | 3 | P1.3 (I/O)                | I: 0; O: 1                              | 0       | X       |
|  |   | UCA0TXD/UCA0SIMO          | X                                       | 1       | default |
|  |   | R03 <sup>(2)</sup>        | X                                       | 1       | = 31    |
| P1.4/PM_UCA1RXD/<br>PM_UCA1SOMI/<br>LCDREF/R13 | 4 | P1.4 (I/O)                | I: 0; O: 1                              | 0       | X       |
|  |   | UCA1RXD/UCA1SOMI          | X                                       | 1       | default |
|  |   | LCDREF/R13 <sup>(2)</sup> | X                                       | 1       | = 31    |
| P1.5/PM_UCA1TXD/<br>PM_UCA1SIMO/R23            | 5 | P1.5 (I/O)                | I: 0; O: 1                              | 0       | X       |
|  |   | UCA1TXD/UCA1SIMO          | X                                       | 1       | default |
|  |   | R23 <sup>(2)</sup>        | X                                       | 1       | = 31    |

(1) X = Don't care

(2) Setting P1SEL.x bit together with P1MAPx = PM\_ANALOG disables the output driver and the input Schmitt trigger.

### 6.13.4 Port P1, P1.6 and P1.7 Port P2, P2.0 and P2.1 (PZ Package Only) Input/Output With Schmitt Trigger



**Table 6-60. Port P1 (P1.6 and P1.7) Pin Functions**

| PIN NAME (P1.x)      | x | FUNCTION   | CONTROL BITS AND SIGNALS <sup>(1)</sup> |         |         |                         |
|----------------------|---|--|---|---------|---------|-------------------------|
|                      |   |  | P1DIR.x                                 | P1SEL.x | P1MAPx  | COM4,5<br>Enable Signal |
| P1.6/PM_UCA0CLK/COM4 | 6 | P1.6 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0                       |
|                      |   | UCA0CLK  | X                                       | 1       | default | 0                       |
|                      |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0                       |
|                      |   | COM4   | X                                       | X       | X       | 1                       |
| P1.7/PM_UCB0CLK/COM5 | 7 | P1.7 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0                       |
|                      |   | UCB0CLK  | X                                       | 1       | default | 0                       |
|                      |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0                       |
|                      |   | COM5   | X                                       | X       | X       | 1                       |

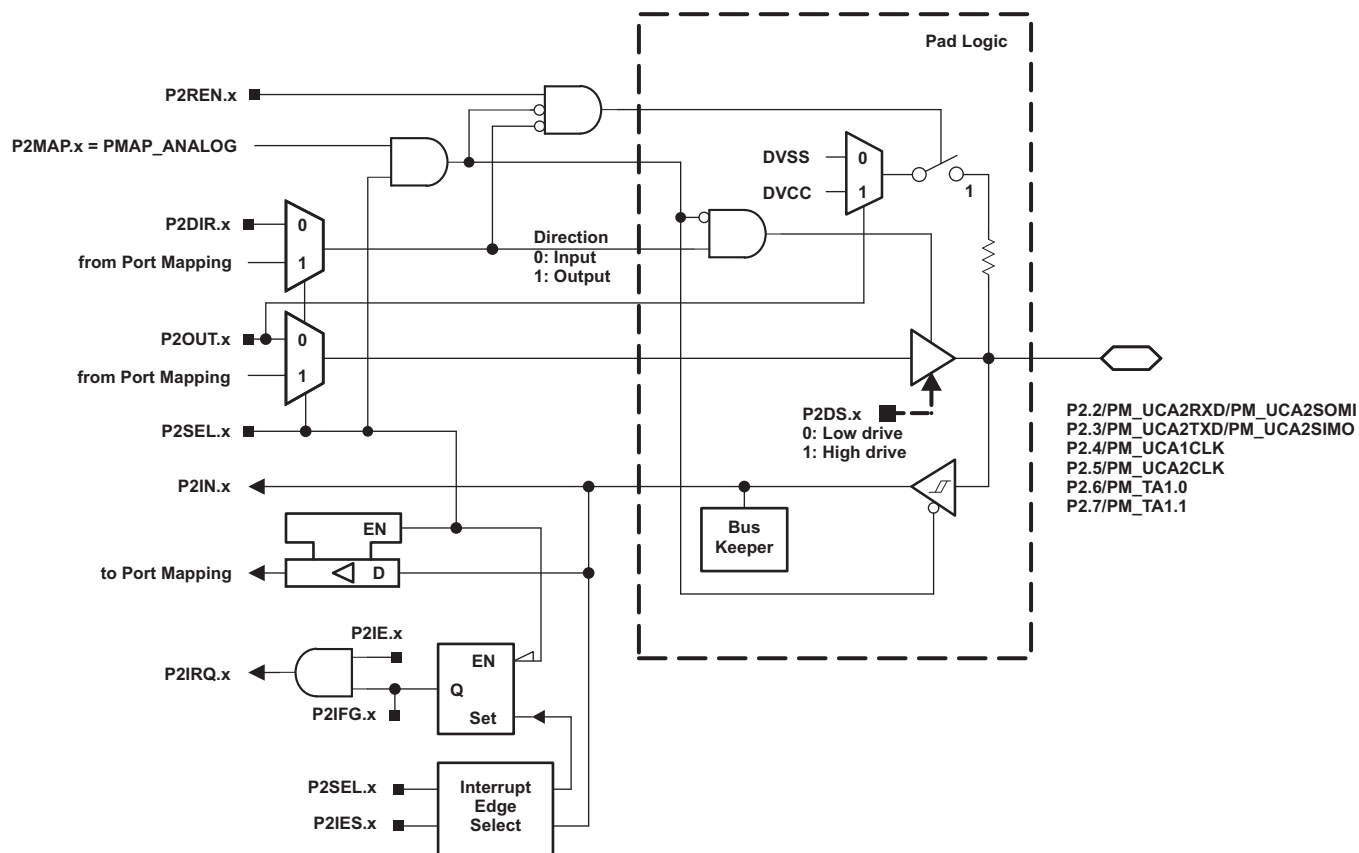
(1) X = Don't care

**Table 6-61. Port P2 (P2.0 and P2.1) Pin Functions (PZ Package Only)**

| PIN NAME (P2.x)                      | x | FUNCTION   | CONTROL BITS AND SIGNALS <sup>(1)</sup> |         |         |                         |
|--------------------------------------|---|--|---|---------|---------|-------------------------|
|                                      |   |  | P2DIR.x                                 | P2SEL.x | P2MAPx  | COM6,7<br>Enable Signal |
| P2.0/PM_UCB0SOMI/<br>PM_UCB0SCL/COM6 | 0 | P2.0 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0                       |
|                                      |   | UCB0SOMI/UCB0SCL                                 | X                                       | 1       | default | 0                       |
|                                      |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0                       |
|                                      |   | COM6   | X                                       | X       | X       | 1                       |
| P2.1/PM_UCB0SIMO/<br>PM_UCB0SDA/COM7 | 1 | P2.1 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0                       |
|                                      |   | UCB0SIMO/UCB0SDA                                 | X                                       | 1       | default | 0                       |
|                                      |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0                       |
|                                      |   | COM7   | X                                       | X       | X       | 1                       |

(1) X = Don't care

### 6.13.5 Port P2, P2.2 to P2.7, Input/Output With Schmitt Trigger (PZ Package Only)



**Table 6-62. Port P2 (P2.2 to P2.7) Pin Functions (PZ Package Only)**

| PIN NAME (P2.x)                 | x | FUNCTION   | CONTROL BITS AND SIGNALS <sup>(1)</sup> |         |         |
|---------------------------------|---|--|---|---------|---------|
|                                 |   |  | P2DIR.x                                 | P2SEL.x | P2MAPx  |
| P2.2/PM_UCA2RXD/<br>PM_UCA2SOMI | 2 | P2.2 (I/O)                                       | I: 0; O: 1                              | 0       | X       |
|                                 |   | UCA2RXD/UCA2SOMI                                 | X                                       | 1       | default |
|                                 |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    |
| P2.3/PM_UCA2TXD/<br>PM_UCA2SIMO | 3 | P2.3 (I/O)                                       | I: 0; O: 1                              | 0       | X       |
|                                 |   | UCA2TXD/UCA2SIMO                                 | X                                       | 1       | default |
|                                 |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    |
| P2.4/PM_UCA1CLK                 | 4 | P2.4 (I/O)                                       | I: 0; O: 1                              | 0       | X       |
|                                 |   | UCA1CLK  | X                                       | 1       | default |
|                                 |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    |
| P2.5/PM_UCA2CLK                 | 5 | P2.5 (I/O)                                       | I: 0; O: 1                              | 0       | X       |
|                                 |   | UCA2CLK  | X                                       | 1       | default |
|                                 |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    |
| P2.6/PM_TA1.0                   | 6 | P2.6 (I/O)                                       | I: 0; O: 1                              | 0       | X       |
|                                 |   | TA1.CC10A  | 0                                       | 1       | default |
|                                 |   | TA1.TA0  | 1                                       | 1       | default |
|                                 |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    |
| P2.7/PM_TA1.1                   | 7 | P2.7 (I/O)                                       | I: 0; O: 1                              | 0       | X       |
|                                 |   | TA1.CC11A  | 0                                       | 1       | default |
|                                 |   | TA1.TA1  | 1                                       | 1       | default |
|                                 |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    |

(1) X = Don't care



6.13.6 Port P3, P3.0 to P3.3, Input/Output With Schmitt Trigger (PZ Package Only)

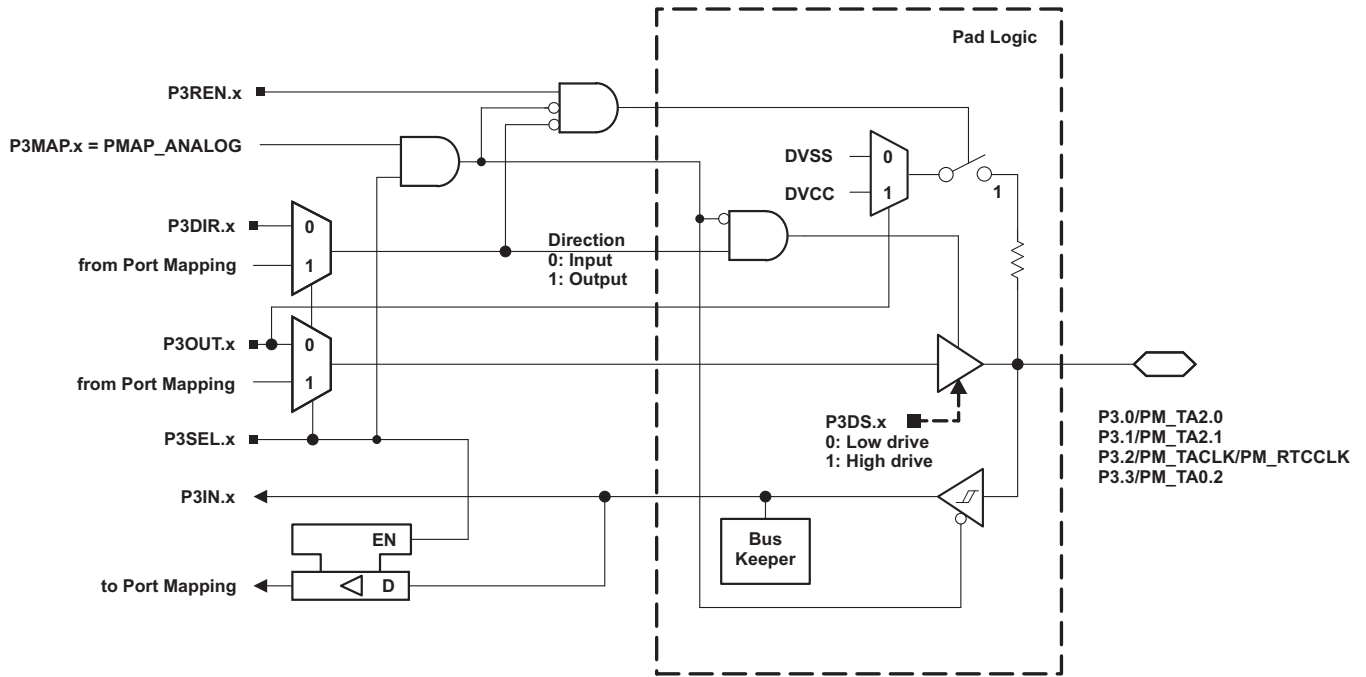
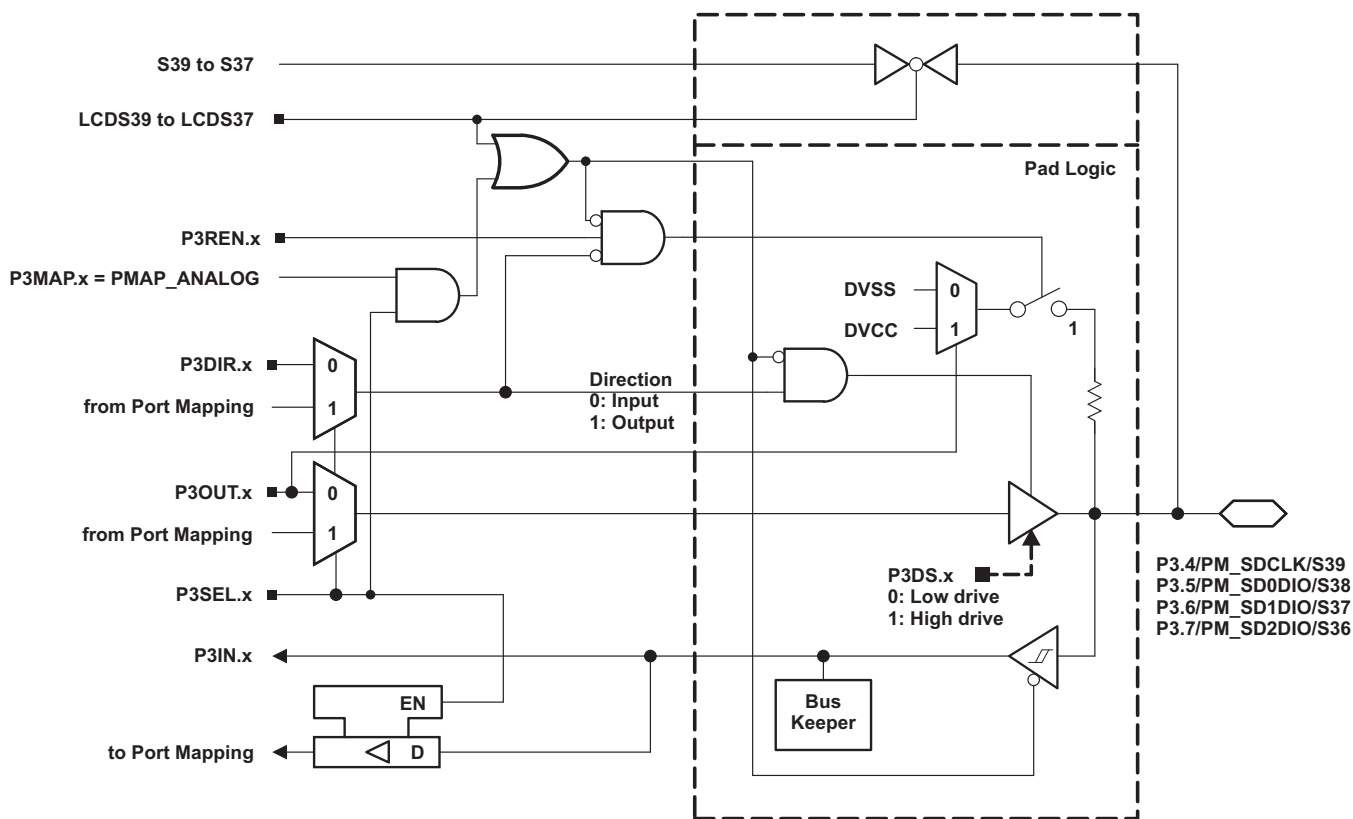


Table 6-63. Port P3 (P3.0 to P3.3) Pin Functions (PZ Package Only)

| PIN NAME (P3.x)             | x | FUNCTION   | CONTROL BITS AND SIGNALS <sup>(1)</sup> |         |         |
|-----------------------------|---|--|---|---------|---------|
|                             |   |  | P3DIR.x                                 | P3SEL.x | P3MAPx  |
| P3.0/PM_TA2.0               | 0 | P3.0 (I/O)                                       | I: 0; O: 1                              | 0       | X       |
|                             |   | TA2.CC10A  | 0                                       | 1       | default |
|                             |   | TA2.TA0  | 1                                       | 1       | default |
|                             |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    |
| P3.1/PM_TA2.1               | 1 | P3.1 (I/O)                                       | I: 0; O: 1                              | 0       | X       |
|                             |   | TA2.CC11A  | 0                                       | 1       | default |
|                             |   | TA2.TA1  | 1                                       | 1       | default |
|                             |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    |
| P3.2/PM_TACLK/<br>PM_RTCCLK | 2 | P3.2 (I/O)                                       | I: 0; O: 1                              | 0       | X       |
|                             |   | TACLK  | 0                                       | 1       | default |
|                             |   | RTCCLK   | 1                                       | 1       | default |
|                             |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    |
| P3.3/PM_TA0.2               | 3 | P3.3 (I/O)                                       | I: 0; O: 1                              | 0       | X       |
|                             |   | TA0.CC12A  | 0                                       | 1       | default |
|                             |   | TA0.TA2  | 1                                       | 1       | default |
|                             |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    |

(1) X = Don't care

### 6.13.7 Port P3, P3.4 to P3.7, Input/Output With Schmitt Trigger (PZ Package Only)

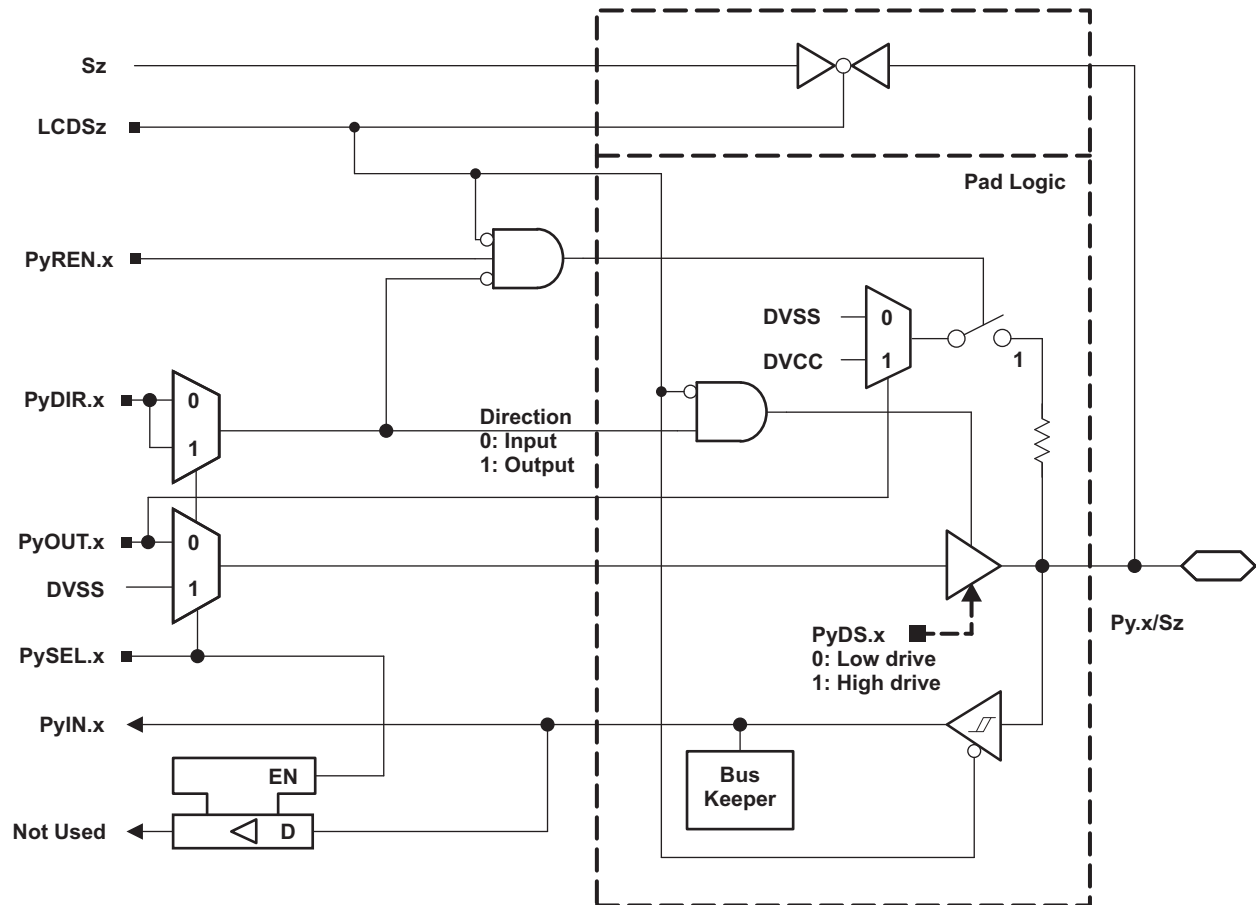


**Table 6-64. Port P3 (P3.4 to P3.7) Pin Functions (PZ Package Only)**

| PIN NAME (P3.x)    | x | FUNCTION   | CONTROL BITS AND SIGNALS <sup>(1)</sup> |         |         |             |
|--------------------|---|--|---|---------|---------|-------------|
|                    |   |  | P3DIR.x                                 | P3SEL.x | P3MAPx  | LCDS39...36 |
| P3.4/PM_SDCLK/S39  | 4 | P3.4 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0           |
|                    |   | SDCLK  | X                                       | 1       | default | 0           |
|                    |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0           |
|                    |   | S39  | X                                       | X       | X       | 1           |
| P3.5/PM_SD0DIO/S38 | 5 | P3.5 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0           |
|                    |   | SD0DIO   | X                                       | 1       | default | 0           |
|                    |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0           |
|                    |   | S38  | X                                       | X       | X       | 1           |
| P3.6/PM_SD1DIO/S37 | 6 | P3.6 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0           |
|                    |   | SD1DIO   | X                                       | 1       | default | 0           |
|                    |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0           |
|                    |   | S37  | X                                       | X       | X       | 1           |
| P3.7/PM_SD2DIO/S36 | 7 | P3.7 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0           |
|                    |   | SD2DIO   | X                                       | 1       | default | 0           |
|                    |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0           |
|                    |   | S36  | X                                       | X       | X       | 1           |

(1) X = Don't care

**6.13.8 Port P4, Port P5, Port P6, Port P7, Port P8, P8.0 to P8.3  
Input/Output With Schmitt Trigger (PZ Package Only)**



**Table 6-65. Port P4 (P4.0 to P4.7) Pin Functions (PZ Package Only)**

| PIN NAME (P4.x) | x | FUNCTION   | CONTROL BITS AND SIGNALS <sup>(1)</sup> |         |             |
|-----------------|---|------------|---|---------|-------------|
|                 |   |            | P4DIR.x                                 | P4SEL.x | LCDS35...28 |
| P4.0/S35        | 0 | P4.0 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S35        | X                                       | X       | 1           |
| P4.1/S34        | 1 | P4.1 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S34        | X                                       | X       | 1           |
| P4.2/S33        | 2 | P4.2 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S33        | X                                       | X       | 1           |
| P4.3/S32        | 3 | P4.3 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S32        | X                                       | X       | 1           |
| P4.4/S31        | 4 | P4.4 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S31        | X                                       | X       | 1           |
| P4.5/S30        | 5 | P4.5 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S30        | X                                       | X       | 1           |
| P4.6/S29        | 6 | P4.6 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S29        | X                                       | X       | 1           |
| P4.7/S28        | 7 | P4.7 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S28        | X                                       | X       | 1           |

(1) X = Don't care

**Table 6-66. Port P5 (P5.0 to P5.7) Pin Functions (PZ Package Only)**

| PIN NAME (P5.x) | x | FUNCTION   | CONTROL BITS AND SIGNALS <sup>(1)</sup> |         |             |
|-----------------|---|------------|---|---------|-------------|
|                 |   |            | P5DIR.x                                 | P5SEL.x | LCDS27...20 |
| P5.0/S27        | 0 | P5.0 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S27        | X                                       | X       | 1           |
| P5.1/S26        | 1 | P5.1 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S26        | X                                       | X       | 1           |
| P5.2/S25        | 2 | P5.2 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S25        | X                                       | X       | 1           |
| P5.3/S24        | 3 | P5.3 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S24        | X                                       | X       | 1           |
| P5.4/S23        | 4 | P5.4 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S23        | X                                       | X       | 1           |
| P5.5/S22        | 5 | P5.5 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S22        | X                                       | X       | 1           |
| P5.6/S21        | 6 | P5.6 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S21        | X                                       | X       | 1           |
| P5.7/S20        | 7 | P5.7 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S20        | X                                       | X       | 1           |

(1) X = Don't care

**Table 6-67. Port P6 (P6.0 to P6.7) Pin Functions (PZ Package Only)**

| PIN NAME (P6.x) | x | FUNCTION   | CONTROL BITS AND SIGNALS <sup>(1)</sup> |         |             |
|-----------------|---|------------|---|---------|-------------|
|                 |   |            | P6DIR.x                                 | P6SEL.x | LCDS19...12 |
| P6.0/S19        | 0 | P6.0 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S19        | X                                       | X       | 1           |
| P6.1/S18        | 1 | P6.1 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S18        | X                                       | X       | 1           |
| P6.2/S17        | 2 | P6.2 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S17        | X                                       | X       | 1           |
| P6.3/S16        | 3 | P6.3 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S16        | X                                       | X       | 1           |
| P6.4/S15        | 4 | P6.4 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S15        | X                                       | X       | 1           |
| P6.5/S14        | 5 | P6.5 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S14        | X                                       | X       | 1           |
| P6.6/S13        | 6 | P6.6 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S13        | X                                       | X       | 1           |
| P6.7/S12        | 7 | P6.7 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S12        | X                                       | X       | 1           |

(1) X = Don't care

**Table 6-68. Port P7 (P7.0 to P7.7) Pin Functions (PZ Package Only)**

| PIN NAME (P7.x) | x | FUNCTION   | CONTROL BITS AND SIGNALS <sup>(1)</sup> |         |            |
|-----------------|---|------------|---|---------|------------|
|                 |   |            | P7DIR.x                                 | P7SEL.x | LCDS11...4 |
| P7.0/S11        | 0 | P7.0 (I/O) | I: 0; O: 1                              | 0       | 0          |
|                 |   | N/A        | 0                                       | 1       | 0          |
|                 |   | DVSS       | 1                                       | 1       | 0          |
|                 |   | S11        | X                                       | X       | 1          |
| P7.1/S10        | 1 | P7.1 (I/O) | I: 0; O: 1                              | 0       | 0          |
|                 |   | N/A        | 0                                       | 1       | 0          |
|                 |   | DVSS       | 1                                       | 1       | 0          |
|                 |   | S10        | X                                       | X       | 1          |
| P7.2/S9         | 2 | P7.2 (I/O) | I: 0; O: 1                              | 0       | 0          |
|                 |   | N/A        | 0                                       | 1       | 0          |
|                 |   | DVSS       | 1                                       | 1       | 0          |
|                 |   | S9         | X                                       | X       | 1          |
| P7.3/S8         | 3 | P7.3 (I/O) | I: 0; O: 1                              | 0       | 0          |
|                 |   | N/A        | 0                                       | 1       | 0          |
|                 |   | DVSS       | 1                                       | 1       | 0          |
|                 |   | S8         | X                                       | X       | 1          |
| P7.4/S7         | 4 | P7.4 (I/O) | I: 0; O: 1                              | 0       | 0          |
|                 |   | N/A        | 0                                       | 1       | 0          |
|                 |   | DVSS       | 1                                       | 1       | 0          |
|                 |   | S7         | X                                       | X       | 1          |
| P7.5/S6         | 5 | P7.5 (I/O) | I: 0; O: 1                              | 0       | 0          |
|                 |   | N/A        | 0                                       | 1       | 0          |
|                 |   | DVSS       | 1                                       | 1       | 0          |
|                 |   | S6         | X                                       | X       | 1          |
| P7.6/S5         | 6 | P7.6 (I/O) | I: 0; O: 1                              | 0       | 0          |
|                 |   | N/A        | 0                                       | 1       | 0          |
|                 |   | DVSS       | 1                                       | 1       | 0          |
|                 |   | S5         | X                                       | X       | 1          |
| P7.7/S4         | 7 | P7.7 (I/O) | I: 0; O: 1                              | 0       | 0          |
|                 |   | N/A        | 0                                       | 1       | 0          |
|                 |   | DVSS       | 1                                       | 1       | 0          |
|                 |   | S4         | X                                       | X       | 1          |

(1) X = Don't care

**Table 6-69. Port P8 (P8.0 to P8.3) Pin Functions (PZ Package Only)**

| PIN NAME (P8.x) | x | FUNCTION   | CONTROL BITS AND SIGNALS <sup>(1)</sup> |         |           |
|-----------------|---|------------|---|---------|-----------|
|                 |   |            | P8DIR.x                                 | P8SEL.x | LCDS3...0 |
| P8.0/S3         | 0 | P8.0 (I/O) | I: 0; O: 1                              | 0       | 0         |
|                 |   | N/A        | 0                                       | 1       | 0         |
|                 |   | DVSS       | 1                                       | 1       | 0         |
|                 |   | S3         | X                                       | X       | 1         |
| P8.1/S2         | 1 | P8.1 (I/O) | I: 0; O: 1                              | 0       | 0         |
|                 |   | N/A        | 0                                       | 1       | 0         |
|                 |   | DVSS       | 1                                       | 1       | 0         |
|                 |   | S2         | X                                       | X       | 1         |
| P8.2/S1         | 2 | P8.2 (I/O) | I: 0; O: 1                              | 0       | 0         |
|                 |   | N/A        | 0                                       | 1       | 0         |
|                 |   | DVSS       | 1                                       | 1       | 0         |
|                 |   | S1         | X                                       | X       | 1         |
| P8.3/S0         | 3 | P8.3 (I/O) | I: 0; O: 1                              | 0       | 0         |
|                 |   | N/A        | 0                                       | 1       | 0         |
|                 |   | DVSS       | 1                                       | 1       | 0         |
|                 |   | S0         | X                                       | X       | 1         |

(1) X = Don't care



6.13.9 Port P8, P8.4 to P8.7, Input/Output With Schmitt Trigger (PZ Package Only)

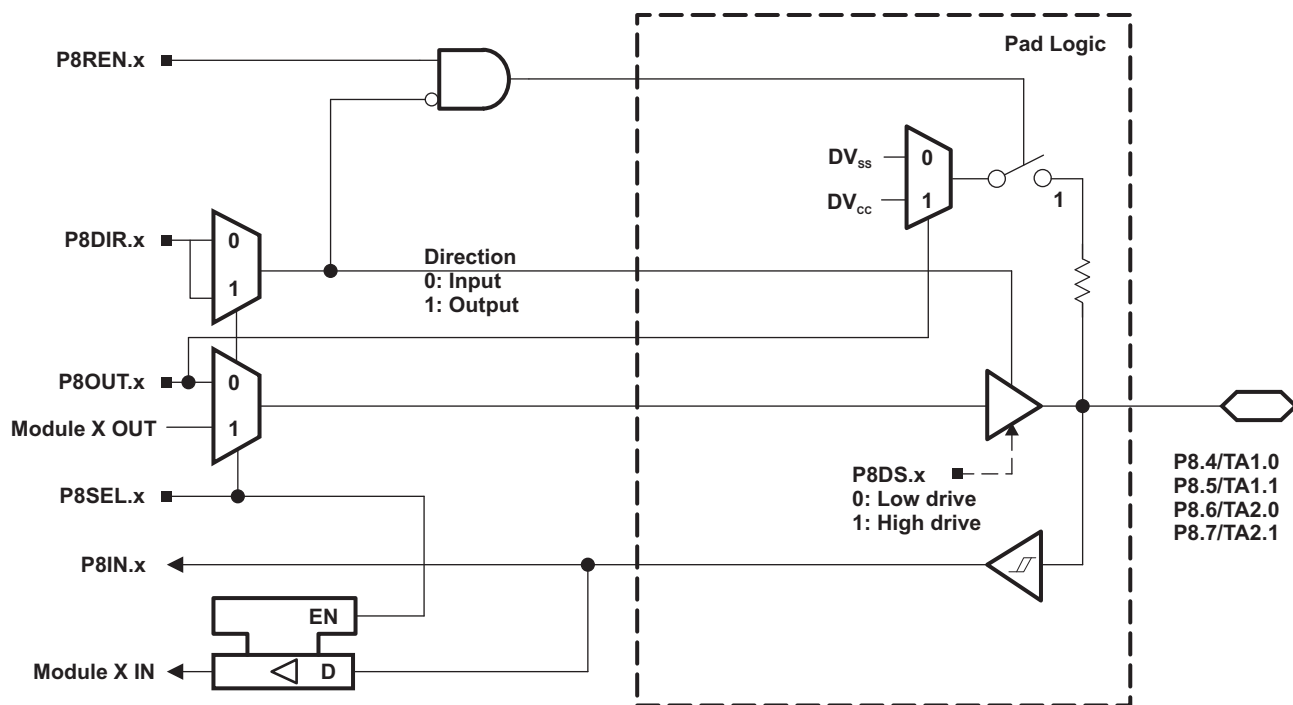


Table 6-70. Port P8 (P8.4 to P8.7) Pin Functions (PZ Package Only)

| PIN NAME (P8.x) | x | FUNCTION   | CONTROL BITS AND SIGNALS |         |
|-----------------|---|------------|--------------------------|---------|
|                 |   |            | P8DIR.x                  | P8SEL.x |
| P8.4/TA1.0      | 4 | P8.4 (I/O) | I: 0; O: 1               | 0       |
|                 |   | TA1.CCI0A  | 0                        | 1       |
|                 |   | TA1.TA0    | 1                        | 1       |
| P8.5/TA1.1      | 5 | P8.5 (I/O) | I: 0; O: 1               | 0       |
|                 |   | TA1.CCI1A  | 0                        | 1       |
|                 |   | TA1.TA1    | 1                        | 1       |
| P8.6/TA2.0      | 6 | P8.6 (I/O) | I: 0; O: 1               | 0       |
|                 |   | TA2.CCI0A  | 0                        | 1       |
|                 |   | TA2.TA0    | 1                        | 1       |
| P8.7/TA2.1      | 7 | P8.7 (I/O) | I: 0; O: 1               | 0       |
|                 |   | TA2.CCI1A  | 0                        | 1       |
|                 |   | TA2.TA1    | 1                        | 1       |

6.13.10 Port P9, P9.0, Input/Output With Schmitt Trigger (PZ Package Only)

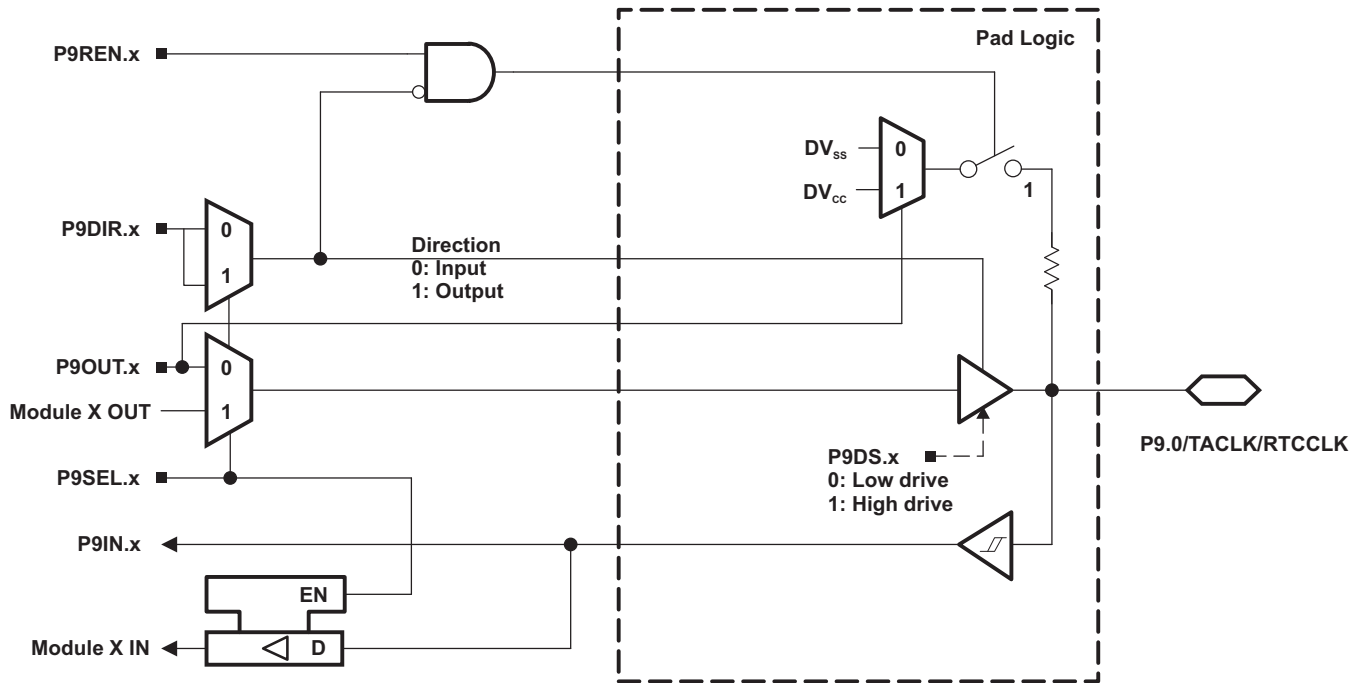


Table 6-71. Port P9 (P9.0) Pin Functions (PZ Package Only)

| PIN NAME (P9.x)   | x | FUNCTION   | CONTROL BITS AND SIGNALS |         |
|-------------------|---|------------|--------------------------|---------|
|                   |   |            | P9DIR.x                  | P9SEL.x |
| P9.0/TACLK/RTCCLK | 0 | P9.0 (I/O) | I: 0; O: 1               | 0       |
|                   |   | TACLK      | 0                        | 1       |
|                   |   | RTCCLK     | 1                        | 1       |

6.13.11 Port P9, P9.1 to P9.3, Input/Output With Schmitt Trigger (PZ Package Only)

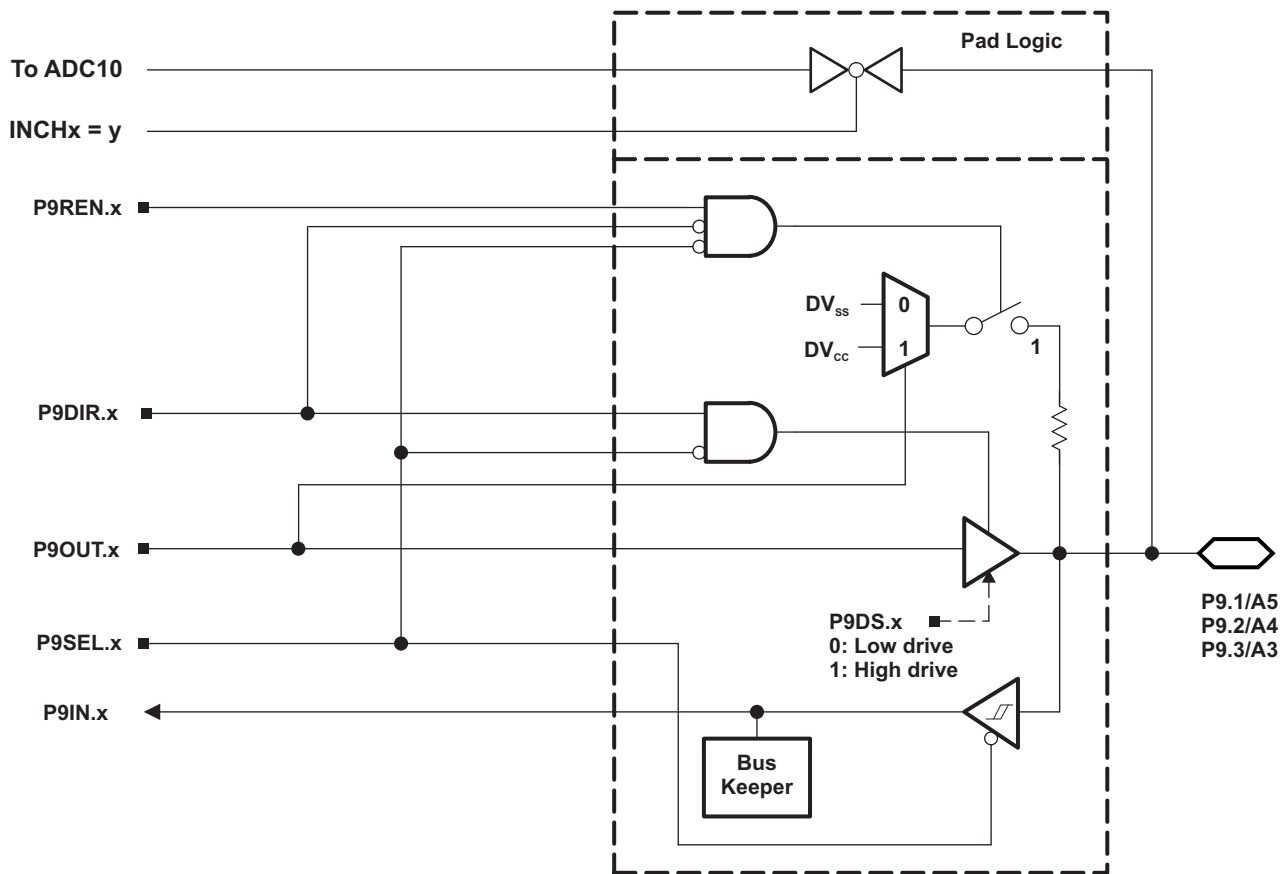


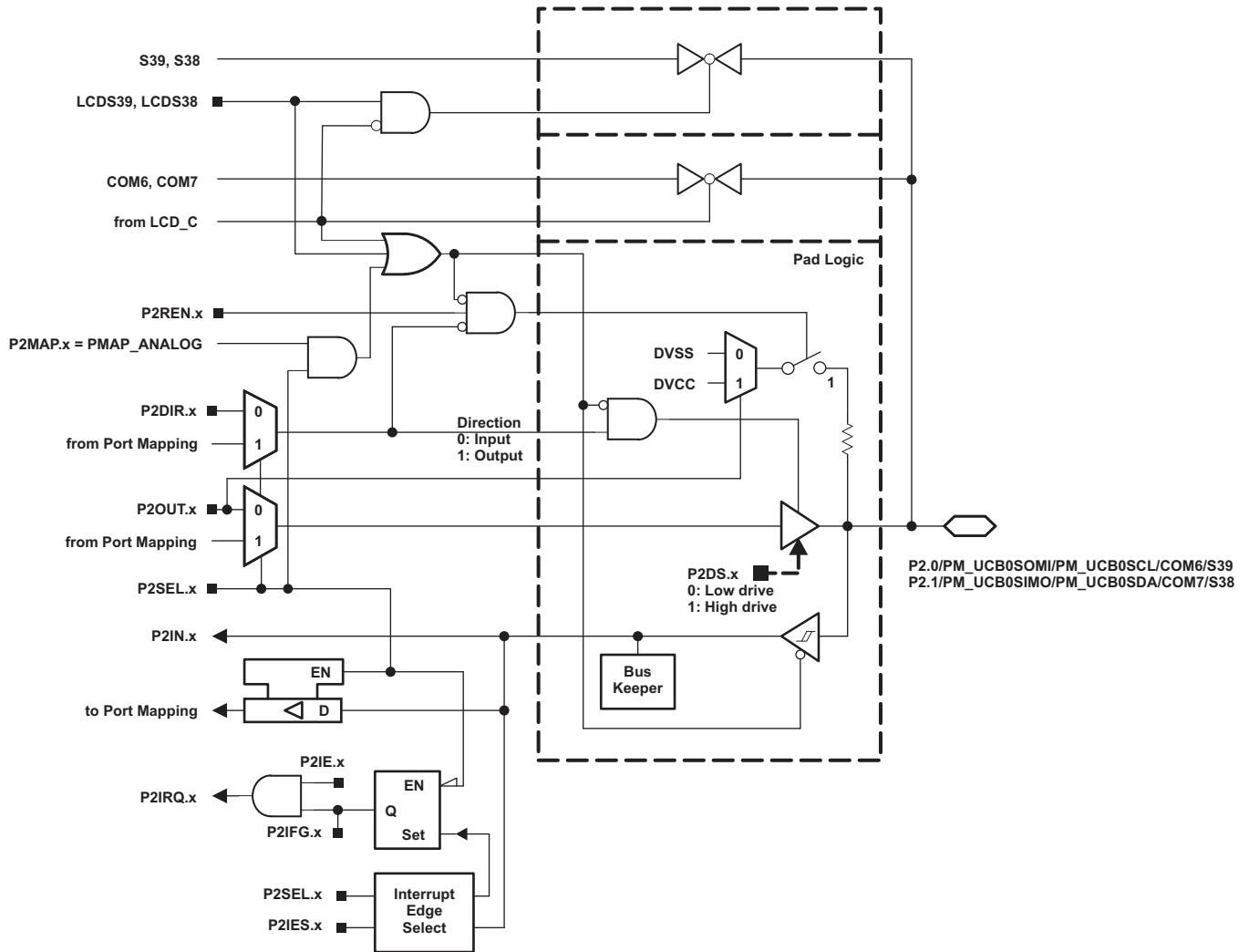
Table 6-72. Port P9 (P9.1 to P9.3) Pin Functions (PZ Package Only)

| PIN NAME (P9.x) | x | FUNCTION          | CONTROL BITS AND SIGNALS <sup>(1)</sup> |         |
|-----------------|---|-------------------|---|---------|
|                 |   |                   | P9DIR.x                                 | P9SEL.x |
| P9.1/A5         | 1 | P9.1 (I/O)        | I: 0; O: 1                              | 0       |
|                 |   | A5 <sup>(2)</sup> | X                                       | 1       |
| P9.2/A4         | 2 | P9.2 (I/O)        | I: 0; O: 1                              | 0       |
|                 |   | A4 <sup>(2)</sup> | X                                       | 1       |
| P9.3/A3         | 3 | P9.3 (I/O)        | I: 0; O: 1                              | 0       |
|                 |   | A3 <sup>(2)</sup> | X                                       | 1       |

(1) X = Don't care

(2) Setting P9SEL.x bit disables the output driver and the input Schmitt trigger.

### 6.13.12 Port P2, P2.0 and P2.1, Input/Output With Schmitt Trigger (PN Package Only)

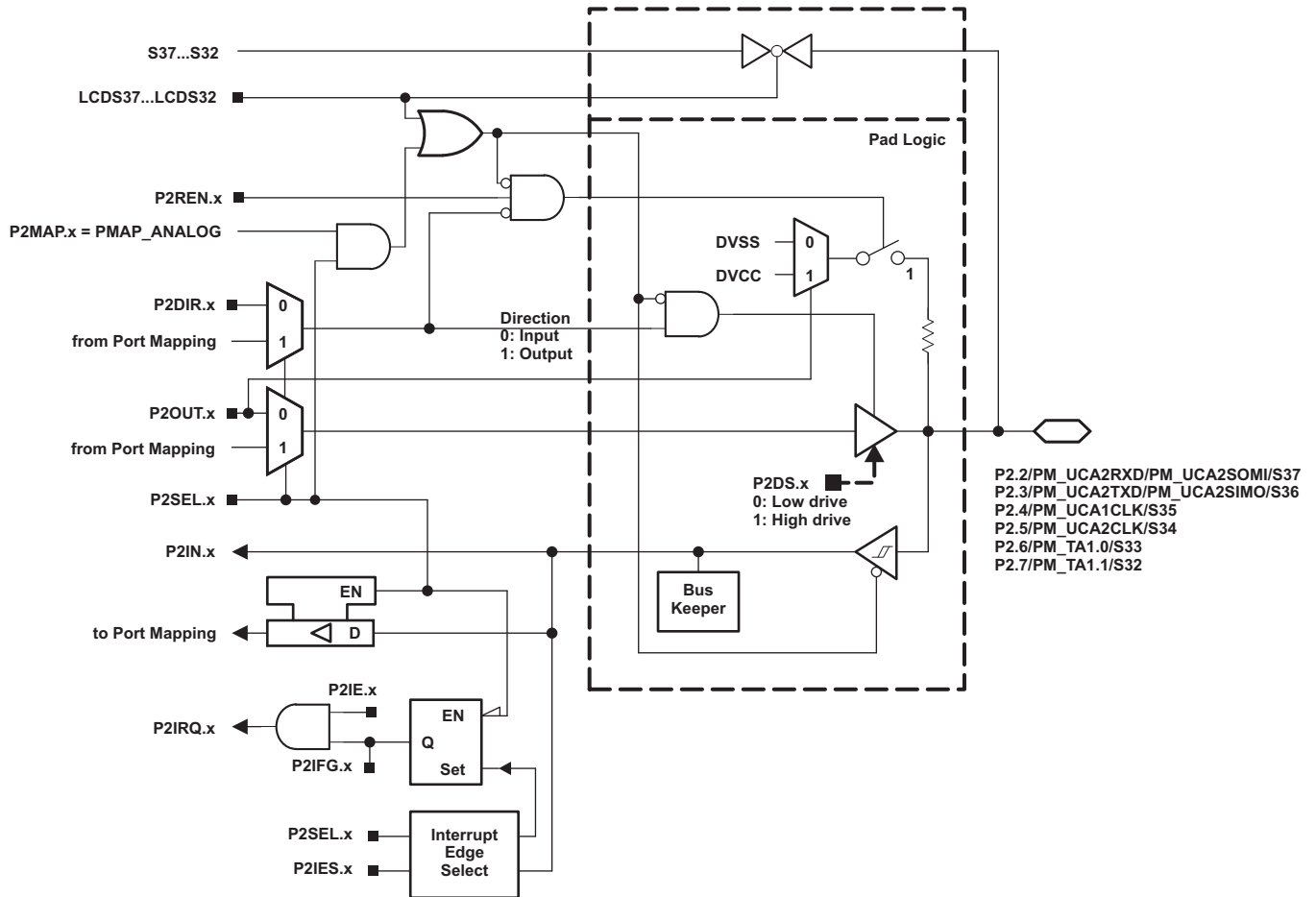


**Table 6-73. Port P2 (P2.0 and P2.1) Pin Functions (PN Package Only)**

| PIN NAME (P2.x)                              | x | FUNCTION  | CONTROL BITS AND SIGNALS <sup>(1)</sup> |         |         |                   |                            |
|--|---|---|---|---------|---------|-------------------|----------------------------|
|  |   |   | P2DIR.x                                 | P2SEL.x | P2MAPx  | LCDS39,<br>LCDS38 | COM6,7<br>Enable<br>Signal |
| P2.0/PM_UCB0SOMI/<br>PM_UCB0SCL/COM6/<br>S39 | 0 | P2.0 (I/O)  | I: 0; O: 1                              | 0       | X       | 0                 | 0                          |
|  |   | UCB0SOMI/UCB0SCL                                    | X                                       | 1       | default | 0                 | 0                          |
|  |   | Output driver and input<br>Schmitt trigger disabled | X                                       | 1       | = 31    | 0                 | 0                          |
|  |   | COM6  | X                                       | X       | X       | X                 | 1                          |
|  |   | S39   | X                                       | X       | X       | 1                 | 0                          |
| P2.1/PM_UCB0SIMO/<br>PM_UCB0SDA/COM7/<br>S38 | 1 | P2.1 (I/O)  | I: 0; O: 1                              | 0       | X       | 0                 | 0                          |
|  |   | UCB0SIMO/UCB0SDA                                    | X                                       | 1       | default | 0                 | 0                          |
|  |   | Output driver and input<br>Schmitt trigger disabled | X                                       | 1       | = 31    | 0                 | 0                          |
|  |   | COM7  | X                                       | X       | X       | X                 | 1                          |
|  |   | S38   | X                                       | X       | X       | 1                 | 0                          |

(1) X = Don't care

### 6.13.13 Port P2, P2.2 to P2.7 , Input/Output With Schmitt Trigger (PN Package Only)

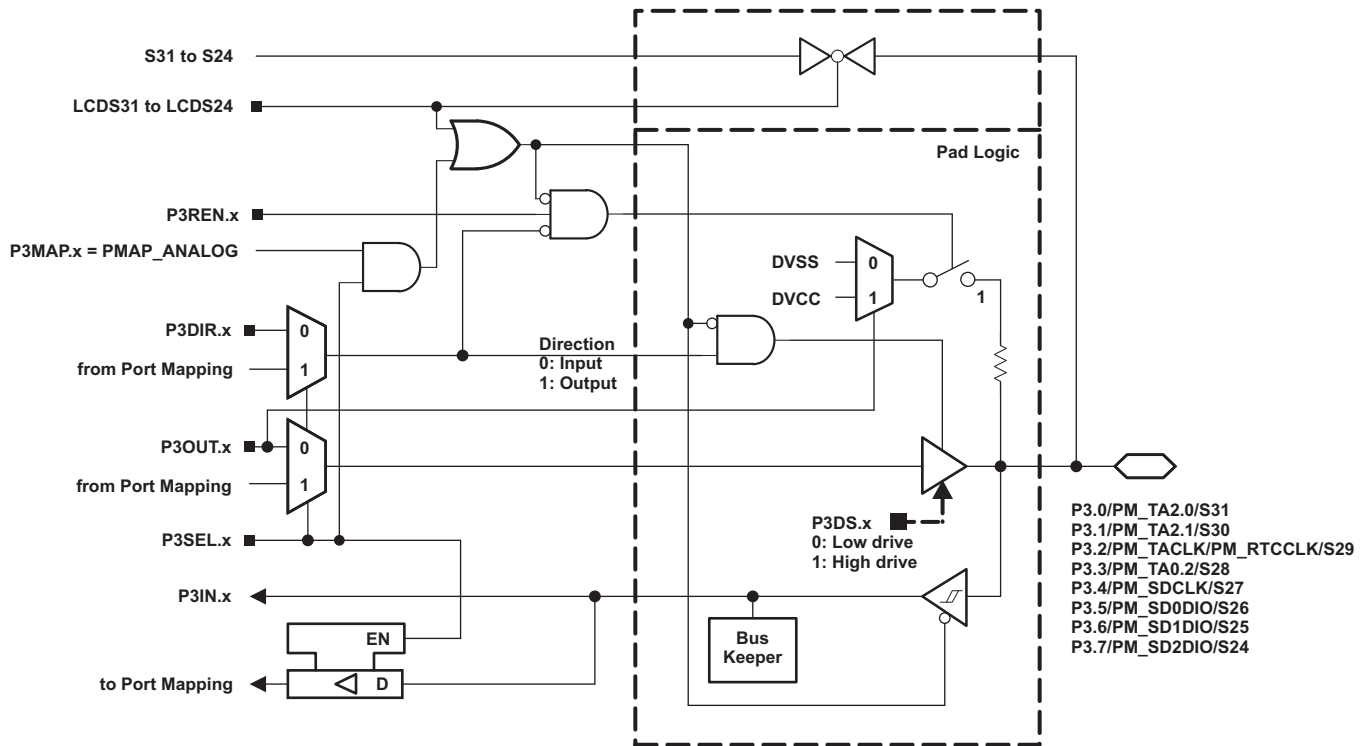


**Table 6-74. Port P2 (P2.2 to P2.7) Pin Functions (PN Package Only)**

| PIN NAME (P2.x)                     | x | FUNCTION   | CONTROL BITS AND SIGNALS <sup>(1)</sup> |         |         |             |
|-------------------------------------|---|--|---|---------|---------|-------------|
|                                     |   |  | P2DIR.x                                 | P2SEL.x | P2MAPx  | LCDS37...32 |
| P2.2/PM_UCA2RXD/<br>PM_UCA2SOMI/S37 | 2 | P2.2 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0           |
|                                     |   | UCA2RXD/UCA2SOMI                                 | X                                       | 1       | default | 0           |
|                                     |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0           |
|                                     |   | S37  | X                                       | X       | X       | 1           |
| P2.3/PM_UCA2TXD/<br>PM_UCA2SIMO/S36 | 3 | P2.3 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0           |
|                                     |   | UCA2TXD/UCA2SIMO                                 | X                                       | 1       | default | 0           |
|                                     |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0           |
|                                     |   | S36  | X                                       | X       | X       | 1           |
| P2.4/PM_UCA1CLK/S35                 | 4 | P2.4 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0           |
|                                     |   | UCA1CLK  | X                                       | 1       | default | 0           |
|                                     |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0           |
|                                     |   | S35  | X                                       | X       | X       | 1           |
| P2.5/PM_UCA2CLK/S34                 | 5 | P2.5 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0           |
|                                     |   | UCA2CLK  | X                                       | 1       | default | 0           |
|                                     |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0           |
|                                     |   | S34  | X                                       | X       | X       | 1           |
| P2.6/PM_TA1.0/S33                   | 6 | P2.6 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0           |
|                                     |   | TA1.CCI0A  | 0                                       | 1       | default | 0           |
|                                     |   | TA1.TA0  | 1                                       | 1       | default | 0           |
|                                     |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0           |
|                                     |   | S33  | X                                       | X       | X       | 1           |
| P2.7/PM_TA1.1/S32                   | 7 | P2.7 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0           |
|                                     |   | TA1.CCI1A  | 0                                       | 1       | default | 0           |
|                                     |   | TA1.TA1  | 1                                       | 1       | default | 0           |
|                                     |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0           |
|                                     |   | S32  | X                                       | X       | X       | 1           |

(1) X = Don't care

**6.13.14 Port P3, P3.0 to P3.7 , Input/Output With Schmitt Trigger (PN Package Only)**



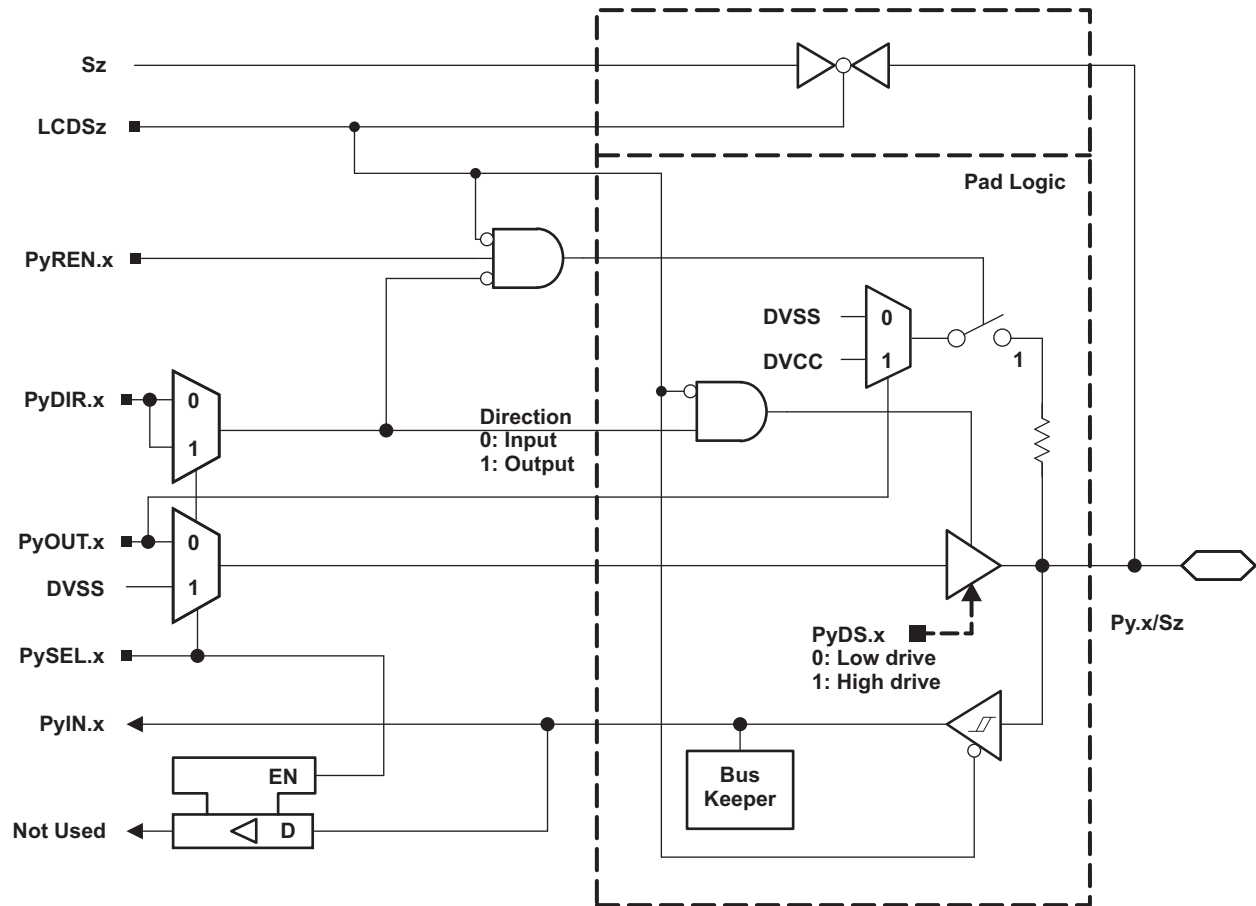


**Table 6-75. Port P3 (P3.0 to P3.7) Pin Functions (PN Package Only)**

| PIN NAME (P3.x)                 | x | FUNCTION   | CONTROL BITS AND SIGNALS <sup>(1)</sup> |         |         |             |
|---------------------------------|---|--|---|---------|---------|-------------|
|                                 |   |  | P3DIR.x                                 | P3SEL.x | P3MAPx  | LCDS31...24 |
| P3.0/PM_TA2.0/S31               | 0 | P3.0 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0           |
|                                 |   | TA2.CCI0A  | 0                                       | 1       | default | 0           |
|                                 |   | TA2.TA0  | 1                                       | 1       | default | 0           |
|                                 |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0           |
|                                 |   | S31  | X                                       | X       | X       | 1           |
| P3.1/PM_TA2.1/S30               | 1 | P3.1 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0           |
|                                 |   | TA2.CCI1A  | 0                                       | 1       | default | 0           |
|                                 |   | TA2.TA1  | 1                                       | 1       | default | 0           |
|                                 |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0           |
|                                 |   | S30  | X                                       | X       | X       | 1           |
| P3.2/PM_TACLK/<br>PM_RTCCLK/S29 | 2 | P3.2 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0           |
|                                 |   | TACLK  | 0                                       | 1       | default | 0           |
|                                 |   | RTCCLK   | 1                                       | 1       | default | 0           |
|                                 |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0           |
|                                 |   | S29  | X                                       | X       | X       | 1           |
| P3.3/PM_TA0.2/S28               | 3 | P3.3 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0           |
|                                 |   | TA0.CCI2A  | 0                                       | 1       | default | 0           |
|                                 |   | TA0.TA2  | 1                                       | 1       | default | 0           |
|                                 |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0           |
|                                 |   | S28  | X                                       | X       | X       | 1           |
| P3.4/PM_SDCLK/S27               | 4 | P3.4 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0           |
|                                 |   | SDCLK  | X                                       | 1       | default | 0           |
|                                 |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0           |
|                                 |   | S27  | X                                       | X       | X       | 1           |
| P3.5/PM_SD0DIO/S26              | 5 | P3.5 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0           |
|                                 |   | SD0DIO   | X                                       | 1       | default | 0           |
|                                 |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0           |
|                                 |   | S26  | X                                       | X       | X       | 1           |
| P3.6/PM_SD1DIO/S25              | 6 | P3.6 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0           |
|                                 |   | SD1DIO   | X                                       | 1       | default | 0           |
|                                 |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0           |
|                                 |   | S25  | X                                       | X       | X       | 1           |
| P3.7/PM_SD2DIO/S24              | 7 | P3.7 (I/O)                                       | I: 0; O: 1                              | 0       | X       | 0           |
|                                 |   | SD2DIO   | X                                       | 1       | default | 0           |
|                                 |   | Output driver and input Schmitt trigger disabled | X                                       | 1       | = 31    | 0           |
|                                 |   | S24  | X                                       | X       | X       | 1           |

(1) X = Don't care

**6.13.15 Port P4, Port P5, Port P6, Input/Output With Schmitt Trigger (PN Package Only)**



**Table 6-76. Port P4 (P4.0 to P4.7) Pin Functions (PN Package Only)**

| PIN NAME (P4.x) | x | FUNCTION   | CONTROL BITS AND SIGNALS <sup>(1)</sup> |         |             |
|-----------------|---|------------|---|---------|-------------|
|                 |   |            | P4DIR.x                                 | P4SEL.x | LCDS23...16 |
| P4.0/S23        | 0 | P4.0 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S23        | X                                       | X       | 1           |
| P4.1/S22        | 1 | P4.1 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S22        | X                                       | X       | 1           |
| P4.2/S21        | 2 | P4.2 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S21        | X                                       | X       | 1           |
| P4.3/S20        | 3 | P4.3 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S20        | X                                       | X       | 1           |
| P4.4/S19        | 4 | P4.4 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S19        | X                                       | X       | 1           |
| P4.5/S18        | 5 | P4.5 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S18        | X                                       | X       | 1           |
| P4.6/S17        | 6 | P4.6 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S17        | X                                       | X       | 1           |
| P4.7/S16        | 7 | P4.7 (I/O) | I: 0; O: 1                              | 0       | 0           |
|                 |   | N/A        | 0                                       | 1       | 0           |
|                 |   | DVSS       | 1                                       | 1       | 0           |
|                 |   | S16        | X                                       | X       | 1           |

(1) X = Don't care

**Table 6-77. Port P5 (P5.0 to P5.7) Pin Functions (PN Package Only)**

| PIN NAME (P5.x) | x | FUNCTION   | CONTROL BITS AND SIGNALS <sup>(1)</sup> |         |            |
|-----------------|---|------------|---|---------|------------|
|                 |   |            | P5DIR.x                                 | P5SEL.x | LCDS15...8 |
| P5.0/S15        | 0 | P5.0 (I/O) | I: 0; O: 1                              | 0       | 0          |
|                 |   | N/A        | 0                                       | 1       | 0          |
|                 |   | DVSS       | 1                                       | 1       | 0          |
|                 |   | S15        | X                                       | X       | 1          |
| P5.1/S14        | 1 | P5.1 (I/O) | I: 0; O: 1                              | 0       | 0          |
|                 |   | N/A        | 0                                       | 1       | 0          |
|                 |   | DVSS       | 1                                       | 1       | 0          |
|                 |   | S14        | X                                       | X       | 1          |
| P5.2/S13        | 2 | P5.2 (I/O) | I: 0; O: 1                              | 0       | 0          |
|                 |   | N/A        | 0                                       | 1       | 0          |
|                 |   | DVSS       | 1                                       | 1       | 0          |
|                 |   | S13        | X                                       | X       | 1          |
| P5.3/S12        | 3 | P5.3 (I/O) | I: 0; O: 1                              | 0       | 0          |
|                 |   | N/A        | 0                                       | 1       | 0          |
|                 |   | DVSS       | 1                                       | 1       | 0          |
|                 |   | S12        | X                                       | X       | 1          |
| P5.4/S11        | 4 | P5.4 (I/O) | I: 0; O: 1                              | 0       | 0          |
|                 |   | N/A        | 0                                       | 1       | 0          |
|                 |   | DVSS       | 1                                       | 1       | 0          |
|                 |   | S11        | X                                       | X       | 1          |
| P5.5/S10        | 5 | P5.5 (I/O) | I: 0; O: 1                              | 0       | 0          |
|                 |   | N/A        | 0                                       | 1       | 0          |
|                 |   | DVSS       | 1                                       | 1       | 0          |
|                 |   | S10        | X                                       | X       | 1          |
| P5.6/S9         | 6 | P5.6 (I/O) | I: 0; O: 1                              | 0       | 0          |
|                 |   | N/A        | 0                                       | 1       | 0          |
|                 |   | DVSS       | 1                                       | 1       | 0          |
|                 |   | S9         | X                                       | X       | 1          |
| P5.7/S8         | 7 | P5.7 (I/O) | I: 0; O: 1                              | 0       | 0          |
|                 |   | N/A        | 0                                       | 1       | 0          |
|                 |   | DVSS       | 1                                       | 1       | 0          |
|                 |   | S8         | X                                       | X       | 1          |

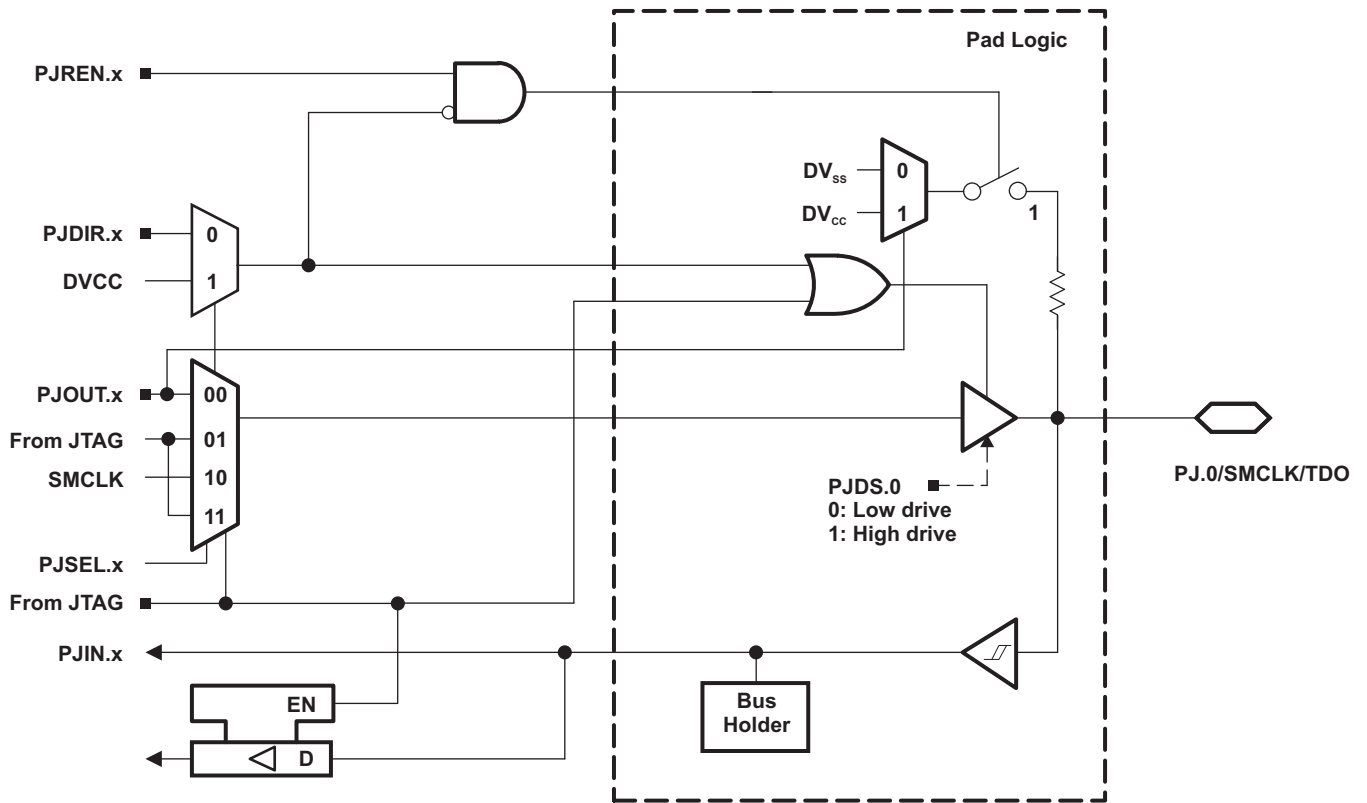
(1) X = Don't care

**Table 6-78. Port P6 (P6.0 to P6.7) Pin Functions (PN Package Only)**

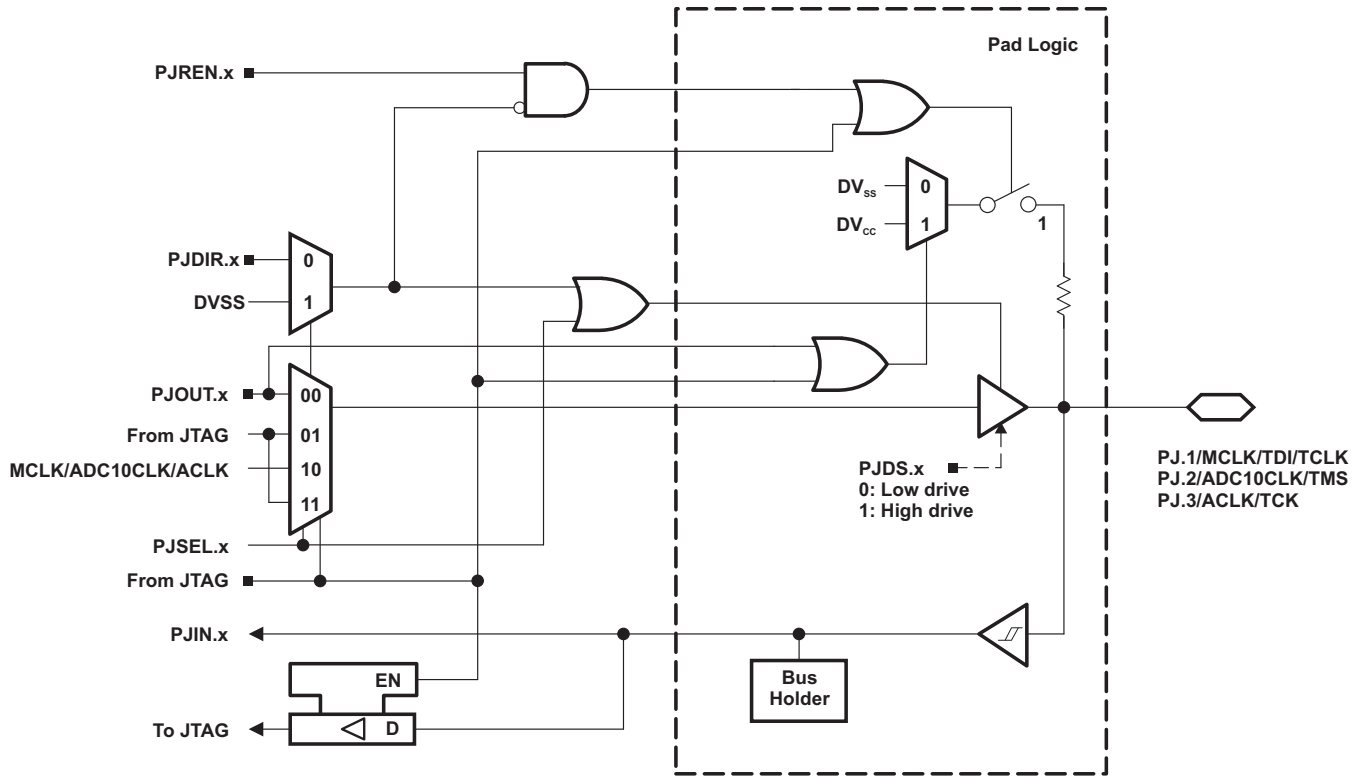
| PIN NAME (P6.x) | x | FUNCTION   | CONTROL BITS AND SIGNALS <sup>(1)</sup> |         |           |
|-----------------|---|------------|---|---------|-----------|
|                 |   |            | P6DIR.x                                 | P6SEL.x | LCDS7...0 |
| P6.0/S7         | 0 | P6.0 (I/O) | I: 0; O: 1                              | 0       | 0         |
|                 |   | N/A        | 0                                       | 1       | 0         |
|                 |   | DVSS       | 1                                       | 1       | 0         |
|                 |   | S7         | X                                       | X       | 1         |
| P6.1/S6         | 1 | P6.1 (I/O) | I: 0; O: 1                              | 0       | 0         |
|                 |   | N/A        | 0                                       | 1       | 0         |
|                 |   | DVSS       | 1                                       | 1       | 0         |
|                 |   | S6         | X                                       | X       | 1         |
| P6.2/S5         | 2 | P6.2 (I/O) | I: 0; O: 1                              | 0       | 0         |
|                 |   | N/A        | 0                                       | 1       | 0         |
|                 |   | DVSS       | 1                                       | 1       | 0         |
|                 |   | S5         | X                                       | X       | 1         |
| P6.3/S4         | 3 | P6.3 (I/O) | I: 0; O: 1                              | 0       | 0         |
|                 |   | N/A        | 0                                       | 1       | 0         |
|                 |   | DVSS       | 1                                       | 1       | 0         |
|                 |   | S4         | X                                       | X       | 1         |
| P6.4/S3         | 4 | P6.4 (I/O) | I: 0; O: 1                              | 0       | 0         |
|                 |   | N/A        | 0                                       | 1       | 0         |
|                 |   | DVSS       | 1                                       | 1       | 0         |
|                 |   | S3         | X                                       | X       | 1         |
| P6.5/S2         | 5 | P6.5 (I/O) | I: 0; O: 1                              | 0       | 0         |
|                 |   | N/A        | 0                                       | 1       | 0         |
|                 |   | DVSS       | 1                                       | 1       | 0         |
|                 |   | S2         | X                                       | X       | 1         |
| P6.6/S1         | 6 | P6.6 (I/O) | I: 0; O: 1                              | 0       | 0         |
|                 |   | N/A        | 0                                       | 1       | 0         |
|                 |   | DVSS       | 1                                       | 1       | 0         |
|                 |   | S1         | X                                       | X       | 1         |
| P6.7/S0         | 7 | P6.7 (I/O) | I: 0; O: 1                              | 0       | 0         |
|                 |   | N/A        | 0                                       | 1       | 0         |
|                 |   | DVSS       | 1                                       | 1       | 0         |
|                 |   | S0         | X                                       | X       | 1         |

(1) X = Don't care

**6.13.16 Port J, J.0, JTAG pin TDO, Input/Output With Schmitt Trigger or Output**



**6.13.17 Port J, J.1 to J.3, JTAG pins TMS, TCK, TDI/TCLK, Input/Output With Schmitt Trigger or Output**



**Table 6-79. Port PJ (PJ.0 to PJ.3) Pin Functions**

| PIN NAME (PJ.x)    | x | FUNCTION                   | CONTROL BITS AND SIGNALS <sup>(1)</sup> |         |                  |
|--------------------|---|----------------------------|---|---------|------------------|
|                    |   |                            | PJDIR.x                                 | PJSEL.x | JTAG Mode Signal |
| PJ.0/SMCLK/TDO     | 0 | PJ.0 (I/O) <sup>(2)</sup>  | I: 0; O: 1                              | 0       | 0                |
|                    |   | SMCLK                      | 1                                       | 1       | 0                |
|                    |   | TDO <sup>(3)</sup>         | X                                       | X       | 1                |
| PJ.1/MCLK/TDI/TCLK | 1 | PJ.1 (I/O) <sup>(2)</sup>  | I: 0; O: 1                              | 0       | 0                |
|                    |   | MCLK                       | 1                                       | 1       | 0                |
|                    |   | TDI/TCLK <sup>(3)(4)</sup> | X                                       | X       | 1                |
| PJ.2/ADC10CLK/TMS  | 2 | PJ.2 (I/O) <sup>(2)</sup>  | I: 0; O: 1                              | 0       | 0                |
|                    |   | ADC10CLK                   | 1                                       | 1       | 0                |
|                    |   | TMS <sup>(3)(4)</sup>      | X                                       | X       | 1                |
| PJ.3/ACLK/TCK      | 3 | PJ.3 (I/O) <sup>(2)</sup>  | I: 0; O: 1                              | 0       | 0                |
|                    |   | ACLK                       | 1                                       | 1       | 0                |
|                    |   | TCK <sup>(3)(4)</sup>      | X                                       | X       | 1                |

- (1) X = Don't care
- (2) Default condition
- (3) The pin direction is controlled by the JTAG module.
- (4) In JTAG mode, pullups are activated automatically on TMS, TCK, and TDI/TCLK. PJREN.x are don't care.

## 6.14 Device Descriptors (TLV)

Table 6-80 shows the contents of the device descriptor tag-length-value (TLV) structure for each device.

**Table 6-80. Device Descriptor Table**

|                          | Description                           | Address | Size (bytes) | F67641   | F67621   |
|--------------------------|---------------------------------------|---------|--------------|----------|----------|
|                          |                                       |         |              | Value    | Value    |
| <b>Info Block</b>        | Info length                           | 01A00h  | 1            | 06h      | 06h      |
|                          | CRC length                            | 01A01h  | 1            | 06h      | 06h      |
|                          | CRC value                             | 01A02h  | 2            | per unit | per unit |
|                          | Device ID                             | 01A04h  | 1            | 39h      | 38h      |
|                          | Device ID                             | 01A05h  | 1            | 82h      | 82h      |
|                          | Hardware revision                     | 01A06h  | 1            | per unit | per unit |
|                          | Firmware revision                     | 01A07h  | 1            | per unit | per unit |
| <b>Die Record</b>        | Die Record Tag                        | 01A08h  | 1            | 08h      | 08h      |
|                          | Die Record length                     | 01A09h  | 1            | 0Ah      | 0Ah      |
|                          | Lot/Wafer ID                          | 01A0Ah  | 4            | per unit | per unit |
|                          | Die X position                        | 01A0Eh  | 2            | per unit | per unit |
|                          | Die Y position                        | 01A10h  | 2            | per unit | per unit |
|                          | Test results                          | 01A12h  | 2            | per unit | per unit |
| <b>ADC10 Calibration</b> | ADC10 Calibration Tag                 | 01A14h  | 1            | 13h      | 13h      |
|                          | ADC10 Calibration length              | 01A15h  | 1            | 10h      | 10h      |
|                          | ADC Gain Factor                       | 01A16h  | 2            | per unit | per unit |
|                          | ADC Offset                            | 01A18h  | 2            | per unit | per unit |
|                          | ADC 1.5-V Reference Temp. Sensor 30°C | 01A1Ah  | 2            | per unit | per unit |
|                          | ADC 1.5-V Reference Temp. Sensor 85°C | 01A1Ch  | 2            | per unit | per unit |
|                          | ADC 2.0-V Reference Temp. Sensor 30°C | 01A1Eh  | 2            | per unit | per unit |
|                          | ADC 2.0-V Reference Temp. Sensor 85°C | 01A20h  | 2            | per unit | per unit |
|                          | ADC 2.5-V Reference Temp. Sensor 30°C | 01A22h  | 2            | per unit | per unit |
|                          | ADC 2.5-V Reference Temp. Sensor 85°C | 01A24h  | 2            | per unit | per unit |



## 6.15 Identification

### 6.15.1 Revision Identification

The device revision information is shown as part of the top-side marking on the device package. The device-specific erratasheet describes these markings. For links to all of the erratasheets for the devices in this data sheet, see [Section 8.2](#).

The hardware revision is also stored in the Device Descriptor structure in the Info Block section. For details on this value, see the "Hardware Revision" entries in [Section 6.14](#).

### 6.15.2 Device Identification

The device type can be identified from the top-side marking on the device package. The device-specific erratasheet describes these markings. For links to all of the erratasheets for the devices in this data sheet, see [Section 8.2](#).

A device identification value is also stored in the Device Descriptor structure in the Info Block section. For details on this value, see the "Device ID" entries in [Section 6.14](#).

### 6.15.3 JTAG Identification

Programming through the JTAG interface, including reading and identifying the JTAG ID, is described in detail in the *MSP430 Programming Via the JTAG Interface User's Guide* ([SLAU320](#)).

## 7 Applications, Implementation, and Layout

The following resources provide application guidelines and best practices when designing with the MSP430F67641 and MSP430F67621 devices.

### ***Implementation of a Low-Cost Three-Phase Watt-Hour Meter Using the MSP430F67641*** ([SLAA621](#))

This application report describes the implementation of a low-cost three-phase electronic electricity meter using the Texas Instruments MSP430F67641 metering processor. This application report includes the necessary information with regard to metrology software and hardware procedures for this single-chip implementation.

### ***Class 0.5 Three-Phase Smart Meter Reference Design*** ([TIDM-THREEPHASEMETER-F67641](#))

This design implements a complete smart meter design using the MSP430F67641 polyphase metering System on Chip. The design meets all requirements for ANSI/IEC Class 0.5 accuracy and the firmware provided calculates all energy measurement parameters. The F67641 SoC features 128KB of on-chip flash plus a 320-segment LCD controller for a single-chip solution to low-cost polyphase meter design challenges.

#### **Features**

- Low-cost three-phase electricity meter for Class 0.5 accuracy
- TI Energy Library firmware calculates all energy measurement parameters including active and reactive power and energy, RMS current and voltage, power factor, line frequency, fundamental and THD readings
- Add-on communications modules for wireless communications standards such as ZigBee®, Wi-Fi®, Wireless M-Bus, and IEEE-802.15.4g. Both 2.4 GHz and Sub-1 GHz.
- Built-in 160-segment display
- Powered from three-phase line voltage

## 8 Device and Documentation Support

### 8.1 Device Support

#### 8.1.1 Getting Started and Next Steps

For more information on the MSP430™ family of devices and the tools and libraries that are available to help with your development, visit the [Getting Started](#) page.

#### 8.1.2 Development Tools Support

All MSP430™ microcontrollers are supported by a wide variety of software and hardware development tools. Tools are available from TI and various third parties. See them all at [www.ti.com/msp430tools](http://www.ti.com/msp430tools).

##### 8.1.2.1 Hardware Features

See the *Code Composer Studio for MSP430 User's Guide* ([SLAU157](#)) for details on the available features.

| MSP430 Architecture | 4-Wire JTAG | 2-Wire JTAG | Break-points (N) | Range Break-points | Clock Control | State Sequencer | Trace Buffer | LPMx.5 Debugging Support |
|---------------------|-------------|-------------|------------------|--------------------|---------------|-----------------|--------------|--------------------------|
| MSP430Xv2           | Yes         | Yes         | 3                | Yes                | Yes           | No              | No           | No                       |

##### 8.1.2.2 Recommended Hardware Options

###### 8.1.2.2.1 Target Socket Boards

The target socket boards allow easy programming and debugging of the device using JTAG. They also feature header pin outs for prototyping. Target socket boards are orderable individually or as a kit with the JTAG programmer and debugger included. The following table shows the compatible target boards and the supported packages.

| Package           | Target Board and Programmer Bundle | Target Board Only               |
|-------------------|------------------------------------|---------------------------------|
| 100-pin LQFP (PZ) | <a href="#">MSP-FET430U100B</a>    | <a href="#">MSP-TS430PZ100B</a> |

###### 8.1.2.2.2 Experimenter Boards

Experimenter Boards and Evaluation kits are available for some MSP430 devices. These kits feature additional hardware components and connectivity for full system evaluation and prototyping. See [www.ti.com/msp430tools](http://www.ti.com/msp430tools) for details.

###### 8.1.2.2.3 Debugging and Programming Tools

Hardware programming and debugging tools are available from TI and from its third party suppliers. See the full list of available tools at [www.ti.com/msp430tools](http://www.ti.com/msp430tools).

###### 8.1.2.2.4 Production Programmers

The production programmers expedite loading firmware to devices by programming several devices simultaneously.

| Part Number              | PC Port        | Features  | Provider          |
|--------------------------|----------------|---|-------------------|
| <a href="#">MSP-GANG</a> | Serial and USB | Program up to eight devices at a time. Works with PC or standalone. | Texas Instruments |

##### 8.1.2.3 Recommended Software Options

###### 8.1.2.3.1 Integrated Development Environments

Software development tools are available from TI or from third parties. Open source solutions are also available.

This device is supported by Code Composer Studio™ IDE (CCS).

### 8.1.2.3.2 MSP430Ware

[MSP430Ware](#) is a collection of code examples, data sheets, and other design resources for all MSP430 devices delivered in a convenient package. In addition to providing a complete collection of existing MSP430 design resources, MSP430Ware also includes a high-level API called MSP430 Driver Library. This library makes it easy to program MSP430 hardware. MSP430Ware is available as a component of CCS or as a standalone package.

### 8.1.2.3.3 Command-Line Programmer

[MSP430 Flasher](#) is an open-source, shell-based interface for programming MSP430 microcontrollers through a FET programmer or eZ430 using JTAG or Spy-Bi-Wire (SBW) communication. MSP430 Flasher can be used to download binary files (.txt or .hex) files directly to the MSP430 microcontroller without the need for an IDE.

## 8.1.3 Device and Development Tool Nomenclature

To designate the stages in the product development cycle, TI assigns prefixes to the part numbers of all MSP430 MCU devices and support tools. Each MSP430 MCU commercial family member has one of three prefixes: MSP, PMS, or XMS (for example, MSP430F5259). Texas Instruments recommends two of three possible prefix designators for its support tools: MSP and MSPX. These prefixes represent evolutionary stages of product development from engineering prototypes (with XMS for devices and MSPX for tools) through fully qualified production devices and tools (with MSP for devices and MSP for tools).

Device development evolutionary flow:

**XMS** – Experimental device that is not necessarily representative of the final device's electrical specifications

**PMS** – Final silicon die that conforms to the device's electrical specifications but has not completed quality and reliability verification

**MSP** – Fully qualified production device

Support tool development evolutionary flow:

**MSPX** – Development-support product that has not yet completed Texas Instruments internal qualification testing.

**MSP** – Fully-qualified development-support product

XMS and PMS devices and MSPX development-support tools are shipped against the following disclaimer:

"Developmental product is intended for internal evaluation purposes."

MSP devices and MSP development-support tools have been characterized fully, and the quality and reliability of the device have been demonstrated fully. TI's standard warranty applies.

Predictions show that prototype devices (XMS and PMS) have a greater failure rate than the standard production devices. Texas Instruments recommends that these devices not be used in any production system because their expected end-use failure rate still is undefined. Only qualified production devices are to be used.

TI device nomenclature also includes a suffix with the device family name. This suffix indicates the package type (for example, PZP) and temperature range (for example, T). [Figure 8-1](#) provides a legend for reading the complete device name for any family member.

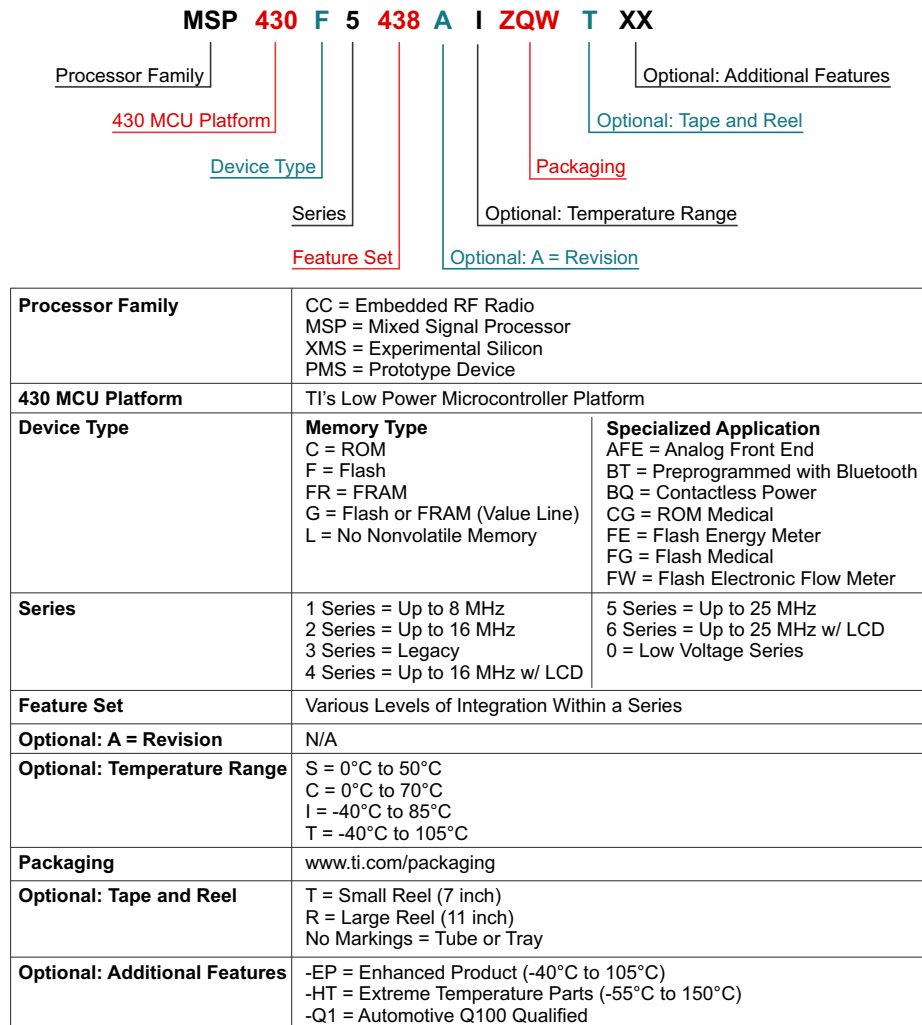


Figure 8-1. Device Nomenclature

## 8.2 Documentation Support

The following documents describe the MSP430F676x1 devices. Copies of these documents are available on the Internet at [www.ti.com](http://www.ti.com).

[SLAU208](#) **MSP430x5xx and MSP430x6xx Family User's Guide.** Detailed information on the modules and peripherals available in this device family.

[SLAZ606](#) **MSP430F67641 Device Erratasheet.** Describes the known exceptions to the functional specifications for the MSP430F67641 device.

[SLAZ607](#) **MSP430F67621 Device Erratasheet.** Describes the known exceptions to the functional specifications for the MSP430F67621 device.

## 8.3 Related Links

[Table 8-1](#) lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

**Table 8-1. Related Links**

| PARTS        | PRODUCT FOLDER             | SAMPLE & BUY               | TECHNICAL DOCUMENTS        | TOOLS & SOFTWARE           | SUPPORT & COMMUNITY        |
|--------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| MSP430F67641 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| MSP430F67621 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |

## 8.4 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

### [TI E2E Community](#)

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### [TI Embedded Processors Wiki](#)

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## 8.5 Trademarks

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## 8.6 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## 8.7 Glossary

[SLYZ022](#) — *TI Glossary.*

This glossary lists and explains terms, acronyms and definitions.

## 9 Mechanical, Packaging, and Orderable Information

The following pages include mechanical packaging and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2)         | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|-----------------|------|-------------|-------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| MSP430F67621IPN  | ACTIVE        | LQFP         | PN              | 80   | 119         | Green (RoHS & no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | F67621                  | <a href="#">Samples</a> |
| MSP430F67621IPNR | ACTIVE        | LQFP         | PN              | 80   | 1000        | Green (RoHS & no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | F67621                  | <a href="#">Samples</a> |
| MSP430F67621IPZ  | ACTIVE        | LQFP         | PZ              | 100  | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | F67621                  | <a href="#">Samples</a> |
| MSP430F67621IPZR | ACTIVE        | LQFP         | PZ              | 100  | 1000        | Green (RoHS & no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | F67621                  | <a href="#">Samples</a> |
| MSP430F67641IPN  | ACTIVE        | LQFP         | PN              | 80   | 119         | Green (RoHS & no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | F67641                  | <a href="#">Samples</a> |
| MSP430F67641IPNR | ACTIVE        | LQFP         | PN              | 80   | 1000        | Green (RoHS & no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | F67641                  | <a href="#">Samples</a> |
| MSP430F67641IPZ  | ACTIVE        | LQFP         | PZ              | 100  | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | F67641                  | <a href="#">Samples</a> |
| MSP430F67641IPZR | ACTIVE        | LQFP         | PZ              | 100  | 1000        | Green (RoHS & no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | F67641                  | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| MSP430F67621IPNR | LQFP         | PN              | 80   | 1000 | 330.0              | 24.4               | 15.0    | 15.0    | 2.1     | 20.0    | 24.0   | Q2            |
| MSP430F67621IPZR | LQFP         | PZ              | 100  | 1000 | 330.0              | 24.4               | 17.0    | 17.0    | 2.1     | 20.0    | 24.0   | Q2            |
| MSP430F67641IPNR | LQFP         | PN              | 80   | 1000 | 330.0              | 24.4               | 15.0    | 15.0    | 2.1     | 20.0    | 24.0   | Q2            |
| MSP430F67641IPZR | LQFP         | PZ              | 100  | 1000 | 330.0              | 24.4               | 17.0    | 17.0    | 2.1     | 20.0    | 24.0   | Q2            |

**TAPE AND REEL BOX DIMENSIONS**



\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| MSP430F67621IPNR | LQFP         | PN              | 80   | 1000 | 367.0       | 367.0      | 45.0        |
| MSP430F67621IPZR | LQFP         | PZ              | 100  | 1000 | 367.0       | 367.0      | 45.0        |
| MSP430F67641IPNR | LQFP         | PN              | 80   | 1000 | 367.0       | 367.0      | 45.0        |
| MSP430F67641IPZR | LQFP         | PZ              | 100  | 1000 | 367.0       | 367.0      | 45.0        |

PN (S-PQFP-G80)

PLASTIC QUAD FLATPACK



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Falls within JEDEC MS-026

PZ (S-PQFP-G100)

PLASTIC QUAD FLATPACK



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| Data Converters              | <a href="http://dataconverter.ti.com">dataconverter.ti.com</a>                       |
| DLP® Products                | <a href="http://www.dlp.com">www.dlp.com</a>   |
| DSP                          | <a href="http://dsp.ti.com">dsp.ti.com</a>   |
| Clocks and Timers            | <a href="http://www.ti.com/clocks">www.ti.com/clocks</a>                             |
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| Logic                        | <a href="http://logic.ti.com">logic.ti.com</a>                                       |
| Power Mgmt                   | <a href="http://power.ti.com">power.ti.com</a>                                       |
| Microcontrollers             | <a href="http://microcontroller.ti.com">microcontroller.ti.com</a>                   |
| RFID                         | <a href="http://www.ti-rfid.com">www.ti-rfid.com</a>                                 |
| OMAP Applications Processors | <a href="http://www.ti.com/omap">www.ti.com/omap</a>                                 |
| Wireless Connectivity        | <a href="http://www.ti.com/wirelessconnectivity">www.ti.com/wirelessconnectivity</a> |

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| Communications and Telecom    | <a href="http://www.ti.com/communications">www.ti.com/communications</a>                 |
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| Consumer Electronics          | <a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a>                   |
| Energy and Lighting           | <a href="http://www.ti.com/energy">www.ti.com/energy</a>                                 |
| Industrial                    | <a href="http://www.ti.com/industrial">www.ti.com/industrial</a>                         |
| Medical                       | <a href="http://www.ti.com/medical">www.ti.com/medical</a>                               |
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